

PIC32MX1XX/2XX 28/36/44-PIN

32-bit Microcontrollers (up to 256 KB Flash and 64 KB SRAM) with Audio and Graphics Interfaces, USB, and Advanced Analog

Operating Conditions

- 2.3V to 3.6V, -40°C to +105°C, DC to 40 MHz
- 2.3V to 3.6V, -40°C to +85°C, DC to 50 MHz

Core: 50 MHz/83 DMIPS MIPS32[®] M4K[®]

- MIPS16e[®] mode for up to 40% smaller code size
- Code-efficient (C and Assembly) architecture
- Single-cycle (MAC) 32x16 and two-cycle 32x32 multiply

Clock Management

- 0.9% internal oscillator
- · Programmable PLLs and oscillator clock sources
- Fail-Safe Clock Monitor (FSCM)
- Independent Watchdog Timer
- Fast wake-up and start-up

Power Management

- · Low-power management modes (Sleep and Idle)
- · Integrated Power-on Reset and Brown-out Reset
- 0.5 mA/MHz dynamic current (typical)
- 44 µA IPD current (typical)

Audio Interface Features

- Data communication: I²S, LJ, RJ, and DSP modes
- Control interface: SPI and I²C
- Master clock:
 - Generation of fractional clock frequencies
- Can be synchronized with USB clock
- Can be tuned in run-time

Advanced Analog Features

- · ADC Module:
 - 10-bit 1.1 Msps rate with one S&H
 - Up to 10 analog inputs on 28-pin devices and 13 analog inputs on 44-pin devices
- Flexible and independent ADC trigger sources
- Charge Time Measurement Unit (CTMU):
 - Supports mTouch™ capacitive touch sensing
 - Provides high-resolution time measurement (1 ns)
 - On-chip temperature measurement capability
- Comparators:
 - Up to three Analog Comparator modules
 - Programmable references with 32 voltage points

Timers/Output Compare/Input Capture

- Five General Purpose Timers:
- Five 16-bit and up to two 32-bit Timers/Counters
- Five Output Compare (OC) modules
- Five Input Capture (IC) modules
- · Peripheral Pin Select (PPS) to allow function remap
- · Real-Time Clock and Calendar (RTCC) module

Communication Interfaces

- USB 2.0-compliant Full-speed OTG controller
- Two UART modules (12.5 Mbps):
 - Supports LIN 2.0 protocols and IrDA[®] support
- Two 4-wire SPI modules (25 Mbps)
- Two I²C modules (up to 1 Mbaud) with SMBus support
- PPS to allow function remap
- Parallel Master Port (PMP)

Direct Memory Access (DMA)

- Four channels of hardware DMA with automatic data size detection
- · Two additional channels dedicated for USB
- Programmable Cyclic Redundancy Check (CRC)

Input/Output

- 10 mA source/sink on all I/O pins and up to 14 mA on non-standard VOH
- 5V-tolerant pins
- · Selectable open drain, pull-ups, and pull-downs
- External interrupts on all I/O pins

Qualification and Class B Support

- AEC-Q100 REVG (Grade 2 -40°C to +105°C) planned
- Class B Safety Library, IEC 60730

Debugger Development Support

- · In-circuit and in-application programming
- 4-wire MIPS[®] Enhanced JTAG interface
- · Unlimited program and six complex data breakpoints
- IEEE 1149.2-compatible (JTAG) boundary scan

Packages

U								
Туре	SOIC	SSOP	SPDIP	QFN		VT	TQFP	
Pin Count	28	28	28	28	44	36	44	44
I/O Pins (up to)	21	21	21	21	34	25	34	34
Contact/Lead Pitch	1.27	0.65	0.100"	0.65	0.65	0.50	0.50	0.80
Dimensions	17.90x7.50x2.65	10.2x5.3x2	1.365"x.285"x.135"	6x6x0.9	8x8x0.9	5x5x0.9	6x6x0.9	10x10x1

Note: All dimensions are in millimeters (mm) unless specified.

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Device	Pins	Program Memory (KB) ⁽¹⁾	Data Memory (KB)	Remappable Pins	Timers ⁽²⁾ /Capture/Compare	UART	SPI/I ² S	External Interrupts ⁽³⁾	Analog Comparators	USB On-The-Go (OTG)	I ² C	dWd	DMA Channels (Programmable/Dedicated)	CTMU	10-bit 1 Msps ADC (Channels)	RTCC	I/O Pins	JTAG	Packages
PIC32MX110F016B	28	16+3	4	20	5/5/5	2	2	5	3	N	2	Y	4/0	Y	10	Y	21	Y	SOIC, SSOP, SPDIP, QFN
PIC32MX110F016C	36	16+3	4	24	5/5/5	2	2	5	3	Ν	2	Υ	4/0	Y	12	Y	25	Υ	VTLA
PIC32MX110F016D	44	16+3	4	32	5/5/5	2	2	5	3	N	2	Y	4/0	Y	13	Y	35	Y	VTLA, TQFP, QFN
PIC32MX120F032B	28	32+3	8	20	5/5/5	2	2	5	3	N	2	Y	4/0	Y	10	Y	21	Y	SOIC, SSOP, SPDIP, QFN
PIC32MX120F032C	36	32+3	8	24	5/5/5	2	2	5	3	Ν	2	Y	4/0	Y	12	Y	25	Y	VTLA
PIC32MX120F032D	44	32+3	8	32	5/5/5	2	2	5	3	N	2	Y	4/0	Y	13	Y	35	Y	VTLA, TQFP, QFN
PIC32MX130F064B	28	64+3	16	20	5/5/5	2	2	5	3	N	2	Y	4/0	Y	10	Y	21	Y	SOIC, SSOP, SPDIP, QFN
PIC32MX130F064C	36	64+3	16	24	5/5/5	2	2	5	3	Ν	2	Y	4/0	Y	12	Y	25	Υ	VTLA
PIC32MX130F064D	44	64+3	16	32	5/5/5	2	2	5	3	N	2	Y	4/0	Y	13	Y	35	Y	VTLA, TQFP, QFN
PIC32MX150F128B	28	128+3	32	20	5/5/5	2	2	5	3	N	2	Y	4/0	Y	10	Y	21	Y	SOIC, SSOP, SPDIP, QFN
PIC32MX150F128C	36	128+3	32	24	5/5/5	2	2	5	3	Ν	2	Υ	4/0	Y	12	Y	25	Υ	VTLA
PIC32MX150F128D	44	128+3	32	32	5/5/5	2	2	5	3	N	2	Y	4/0	Y	13	Y	35	Y	VTLA, TQFP, QFN
PIC32MX130F256B	28	256+3	16	20	5/5/5	2	2	5	3	N	2	Y	4/0	Y	10	Y	21	Y	SSOP, SPDIP, QFN
PIC32MX130F256D	44	256+3	16	32	5/5/5	2	2	5	3	N	2	Y	4/0	Y	13	Y	35	Y	VTLA, TQFP, QFN
PIC32MX170F256B	28	256+3	64	20	5/5/5	2	2	5	3	N	2	Y	4/0	Y	10	Y	21	Y	SOIC, SSOP, SPDIP, QFN
PIC32MX170F256D	44	256+3	64	32	5/5/5	2	2	5	3	N	2	Y	4/0	Y	13	Y	35	Y	VTLA, TQFP, QFN

TABLE 1: PIC32MX1XX 28/36/44-PIN GENERAL PURPOSE FAMILY FEATURES

Note 1: This device features 3 KB of boot Flash memory.

2: Four out of five timers are remappable.

3: Four out of five external interrupts are remappable.

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Device	Pins	Program Memory (KB) ⁽¹⁾	Data Memory (KB)	Remappable Pins	Timers ⁽²⁾ /Capture/Compare	UART	SPI/I ² S	External Interrupts ⁽³⁾	Analog Comparators	USB On-The-Go (OTG)	I ² C	dWd	DMA Channels (Programmable/Dedicated)	CTMU	10-bit 1 Msps ADC (Channels)	RTCC	VO Pins	ÐTTAG	Packages
PIC32MX210F016B	28	16+3	4	19	5/5/5	2	2	5	3	Y	2	Y	4/2	Y	9	Y	19	Y	SOIC, SSOP, SPDIP, QFN
PIC32MX210F016C	36	16+3	4	23	5/5/5	2	2	5	3	Y	2	Y	4/2	Y	12	Y	25	Y	VTLA
PIC32MX210F016D	44	16+3	4	31	5/5/5	2	2	5	3	Y	2	Y	4/2	Y	13	Y	33	Y	VTLA, TQFP, QFN
PIC32MX220F032B	28	32+3	8	19	5/5/5	2	2	5	3	Y	2	Y	4/2	Y	9	Y	19	Y	SOIC, SSOP, SPDIP, QFN
PIC32MX220F032C	36	32+3	8	23	5/5/5	2	2	5	3	Y	2	Y	4/2	Υ	12	Y	23	Y	VTLA
PIC32MX220F032D	44	32+3	8	31	5/5/5	2	2	5	3	Y	2	Y	4/2	Y	13	Y	33	Y	VTLA, TQFP, QFN
PIC32MX230F064B	28	64+3	16	19	5/5/5	2	2	5	3	Y	2	Y	4/2	Y	9	Y	19	Y	SOIC, SSOP, SPDIP, QFN
PIC32MX230F064C	36	64+3	16	23	5/5/5	2	2	5	3	Y	2	Y	4/2	Υ	12	Y	23	Y	VTLA
PIC32MX230F064D	44	64+3	16	31	5/5/5	2	2	5	3	Y	2	Y	4/2	Y	13	Y	33	Y	VTLA, TQFP, QFN
PIC32MX250F128B	28	128+3	32	19	5/5/5	2	2	5	3	Y	2	Y	4/2	Y	9	Y	19	Y	SOIC, SSOP, SPDIP, QFN
PIC32MX250F128C	36	128+3	32	23	5/5/5	2	2	5	3	Y	2	Y	4/2	Y	12	Y	23	Y	VTLA
PIC32MX250F128D	44	128+3	32	31	5/5/5	2	2	5	3	Y	2	Y	4/2	Y	13	Y	33	Y	VTLA, TQFP, QFN
PIC32MX230F256B	28	256+3	16	20	5/5/5	2	2	5	3	Y	2	Y	4/2	Y	9	Y	19	Y	SSOP, SPDIP, QFN
PIC32MX230F256D	44	256+3	16	31	5/5/5	2	2	5	3	Y	2	Y	4/2	Y	13	Y	33	Y	VTLA, TQFP, QFN
PIC32MX270F256B	28	256+3	64	19	5/5/5	2	2	5	3	Y	2	Y	4/2	Y	9	Y	19	Y	SOIC, SSOP, SPDIP, QFN
PIC32MX270F256D Note 1: This device	44	256+3	64	31	5/5/5	2	2	5	3	Y	2	Y	4/2	Y	13	Y	33	Y	VTLA, TQFP, QFN

TABLE 2: PIC32MX2XX 28/36/44-PIN USB FAMILY FEATURES

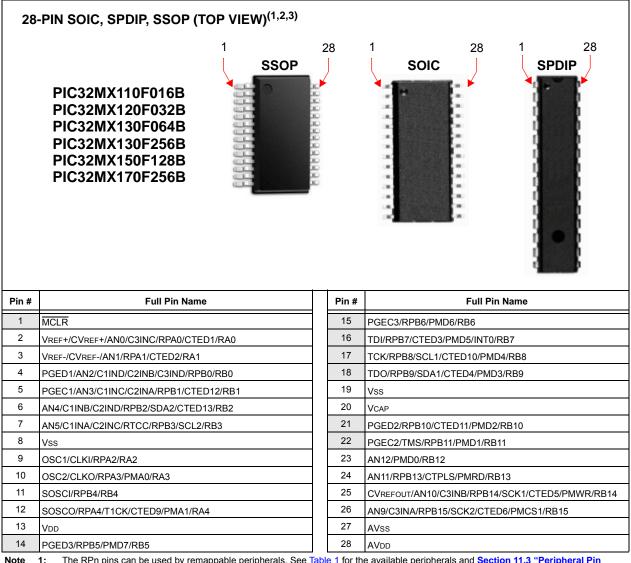
Note 1: This device features 3 KB of boot Flash memory.

2: Four out of five timers are remappable.

3: Four out of five external interrupts are remappable.

Pin Diagrams

TABLE 3: PIN NAMES FOR 28-PIN GENERAL PURPOSE DEVICES



1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and Section 11.3 "Peripheral Pin Select" for restrictions.

2: Every I/O port pin (RAx-RCx) can be used as a change notification pin (CNAx-CNCx). See Section 11.0 "I/O Ports" for more information.

3: Shaded pins are 5V tolerant.

TABL	E 4: PIN NAMES FOR 28-PIN USB DEVIC	CES	
28	-PIN SOIC, SPDIP, SSOP (TOP VIEW) ^(1,2,3)		
	PIC32MX210F016B PIC32MX220F032B PIC32MX230F064B PIC32MX230F256B PIC32MX250F128B PIC32MX270F256B		SOIC SPDIP
Pin #	Full Pin Name	Pin #	Full Pin Name
Pin #	Full Pin Name	Pin #	Full Pin Name VBUS
		-	
1	MCLR	15	VBUS
1	MCLR	15	VBUS
2	PGED3/VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/PMD7/RA0	16	TDI/RPB7/CTED3/PMD5/INT0/RB7
1	MCLR	15	VBUS
2	PGED3/VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/PMD7/RA0	16	TDI/RPB7/CTED3/PMD5/INT0/RB7
3	PGEC3/VREF-/CVREF-/AN1/RPA1/CTED2/PMD6/RA1	17	TCK/RPB8/SCL1/CTED10/PMD4/RB8
1	MCLR	15	VBUS
2	PGED3/VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/PMD7/RA0	16	TDI/RPB7/CTED3/PMD5/INT0/RB7
3	PGEC3/VREF-/CVREF-/AN1/RPA1/CTED2/PMD6/RA1	17	TCK/RPB8/SCL1/CTED10/PMD4/RB8
4	PGED1/AN2/C1IND/C2INB/C3IND/RPB0/PMD0/RB0	18	TDO/RPB9/SDA1/CTED4/PMD3/RB9
1	MCLR PGED3/VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/PMD7/RA0 PGEC3/VREF-/CVREF-/AN1/RPA1/CTED2/PMD6/RA1 PGED1/AN2/C1IND/C2INB/C3IND/RPB0/PMD0/RB0 PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/PMD1/RB1	15	VBUS
2		16	TDI/RPB7/CTED3/PMD5/INT0/RB7
3		17	TCK/RPB8/SCL1/CTED10/PMD4/RB8
4		18	TDO/RPB9/SDA1/CTED4/PMD3/RB9
5		19	Vss
1	MCLR PGED3/VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/PMD7/RA0 PGEC3/VREF-/CVREF-/AN1/RPA1/CTED2/PMD6/RA1 PGED1/AN2/C1IND/C2INB/C3IND/RPB0/PMD0/RB0 PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/PMD1/RB1 AN4/C1INB/C2IND/RPB2/SDA2/CTED13/PMD2/RB2	15	VBUS
2		16	TDI/RPB7/CTED3/PMD5/INT0/RB7
3		17	TCK/RPB8/SCL1/CTED10/PMD4/RB8
4		18	TDO/RPB9/SDA1/CTED4/PMD3/RB9
5		19	Vss
6		20	Vcap
1	MCLR PGED3/VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/PMD7/RA0 PGEC3/VREF-/CVREF-/AN1/RPA1/CTED2/PMD6/RA1 PGED1/AN2/C1IND/C2INB/C3IND/RPB0/PMD0/RB0 PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/PMD1/RB1 AN4/C1INB/C2IND/RPB2/SDA2/CTED13/PMD2/RB2 AN5/C1INA/C2INC/RTCC/RPB3/SCL2/PMWR/RB3	15	VBUS
2		16	TDI/RPB7/CTED3/PMD5/INT0/RB7
3		17	TCK/RPB8/SCL1/CTED10/PMD4/RB8
4		18	TDO/RPB9/SDA1/CTED4/PMD3/RB9
5		19	Vss
6		20	Vcap
7		21	PGED2/RPB10/D+/CTED11/RB10
1	MCLR PGED3/VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/PMD7/RA0 PGEC3/VREF-/CVREF-/AN1/RPA1/CTED2/PMD6/RA1 PGED1/AN2/C1IND/C2INB/C3IND/RPB0/PMD0/RB0 PGEC1/AN3/C1INC/C2INB/C3IND/RPB0/PMD0/RB1 AN4/C1INB/C2IND/RPB2/SDA2/CTED13/PMD2/RB2 AN5/C1INA/C2INC/RTCC/RPB3/SCL2/PMWR/RB3 Vss	15	VBUS
2		16	TDI/RPB7/CTED3/PMD5/INT0/RB7
3		17	TCK/RPB8/SCL1/CTED10/PMD4/RB8
4		18	TDO/RPB9/SDA1/CTED4/PMD3/RB9
5		19	VSS
6		20	VCAP
7		21	PGED2/RPB10/D+/CTED11/RB10
8		22	PGEC2/RPB11/D-/RB11
1	MCLR PGED3/VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/PMD7/RA0 PGEC3/VREF-/CVREF-/AN1/RPA1/CTED2/PMD6/RA1 PGED1/AN2/C1IND/C2INB/C3IND/RPB0/PMD0/RB0 PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/PMD1/RB1 AN4/C1INB/C2IND/RPB2/SDA2/CTED13/PMD2/RB2 AN5/C1INA/C2INC/RTCC/RPB3/SCL2/PMWR/RB3 Vss OSC1/CLKI/RPA2/RA2	15	VBUS
2		16	TDI/RPB7/CTED3/PMD5/INT0/RB7
3		17	TCK/RPB8/SCL1/CTED10/PMD4/RB8
4		18	TDO/RPB9/SDA1/CTED4/PMD3/RB9
5		19	Vss
6		20	VCAP
7		21	PGED2/RPB10/D+/CTED11/RB10
8		22	PGEC2/RPB11/D-/RB11
9		23	VUSB3V3
1	MCLR PGED3/VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/PMD7/RA0 PGEC3/VREF-/CVREF-/AN1/RPA1/CTED2/PMD6/RA1 PGED1/AN2/C1IND/C2INB/C3IND/RPB0/PMD0/RB0 PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/PMD1/RB1 AN4/C1INB/C2IND/RPB2/SDA2/CTED13/PMD2/RB2 AN5/C1INA/C2INC/RTCC/RPB3/SCL2/PMWR/RB3 Vss OSC1/CLKI/RPA2/RA2 OSC2/CLKO/RPA3/PMA0/RA3	15	VBUS
2		16	TDI/RPB7/CTED3/PMD5/INT0/RB7
3		17	TCK/RPB8/SCL1/CTED10/PMD4/RB8
4		18	TDO/RPB9/SDA1/CTED4/PMD3/RB9
5		19	VSS
6		20	VCAP
7		21	PGED2/RPB10/D+/CTED11/RB10
8		22	PGEC2/RPB11/D-/RB11
9		23	VUSB3V3
10		24	AN11/RPB13/CTPLS/PMRD/RB13
1 2 3 4 5 6 7 8 9 10 11	MCLR PGED3/VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/PMD7/RA0 PGEC3/VREF-/CVREF-/AN1/RPA1/CTED2/PMD6/RA1 PGED1/AN2/C1IND/C2INB/C3IND/RPB0/PMD0/RB0 PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/PMD1/RB1 AN4/C1INB/C2IND/RPB2/SDA2/CTED13/PMD2/RB2 AN5/C1INA/C2INC/RTCC/RPB3/SCL2/PMWR/RB3 Vss OSC1/CLKI/RPA2/RA2 OSC2/CLKO/RPA3/PMA0/RA3 SOSCI/RPB4/RB4	15 16 17 18 19 20 21 22 23 24 25	VBUS TDI/RPB7/CTED3/PMD5/INT0/RB7 TCK/RPB8/SCL1/CTED10/PMD4/RB8 TDO/RPB9/SDA1/CTED4/PMD3/RB9 Vss VCAP PGED2/RPB10/D+/CTED11/RB10 PGEC2/RPB11/D-/RB11 VUSB3V3 AN11/RPB13/CTPLS/PMRD/RB13 CVREFOUT/AN10/C3INB/RPB14/VBUSON/SCK1/CTED5/RB14

The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and Section 11.3 "Peripheral Pin Select" for restrictions. 1:

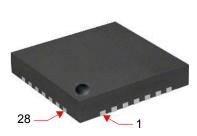
Every I/O port pin (RAx-RCx) can be used as a change notification pin (CNAx-CNCx). See Section 11.0 "I/O Ports" for more informa-2: tion.

Shaded pins are 5V tolerant. 3:

TABLE 5: PIN NAMES FOR 28-PIN GENERAL PURPOSE DEVICES

28-PIN QFN (TOP VIEW)^(1,2,3.4)

PIC32MX110F016B PIC32MX120F032B PIC32MX130F064B PIC32MX130F256B PIC32MX150F128B PIC32MX170F256B



Pin #	Full Pin Name	Pin #	Full Pin Name
1	PGED1/AN2/C1IND/C2INB/C3IND/RPB0/RB0	15	TDO/RPB9/SDA1/CTED4/PMD3/RB9
2	PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/RB1	16	Vss
3	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/RB2	17	VCAP
4	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/RB3	18	PGED2/RPB10/CTED11/PMD2/RB10
5	Vss	19	PGEC2/TMS/RPB11/PMD1/RB11
6	OSC1/CLKI/RPA2/RA2	20	AN12/PMD0/RB12
7	OSC2/CLKO/RPA3/PMA0/RA3	21	AN11/RPB13/CTPLS/PMRD/RB13
8	SOSCI/RPB4/RB4	22	CVREFOUT/AN10/C3INB/RPB14/SCK1/CTED5/PMWR/RB14
9	SOSCO/RPA4/T1CK/CTED9/PMA1/RA4	23	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15
10	Vdd	24	AVss
11	PGED3/RPB5/PMD7/RB5	25	AVDD
12	PGEC3/RPB6/PMD6/RB6	26	MCLR
13	TDI/RPB7/CTED3/PMD5/INT0/RB7	27	VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/RA0
14	TCK/RPB8/SCL1/CTED10/PMD4/RB8	28	VREF-/CVREF-/AN1/RPA1/CTED2/RA1
Note	1: The RPn pins can be used by remappable peripherals. See T	able 1 for th	ne available peripherals and Section 11.3 "Peripheral Pin

1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and Section 11.3 "Peripheral Pin Select" for restrictions.

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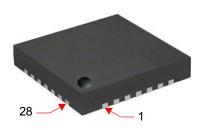
3: The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to Vss externally.

4: Shaded pins are 5V tolerant.

TABLE 6: **PIN NAMES FOR 28-PIN USB DEVICES**

28-PIN QFN (TOP VIEW)^(1,2,3,4)

PIC32MX210F016B PIC32MX220F032B PIC32MX230F064B PIC32MX230F256B PIC32MX250F128B PIC32MX270F256B



Pin #	Full Pin Name		Pin #	
1	PGED1/AN2/C1IND/C2INB/C3IND/RPB0/PMD0/RB0		15	TDO/RPB9/SDA1/0
2	PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/PMD1/RB1		16	Vss
3	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/PMD2/RB2		17	VCAP
4	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/PMWR/RB3		18	PGED2/RPB10/D+
5	Vss		19	PGEC2/RPB11/D-/
6	OSC1/CLKI/RPA2/RA2		20	VUSB3V3
7	OSC2/CLKO/RPA3/PMA0/RA3		21	AN11/RPB13/CTPL
8	SOSCI/RPB4/RB4		22	CVREFOUT/AN10/C
9	SOSCO/RPA4/T1CK/CTED9/PMA1/RA4		23	AN9/C3INA/RPB15
10	VDD		24	AVss
11	TMS/RPB5/USBID/RB5		25	AVDD
12	VBUS		26	MCLR
13	TDI/RPB7/CTED3/PMD5/INT0/RB7		27	PGED3/VREF+/CVF
14	TCK/RPB8/SCL1/CTED10/PMD4/RB8		28	PGEC3/VREF-/CVR
Note	1: The RPn pins can be used by remappable peripherals. Se	e Table	a 1 for th	

Pin #	Full Pin Name
15	TDO/RPB9/SDA1/CTED4/PMD3/RB9
16	Vss
17	VCAP
18	PGED2/RPB10/D+/CTED11/RB10
19	PGEC2/RPB11/D-/RB11
20	VUSB3V3
21	AN11/RPB13/CTPLS/PMRD/RB13
22	CVREFOUT/AN10/C3INB/RPB14/VBUSON/SCK1/CTED5/RB14
23	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15
24	AVss
25	AVdd
26	MCLR
27	PGED3/VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/PMD7/RA0
28	PGEC3/VREF-/CVREF-/AN1/RPA1/CTED2/PMD6/RA1

The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and Section 11.3 "Peripheral Pin 1: Select" for restrictions.

2:

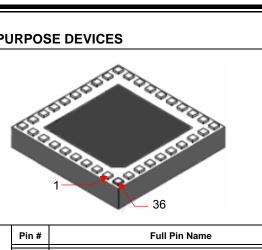
Every I/O port pin (RAx-RCx) can be used as a change notification pin (CNAx-CNCx). See Section 11.0 "I/O Ports" for more information. The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to Vss externally. 3:

4: Shaded pins are 5V tolerant.

TABLE 7: PIN NAMES FOR 36-PIN GENERAL PURPOSE DEVICES

36-PIN VTLA (BOTTOM VIEW)^(1,2,3,5)

PIC32MX110F016C PIC32MX120F032C PIC32MX130F064C PIC32MX150F128C



Pin #	Full Pin Name	Pin #	Full Pin Name
1	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/RB2	19	TDO/RPB9/SDA1/CTED4/PMD3/RB9
2	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/RB3	20	RPC9/CTED7/RC9
3	PGED4 ⁽⁴⁾ /AN6/RPC0/RC0	21	Vss
4	PGEC4 ⁽⁴⁾ /AN7/RPC1/RC1	22	VCAP
5	Vdd	23	Vdd
6	Vss	24	PGED2/RPB10/CTED11/PMD2/RB10
7	OSC1/CLKI/RPA2/RA2	25	PGEC2/TMS/RPB11/PMD1/RB11
8	OSC2/CLKO/RPA3/PMA0/RA3	26	AN12/PMD0/RB12
9	SOSCI/RPB4/RB4	27	AN11/RPB13/CTPLS/PMRD/RB13
10	SOSCO/RPA4/T1CK/CTED9/PMA1/RA4	28	CVREFOUT/AN10/C3INB/RPB14/SCK1/CTED5/PMWR/RB14
11	RPC3/RC3	29	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15
12	Vss	30	AVss
13	VDD	31	AVdd
14	VDD	32	MCLR
15	PGED3/RPB5/PMD7/RB5	33	VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/RA0
16	PGEC3/RPB6/PMD6/RB6	34	VREF-/CVREF-/AN1/RPA1/CTED2/RA1
17	TDI/RPB7/CTED3/PMD5/INT0/RB7	35	PGED1/AN2/C1IND/C2INB/C3IND/RPB0/RB0
18	TCK/RPB8/SCL1/CTED10/PMD4/RB8	36	PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/RB1

Note 1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and Section 11.3 "Peripheral Pin Select" for restrictions.

2: Every I/O port pin (RAx-RCx) can be used as a change notification pin (CNAx-CNCx). See Section 11.0 "I/O Ports" for more information.

3: The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to Vss externally.

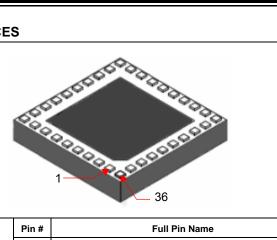
4: This pin function is not available on PIC32MX110F016C and PIC32MX120F032C devices.

5: Shaded pins are 5V tolerant.

TABLE 8: PIN NAMES FOR 36-PIN USB DEVICES

36-PIN VTLA (BOTTOM VIEW)^(1,2,3,5)

PIC32MX210F016C PIC32MX220F032C PIC32MX230F064C PIC32MX250F128C



Pin #	Full Pin Name	Pin #	Full Pin Name
1	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/PMD2/RB2	19	TDO/RPB9/SDA1/CTED4/PMD3/RB9
2	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/PMWR/RB3	20	RPC9/CTED7/RC9
3	PGED4 ⁽⁴⁾ /AN6/RPC0/RC0	21	Vss
4	PGEC4 ⁽⁴⁾ /AN7/RPC1/RC1	22	VCAP
5	VDD	23	VDD
6	Vss	24	PGED2/RPB10/D+/CTED11/RB10
7	OSC1/CLKI/RPA2/RA2	25	PGEC2/RPB11/D-/RB11
8	OSC2/CLKO/RPA3/PMA0/RA3	26	VUSB3V3
9	SOSCI/RPB4/RB4	27	AN11/RPB13/CTPLS/PMRD/RB13
10	SOSCO/RPA4/T1CK/CTED9/PMA1/RA4	28	CVREFOUT/AN10/C3INB/RPB14/VBUSON/SCK1/CTED5/RB14
11	AN12/RPC3/RC3	29	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15
12	Vss	30	AVss
13	VDD	31	AVDD
14	VDD	32	MCLR
15	TMS/RPB5/USBID/RB5	33	PGED3/VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/PMD7/RA0
16	VBUS	34	PGEC3/VREF-/CVREF-/AN1/RPA1/CTED2/PMD6/RA1
17	TDI/RPB7/CTED3/PMD5/INT0/RB7	35	PGED1/AN2/C1IND/C2INB/C3IND/RPB0/PMD0/RB0
18	TCK/RPB8/SCL1/CTED10/PMD4/RB8	36	PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/PMD1/RB1

Note 1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and Section 11.3 "Peripheral Pin Select" for restrictions.

2: Every I/O port pin (RAx-RCx) can be used as a change notification pin (CNAx-CNCx). See Section 11.0 "I/O Ports" for more information.

3: The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to Vss externally.

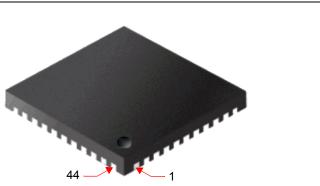
4: This pin function is not available on PIC32MX210F016C and PIC32MX120F032C devices.

5: Shaded pins are 5V tolerant.

TABLE 9: **PIN NAMES FOR 44-PIN GENERAL PURPOSE DEVICES**

44-PIN QFN (TOP VIEW)^(1,2,3,5)

PIC32MX110F016D PIC32MX120F032D PIC32MX130F064D PIC32MX130F256D PIC32MX150F128D PIC32MX170F256D



Pin #	Full Pin Name	Pin #	Full Pin Name
1	RPB9/SDA1/CTED4/PMD3/RB9	23	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/RB2
2	RPC6/PMA1/RC6	24	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/RB3
3	RPC7/PMA0/RC7	25	AN6/RPC0/RC0
4	RPC8/PMA5/RC8	26	AN7/RPC1/RC1
5	RPC9/CTED7/PMA6/RC9	27	AN8/RPC2/PMA2/RC2
6	Vss	28	VDD
7	VCAP	29	Vss
8	PGED2/RPB10/CTED11/PMD2/RB10	30	OSC1/CLKI/RPA2/RA2
9	PGEC2/RPB11/PMD1/RB11	31	OSC2/CLKO/RPA3/RA3
10	AN12/PMD0/RB12	32	TDO/RPA8/PMA8/RA8
11	AN11/RPB13/CTPLS/PMRD/RB13	33	SOSCI/RPB4/RB4
12	PGED4 ⁽⁴⁾ /TMS/PMA10/RA10	34	SOSCO/RPA4/T1CK/CTED9/RA4
13	PGEC4 ⁽⁴⁾ /TCK/CTED8/PMA7/RA7	35	TDI/RPA9/PMA9/RA9
14	CVREFOUT/AN10/C3INB/RPB14/SCK1/CTED5/PMWR/RB14	36	RPC3/RC3
15	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15	37	RPC4/PMA4/RC4
16	AVss	38	RPC5/PMA3/RC5
17	AVdd	39	Vss
18	MCLR	40	VDD
19	VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/RA0	41	PGED3/RPB5/PMD7/RB5
20	VREF-/CVREF-/AN1/RPA1/CTED2/RA1	42	PGEC3/RPB6/PMD6/RB6
21	PGED1/AN2/C1IND/C2INB/C3IND/RPB0/RB0	43	RPB7/CTED3/PMD5/INT0/RB7
22	PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/RB1	44	RPB8/SCL1/CTED10/PMD4/RB8

The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and Section 11.3 "Peripheral Pin 1: Select" for restrictions.

Every I/O port pin (RAx-RCx) can be used as a change notification pin (CNAx-CNCx). See Section 11.0 "I/O Ports" for more information. 2:

The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to Vss externally. This pin function is not available on PIC32MX110F016D and PIC32MX120F032D devices. 3:

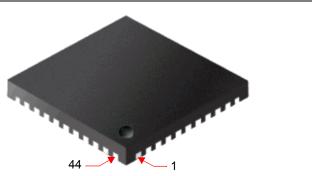
4:

5: Shaded pins are 5V tolerant.

TABLE 10: PIN NAMES FOR 44-PIN USB DEVICES

44-PIN QFN (TOP VIEW)^(1,2,3,5)

PIC32MX210F016D PIC32MX220F032D PIC32MX230F064D PIC32MX230F256D PIC32MX250F128D PIC32MX270F256D



Pin #	Full Pin Name	Pin #	Full Pin Name
1	RPB9/SDA1/CTED4/PMD3/RB9	23	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/PMD2/RB2
2	RPC6/PMA1/RC6	24	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/PMWR/RB3
3	RPC7/PMA0/RC7	25	AN6/RPC0/RC0
4	RPC8/PMA5/RC8	26	AN7/RPC1/RC1
5	RPC9/CTED7/PMA6/RC9	27	AN8/RPC2/PMA2/RC2
6	Vss	28	VDD
7	VCAP	29	Vss
8	PGED2/RPB10/D+/CTED11/RB10	30	OSC1/CLKI/RPA2/RA2
9	PGEC2/RPB11/D-/RB11	31	OSC2/CLKO/RPA3/RA3
10	VUSB3V3	32	TDO/RPA8/PMA8/RA8
11	AN11/RPB13/CTPLS/PMRD/RB13	33	SOSCI/RPB4/RB4
12	PGED4/TMS/PMA10/RA10	34	SOSCO/RPA4/T1CK/CTED9/RA4
13	PGEC4/TCK/CTED8/PMA7/RA7	35	TDI/RPA9/PMA9/RA9
14	CVREFOUT/AN10/C3INB/RPB14/VBUSON/SCK1/CTED5/RB14	36	AN12/RPC3/RC3
15	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15	37	RPC4/PMA4/RC4
16	AVss	38	RPC5/PMA3/RC5
17	AVdd	39	Vss
18	MCLR	40	VDD
19	PGED3/VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/PMD7/RA0	41	RPB5/USBID/RB5
20	PGEC3/VREF-/CVREF-/AN1/RPA1/CTED2/PMD6/RA1	42	VBUS
21	PGED1/AN2/C1IND/C2INB/C3IND/RPB0/PMD0/RB0	43	RPB7/CTED3/PMD5/INT0/RB7
22	PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/PMD1/RB1	44	RPB8/SCL1/CTED10/PMD4/RB8
Note	1: The RPn pins can be used by remappable peripherals. See Ta	able 1 for th	e available peripherals and Section 11.3 "Peripheral Pin

1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and Section 11.3 "Peripheral Pin Select" for restrictions.

2: Every I/O port pin (RAx-RCx) can be used as a change notification pin (CNAx-CNCx). See Section 11.0 "I/O Ports" for more information.

3: The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to Vss externally.

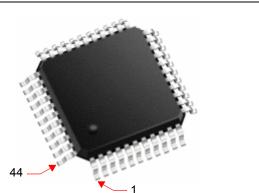
4: This pin function is not available on PIC32MX110F016D and PIC32MX120F032D devices.

5: Shaded pins are 5V tolerant.

TABLE 11: PIN NAMES FOR 44-PIN GENERAL PURPOSE DEVICES

44-PIN TQFP (TOP VIEW)^(1,2,3,5)

PIC32MX110F016D PIC32MX120F032D PIC32MX130F064D PIC32MX130F256D PIC32MX150F128D PIC32MX170F256D



Pin #	Full Pin Name	Pin #	Full Pin Name
1	RPB9/SDA1/CTED4/PMD3/RB9	23	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/RB2
2	RPC6/PMA1/RC6	24	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/RB3
3	RPC7/PMA0/RC7	25	AN6/RPC0/RC0
4	RPC8/PMA5/RC8	26	AN7/RPC1/RC1
5	RPC9/CTED7/PMA6/RC9	27	AN8/RPC2/PMA2/RC2
6	Vss	28	Vdd
7	VCAP	29	Vss
8	PGED2/RPB10/CTED11/PMD2/RB10	30	OSC1/CLKI/RPA2/RA2
9	PGEC2/RPB11/PMD1/RB11	31	OSC2/CLKO/RPA3/RA3
10	AN12/PMD0/RB12	32	TDO/RPA8/PMA8/RA8
11	AN11/RPB13/CTPLS/PMRD/RB13	33	SOSCI/RPB4/RB4
12	PGED4 ⁽⁴⁾ /TMS/PMA10/RA10	34	SOSCO/RPA4/T1CK/CTED9/RA4
13	PGEC4 ⁽⁴⁾ /TCK/CTED8/PMA7/RA7	35	TDI/RPA9/PMA9/RA9
14	CVREFOUT/AN10/C3INB/RPB14/SCK1/CTED5/PMWR/RB14	36	RPC3/RC3
15	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15	37	RPC4/PMA4/RC4
16	AVss	38	RPC5/PMA3/RC5
17	AVdd	39	Vss
18	MCLR	40	Vdd
19	VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/RA0	41	PGED3/RPB5/PMD7/RB5
20	VREF-/CVREF-/AN1/RPA1/CTED2/RA1	42	PGEC3/RPB6/PMD6/RB6
21	PGED1/AN2/C1IND/C2INB/C3IND/RPB0/RB0	43	RPB7/CTED3/PMD5/INT0/RB7
22	PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/RB1	44	RPB8/SCL1/CTED10/PMD4/RB8

1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and Section 11.3 "Peripheral Pin Select" for restrictions.

2: Every I/O port pin (RAx-RCx) can be used as a change notification pin (CNAx-CNCx). See Section 11.0 "I/O Ports" for more information.

3: The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to VSs externally.

4: This pin function is not available on PIC32MX110F016D and PIC32MX120F032D devices.

5: Shaded pins are 5V tolerant.

TABLE 12: PIN NAMES FOR 44-PIN USB DEVICES

44-PIN TQFP (TOP VIEW)^(1,2,3,5)

PIC32MX210F016D PIC32MX220F032D PIC32MX230F064D PIC32MX230F256D PIC32MX250F128D PIC32MX270F256D

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Pin #	Full Pin Name	Pin #	Full Pin Name
1	RPB9/SDA1/CTED4/PMD3/RB9	23	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/PMD2/RB2
2	RPC6/PMA1/RC6	24	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/PMWR/RB3
3	RPC7/PMA0/RC7	25	AN6/RPC0/RC0
4	RPC8/PMA5/RC8	26	AN7/RPC1/RC1
5	RPC9/CTED7/PMA6/RC9	27	AN8/RPC2/PMA2/RC2
6	Vss	28	VDD
7	VCAP	29	Vss
8	PGED2/RPB10/D+/CTED11/RB10	30	OSC1/CLKI/RPA2/RA2
9	PGEC2/RPB11/D-/RB11	31	OSC2/CLKO/RPA3/RA3
10	VUSB3V3	32	TDO/RPA8/PMA8/RA8
11	AN11/RPB13/CTPLS/PMRD/RB13	33	SOSCI/RPB4/RB4
12	PGED4 ⁽⁴⁾ /TMS/PMA10/RA10	34	SOSCO/RPA4/T1CK/CTED9/RA4
13	PGEC4 ⁽⁴⁾ /TCK/CTED8/PMA7/RA7	35	TDI/RPA9/PMA9/RA9
14	CVREFOUT/AN10/C3INB/RPB14/VBUSON/SCK1/CTED5/RB14	36	AN12/RPC3/RC3
15	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15	37	RPC4/PMA4/RC4
16	AVss	38	RPC5/PMA3/RC5
17	AVdd	39	Vss
18	MCLR	40	VDD
19	PGED3/VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/PMD7/RA0	41	RPB5/USBID/RB5
20	PGEC3/VREF-/CVREF-/AN1/RPA1/CTED2/PMD6/RA1	42	VBUS
21	PGED1/AN2/C1IND/C2INB/C3IND/RPB0/PMD0/RB0	43	RPB7/CTED3/PMD5/INT0/RB7
22	PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/PMD1/RB1	44	RPB8/SCL1/CTED10/PMD4/RB8

The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and Section 11.3 "Peripheral Pin 1: Select" for restrictions.

Every I/O port pin (RAx-RCx) can be used as a change notification pin (CNAx-CNCx). See Section 11.0 "I/O Ports" for more information. 2:

The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to Vss externally. This pin function is not available on PIC32MX210F016D and PIC32MX220F032D devices. 3:

4:

5: Shaded pins are 5V tolerant.

TABLE 13: PIN NAMES FOR 44-PIN GENERAL PURPOSE DEVICES

44	-PIN VTLA (BOTTOM VIEW) ^(1,2,3,5) PIC32MX110F016D PIC32MX120F032D PC32MX130F064D PIC32MX130F256D PIC32MX150F128D PIC32MX170F256D		
Pin #	Full Pin Name	Pin #	Full Pin Name
1	RPB9/SDA1/CTED4/PMD3/RB9	23	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/RB2
2	RPC6/PMA1/RC6	24	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/RB3
3	RPC7/PMA0/RC7	25	AN6/RPC0/RC0
4	RPC8/PMA5/RC8	26	AN7/RPC1/RC1
5	RPC9/CTED7/PMA6/RC9	27	AN8/RPC2/PMA2/RC2
6	Vss	28	VDD
7	VCAP	29	Vss
8	PGED2/RPB10/CTED11/PMD2/RB10	30	OSC1/CLKI/RPA2/RA2
9	PGEC2/RPB11/PMD1/RB11	31	OSC2/CLKO/RPA3/RA3
10	AN12/PMD0/RB12	32	TDO/RPA8/PMA8/RA8
11	AN11/RPB13/CTPLS/PMRD/RB13	33	SOSCI/RPB4/RB4
12	PGED4 ⁽⁴⁾ /TMS/PMA10/RA10	34	SOSCO/RPA4/T1CK/CTED9/RA4
13	PGEC4 ⁽⁴⁾ /TCK/CTED8/PMA7/RA7	35	TDI/RPA9/PMA9/RA9
14	CVREFOUT/AN10/C3INB/RPB14/SCK1/CTED5/PMWR/RB14	36	RPC3/RC3
15	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15	37	RPC4/PMA4/RC4
16	AVss	38	RPC5/PMA3/RC5
17	AVdd	39	Vss
18	MCLR	40	VDD
19	VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/RA0	41	PGED3/RPB5/PMD7/RB5
20	VREF-/CVREF-/AN1/RPA1/CTED2/RA1	42	PGEC3/RPB6/PMD6/RB6
21	PGED1/AN2/C1IND/C2INB/C3IND/RPB0/RB0	43	RPB7/CTED3/PMD5/INT0/RB7

1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and Section 11.3 "Peripheral Pin Select" for restrictions.

2: Every I/O port pin (RAx-RCx) can be used as a change notification pin (CNAx-CNCx). See Section 11.0 "I/O Ports" for more information.

3: The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to Vss externally.

4: This pin function is not available on PIC32MX110F016D and PIC32MX120F032D devices.

5: Shaded pins are 5V tolerant.

TABLI	3LE 14: PIN NAMES FOR 44-PIN USB DEVICES								
44-	-PIN VTLA (BOTTOM VIEW) ^(1,2,3,5)		^						
	PIC32MX210F016D PIC32MX220F032D PIC32MX230F064D PIC32MX230F256D PIC32MX250F128D PIC32MX270F256D	1	44						
Pin #	Full Pin Name	Pin #	Full Pin Name						
1	RPB9/SDA1/CTED4/PMD3/RB9	23	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/PMD2/RB2						
2	RPC6/PMA1/RC6	24	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/PMWR/RB3						
3	RPC7/PMA0/RC7	25	AN6/RPC0/RC0						
4	RPC8/PMA5/RC8	26	AN7/RPC1/RC1						
5	RPC9/CTED7/PMA6/RC9	27	AN8/RPC2/PMA2/RC2						
6	Vss	28	VDD						
7	VCAP	29	Vss						
8	PGED2/RPB10/D+/CTED11/RB10	30	OSC1/CLKI/RPA2/RA2						
9	PGEC2/RPB11/D-/RB11	31	OSC2/CLKO/RPA3/RA3						
10	VUSB3V3	32	TDO/RPA8/PMA8/RA8						
11	AN11/RPB13/CTPLS/PMRD/RB13	33	SOSCI/RPB4/RB4						
12	PGED4 ⁽⁴⁾ /TMS/PMA10/RA10	34	SOSCO/RPA4/T1CK/CTED9/RA4						
13	PGEC4 ⁽⁴⁾ /TCK/CTED8/PMA7/RA7	35	TDI/RPA9/PMA9/RA9						
14	CVREFOUT/AN10/C3INB/RPB14/VBUSON/SCK1/CTED5/RB14	36	AN12/RPC3/RC3						
15	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15	37	RPC4/PMA4/RC4						
16	AVss	38	RPC5/PMA3/RC5						
17	AVdd	39	Vss						
18	MCLR	40	VDD						
19	PGED3/VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/PMD7/RA0	41	RPB5/USBID/RB5						
00		42	VBUS						
20	PGEC3/VREF-/CVREF-/AN1/RPA1/CTED2/PMD6/RA1								
20 21	PGEC3/VREF-/CVREF-/AN1/RPA1/C1ED2/PMD0/RA1 PGED1/AN2/C1IND/C2INB/C3IND/RPB0/PMD0/RB0	43	RPB7/CTED3/PMD5/INT0/RB7						

Note 1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and Section 11.3 "Peripheral Pin Select" for restrictions.

Every I/O port pin (RAx-RCx) can be used as a change notification pin (CNAx-CNCx). See Section 11.0 "I/O Ports" for more information. 2:

The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to Vss externally. This pin function is not available on PIC32MX210F016D and PIC32MX220F032D devices. 3:

4:

5: Shaded pins are 5V tolerant.

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An errata sheet, describing minor operational differences from the data sheet and recommended workarounds, may exist for current devices. As device/documentation issues become known to us, we will publish an errata sheet. The errata will specify the revision of silicon and revision of document to which it applies.

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Referenced Sources

This device data sheet is based on the following individual chapters of the *"PIC32 Family Reference Manual"*. These documents should be considered as the general reference for the operation of a particular module or device feature.

Note:	To access the following documents, refer
	to the Documentation > Reference
	Manuals section of the Microchip PIC32
	website: http://www.microchip.com/pic32

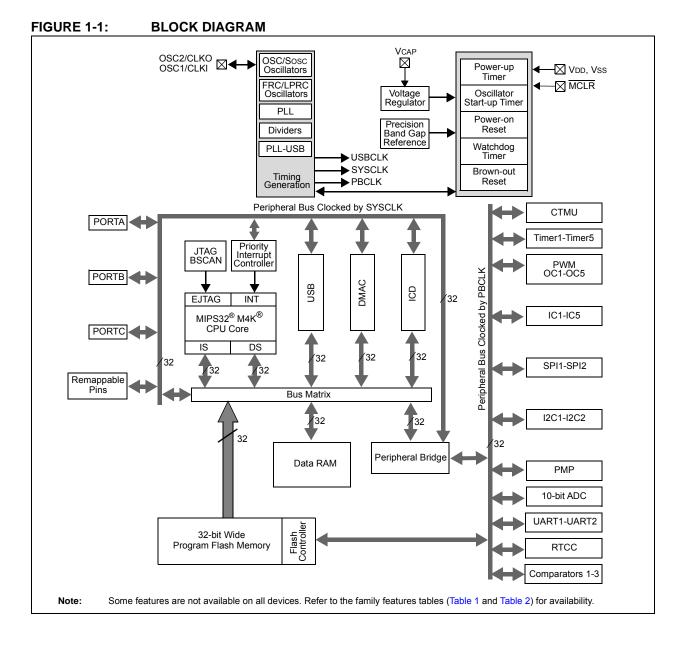
- Section 1. "Introduction" (DS60001127)
- Section 2. "CPU" (DS60001113)
- Section 3. "Memory Organization" (DS60001115)
- Section 5. "Flash Program Memory" (DS60001121)
- Section 6. "Oscillator Configuration" (DS60001112)
- Section 7. "Resets" (DS60001118)
- Section 8. "Interrupt Controller" (DS60001108)
- Section 9. "Watchdog Timer and Power-up Timer" (DS60001114)
- Section 10. "Power-Saving Features" (DS60001130)
- Section 12. "I/O Ports" (DS60001120)
- Section 13. "Parallel Master Port (PMP)" (DS60001128)
- Section 14. "Timers" (DS60001105)
- Section 15. "Input Capture" (DS60001122)
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- Section 19. "Comparator" (DS60001110)
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- Section 21. "Universal Asynchronous Receiver Transmitter (UART)" (DS60001107)
- Section 23. "Serial Peripheral Interface (SPI)" (DS60001106)
- Section 24. "Inter-Integrated Circuit (I²C)" (DS60001116)
- Section 27. "USB On-The-Go (OTG)" (DS60001126)
- Section 29. "Real-Time Clock and Calendar (RTCC)" (DS60001125)
- Section 31. "Direct Memory Access (DMA) Controller" (DS60001117)
- Section 32. "Configuration" (DS60001124)
- Section 33. "Programming and Diagnostics" (DS60001129)
- Section 37. "Charge Time Measurement Unit (CTMU)" (DS60001167)

1.0 DEVICE OVERVIEW

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to documents listed in the *Documentation* > *Reference Manual* section of the Microchip PIC32 web site (www.microchip.com/pic32). This document contains device-specific information for PIC32MX1XX/2XX 28/36/44-pin Family of devices.

Figure 1-1 illustrates a general block diagram of the core and peripheral modules in the PIC32MX1XX/2XX 28/36/44-pin Family of devices.

Table 1-1 lists the functions of the various pins shownin the pinout diagrams.



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		Pin Nu	mber ⁽¹⁾				
Pin Name	28-pin QFN	28-pin SSOP/ SPDIP/ SOIC	36-pin VTLA	44-pin QFN/ TQFP/ VTLA	Pin Type	Buffer Type	Description
AN0	27	2	33	19	I	Analog	Analog input channels.
AN1	28	3	34	20	I	Analog	
AN2	1	4	35	21	I	Analog	1
AN3	2	5	36	22	I	Analog	1
AN4	3	6	1	23	I	Analog	1
AN5	4	7	2	24	I	Analog	1
AN6	_	_	3	25	I	Analog	
AN7	_	_	4	26	I	Analog	
AN8	_	—	-	27	I	Analog	
AN9	23	26	29	15	I	Analog	
AN10	22	25	28	14	I	Analog	
AN11	21	24	27	11	I	Analog	
AN12	20 ⁽²⁾	23 ⁽²⁾	26 ⁽²⁾ 11 ⁽³⁾	10 ⁽²⁾ 36 ⁽³⁾	- 1	Analog	
CLKI	6	9	7	30	I	ST/CMOS	External clock source input. Always associated with OSC1 pin function.
CLKO	7	10	8	31	0	_	Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillato mode. Optionally functions as CLKO in RC and EC modes. Always associated with OSC2 pin function.
OSC1	6	9	7	30	I	ST/CMOS	Oscillator crystal input. ST buffer when configured in RC mode; CMOS otherwise.
OSC2	7	10	8	31	0	_	Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillato mode. Optionally functions as CLKO in RC and EC modes.
SOSCI	8	11	9	33	I	ST/CMOS	32.768 kHz low-power oscillator crysta input; CMOS otherwise.
SOSCO	9	12	10	34	0	_	32.768 kHz low-power oscillator crysta output.
REFCLKI	PPS	PPS	PPS	PPS	I	ST	Reference Input Clock
REFCLKO	PPS	PPS	PPS	PPS	0	—	Reference Output Clock
IC1	PPS	PPS	PPS	PPS	I	ST	Capture Inputs 1-5
IC2	PPS	PPS	PPS	PPS	I	ST	1
IC3	PPS	PPS	PPS	PPS	I	ST	1
IC4	PPS	PPS	PPS	PPS	1	ST	1
IC5	PPS	PPS	PPS	PPS	I	ST	1
Legend:	CMOS = CI ST = Schmi TTL = TTL i	MOS compa itt Trigger in		or output		O = Outp	Analog input P = Power ut I = Input eripheral Pin Select — = N/A
Note 1:		-	led for refe	rence only	See the		rams" section for device pin availability.

TABLE 1-1: PINOUT I/O DESCRIPTIONS

Pin number for PIC32MX1XX devices only.
 Pin number for PIC32MX2XX devices only.

		Pin Nu	mber ⁽¹⁾				
Pin Name	28-pin QFN	28-pin SSOP/ SPDIP/ SOIC	36-pin VTLA	44-pin QFN/ TQFP/ VTLA	Pin Type	Buffer Type	Description
OC1	PPS	PPS	PPS	PPS	0	_	Output Compare Output 1
OC2	PPS	PPS	PPS	PPS	0	_	Output Compare Output 2
OC3	PPS	PPS	PPS	PPS	0	-	Output Compare Output 3
OC4	PPS	PPS	PPS	PPS	0	_	Output Compare Output 4
OC5	PPS	PPS	PPS	PPS	0	_	Output Compare Output 5
OCFA	PPS	PPS	PPS	PPS	I	ST	Output Compare Fault A Input
OCFB	PPS	PPS	PPS	PPS	I	ST	Output Compare Fault B Input
INT0	13	16	17	43	I	ST	External Interrupt 0
INT1	PPS	PPS	PPS	PPS	I	ST	External Interrupt 1
INT2	PPS	PPS	PPS	PPS	Ι	ST	External Interrupt 2
INT3	PPS	PPS	PPS	PPS	I	ST	External Interrupt 3
INT4	PPS	PPS	PPS	PPS	I	ST	External Interrupt 4
RA0	27	2	33	19	I/O	ST	PORTA is a bidirectional I/O port
RA1	28	3	34	20	I/O	ST	-
RA2	6	9	7	30	I/O	ST	
RA3	7	10	8	31	I/O	ST	
RA4	9	12	10	34	I/O	ST	
RA7	<u> </u>	_	_	13	I/O	ST	-
RA8	<u> </u>	_	_	32	I/O	ST	-
RA9	_		_	35	I/O	ST	-
RA10	_		_	12	I/O	ST	
RB0	1	4	35	21	I/O	ST	PORTB is a bidirectional I/O port
RB1	2	5	36	22	I/O	ST	
RB2	3	6	1	23	I/O	ST	
RB3	4	7	2	24	I/O	ST	7
RB4	8	11	9	33	I/O	ST	1
RB5	11	14	15	41	I/O	ST	1
RB6	12 ⁽²⁾	15 ⁽²⁾	16 ⁽²⁾	42 ⁽²⁾	I/O	ST	1
RB7	13	16	17	43	I/O	ST	1
RB8	14	17	18	44	I/O	ST	1
RB9	15	18	19	1	I/O	ST	1
RB10	18	21	24	8	I/O	ST	1
RB11	19	22	25	9	I/O	ST	1
RB12	20 ⁽²⁾	23 ⁽²⁾	26 ⁽²⁾	10 (2)	I/O	ST	1
RB13	21	24	27	11	I/O	ST	1
RB14	22	25	28	14	I/O	ST	1
RB15	23	26	29	15	I/O	ST	1
Legend:	CMOS = CI	MOS compa	atible input	or output	1	Analog =	Analog input P = Power
-	ST = Schmi	itt Trigger in				O = Outp	put I=Input
	TTL = TTL i	nput buffer				PPS = P	Peripheral Pin Select — = N/A

TABLE 1-1: PINOUT I/O DESCRIPTIONS (CONTINUED)

Note 1: Pin numbers are provided for reference only. See the "Pin Diagrams" section for device pin availability.

2: Pin number for PIC32MX1XX devices only.

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		Pin Nu	mber ⁽¹⁾				
Pin Name	28-pin QFN	28-pin SSOP/ SPDIP/ SOIC	36-pin VTLA	44-pin QFN/ TQFP/ VTLA	Pin Type	Buffer Type	Description
RC0		—	3	25	I/O	ST	PORTC is a bidirectional I/O port
RC1		_	4	26	I/O	ST	
RC2	—	—	—	27	I/O	ST	
RC3		—	11	36	I/O	ST	
RC4		—	_	37	I/O	ST	
RC5		—		38	I/O	ST	_
RC6	—	—	—	2	I/O	ST	
RC7	—	—	—	3	I/O	ST	
RC8		_	—	4	I/O	ST	4
RC9		-	20	5	I/O	ST	
T1CK	9	12	10	34		ST	Timer1 external clock input
T2CK	PPS	PPS	PPS	PPS		ST	Timer2 external clock input
T3CK T4CK	PPS PPS	PPS PPS	PPS PPS	PPS PPS		ST ST	Timer3 external clock input Timer4 external clock input
T4CK	PPS	PPS PPS	PPS PPS	PPS PPS		ST	Timer5 external clock input
					-		
U1CTS	PPS	PPS	PPS	PPS		ST	UART1 clear to send
U1RTS	PPS	PPS	PPS	PPS	0		UART1 ready to send
U1RX	PPS	PPS	PPS	PPS	I	ST	UART1 receive
U1TX	PPS	PPS	PPS	PPS	0	_	UART1 transmit
U2CTS	PPS	PPS	PPS	PPS	I	ST	UART2 clear to send
U2RTS	PPS	PPS	PPS	PPS	0	_	UART2 ready to send
U2RX	PPS	PPS	PPS	PPS	I	ST	UART2 receive
U2TX	PPS	PPS	PPS	PPS	0	_	UART2 transmit
SCK1	22	25	28	14	I/O	ST	Synchronous serial clock input/output for SPI1
SDI1	PPS	PPS	PPS	PPS	1	ST	SPI1 data in
SDO1	PPS	PPS	PPS	PPS	0		SPI1 data out
SS1	PPS	PPS	PPS	PPS	I/O	ST	SPI1 slave synchronization or frame pulse I/O
SCK2	23	26	29	15	I/O	ST	Synchronous serial clock input/output for SPI2
SDI2	PPS	PPS	PPS	PPS	1	ST	SPI2 data in
SDO2	PPS	PPS	PPS	PPS	0		SPI2 data out
SS2	PPS	PPS	PPS	PPS	I/O	ST	SPI2 slave synchronization or frame pulse I/O
SCL1	14	17	18	44	I/O	ST	Synchronous serial clock input/output for I2C1
	ST = Schm FTL = TTL i	itt Trigger in input buffer	put with CN	IOS levels		O = Outp PPS = P	Analog input $P = Power$ but $I = Input$ eripheral Pin Select $- = N/A$

TABLE 1-1: PINOUT I/O DESCRIPTIONS (CONTINUED)

Note 1: Pin numbers are provided for reference only. See the "Pin Diagrams" section for device pin availability.

2: Pin number for PIC32MX1XX devices only.

		Pin Nu	mber ⁽¹⁾				
Pin Name	28-pin QFN	28-pin SSOP/ SPDIP/ SOIC	36-pin VTLA	44-pin QFN/ TQFP/ VTLA	Pin Type	Buffer Type	Description
SDA1	15	18	19	1	I/O	ST	Synchronous serial data input/output for I2C1
SCL2	4	7	2	24	I/O	ST	Synchronous serial clock input/output for I2C2
SDA2	3	6	1	23	I/O	ST	Synchronous serial data input/output for I2C2
TMS	19 (2) 11 (3)	22 ⁽²⁾ 14 ⁽³⁾	25 (2) 15 (3)	12	I	ST	JTAG Test mode select pin
TCK	14	17	18	13	I	ST	JTAG test clock input pin
TDI	13	16	17	35	0	_	JTAG test data input pin
TDO	15	18	19	32	0		JTAG test data output pin
RTCC	4	7	2	24	0	ST	Real-Time Clock alarm output
CVREF-	28	3	34	20	I	Analog	Comparator Voltage Reference (low)
CVREF+	27	2	33	19	I	Analog	Comparator Voltage Reference (high)
CVREFOUT	22	25	28	14	0	Analog	Comparator Voltage Reference output
C1INA	4	7	2	24	I	Analog	Comparator Inputs
C1INB	3	6	1	23		Analog	7
C1INC	2	5	36	22	I	Analog	1
C1IND	1	4	35	21	I	Analog	
C2INA	2	5	36	22	I	Analog	
C2INB	1	4	35	21	I	Analog	-
C2INC	4	7	2	24	I	Analog	-
C2IND	3	6	1	23	I	Analog	-
C3INA	23	26	29	15	I	Analog	1
C3INB	22	25	28	14	Ι	Analog	
C3INC	27	2	33	19	Ι	Analog]
C3IND	1	4	35	21	I	Analog	
C10UT	PPS	PPS	PPS	PPS	0	_	Comparator Outputs
C2OUT	PPS	PPS	PPS	PPS	0	_	7
C3OUT	PPS	PPS	PPS	PPS	0	_	
		MOS compa tt Trigger in				Analog = O = Outp	· · · · · · · · · · · · · · · · · · ·

TABLE 1-1: **PINOUT I/O DESCRIPTIONS (CONTINUED)**

TTL = TTL input buffer

PPS = Peripheral Pin Select — = N/A

Note 1: Pin numbers are provided for reference only. See the "Pin Diagrams" section for device pin availability.

2: Pin number for PIC32MX1XX devices only.

		Pin Nu	nber ⁽¹⁾				
Pin Name	28-pin QFN	28-pin SSOP/ SPDIP/ SOIC	36-pin VTLA	44-pin QFN/ TQFP/ VTLA	Pin Type	Buffer Type	Description
PMA0	7	10	8	3	I/O	TTL/ST	Parallel Master Port Address bit 0 input (Buffered Slave modes) and output (Master modes)
PMA1	9	12	10	2	I/O	TTL/ST	Parallel Master Port Address bit 1 input (Buffered Slave modes) and output (Master modes)
PMA2		—	_	27	0	—	Parallel Master Port address
PMA3		—	_	38	0		(Demultiplexed Master modes)
PMA4		—	_	37	0		
PMA5		—	_	4	0	_	
PMA6		—	_	5	0	_	
PMA7		—	_	13	0	—	
PMA8		—	—	32	0	—	
PMA9		—	_	35	0	_	
PMA10		—		12	0	_	
PMCS1	23	26	29	15	0		Parallel Master Port Chip Select 1 strobe
PMD0	20 ⁽²⁾ 1 ⁽³⁾	23 ⁽²⁾	26 ⁽²⁾	10 ⁽²⁾	I/O	TTL/ST	Parallel Master Port data (Demultiplexed Master mode) or address/data
	1(3) 19 (2)	4 ⁽³⁾ 22 ⁽²⁾	35 ⁽³⁾ 25 ⁽²⁾	21 ⁽³⁾ 9 ⁽²⁾			(Multiplexed Master modes)
PMD1	2 ⁽³⁾	5(3)	36 ⁽³⁾	22 ⁽³⁾	I/O	TTL/ST	
	18 ⁽²⁾	21 ⁽²⁾	24 ⁽²⁾	8(2)			_
PMD2	<u>- 18(-)</u> - 3(3)	6(3)	<u></u> 1(3)	23(3)	I/O	TTL/ST	
PMD3	15	18	19	1	1/0	TTL/ST	-
PMD4	13	17	13	44	I/O I/O	TTL/ST	-
PMD4 PMD5	14	17	18	44	1/O	TTL/ST	-
PMD6	12 ⁽²⁾	15 ⁽²⁾	16 ⁽²⁾	43 42 ⁽²⁾	1/0	111/31	-
	28(3)	3(3)	34(3)	20(3)	I/O	TTL/ST	
PMD7	11 ⁽²⁾	14(2)	15 ⁽²⁾	41 ⁽²⁾			-
	27 ⁽³⁾	2 ⁽³⁾	33(3)	19 ⁽³⁾	I/O	TTL/ST	
PMRD	21	24	27	11	0		Parallel Master Port read strobe
	22 ⁽²⁾	25(2)	28 ⁽²⁾	14 ⁽²⁾			
PMWR	4 ⁽³⁾	7 ⁽³⁾	2 ⁽³⁾	24 ⁽³⁾	0	—	Parallel Master Port write strobe
VBUS	12 ⁽³⁾	15(3)	16 (3)	42 ⁽³⁾	I	Analog	USB bus power monitor
VUSB3V3	20 ⁽³⁾	23 ⁽³⁾	26 ⁽³⁾	10 ⁽³⁾	Р		USB internal transceiver supply. This pin must be connected to VDD.
VBUSON	22 ⁽³⁾	25 ⁽³⁾	28 ⁽³⁾	14 ⁽³⁾	0	_	USB Host and OTG bus power control output
D+	18 ⁽³⁾	21 ⁽³⁾	24 ⁽³⁾	8 ⁽³⁾	I/O	Analog	USB D+
D-	19 (3)	22 ⁽³⁾	25 ⁽³⁾	9(3)	I/O	Analog	USB D-
	ST = Schm	MOS compa itt Trigger in nput buffer				O = Outp	Analog input P = Power but I = Input eripheral Pin Select — = N/A

TABLE 1-1: PINOUT I/O DESCRIPTIONS (CONTINUED)

Note 1: Pin numbers are provided for reference only. See the "Pin Diagrams" section for device pin availability.

2: Pin number for PIC32MX1XX devices only.

		Pin Nu	mber ⁽¹⁾				
Pin Name	28-pin QFN	28-pin SSOP/ SPDIP/ SOIC	36-pin VTLA	44-pin QFN/ TQFP/ VTLA	Pin Type	Buffer Type	Description
USBID	11 ⁽³⁾	14 ⁽³⁾	15 ⁽³⁾	41 ⁽³⁾	I	ST	USB OTG ID detect
CTED1	27	2	33	19	I	ST	CTMU External Edge Input
CTED2	28	3	34	20	I	ST	
CTED3	13	16	17	43	I	ST	
CTED4	15	18	19	1	I	ST	
CTED5	22	25	28	14	I	ST	
CTED6	23	26	29	15	I	ST	
CTED7	_	—	20	5	I	ST	
CTED8	_	—	_	13	I	ST	
CTED9	9	12	10	34	I	ST	
CTED10	14	17	18	44	I	ST	
CTED11	18	21	24	8	I	ST	
CTED12	2	5	36	22	I	ST	
CTED13	3	6	1	23	I	ST	
CTPLS	21	24	27	11	0	_	CTMU Pulse Output
PGED1	1	4	35	21	I/O	ST	Data I/O pin for Programming/Debugging Communication Channel 1
PGEC1	2	5	36	22	I	ST	Clock input pin for Programming/Debugging Communication Channel 1
PGED2	18	21	24	8	I/O	ST	Data I/O pin for Programming/Debugging Communication Channel 2
PGEC2	19	22	25	9	I	ST	Clock input pin for Programming/Debugging Communication Channel 2
PGED3	11 ⁽²⁾ 27 ⁽³⁾	14 ⁽²⁾ 2 ⁽³⁾	15 ⁽²⁾ 33 ⁽³⁾	41 ⁽²⁾ 19 ⁽³⁾	I/O	ST	Data I/O pin for Programming/Debugging Communication Channel 3
PGEC3	12 ⁽²⁾ 28 ⁽³⁾	15 ⁽²⁾ 3 ⁽³⁾	16 ⁽²⁾ 34 ⁽³⁾	42 ⁽²⁾ 20 ⁽³⁾	- 1	ST	Clock input pin for Programming/ Debugging Communication Channel 3
PGED4	_	-	3	12	I/O	ST	Data I/O pin for Programming/Debugging Communication Channel 4
PGEC4	—	—	4	13	I	ST	Clock input pin for Programming/ Debugging Communication Channel 4
	ST = Schmi	MOS compa itt Trigger in nput buffer		O = Outp	Analog inputP = PowerbutI = Inputeripheral Pin Select— = N/A		

TABLE 1-1: PINOUT I/O DESCRIPTIONS (CONTINUED)

TTL = TTL input bufferPPS = Peripheral Pin Select-- = N/ANote 1:Pin numbers are provided for reference only. See the "Pin Diagrams" section for device pin availability.

2: Pin number for PIC32MX1XX devices only.

	Pin Number ⁽¹⁾							
Pin Name	28-pin QFN	28-pin SSOP/ SPDIP/ SOIC	36-pin VTLA	44-pin QFN/ TQFP/ VTLA	Pin Type	Buffer Type	Description	
MCLR	26	1	32	18	I/P	ST	Master Clear (Reset) input. This pin is an active-low Reset to the device.	
AVdd	25	28	31	17	Р	_	Positive supply for analog modules. This pin must be connected at all times.	
AVss	24	27	30	16	Р	_	Ground reference for analog modules	
Vdd	10	13	5, 13, 14, 23	28, 40	Р	_	Positive supply for peripheral logic and I/O pins	
VCAP	17	20	22	7	Р		CPU logic filter capacitor connection	
Vss	5, 16	8, 19	6, 12, 21	6, 29, 39	Р	_	Ground reference for logic and I/O pins. This pin must be connected at all times.	
VREF+	27	2	33	19	I	Analog	Analog voltage reference (high) input	
VREF-	28	3	34	20	I	Analog	Analog voltage reference (low) input	
Legend: (CMOS = CN	AOS compa	atible input	or output		Analog =	Analog input P = Power	

TABLE 1-1: PINOUT I/O DESCRIPTIONS (CONTINUED)

Legend: CMOS = CMOS compatible input or output ST = Schmitt Trigger input with CMOS levels TTL = TTL input buffer

	-		
	Analog =	Analog input	P = Power
	O = Outpi	ut	I = Input
	PPS = Pe	ripheral Pin Select	— = N/A
2	"Pin Diagr	ams" section for devic	e nin availability

Note 1: Pin numbers are provided for reference only. See the "Pin Diagrams" section for device pin availability.

2: Pin number for PIC32MX1XX devices only.

2.0 GUIDELINES FOR GETTING STARTED WITH 32-BIT MCUs

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the documents listed in the *Documentation* > *Reference Manual* section of the Microchip PIC32 web site (www.microchip.com/pic32).

2.1 Basic Connection Requirements

Getting started with the PIC32MX1XX/2XX 28/36/44pin Family of 32-bit Microcontrollers (MCUs) requires attention to a minimal set of device pin connections before proceeding with development. The following is a list of pin names, which must always be connected:

- All VDD and Vss pins (see 2.2 "Decoupling Capacitors")
- All AVDD and AVss pins, even if the ADC module is not used (see 2.2 "Decoupling Capacitors")
- VCAP pin (see 2.3 "Capacitor on Internal Voltage Regulator (VCAP)")
- MCLR pin (see 2.4 "Master Clear (MCLR) Pin")
- PGECx/PGEDx pins, used for In-Circuit Serial Programming™ (ICSP™) and debugging purposes (see 2.5 "ICSP Pins")
- OSC1 and OSC2 pins, when external oscillator source is used (see 2.7 "External Oscillator Pins")

The following pins may be required:

• VREF+/VREF- pins – used when external voltage reference for the ADC module is implemented

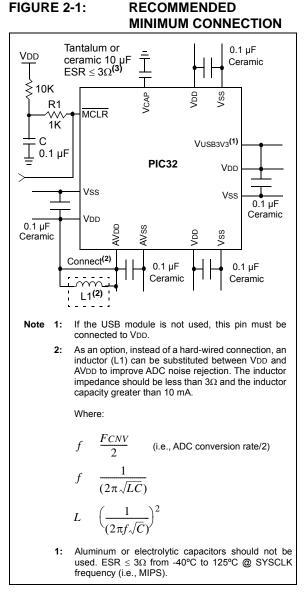
Note: The AVDD and AVSS pins must be connected, regardless of ADC use and the ADC voltage reference source.

2.2 Decoupling Capacitors

The use of decoupling capacitors on power supply pins, such as VDD, VSS, AVDD and AVSS is required. See Figure 2-1.

Consider the following criteria when using decoupling capacitors:

- Value and type of capacitor: A value of $0.1 \ \mu F$ (100 nF), 10-20V is recommended. The capacitor should be a low Equivalent Series Resistance (low-ESR) capacitor and have resonance frequency in the range of 20 MHz and higher. It is further recommended that ceramic capacitors be used.
- Placement on the printed circuit board: The decoupling capacitors should be placed as close to the pins as possible. It is recommended that the capacitors be placed on the same side of the board as the device. If space is constricted, the capacitor can be placed on another layer on the PCB using a via; however, ensure that the trace length from the pin to the capacitor is within one-quarter inch (6 mm) in length.
- Handling high frequency noise: If the board is experiencing high frequency noise, upward of tens of MHz, add a second ceramic-type capacitor in parallel to the above described decoupling capacitor. The value of the second capacitor can be in the range of 0.01 μF to 0.001 μF . Place this second capacitor next to the primary decoupling capacitor. In high-speed circuit designs, consider implementing a decade pair of capacitances as close to the power and ground pins as possible. For example, 0.1 μF in parallel with 0.001 μF .
- Maximizing performance: On the board layout from the power supply circuit, run the power and return traces to the decoupling capacitors first, and then to the device pins. This ensures that the decoupling capacitors are first in the power chain. Equally important is to keep the trace length between the capacitor and the power pins to a minimum thereby reducing PCB track inductance.



2.2.1 BULK CAPACITORS

The use of a bulk capacitor is recommended to improve power supply stability. Typical values range from 4.7 μF to 47 μF . This capacitor should be located as close to the device as possible.

2.3 Capacitor on Internal Voltage Regulator (VCAP)

2.3.1 INTERNAL REGULATOR MODE

A low-ESR (3 ohm) capacitor is required on the VCAP pin, which is used to stabilize the internal voltage regulator output. The VCAP pin must not be connected to VDD, and must have a CEFC capacitor, with at least a 6V rating, connected to ground. The type can be ceramic or tantalum. Refer to **30.0 "Electrical Characteristics"** for additional information on CEFC specifications.

2.4 Master Clear (MCLR) Pin

The $\overline{\text{MCLR}}$ pin provides two specific device functions:

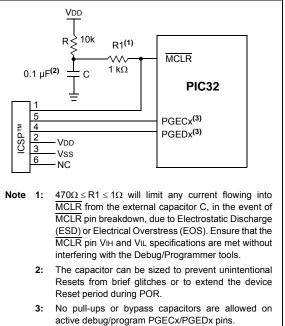
- Device Reset
- Device programming and debugging

Pulling The MCLR pin low generates a device Reset. Figure 2-2 illustrates a typical MCLR circuit. During device programming and debugging, the resistance and capacitance that can be added to the pin must be considered. Device programmers and debuggers drive the MCLR pin. Consequently, specific voltage levels (VIH and VIL) and fast signal transitions must not be adversely affected. Therefore, specific values of R and C will need to be adjusted based on the application and PCB requirements.

For example, as illustrated in Figure 2-2, it is recommended that the capacitor C, be isolated from the MCLR pin during programming and debugging operations.

Place the components illustrated in Figure 2-2 within one-quarter inch (6 mm) from the MCLR pin.





2.5 ICSP Pins

The PGECx and PGEDx pins are used for ICSP and debugging purposes. It is recommended to keep the trace length between the ICSP connector and the ICSP pins on the device as short as possible. If the ICSP connector is expected to experience an ESD event, a series resistor is recommended, with the value in the range of a few tens of Ohms, not to exceed 100 Ohms.

Pull-up resistors, series diodes and capacitors on the PGECx and PGEDx pins are not recommended as they will interfere with the programmer/debugger communications to the device. If such discrete components are an application requirement, they should be removed from the circuit during programming and debugging. Alternatively, refer to the AC/DC characteristics and timing requirements information in the respective device Flash programming specification for information on capacitive loading limits and pin input voltage high (VIH) and input low (VIL) requirements.

Ensure that the "Communication Channel Select" (i.e., PGECx/PGEDx pins) programmed into the device matches the physical connections for the ICSP to MPLAB[®] ICD 3 or MPLAB REAL ICETM.

For more information on ICD 3 and REAL ICE connection requirements, refer to the following documents that are available on the Microchip web site:

- "Using MPLAB[®] ICD 3" (poster) (DS50001765)
- *"MPLAB[®] ICD 3 Design Advisory"* (DS50001764)
- "MPLAB[®] REAL ICE[™] In-Circuit Debugger User's Guide" (DS50001616)
- "Using MPLAB[®] REAL ICE™ Emulator" (poster) (DS50001749)

2.6 JTAG

The TMS, TDO, TDI and TCK pins are used for testing and debugging according to the Joint Test Action Group (JTAG) standard. It is recommended to keep the trace length between the JTAG connector and the JTAG pins on the device as short as possible. If the JTAG connector is expected to experience an ESD event, a series resistor is recommended with the value in the range of a few tens of Ohms, not to exceed 100 Ohms.

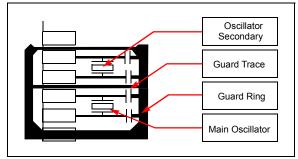
Pull-up resistors, series diodes and capacitors on the TMS, TDO, TDI and TCK pins are not recommended as they will interfere with the programmer/debugger communications to the device. If such discrete components are an application requirement, they should be removed from the circuit during programming and debugging. Alternatively, refer to the AC/DC characteristics and timing requirements information in the respective device Flash programming specification for information on capacitive loading limits and pin input voltage high (VIH) and input low (VIL) requirements.

2.7 External Oscillator Pins

Many MCUs have options for at least two oscillators: a high-frequency primary oscillator and a low-frequency secondary oscillator (refer to **Section 8.0 "Oscillator Configuration**" for details).

The oscillator circuit should be placed on the same side of the board as the device. Also, place the oscillator circuit close to the respective oscillator pins, not exceeding one-half inch (12 mm) distance between them. The load capacitors should be placed next to the oscillator itself, on the same side of the board. Use a grounded copper pour around the oscillator circuit to isolate them from surrounding circuits. The grounded copper pour should be routed directly to the MCU ground. Do not run any signal traces or power traces inside the ground pour. Also, if using a two-sided board, avoid any traces on the other side of the board where the crystal is placed. A suggested layout is illustrated in Figure 2-3.

FIGURE 2-3: SUGGESTED OSCILLATOR CIRCUIT PLACEMENT



2.8 Unused I/Os

Unused I/O pins should not be allowed to float as inputs. They can be configured as outputs and driven to a logic-low state.

Alternatively, inputs can be reserved by connecting the pin to Vss through a 1k to 10k resistor and configuring the pin as an input.

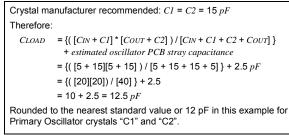
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2.8.1 CRYSTAL OSCILLATOR DESIGN CONSIDERATION

The following example assumptions are used to calculate the Primary Oscillator loading capacitor values:

- CIN = PIC32_OSC2_Pin Capacitance = ~4-5 pF
- COUT = PIC32_OSC1_Pin Capacitance = ~4-5 pF
- C1 and C2 = XTAL manufacturing recommended loading capacitance
- Estimated PCB stray capacitance, (i.e.,12 mm length) = 2.5 pF

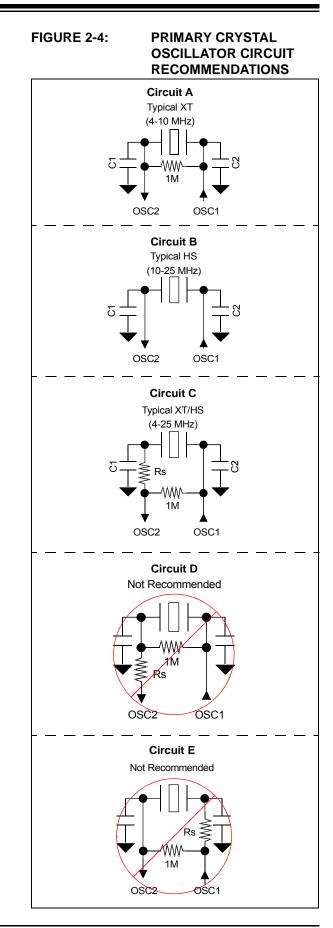
EXAMPLE 2-1: CRYSTAL LOAD CAPACITOR CALCULATION



The following tips are used to increase oscillator gain, (i.e., to increase peak-to-peak oscillator signal):

- Select a crystal with a lower "minimum" power drive rating
- Select an crystal oscillator with a lower XTAL manufacturing "ESR" rating.
- Add a parallel resistor across the crystal. The smaller the resistor value the greater the gain. It is recommended to stay in the range of 600k to 1M
- C1 and C2 values also affect the gain of the oscillator. The lower the values, the higher the gain.
- C2/C1 ratio also affects gain. To increase the gain, make C1 slightly smaller than C2, which will also help start-up performance.
- Note: Do not add excessive gain such that the oscillator signal is clipped, flat on top of the sine wave. If so, you need to reduce the gain or add a series resistor, RS, as shown in circuit "C" in Figure 2-4. Failure to do so will stress and age the crystal, which can result in an early failure. Adjust the gain to trim the max peak-to-peak to ~VDD-0.6V. When measuring the oscillator signal you must use a FET scope probe or a probe with ≤ 1.5 pF or the scope probe itself will unduly change the gain and peak-to-peak levels.
- 2.8.1.1 Additional Microchip References
- AN588 "PICmicro[®] Microcontroller Oscillator Design Guide"
- AN826 "Crystal Oscillator Basics and Crystal Selection for rfPIC[™] and PICmicro[®] Devices"
- AN849 "Basic PICmicro[®] Oscillator Design"





2.9 Typical Application Connection Examples

Examples of typical application connections are shown in Figure 2-5 and Figure 2-6.

FIGURE 2-5: CAPACITIVE TOUCH SENSING WITH GRAPHICS APPLICATION

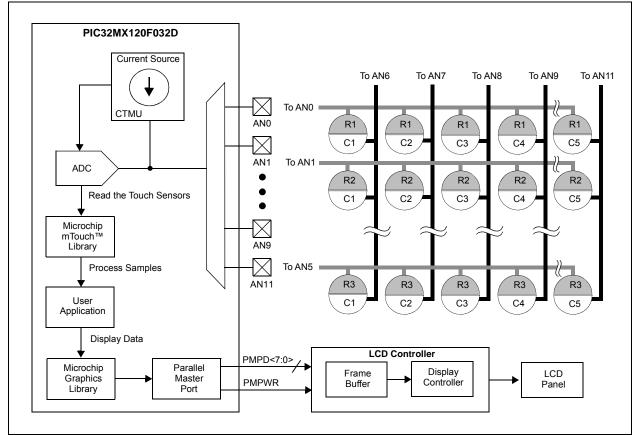
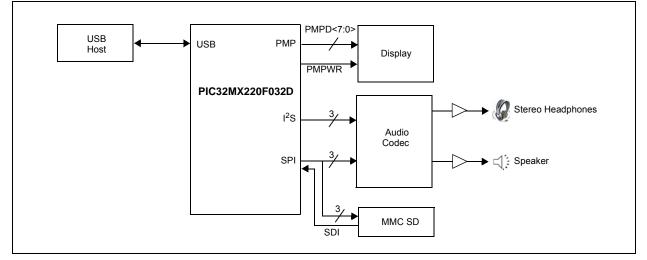


FIGURE 2-6: AUDIO PLAYBACK APPLICATION

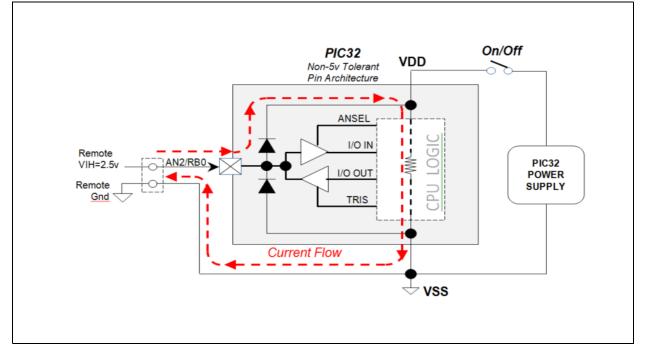


2.10 Considerations When Interfacing To Remotely Powered Circuits

2.10.1 NON-5V TOLERANT INPUT PINS

A quick review of the maximum rating section in the **Section 30.0 "Electrical Characteristics"** will indicate that the voltage on any non-5V tolerant pin should not exceed AVDD/VDD+0.3V. Figure 2-7 illustrates a remote circuit using an independent power source that is powered while connected to a PIC32 non-5V tolerant circuit which is not powered.

FIGURE 2-7: REMOTE CIRCUIT WITH AN INDEPENDENT POWER SOURCE



Without proper signal isolation on non-5V tolerant pins, the remote signal can power the PIC32 through the high side ESD protection diodes. This violates the maximum rating specification and can cause improper initialization of internal PIC32 logic circuits. In this case, it is recommended that users can implement a digital or analog signal isolation, as shown in Figure 2-8.

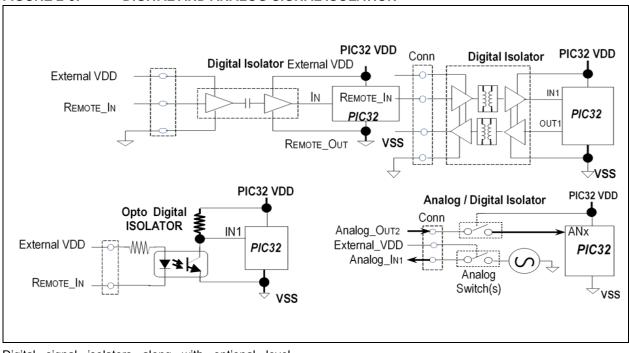


FIGURE 2-8: DIGITAL AND ANALOG SIGNAL ISOLATION

Digital signal isolators along with optional level translation examples are provided in Table 2-1.

TABLE 2-1: EXAMPLES OF DIGITAL ISOLATORS WITH OPTIONAL LEVEL TRANSLATION

	Inductive Coupling	Capacitive Coupling	Optional Coupling	Analog/Digital Switch
ADuM7241 / 40 ARZ (1Mbps)	Х	-	-	-
ADuM7241 / 40 CRZ (25 Mbps)	Х	-	-	-
ISO721	-	Х	-	-
LTV-829S (2 Chan)	-	-	Х	-
LTV-849S (4 Chan)	-	-	-	-
FSA266 / NC7WB66	-	-	-	Х

2.10.2 5V-TOLERANT INPUT PINS

The internal high-side diode on 5V-tolerant pins, rather than being connected to VDD, are bussed to an internal floating node, as shown in Figure 2-9. Voltages on these pins, if VDD < 2.3V, should not exceed roughly 3.2V relative to PIC32 VSS. At 3.6V or above, it will violate the absolute maximum specification and impact the device reliability.

If a remotely powered digital only signal can be guaranteed to always be $\leq 3.2V$ relative to PIC32 Vss, then a 5V-tolerant pin can be used without a digital isolator. This can be assumed when the following is applicable:

- No ground loop issue
- The logic ground of the two circuits is not at the same absolute level
- No remote logic low inputs are less than $V {\rm SS}$ 0.3V

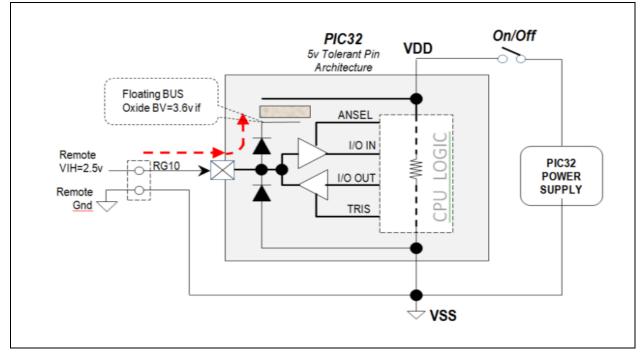


FIGURE 2-9: 5V-TOLERANT INPUT PINS BUSSED TO AN INTERNAL FLOATING NODE

3.0 CPU

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 2. "CPU" (DS60001113), which is available from the *Documentation* > *Reference Manual* section of the Microchip PIC32 web site (www.microchip.com/pic32). Resources for the MIPS32[®] M4K[®] Processor Core are available at: www.imgtec.com.

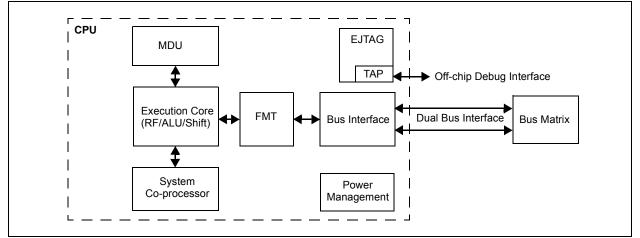
The MIPS32[®] M4K[®] Processor Core is the heart of the PIC32MX1XX/2XX family processor. The CPU fetches instructions, decodes each instruction, fetches source operands, executes each instruction and writes the results of instruction execution to the destinations.

3.1 Features

- 5-stage pipeline
- · 32-bit address and data paths
- MIPS32 Enhanced Architecture (Release 2)
 - Multiply-accumulate and multiply-subtract instructions
 - Targeted multiply instruction
 - Zero/One detect instructions
 - WAIT instruction
 - Conditional move instructions (MOVN, MOVZ)
 - Vectored interrupts
 - Programmable exception vector base
 - Atomic interrupt enable/disable
 - Bit field manipulation instructions

- $MIPS16e^{I\!\!R}$ code compression
 - 16-bit encoding of 32-bit instructions to improve code density
 - Special PC-relative instructions for efficient loading of addresses and constants
 - SAVE and RESTORE macro instructions for setting up and tearing down stack frames within subroutines
 - Improved support for handling 8 and 16-bit data types
- Simple Fixed Mapping Translation (FMT) mechanism
- · Simple dual bus interface
 - Independent 32-bit address and data buses
 - Transactions can be aborted to improve interrupt latency
- · Autonomous multiply/divide unit
 - Maximum issue rate of one 32x16 multiply per clock
 - Maximum issue rate of one 32x32 multiply every other clock
 - Early-in iterative divide. Minimum 11 and maximum 33 clock latency (dividend (*rs*) sign extension-dependent)
- Power control
 - Minimum frequency: 0 MHz
 - Low-Power mode (triggered by WAIT instruction)
- Extensive use of local gated clocks
- EJTAG debug and instruction trace
 - Support for single stepping
 - Virtual instruction and data address/value
 - Breakpoints

FIGURE 3-1: MIPS32[®] M4K[®] PROCESSOR CORE BLOCK DIAGRAM



3.2 Architecture Overview

The MIPS32 M4K processor core contains several logic blocks working together in parallel, providing an efficient high-performance computing engine. The following blocks are included with the core:

- Execution Unit
- Multiply/Divide Unit (MDU)
- System Control Coprocessor (CP0)
- Fixed Mapping Translation (FMT)
- Dual Internal Bus interfaces
- Power Management
- MIPS16e[®] Support
- Enhanced JTAG (EJTAG) Controller

3.2.1 EXECUTION UNIT

The MIPS32 M4K processor core execution unit implements a load/store architecture with single-cycle ALU operations (logical, shift, add, subtract) and an autonomous multiply/divide unit. The core contains thirty-two 32-bit General Purpose Registers (GPRs) used for integer operations and address calculation. The register file consists of two read ports and one write port and is fully bypassed to minimize operation latency in the pipeline.

The execution unit includes:

- · 32-bit adder used for calculating the data address
- Address unit for calculating the next instruction address
- Logic for branch determination and branch target address calculation
- Load aligner
- Bypass multiplexers used to avoid stalls when executing instruction streams where data producing instructions are followed closely by consumers of their results
- Leading Zero/One detect unit for implementing the CLZ and CLO instructions
- Arithmetic Logic Unit (ALU) for performing bitwise logical operations
- · Shifter and store aligner

3.2.2 MULTIPLY/DIVIDE UNIT (MDU)

The MIPS32 M4K processor core includes a Multiply/Divide Unit (MDU) that contains a separate pipeline for multiply and divide operations. This pipeline operates in parallel with the Integer Unit (IU) pipeline and does not stall when the IU pipeline stalls. This allows MDU operations to be partially masked by system stalls and/or other integer unit instructions.

The high-performance MDU consists of a 32x16 booth recoded multiplier, result/accumulation registers (HI and LO), a divide state machine, and the necessary multiplexers and control logic. The first number shown ('32' of 32x16) represents the *rs* operand. The second number ('16' of 32x16) represents the *rt* operand. The PIC32 core only checks the value of the latter (*rt*) operand to determine how many times the operation must pass through the multiplier. The 16x16 and 32x16 operations pass through the multiplier once. A 32x32 operation passes through the multiplier twice.

The MDU supports execution of one 16x16 or 32x16 multiply operation every clock cycle; 32x32 multiply operations can be issued every other clock cycle. Appropriate interlocks are implemented to stall the issuance of back-to-back 32x32 multiply operations. The multiply operand size is automatically determined by logic built into the MDU.

Divide operations are implemented with a simple 1 bit per clock iterative algorithm. An early-in detection checks the sign extension of the dividend (*rs*) operand. If *rs* is 8 bits wide, 23 iterations are skipped. For a 16-bit wide *rs*, 15 iterations are skipped and for a 24-bit wide *rs*, 7 iterations are skipped. Any attempt to issue a subsequent MDU instruction while a divide is still active causes an IU pipeline stall until the divide operation is completed.

Table 3-1 lists the repeat rate (peak issue rate of cycles until the operation can be reissued) and latency (number of cycles until a result is available) for the PIC32 core multiply and divide instructions. The approximate latency and repeat rates are listed in terms of pipeline clocks.

MOETIFET/DIVIDE ONT EATENCIES AND REFEAT RATES						
Opcode	Operand Size (mul <i>rt</i>) (div <i>rs</i>)	Latency	Repeat Rate			
MULT/MULTU, MADD/MADDU,	16 bits	1	1			
MSUB/MSUBU	32 bits	2	2			
MUL	16 bits	2	1			
	32 bits	3	2			
DIV/DIVU	8 bits	12	11			
	16 bits	19	18			
	24 bits	26	25			
	32 bits	33	32			

TABLE 3-1:MIPS32[®] M4K[®] PROCESSOR CORE HIGH-PERFORMANCE INTEGER
MULTIPLY/DIVIDE UNIT LATENCIES AND REPEAT RATES

The MIPS architecture defines that the result of a multiply or divide operation be placed in the HI and LO registers. Using the Move-From-HI (MFHI) and Move-From-LO (MFLO) instructions, these values can be transferred to the General Purpose Register file.

In addition to the HI/LO targeted operations, the MIPS32[®] architecture also defines a multiply instruction, MUL, which places the least significant results in the primary register file instead of the HI/LO register pair. By avoiding the explicit MFLO instruction required when using the LO register, and by supporting multiple destination registers, the throughput of multiply-intensive operations is increased.

Two other instructions, Multiply-Add (MADD) and Multiply-Subtract (MSUB), are used to perform the multiply-accumulate and multiply-subtract operations. The MADD instruction multiplies two numbers and then

adds the product to the current contents of the HI and LO registers. Similarly, the MSUB instruction multiplies two operands and then subtracts the product from the HI and LO registers. The MADD and MSUB operations are commonly used in DSP algorithms.

3.2.3 SYSTEM CONTROL COPROCESSOR (CP0)

In the MIPS architecture, CP0 is responsible for the virtual-to-physical address translation, the exception control system, the processor's diagnostics capability, the operating modes (Kernel, User and Debug) and whether interrupts are enabled or disabled. Configuration information, such as presence of options like MIPS16e, is also available by accessing the CP0 registers, listed in Table 3-2.

Register Number	Register Name	Function
0-6	Reserved	Reserved in the PIC32MX1XX/2XX family core.
7	HWREna	Enables access via the RDHWR instruction to selected hardware registers.
8	BadVAddr ⁽¹⁾	Reports the address for the most recent address-related exception.
9	Count ⁽¹⁾	Processor cycle count.
10	Reserved	Reserved in the PIC32MX1XX/2XX family core.
11	Compare ⁽¹⁾	Timer interrupt control.
12	Status ⁽¹⁾	Processor status and control.
12	IntCtl ⁽¹⁾	Interrupt system status and control.
12	SRSCtl ⁽¹⁾	Shadow register set status and control.
12	SRSMap ⁽¹⁾	Provides mapping from vectored interrupt to a shadow set.
13	Cause ⁽¹⁾	Cause of last general exception.
14	EPC ⁽¹⁾	Program counter at last exception.
15	PRId	Processor identification and revision.
15	EBASE	Exception vector base register.
16	Config	Configuration register.
16	Config1	Configuration Register 1.
16	Config2	Configuration Register 2.
16	Config3	Configuration Register 3.
17-22	Reserved	Reserved in the PIC32MX1XX/2XX family core.
23	Debug ⁽²⁾	Debug control and exception status.
24	DEPC ⁽²⁾	Program counter at last debug exception.
25-29	Reserved	Reserved in the PIC32MX1XX/2XX family core.
30	ErrorEPC ⁽¹⁾	Program counter at last error.
31	DESAVE ⁽²⁾	Debug handler scratchpad register.

TABLE 3-2: COPROCESSOR 0 REGISTERS

Note 1: Registers used in exception processing.

2: Registers used during debug.

Coprocessor 0 also contains the logic for identifying and managing exceptions. Exceptions can be caused by a variety of sources, including alignment errors in data, external events or program errors. Table 3-3 lists the exception types in order of priority.

Exception	Description
Reset	Assertion MCLR or a Power-on Reset (POR).
DSS	EJTAG debug single step.
DINT	EJTAG debug interrupt. Caused by the assertion of the external <i>EJ_DINT</i> input or by setting the EjtagBrk bit in the ECR register.
NMI	Assertion of NMI signal.
Interrupt	Assertion of unmasked hardware or software interrupt signal.
DIB	EJTAG debug hardware instruction break matched.
AdEL	Fetch address alignment error. Fetch reference to protected address.
IBE	Instruction fetch bus error.
DBp	EJTAG breakpoint (execution of SDBBP instruction).
Sys	Execution of SYSCALL instruction.
Вр	Execution of BREAK instruction.
RI	Execution of a reserved instruction.
CpU	Execution of a coprocessor instruction for a coprocessor that is not enabled.
CEU	Execution of a CorExtend instruction when CorExtend is not enabled.
Ov	Execution of an arithmetic instruction that overflowed.
Tr	Execution of a trap (when trap condition is true).
DDBL/DDBS	EJTAG Data Address Break (address only) or EJTAG data value break on store (address + value).
AdEL	Load address alignment error. Load reference to protected address.
AdES	Store address alignment error. Store to protected address.
DBE	Load or store bus error.
DDBL	EJTAG data hardware breakpoint matched in load data compare.

TABLE 3-3: MIPS32[®] M4K[®] PROCESSOR CORE EXCEPTION TYPES

3.3 **Power Management**

The MIPS M4K processor core offers many power management features, including low-power design, active power management and power-down modes of operation. The core is a static design that supports slowing or Halting the clocks, which reduces system power consumption during Idle periods.

3.3.1 INSTRUCTION-CONTROLLED POWER MANAGEMENT

The mechanism for invoking Power-Down mode is through execution of the WAIT instruction. For more information on power management, see Section 26.0 "Power-Saving Features".

3.4 EJTAG Debug Support

The MIPS M4K processor core provides an Enhanced JTAG (EJTAG) interface for use in the software debug of application and kernel code. In addition to standard User mode and Kernel modes of operation, the M4K core provides a Debug mode that is entered after a debug exception (derived from a hardware breakpoint, single-step exception, etc.) is taken and continues until a Debug Exception Return (DERET) instruction is executed. During this time, the processor executes the debug exception handler routine.

The EJTAG interface operates through the Test Access Port (TAP), a serial communication port used for transferring test data in and out of the core. In addition to the standard JTAG instructions, special instructions defined in the EJTAG specification define which registers are selected and how they are used.

4.0 MEMORY ORGANIZATION

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source.For detailed information, refer to **Section 3.** "**Memory Organization**" (DS60001115), which is available from the *Documentation* > *Reference Manual* section of the Microchip PIC32 web site (www.microchip.com/pic32).

PIC32MX1XX/2XX 28/36/44-pin Family microcontrollers provide 4 GB unified virtual memory address space. All memory regions, including program, data memory, Special Function Registers (SFRs), and Configuration registers, reside in this address space at their respective unique addresses. The program and data memories can be optionally partitioned into user and kernel memories. In addition, the data memory can be made executable, allowing PIC32MX1XX/2XX 28/36/44-pin Family devices to execute from data memory.

Key features include:

- · 32-bit native data width
- Separate User (KUSEG) and Kernel (KSEG0/KSEG1) mode address space
- · Flexible program Flash memory partitioning
- Flexible data RAM partitioning for data and program space
- · Separate boot Flash memory for protected code
- Robust bus exception handling to intercept runaway code
- Simple memory mapping with Fixed Mapping Translation (FMT) unit
- Cacheable (KSEG0) and non-cacheable (KSEG1) address regions

4.1 PIC32MX1XX/2XX 28/36/44-pin Family Memory Layout

PIC32MX1XX/2XX 28/36/44-pin Family microcontrollers implement two address schemes: virtual and physical. All hardware resources, such as program memory, data memory and peripherals, are located at their respective physical addresses. Virtual addresses are exclusively used by the CPU to fetch and execute instructions as well as access peripherals. Physical addresses are used by bus master peripherals, such as DMA and the Flash controller, that access memory independently of the CPU.

The memory maps for the PIC32MX1XX/2XX 28/36/44-pin Family devices are illustrated in Figure 4-1 through Figure 4-6.

Table 4-1 provides SFR memory map details.

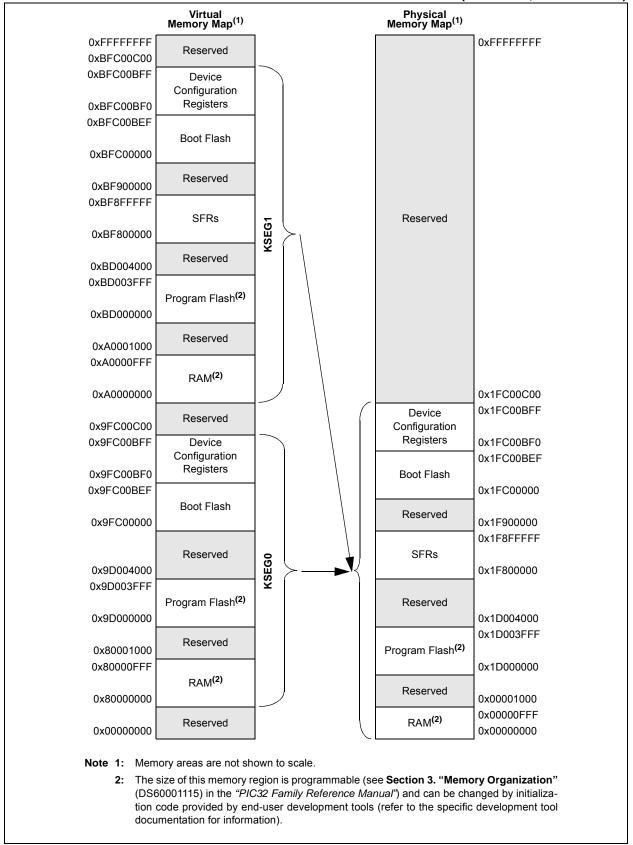


FIGURE 4-1: MEMORY MAP ON RESET FOR PIC32MX110/210 DEVICES (4 KB RAM, 16 KB FLASH)

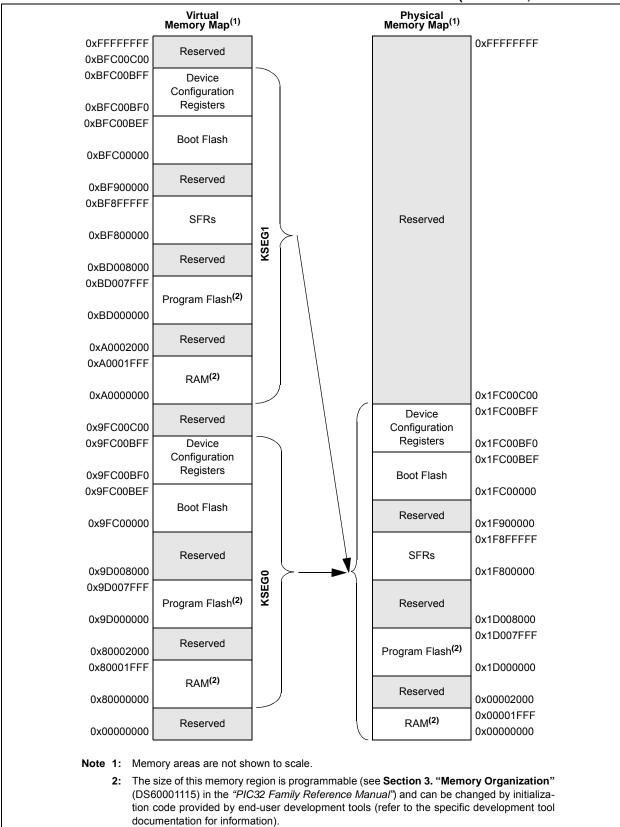


FIGURE 4-2: MEMORY MAP ON RESET FOR PIC32MX120/220 DEVICES (8 KB RAM, 32 KB FLASH)

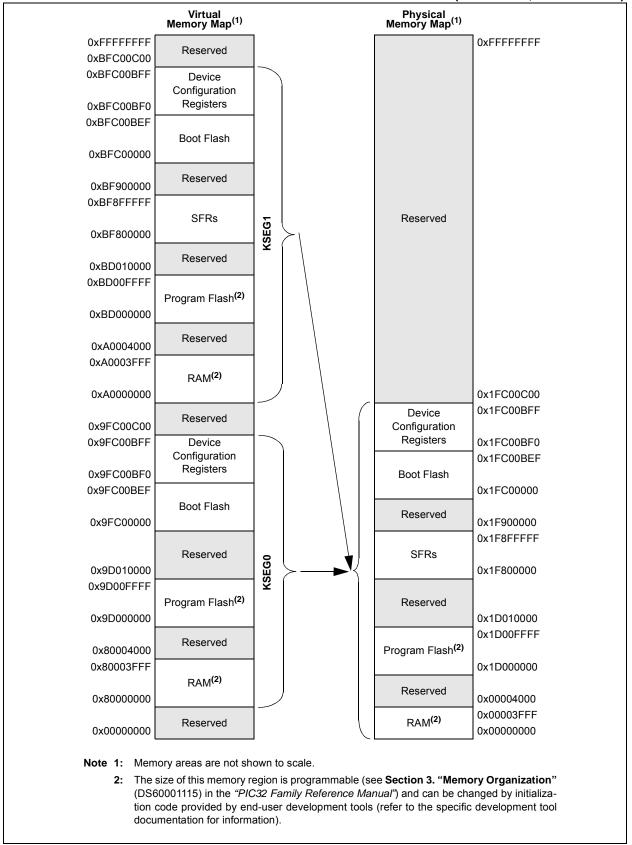


FIGURE 4-3: MEMORY MAP ON RESET FOR PIC32MX130/230 DEVICES (16 KB RAM, 64 KB FLASH)

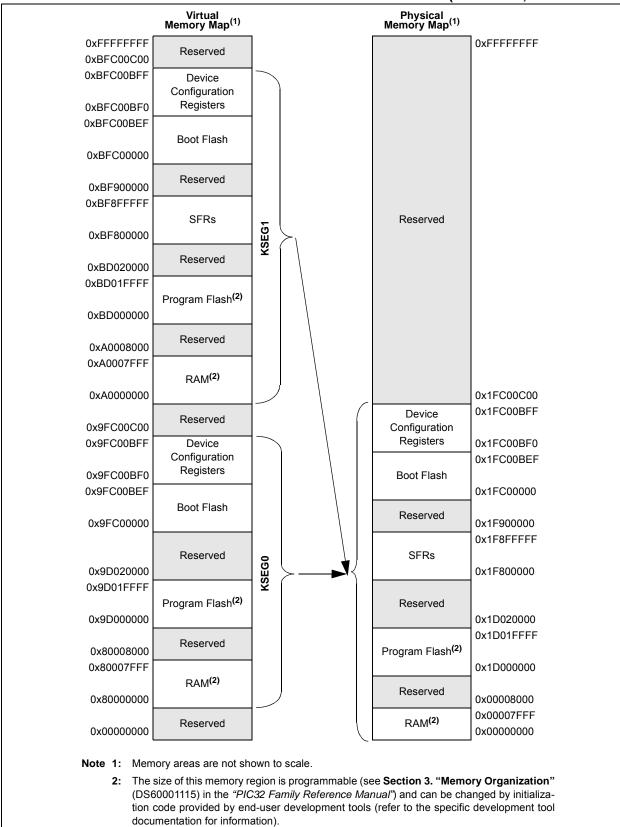


FIGURE 4-4: MEMORY MAP ON RESET FOR PIC32MX150/250 DEVICES (32 KB RAM, 128 KB FLASH)

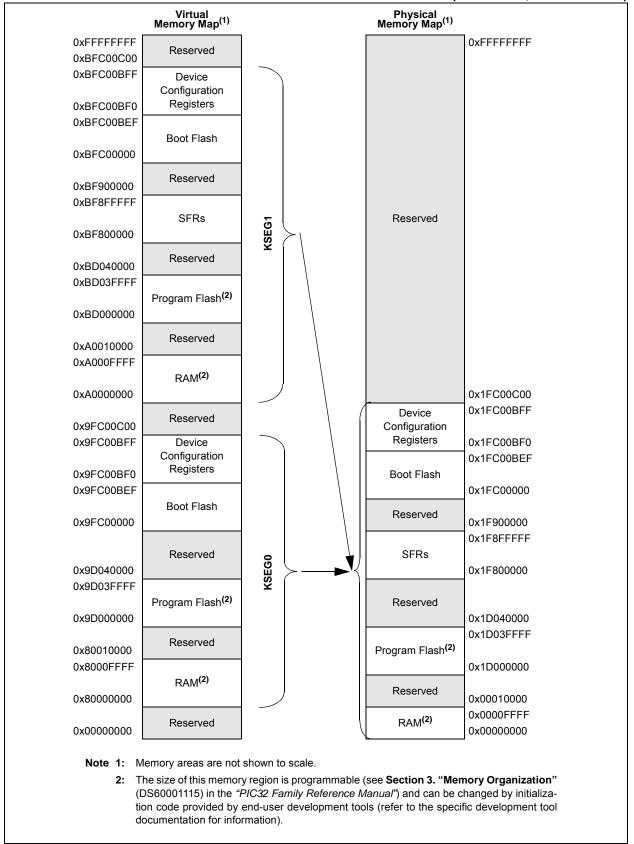


FIGURE 4-5: MEMORY MAP ON RESET FOR PIC32MX170/270 DEVICES (64 KB RAM, 256 KB FLASH)

	Virtual Memory Map ⁽¹⁾		Physical Memory Map ⁽¹⁾	
0xFFFFFFFF	Reserved			0xFFFFFFF
0xBFC00C00		_		
0xBFC00BFF	Device Configuration			
0xBFC00BF0	Registers			
0xBFC00BEF				
	Boot Flash			
0xBFC00000				
0xBF900000	Reserved			
0xBF8FFFFF				
	SFRs	2	Reserved	
0xBF800000		KSEG1		
	Reserved	×		
0xBD040000				
0xBD03FFFF	Program Flash ⁽²⁾			
0xBD000000	riogram riaon			
·	Deserved			
0xA0004000	Reserved			
0xA0003FFF	(2)			
0xA000000	RAM ⁽²⁾			0x1FC00C00
02A000000			Device	0x1FC00BFF
0x9FC00C00	Reserved		Configuration	
0x9FC00BFF	Device	$\overline{}$	Registers	0x1FC00BF0
	Configuration Registers			0x1FC00BEF
0x9FC00BF0	Registers		Boot Flash	0x1FC00000
0x9FC00BEF	Boot Flash			
0x9FC00000	20001 10011		Reserved	0x1F900000
				0x1F8FFFFF
	Reserved	8	SFRs	
0x9D040000		KSEG0		0x1F800000
0x9D03FFFF	Program Flash ⁽²⁾	×	Reserved	
0x9D000000	i rogiani riaon		1 COOLING	0x1D040000
	Reserved			0x1D03FFFF
0x80004000	Reserved		Program Flash ⁽²⁾	
0x80003FFF	$\Box \wedge (2)$			0x1D000000
0x80000000	RAM ⁽²⁾		Reserved	0x00004000
0x0000000			(0)	0x00003FFF
0x0000000	Reserved		RAM ⁽²⁾	0x00000000
2: TI (E tic	0S60001115) in the <i>"I</i>	y region is programmable (PIC32 Family Reference M end-user development too	<i>lanual"</i>) and can be c	hanged by initializa-

FIGURE 4-6: MEMORY MAP ON RESET FOR PIC32MX130/230 DEVICES (16 KB RAM, 256 KB FLASH)

TABLE 4-1: SFR MEMORY MAP

	Virtual Address			
Peripheral	Base	Offset Start		
Watchdog Timer		0x0000		
RTCC		0x0200		
Timer1-5		0x0600		
Input Capture 1-5		0x2000		
Output Compare 1-5		0x3000		
IC1 and IC2		0x5000		
SPI1 and SPI2		0x5800		
UART1 and UART2		0x6000		
PMP		0x7000		
ADC	0xBF80	0x9000		
CVREF		0x9800		
Comparator		0xA000		
CTMU		0xA200		
Oscillator		0xF000		
Device and Revision ID		0xF220		
Peripheral Module Disable		0xF240		
Flash Controller		0xF400		
Reset		0xF600		
PPS		0xFA04		
Interrupts		0x1000		
Bus Matrix		0x2000		
DMA	0xBF88	0x3000		
USB		0x5050		
PORTA-PORTC		0x6000		
Configuration	0xBFC0	0x0BF0		

4.2 Bus Matrix Control Registers

TABLE 4-2:		BU	S MATRIX REGISTER MAP	

	σ										Bits			
Register Name	Bit Rang	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3
	31:16	_	_	_	_	_	—	-	—	_	—	_	BMXERRIXI	BMXERRICD
BWXCON	15:0	-	_	_	_	_	_	_	_	-	BMXWSDRM	_	_	_
(1), פסאסאאנ	31:16	_	_	—					_	_	_		_	_
SIVIAUKPBA	15:0									BM	XDKPBA<15:0>	>		
BMXDUDBA ⁽¹⁾	31:16	_	—	_	_	_	_	_	—	_	—	_	—	—
	15:0								-	BM	XDUDBA<15:0	>	_	
	31:16	—	—	—	_	—	_	_	_	—	_	_	—	_
	15:0	BMXDUPBA<15:0>												
BMXDRMSZ	31:16 15:0									BM	XDRMSZ<31:0	>		
	31:16	_	—	_	—	—	—	_		—	—	_	—	
SWAPUPBA	15:0		BMXPUPBA<15:0>											
	31:16									DM	VDEM07-21-0			
DIVIAFFIVIOZ	15:0									BIVI	AFFIVIOZS01.0-			
BMYBOOT97	31:16									BM	(BOOTS7<31.0	<u> </u>		
DIVINDOUT 32	15:0									DIVIZ	000132531.0	-		
	BMXCON ⁽¹⁾ BMXDKPBA ⁽¹⁾ BMXDUDBA ⁽¹⁾ BMXDUPBA ⁽¹⁾ BMXDRMSZ BMXPUPBA ⁽¹⁾ BMXPUPBA ⁽¹⁾ BMXPFMSZ	BMXCON ⁽¹⁾ 31:16 15:0 3MXDKPBA ⁽¹⁾ 31:16 15:0 15:0	BMXCON ⁽¹⁾ 31:16 — BMXCON ⁽¹⁾ 31:16 — 3MXDKPBA ⁽¹⁾ 31:16 — 3MXDUDBA ⁽¹⁾ 31:16 — 3MXDUDBA ⁽¹⁾ 31:16 — 3MXDUDBA ⁽¹⁾ 31:16 — 3MXDUDBA ⁽¹⁾ 31:16 — 3MXDUPBA ⁽¹⁾ 31:16 — 3MXDUPBA ⁽¹⁾ 31:16 — 3MXDUPBA ⁽¹⁾ 31:16 — BMXDRMSZ 31:16 — BMXPFMSZ 31:16 — BMXBOOTSZ 31:16 —	BMXCON ⁽¹⁾ 31:16 — — BMXCON ⁽¹⁾ 31:16 — — — 3MXDKPBA ⁽¹⁾ 31:16 — — — 3MXDKPBA ⁽¹⁾ 31:16 — — — 3MXDUDBA ⁽¹⁾ 31:16 — — — 3MXDUDBA ⁽¹⁾ 31:16 — — — 3MXDUDBA ⁽¹⁾ 31:16 — — — 3MXDUPBA ⁽¹⁾ 31:16 — — — 3MXDUPBA ⁽¹⁾ 31:16 — — — 3MXPUPBA ⁽¹⁾ 15:0 — — — 3MXBOOTSZ 31:16 — — —	BMXCON ⁽¹⁾ 31:16 15:0 3MXDKPBA ⁽¹⁾ 31:16 3MXDKPBA ⁽¹⁾ 31:16 3MXDUDBA ⁽¹⁾ 31:16 3MXDUDBA ⁽¹⁾ 31:16 3MXDUDBA ⁽¹⁾ 31:16 3MXDUDBA ⁽¹⁾ 31:16 3MXDUPBA ⁽¹⁾ 31:16 3MXPUPBA ⁽¹⁾ 31:16 3MXPUPBA ⁽¹⁾ 31:16 3MXPUPBA ⁽¹⁾ 31:16 3MXPUPBA ⁽¹⁾ 31:16 3MXBOOTSZ 31:16	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	BMXCON ⁽¹⁾ 31:16	BMXCON ⁽¹⁾ 31:16	BMXCON ⁽¹⁾ 31:16 -	by by the 31/15 30/14 29/13 28/12 27/11 26/10 25/9 24/8 23/7 22/6 BMXCON(1) 31:16 -	by by<	beside beside 31/15 30/14 29/13 28/12 27/11 26/10 25/9 24/8 23/7 22/6 21/5 20/4 BMXCON(1) 15:0 <

Leç

nd: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: This register has corresponding CLR, SET and INV registers at its virtual address, plus an offset of 0x4, 0x8 and 0xC, respectively. See Section 11.2 "CLR

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	—	—	—	—	—	_	—	—
	U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
23:16	_	—	—	BMX ERRIXI	BMX ERRICD	BMX ERRDMA	BMX ERRDS	BMX ERRIS
45.0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
15:8	—	—	—	—	—	—	_	—
	U-0	R/W-1	U-0	U-0	U-0	R/W-0	R/W-0	R/W-1
7:0	_	BMX WSDRM	_	_	_	BMXARB<2:0>		

REGISTER 4-1: BMXCON: BUS MATRIX CONFIGURATION REGISTER

Legend:	
---------	--

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared

bit 31-21	Unimplemented: Read as '0'
bit 20	BMXERRIXI: Enable Bus Error from IXI bit
	 1 = Enable bus error exceptions for unmapped address accesses initiated from IXI shared bus 0 = Disable bus error exceptions for unmapped address accesses initiated from IXI shared bus
bit 19	BMXERRICD: Enable Bus Error from ICD Debug Unit bit
	 1 = Enable bus error exceptions for unmapped address accesses initiated from ICD 0 = Disable bus error exceptions for unmapped address accesses initiated from ICD
bit 18	BMXERRDMA: Bus Error from DMA bit
	 1 = Enable bus error exceptions for unmapped address accesses initiated from DMA 0 = Disable bus error exceptions for unmapped address accesses initiated from DMA
bit 17	BMXERRDS: Bus Error from CPU Data Access bit (disabled in Debug mode)
	 1 = Enable bus error exceptions for unmapped address accesses initiated from CPU data access 0 = Disable bus error exceptions for unmapped address accesses initiated from CPU data access
bit 16	BMXERRIS: Bus Error from CPU Instruction Access bit (disabled in Debug mode)
	 1 = Enable bus error exceptions for unmapped address accesses initiated from CPU instruction access 0 = Disable bus error exceptions for unmapped address accesses initiated from CPU instruction access
bit 15-7	Unimplemented: Read as '0'
bit 6	BMXWSDRM: CPU Instruction or Data Access from Data RAM Wait State bit
	 1 = Data RAM accesses from CPU have one wait state for address setup 0 = Data RAM accesses from CPU have zero wait states for address setup
bit 5-3	Unimplemented: Read as '0'
bit 2-0	BMXARB<2:0>: Bus Matrix Arbitration Mode bits
	111 = Reserved (using these Configuration modes will produce undefined behavior)
	•
	•
	011 = Reserved (using these Configuration modes will produce undefined behavior) 010 = Arbitration Mode 2
	001 = Arbitration Mode 1 (default)
	000 = Arbitration Mode 0

-									
Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
04.04	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
31:24	_	—	_	_	_	—	—	—	
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
23:16	_	—	_	_	_	—	_	—	
45.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-0	R-0	
15:8	BMXDKPBA<15:8>								
7.0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	
7:0				BMXDK	PBA<7:0>				

REGISTER 4-2: BMXDKPBA: DATA RAM KERNEL PROGRAM BASE ADDRESS REGISTER

Legend:

- J			
R = Readable bit	R = Readable bit W = Writable bit		ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

bit 15-10 **BMXDKPBA<15:10>:** DRM Kernel Program Base Address bits When non-zero, this value selects the relative base address for kernel program space in RAM

bit 9-0 BMXDKPBA<9:0>: Read-Only bits This value is always '0', which forces 1 KB increments

Note 1: At Reset, the value in this register is forced to zero, which causes all of the RAM to be allocated to Kernal mode data usage.

2: The value in this register must be less than or equal to BMXDRMSZ.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	_	_	_	_	-	_	_	_
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	_	_	_	_	_	_	_	_
45.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-0	R-0
15:8	BMXDUDBA<15:8>							
7.0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
7:0				BMXDU	DBA<7:0>			

REGISTER 4-3: BMXDUDBA: DATA RAM USER DATA BASE ADDRESS REGISTER

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

bit 15-10 **BMXDUDBA<15:10>:** DRM User Data Base Address bits When non-zero, the value selects the relative base address for User mode data space in RAM, the value must be greater than BMXDKPBA.

bit 9-0 BMXDUDBA<9:0>: Read-Only bits This value is always '0', which forces 1 KB increments

Note 1: At Reset, the value in this register is forced to zero, which causes all of the RAM to be allocated to Kernal mode data usage.

2: The value in this register must be less than or equal to BMXDRMSZ.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
31:24	—	_	—	_	_	—	—	—	
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
23:16	_	_	_	—	_	—	_	—	
45.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-0	R-0	
15:8	BMXDUPBA<15:8>								
7.0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	
7:0				BMXDU	PBA<7:0>				

REGISTER 4-4: BMXDUPBA: DATA RAM USER PROGRAM BASE ADDRESS REGISTER

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

bit 15-10 **BMXDUPBA<15:10>:** DRM User Program Base Address bits When non-zero, the value selects the relative base address for User mode program space in RAM, BMXDUPBA must be greater than BMXDUDBA.

bit 9-0 BMXDUPBA<9:0>: Read-Only bits This value is always '0', which forces 1 KB increments

Note 1: At Reset, the value in this register is forced to zero, which causes all of the RAM to be allocated to Kernal mode data usage.

2: The value in this register must be less than or equal to BMXDRMSZ.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
04.04	R	R	R	R	R	R	R	R
31:24				BMXDRM	1SZ<31:24>			
00.40	R	R	R	R	R	R	R	R
23:16				BMXDRM	1SZ<23:16>			
45.0	R	R	R	R	R	R	R	R
15:8	BMXDRMSZ<15:8>							
7.0	R	R	R	R	R	R	R	R
7:0				BMXDR	MSZ<7:0>			

REGISTER 4-5: BMXDRMSZ: DATA RAM SIZE REGISTER

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-0 BMXDRMSZ<31:0>: Data RAM Memory (DRM) Size bits

Static value that indicates the size of the Data RAM in bytes: 0x00001000 = Device has 4 KB RAM 0x00002000 = Device has 8 KB RAM 0x00004000 = Device has 16 KB RAM 0x00008000 = Device has 32 KB RAM 0x00010000 = Device has 64 KB RAM

REGISTER 4-6: BMXPUPBA: PROGRAM FLASH (PFM) USER PROGRAM BASE ADDRESS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
31:24	_	_	—	_	_	—	_	—	
00.40	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	
23:16	_	—	_	—	BMXPUPBA<19:16>				
45.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-0	R-0	R-0	
15:8				BMXPU	PBA<15:8>				
7.0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	
7:0				BMXPU	PBA<7:0>				

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-20 Unimplemented: Read as '0'

bit 19-11 BMXPUPBA<19:11>: Program Flash (PFM) User Program Base Address bits

bit 10-0 BMXPUPBA<10:0>: Read-Only bits

This value is always '0', which forces 2 KB increments

Note 1: At Reset, the value in this register is forced to zero, which causes all of the RAM to be allocated to Kernal mode data usage.

2: The value in this register must be less than or equal to BMXPFMSZ.

Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
R	R	R	R	R	R	R	R	
			BMXPFN	ISZ<31:24>				
R	R	R	R	R	R	R	R	
BMXPFMSZ<23:16>								
R	R	R	R	R	R	R	R	
			BMXPF	/ISZ<15:8>				
R	R	R	R	R	R	R	R	
			BMXPF	MSZ<7:0>				
	Bit 31/23/15/7 R R R	Bit Bit 31/23/15/7 30/22/14/6 R R R R R R R R R R R R	Bit 31/23/15/7 Bit 30/22/14/6 Bit 29/21/13/5 R R R R R R R R R R R R R R R R R R	Bit 31/23/15/7 Bit 30/22/14/6 Bit 29/21/13/5 Bit 28/20/12/4 R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R	Bit 31/23/15/7 Bit 30/22/14/6 Bit 29/21/13/5 Bit 28/20/12/4 Bit 27/19/11/3 R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R BMXPFMSZ<23:16> BMXPFMSZ<15:8>	Bit 31/23/15/7 Bit 30/22/14/6 Bit 29/21/13/5 Bit 28/20/12/4 Bit 27/19/11/3 Bit 26/18/10/2 R R R Bit 26/18/10/2 R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R	Bit 31/23/15/7 Bit 29/21/13/5 Bit 28/20/12/4 Bit 27/19/11/3 Bit 26/18/10/2 Bit 25/17/9/1 R R R Bit 26/18/10/2 25/17/9/1 R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R R	

REGISTER 4-7: BMXPFMSZ: PROGRAM FLASH (PFM) SIZE REGISTER

Legend:

Legena.			
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-0 BMXPFMSZ<31:0>: Program Flash Memory (PFM) Size bits

Static value that indicates the size of the PFM in bytes: 0x00004000 = Device has 16 KB Flash 0x0008000 = Device has 32 KB Flash 0x00010000 = Device has 64 KB Flash 0x00020000 = Device has 128 KB Flash 0x00040000 = Device has 256 KB Flash

REGISTER 4-8: BMXBOOTSZ: BOOT FLASH (IFM) SIZE REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
24.04	R	R	R	R	R	R	R	R	
31:24				BMXBOO	TSZ<31:24>				
00.40	R	R	R	R	R	R	R	R	
23:16	BMXBOOTSZ<23:16>								
45.0	R	R	R	R	R	R	R	R	
15:8	BMXBOOTSZ<15:8>								
7.0	R	R	R	R	R	R	R	R	
7:0				BMXBO	OTSZ<7:0>				

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bi	t, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-0 **BMXBOOTSZ<31:0>:** Boot Flash Memory (BFM) Size bits Static value that indicates the size of the Boot PFM in bytes: 0x00000C00 = Device has 3 KB boot Flash

NOTES:

5.0 FLASH PROGRAM MEMORY

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 5. "Flash Program Memory" (DS60001121), which is available from the *Documentation* > *Reference Manual* section of the Microchip PIC32 web site (www.microchip.com/pic32).

PIC32MX1XX/2XX 28/36/44-pin Family devices contain an internal Flash program memory for executing user code. There are three methods by which the user can program this memory:

- Run-Time Self-Programming (RTSP)
- EJTAG Programming
- In-Circuit Serial Programming[™] (ICSP[™])

RTSP is performed by software executing from either Flash or RAM memory. Information about RTSP techniques is available in **Section 5. "Flash Program Memory"** (DS60001121) in the *"PIC32 Family Reference Manual"*.

EJTAG is performed using the EJTAG port of the device and an EJTAG capable programmer.

ICSP is performed using a serial data connection to the device and allows much faster programming times than RTSP.

The EJTAG and ICSP methods are described in the *"PIC32 Flash Programming Specification"* (DS60001145), which can be downloaded from the Microchip web site.

Note: The Flash page size on PIC32MX-1XX/2XX 28/36/44-pin Family devices is 1 KB and the row size is 128 bytes (256 IW and 32 IW, respectively).

5.1 Flash Controller Control Registers

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TABLE 5-1: FLASH CONTROLLER REGISTER MAP

ess		0		Bits										
Virtual Address (BF80_#)	Register Name	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4
F400 NVMCON ⁽¹⁾	31:16	_	—	_		—	_	_		—	_	—	—	
	INVINCOIN**	15:0	WR	WREN	WRERR	LVDERR	LVDSTAT	_	_		_	_	_	—
F410	NVMKEY	31:16	NVMKEY<31:0>											
1 4 10		15:0		INVINCE 1531.02										
F420	NVMADDR ⁽¹⁾	31:16		NVMADDR<31:0>										
1 720	NUMADDI	15:0												
F430	NVMDATA	31:16								NVMDAT	A<31.0>			
1 400	NYMDAIA	15:0									4501.02			
F440	NVMSRCADDR	31:16		NVMSRCADDR<31:0>										
1 0	NUMBER OADDIN	15:0								VINCINOAL	01.04			
Legen	d: x = unkno	wn valu	e on Reset	t; — = unimp	plemented,	read as '0'.	Reset valu	es are show	wn in hexa	decimal.				

Note 1: This register has corresponding CLR, SET and INV registers at its virtual address, plus offsets of 0x4, 0x8 and 0xC, respectively. See Section 11.2 "C

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	_	—	_	—	_	—	_	_
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	_	—	_	_	_	—		—
15.0	R/W-0	R/W-0	R-0	R-0	R-0	U-0	U-0	U-0
15:8	WR	WREN	WRERR ⁽¹⁾	LVDERR ⁽¹⁾	LVDSTAT ⁽¹⁾	—	—	—
7:0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
7.0	_	_				NVMOF	°<3:0>	

REGISTER 5-1: NVMCON: PROGRAMMING CONTROL REGISTER

Legend:

R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'				
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

bit 31-16 Unimplemented: Read as '0'

bit 31-16	Unimplemented: Read as '0'
bit 15	WR: Write Control bit
	This bit is writable when WREN = 1 and the unlock sequence is followed.
	1 = Initiate a Flash operation. Hardware clears this bit when the operation completes
	0 = Flash operation is complete or inactive
bit 14	WREN: Write Enable bit
	This is the only bit in this register reset by a device Reset.
	1 = Enable writes to WR bit and enables LVD circuit
	0 = Disable writes to WR bit and disables LVD circuit
bit 13	WRERR: Write Error bit ⁽¹⁾
	This bit is read-only and is automatically set by hardware.
	1 = Program or erase sequence did not complete successfully
	0 = Program or erase sequence completed normally
bit 12	LVDERR: Low-Voltage Detect Error bit (LVD circuit must be enabled) ⁽¹⁾
	This bit is read-only and is automatically set by hardware.
	1 = Low-voltage detected (possible data corruption, if WRERR is set)
	0 = Voltage level is acceptable for programming (1)
bit 11	LVDSTAT: Low-Voltage Detect Status bit (LVD circuit must be enabled) ⁽¹⁾
	This bit is read-only and is automatically set and cleared by the hardware.
	1 = Low-voltage event is active
	0 = Low-voltage event is not active
bit 10-4	Unimplemented: Read as '0'
bit 3-0	NVMOP<3:0>: NVM Operation bits
	These bits are writable when $WREN = 0$.
	1111 = Reserved
	•
	•
	0111 = Reserved
	0110 = No operation 0101 = Program Flash Memory (PFM) erase operation: erases PFM, if all pages are not write-protected
	0100 = Page erase operation: erases page selected by NVMADDR, if it is not write-protected
	0011 = Row program operation: programs row selected by NVMADDR, if it is not write-protected
	0010 = No operation
	0001 = Word program operation: programs word selected by NVMADDR, if it is not write-protected
	0000 = No operation

Note 1: This bit is cleared by setting NVMOP == `b0000, and initiating a Flash operation (i.e., WR).

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Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0						
04.04	W-0	W-0	W-0	W-0	W-0	W-0	W-0	W-0						
31:24	NVMKEY<31:24>													
00.40	W-0	W-0	W-0	W-0	W-0	W-0	W-0	W-0						
23:16	NVMKEY<23:16>													
45.0	W-0	W-0	W-0	W-0	W-0	W-0	W-0	W-0						
15:8	NVMKEY<15:8>													
7.0	W-0	W-0	W-0	W-0	W-0	W-0	W-0	W-0						
7:0				NVMK	NVMKEY<7:0>									

REGISTER 5-2: NVMKEY: PROGRAMMING UNLOCK REGISTER

Legend:						
R = Readable bit	W = Writable bit	t U = Unimplemented bit, read as '0'				
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

bit 31-0 NVMKEY<31:0>: Unlock Register bits

These bits are write-only, and read as '0' on any read

Note: This register is used as part of the unlock sequence to prevent inadvertent writes to the PFM.

REGISTER 5-3: NVMADDR: FLASH ADDRESS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0		
04.04	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
31:24	NVMADDR<31:24>									
00.40	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
23:16	NVMADDR<23:16>									
15.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
15:8	NVMADDR<15:8>									
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
7:0				NVMAE)DR<7:0>					

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-0 NVMADDR<31:0>: Flash Address bits

Bulk/Chip/PFM Erase: Address is ignored. Page Erase: Address identifies the page to erase. Row Program: Address identifies the row to program. Word Program: Address identifies the word to program.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0		
04-04	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
31:24	NVMDATA<31:24>									
00.40	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
23:16	NVMDATA<23:16>									
45.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
15:8		NVMDATA<15:8>								
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
7:0				NVMD/	ATA<7:0>					

REGISTER 5-4: NVMDATA: FLASH PROGRAM DATA REGISTER

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, r
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared

l bit, read as '0' x = Bit is unknown

bit 31-0 NVMDATA<31:0>: Flash Programming Data bits

Note: The bits in this register are only reset by a Power-on Reset (POR).

REGISTER 5-5: NVMSRCADDR: SOURCE DATA ADDRESS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0		
04-04	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
31:24	4 NVMSRCADDR<31:24>									
00.40	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
23:16	NVMSRCADDR<23:16>									
45.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
15:8	NVMSRCADDR<15:8>									
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
7:0				NVMSRC	ADDR<7:0>					

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-0 NVMSRCADDR<31:0>: Source Data Address bits

The system physical address of the data to be programmed into the Flash when the NVMOP<3:0> bits (NVMCON<3:0>) are set to perform row programming.

Γ.

NOTES:

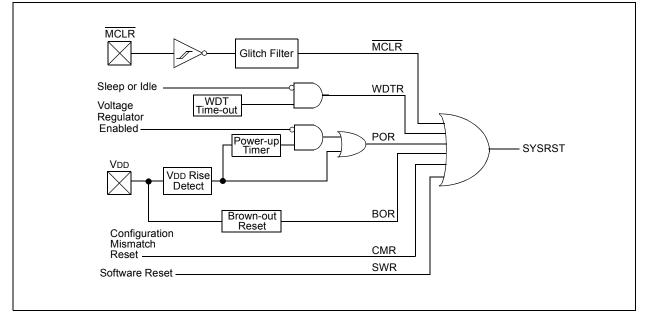
6.0 RESETS

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 7. "Resets"** (DS60001118), which is available from the *Documentation > Reference Manual* section of the Microchip PIC32 web site (www.microchip.com/pic32). The Reset module combines all Reset sources and controls the device Master Reset signal, SYSRST. The following is a list of device Reset sources:

- Power-on Reset (POR)
- Master Clear Reset pin (MCLR)
- Software Reset (SWR)
- Watchdog Timer Reset (WDTR)
- Brown-out Reset (BOR)
- Configuration Mismatch Reset (CMR)

A simplified block diagram of the Reset module is illustrated in Figure 6-1.

FIGURE 6-1: SYSTEM RESET BLOCK DIAGRAM



Reset Control Registers 6.1

TABLE 6-1: **RESET CONTROL REGISTER MAP**

ess		0		Bits												
Virtual Address (BF80_#)		Rang	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/	
5000	DOON	31:16	_	_	_	_	_	_	_	_	_	_	_	_	_	
F600	RCON	15:0	_	_	_	_	_	_	CMR	VREGS	EXTR	SWR	_	WDTO	SLE	
F610	DOWDOT	31:16	_	_	_	_	_	_	_	_	_	—		_	_	
F610 RS	KOWKOI	15:0	_	_			_	_	_						_	

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Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See more information. Note 1:

Reset values are dependent on the DEVCFGx Configuration bits and the type of reset. 2:

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0						
31.24								—
23:16	U-0	U-0						
23.10		_	_	-	_	_	-	—
45.0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0, HS	R/W-0
15:8	_	_	_	_	_		CMR	VREGS
7.0	R/W-0, HS	R/W-0, HS	U-0	R/W-0, HS	R/W-0, HS	R/W-0, HS	R/W-1, HS	R/W-1, HS
7:0	EXTR	SWR	_	WDTO	SLEEP	IDLE	BOR ⁽¹⁾	POR ⁽¹⁾

REGISTER 6-1: RCON: RESET CONTROL REGISTER

Legend:	HS = Set by hardware					
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'				
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

bit 31-10 Unimplemented: Read as '0'

5.00.00	
bit 9	CMR: Configuration Mismatch Reset Flag bit 1 = Configuration mismatch Reset has occurred
	0 = Configuration mismatch Reset has not occurred
bit 8	VREGS: Voltage Regulator Standby Enable bit
	 1 = Regulator is enabled and is on during Sleep mode 0 = Regulator is set to standby tracking mode
bit 7	EXTR: External Reset (MCLR) Pin Flag bit
	1 = Master Clear (pin) Reset has occurred
	0 = Master Clear (pin) Reset has not occurred
bit 6	SWR: Software Reset Flag bit
	1 = Software Reset was executed
	0 = Software Reset as not executed
bit 5	Unimplemented: Read as '0'
bit 4	WDTO: Watchdog Timer Time-out Flag bit
	1 = WDT Time-out has occurred
	0 = WDT Time-out has not occurred
bit 3	SLEEP: Wake From Sleep Flag bit
	1 = Device was in Sleep mode
	0 = Device was not in Sleep mode
bit 2	IDLE: Wake From Idle Flag bit
	1 = Device was in Idle mode
	0 = Device was not in Idle mode
bit 1	BOR: Brown-out Reset Flag bit ⁽¹⁾
	 Brown-out Reset has occurred
	0 = Brown-out Reset has not occurred
bit 0	POR: Power-on Reset Flag bit ⁽¹⁾
	1 = Power-on Reset has occurred
	0 = Power-on Reset has not occurred

Note 1: User software must clear this bit to view next detection.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24				_	_			_
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	-	_	—	—	—	_	-	_
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
10.0	-	_	—	—	—	_	-	_
7:0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	W-0, HC
7:0	_	_	_	_	_		_	SWRST ⁽¹⁾

REGISTER 6-2: RSWRST: SOFTWARE RESET REGISTER

Legend:	HC = Cleared by hardwa	HC = Cleared by hardware					
R = Readable bit	W = Writable bit	W = Writable bit U = Unimplemented bit, read as '0'					
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown				

bit 31-1 Unimplemented: Read as '0'

- bit 0 SWRST: Software Reset Trigger bit⁽¹⁾ 1 = Enable Software Reset event 0 = No effect
- **Note 1:** The system unlock sequence must be performed before the SWRST bit is written. Refer to **Section 6.** "**Oscillator**" (DS60001112) in the "*PIC32 Family Reference Manual*" for details.

7.0 INTERRUPT CONTROLLER

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 8. "Interrupt Controller" (DS60001108), which is available from the *Documentation* > *Reference Manual* section of the Microchip PIC32 web site (www.microchip.com/pic32).

PIC32MX1XX/2XX 28/36/44-pin Family devices generate interrupt requests in response to interrupt events from peripheral modules. The interrupt control module exists externally to the CPU logic and prioritizes the interrupt events before presenting them to the CPU.

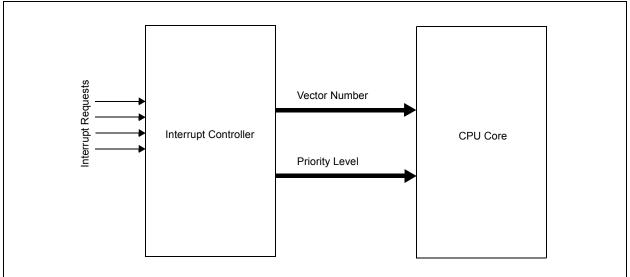
The PIC32MX1XX/2XX 28/36/44-pin Family interrupt module includes the following features:

- Up to 64 interrupt sources
- Up to 44 interrupt vectors
- · Single and multi-vector mode operations
- Five external interrupts with edge polarity control
- Interrupt proximity timer
- Seven user-selectable priority levels for each vector
- Four user-selectable subpriority levels within each priority
- Software can generate any interrupt
- User-configurable Interrupt Vector Table (IVT) location
- · User-configurable interrupt vector spacing

Note: The dedicated shadow register set is not present on PIC32MX1XX/2XX 28/36/44-pin Family devices.

A simplified block diagram of the Interrupt Controller module is illustrated in Figure 7-1.

FIGURE 7-1: INTERRUPT CONTROLLER MODULE BLOCK DIAGRAM



Interrupt Source(1)	IRQ	Vector		Interru	pt Bit Location		Persistent
Interrupt Source ⁽¹⁾	#	#	Flag	Enable	Priority	Sub-priority	Interrupt
		Highes	st Natural O	rder Priority	1		•
CT – Core Timer Interrupt	0	0	IFS0<0>	IEC0<0>	IPC0<4:2>	IPC0<1:0>	No
CS0 – Core Software Interrupt 0	1	1	IFS0<1>	IEC0<1>	IPC0<12:10>	IPC0<9:8>	No
CS1 – Core Software Interrupt 1	2	2	IFS0<2>	IEC0<2>	IPC0<20:18>	IPC0<17:16>	No
INT0 – External Interrupt	3	3	IFS0<3>	IEC0<3>	IPC0<28:26>	IPC0<25:24>	No
T1 – Timer1	4	4	IFS0<4>	IEC0<4>	IPC1<4:2>	IPC1<1:0>	No
IC1E – Input Capture 1 Error	5	5	IFS0<5>	IEC0<5>	IPC1<12:10>	IPC1<9:8>	Yes
IC1 – Input Capture 1	6	5	IFS0<6>	IEC0<6>	IPC1<12:10>	IPC1<9:8>	Yes
OC1 – Output Compare 1	7	6	IFS0<7>	IEC0<7>	IPC1<20:18>	IPC1<17:16>	No
INT1 – External Interrupt 1	8	7	IFS0<8>	IEC0<8>	IPC1<28:26>	IPC1<25:24>	No
T2 – Timer2	9	8	IFS0<9>	IEC0<9>	IPC2<4:2>	IPC2<1:0>	No
IC2E – Input Capture 2	10	9	IFS0<10>	IEC0<10>	IPC2<12:10>	IPC2<9:8>	Yes
IC2 – Input Capture 2	11	9	IFS0<11>	IEC0<11>	IPC2<12:10>	IPC2<9:8>	Yes
OC2 – Output Compare 2	12	10	IFS0<12>	IEC0<12>	IPC2<20:18>	IPC2<17:16>	No
INT2 – External Interrupt 2	13	11	IFS0<13>	IEC0<13>	IPC2<28:26>	IPC2<25:24>	No
T3 – Timer3	14	12	IFS0<14>	IEC0<14>	IPC3<4:2>	IPC3<1:0>	No
IC3E – Input Capture 3	15	13	IFS0<15>	IEC0<15>	IPC3<12:10>	IPC3<9:8>	Yes
IC3 – Input Capture 3	16	13	IFS0<16>	IEC0<16>	IPC3<12:10>	IPC3<9:8>	Yes
OC3 – Output Compare 3	17	14	IFS0<17>	IEC0<17>	IPC3<20:18>	IPC3<17:16>	No
INT3 – External Interrupt 3	18	15	IFS0<18>	IEC0<18>	IPC3<28:26>	IPC3<25:24>	No
T4 – Timer4	19	16	IFS0<19>	IEC0<19>	IPC4<4:2>	IPC4<1:0>	No
IC4E – Input Capture 4 Error	20	17	IFS0<20>	IEC0<20>	IPC4<12:10>	IPC4<9:8>	Yes
IC4 – Input Capture 4	21	17	IFS0<21>	IEC0<21>	IPC4<12:10>	IPC4<9:8>	Yes
OC4 – Output Compare 4	22	18	IFS0<22>	IEC0<22>	IPC4<20:18>	IPC4<17:16>	No
INT4 – External Interrupt 4	23	19	IFS0<23>	IEC0<23>	IPC4<28:26>	IPC4<25:24>	No
T5 – Timer5	24	20	IFS0<24>	IEC0<24>	IPC5<4:2>	IPC5<1:0>	No
IC5E – Input Capture 5 Error	25	21	IFS0<25>	IEC0<25>	IPC5<12:10>	IPC5<9:8>	Yes
IC5 – Input Capture 5	26	21	IFS0<26>	IEC0<26>	IPC5<12:10>	IPC5<9:8>	Yes
OC5 – Output Compare 5	27	22	IFS0<27>	IEC0<27>	IPC5<20:18>	IPC5<17:16>	No
AD1 – ADC1 Convert done	28	23	IFS0<28>	IEC0<28>	IPC5<28:26>	IPC5<25:24>	Yes
FSCM – Fail-Safe Clock Monitor	29	24	IFS0<29>	IEC0<29>	IPC6<4:2>	IPC6<1:0>	No
RTCC – Real-Time Clock and Calendar	30	25	IFS0<30>	IEC0<30>	IPC6<12:10>	IPC6<9:8>	No
FCE – Flash Control Event	31	26	IFS0<31>	IEC0<31>	IPC6<20:18>	IPC6<17:16>	No
CMP1 – Comparator Interrupt	32	27	IFS1<0>	IEC1<0>	IPC6<28:26>	IPC6<25:24>	No
CMP2 – Comparator Interrupt	33	28	IFS1<1>	IEC1<1>	IPC7<4:2>	IPC7<1:0>	No
CMP3 – Comparator Interrupt	34	29	IFS1<2>	IEC1<2>	IPC7<12:10>	IPC7<9:8>	No
USB – USB Interrupts	35	30	IFS1<3>	IEC1<3>	IPC7<20:18>	IPC7<17:16>	Yes
SPI1E – SPI1 Fault	36	31	IFS1<4>	IEC1<4>	IPC7<28:26>	IPC7<25:24>	Yes
SPI1RX – SPI1 Receive Done	37	31	IFS1<5>	IEC1<5>	IPC7<28:26>	IPC7<25:24>	Yes
SPI1TX – SPI1 Transfer Done	38	31	IFS1<6>	IEC1<6>	IPC7<28:26>	IPC7<25:24>	Yes

TABLE 7-1: INTERRUPT IRQ, VECTOR AND BIT LOCATION

Note 1: Not all interrupt sources are available on all devices. See TABLE 1: "PIC32MX1XX 28/36/44-Pin General Purpose Family Features" and TABLE 2: "PIC32MX2XX 28/36/44-pin USB Family Features" for the lists of available peripherals.

Interrupt Source ⁽¹⁾	IRQ	Vector		Interru	pt Bit Location		Persistent
Interrupt Source."	#	#	Flag	Enable	Priority	Sub-priority	Interrupt
U1E – UART1 Fault	39	32	IFS1<7>	IEC1<7>	IPC8<4:2>	IPC8<1:0>	Yes
U1RX – UART1 Receive Done	40	32	IFS1<8>	IEC1<8>	IPC8<4:2>	IPC8<1:0>	Yes
U1TX – UART1 Transfer Done	41	32	IFS1<9>	IEC1<9>	IPC8<4:2>	IPC8<1:0>	Yes
I2C1B – I2C1 Bus Collision Event	42	33	IFS1<10>	IEC1<10>	IPC8<12:10>	IPC8<9:8>	Yes
I2C1S – I2C1 Slave Event	43	33	IFS1<11>	IEC1<11>	IPC8<12:10>	IPC8<9:8>	Yes
I2C1M – I2C1 Master Event	44	33	IFS1<12>	IEC1<12>	IPC8<12:10>	IPC8<9:8>	Yes
CNA – PORTA Input Change Interrupt	45	34	IFS1<13>	IEC1<13>	IPC8<20:18>	IPC8<17:16>	Yes
CNB – PORTB Input Change Interrupt	46	34	IFS1<14>	IEC1<14>	IPC8<20:18>	IPC8<17:16>	Yes
CNC – PORTC Input Change Interrupt	47	34	IFS1<15>	IEC1<15>	IPC8<20:18>	IPC8<17:16>	Yes
PMP – Parallel Master Port	48	35	IFS1<16>	IEC1<16>	IPC8<28:26>	IPC8<25:24>	Yes
PMPE – Parallel Master Port Error	49	35	IFS1<17>	IEC1<17>	IPC8<28:26>	IPC8<25:24>	Yes
SPI2E – SPI2 Fault	50	36	IFS1<18>	IEC1<18>	IPC9<4:2>	IPC9<1:0>	Yes
SPI2RX – SPI2 Receive Done	51	36	IFS1<19>	IEC1<19>	IPC9<4:2>	IPC9<1:0>	Yes
SPI2TX – SPI2 Transfer Done	52	36	IFS1<20>	IEC1<20>	IPC9<4:2>	IPC9<1:0>	Yes
U2E – UART2 Error	53	37	IFS1<21>	IEC1<21>	IPC9<12:10>	IPC9<9:8>	Yes
U2RX – UART2 Receiver	54	37	IFS1<22>	IEC1<22>	IPC9<12:10>	IPC9<9:8>	Yes
U2TX – UART2 Transmitter	55	37	IFS1<23>	IEC1<23>	IPC9<12:10>	IPC9<9:8>	Yes
I2C2B – I2C2 Bus Collision Event	56	38	IFS1<24>	IEC1<24>	IPC9<20:18>	IPC9<17:16>	Yes
I2C2S – I2C2 Slave Event	57	38	IFS1<25>	IEC1<25>	IPC9<20:18>	IPC9<17:16>	Yes
I2C2M – I2C2 Master Event	58	38	IFS1<26>	IEC1<26>	IPC9<20:18>	IPC9<17:16>	Yes
CTMU – CTMU Event	59	39	IFS1<27>	IEC1<27>	IPC9<28:26>	IPC9<25:24>	Yes
DMA0 – DMA Channel 0	60	40	IFS1<28>	IEC1<28>	IPC10<4:2>	IPC10<1:0>	No
DMA1 – DMA Channel 1	61	41	IFS1<29>	IEC1<29>	IPC10<12:10>	IPC10<9:8>	No
DMA2 – DMA Channel 2	62	42	IFS1<30>	IEC1<30>	IPC10<20:18>	IPC10<17:16>	No
DMA3 – DMA Channel 3	63	43	IFS1<31>	IEC1<31>	IPC10<28:26>	IPC10<25:24>	No
		Lowes	t Natural O	rder Priority			

TABLE 7-1: INTERRUPT IRQ, VECTOR AND BIT LOCATION (CONTINUED)

Note 1: Not all interrupt sources are available on all devices. See TABLE 1: "PIC32MX1XX 28/36/44-Pin General Purpose Family Features" and TABLE 2: "PIC32MX2XX 28/36/44-pin USB Family Features" for the lists of available peripherals.

Interrupt Control Registers 7.1

TABLE 7-2: **INTERRUPT REGISTER MAP**

ess (n								Bits					
Virtual Address (BF88_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	
1000	INTCON	31:16	_		_		—	—	—	—	—	—	_	_	
1000	INTCOM	15:0	_	_	—	MVEC	—		TPC<2:0>			_	—	INT4E	
1010	INTSTAT ⁽³⁾	31:16	_		—		—	—	—	—	—	—	—		
1010	INTSTAL	15:0	_	—	—	_	—		SRIPL<2:0>			—			
1020	IPTMR	31:16 15:0					IPTMR<31:0>								
1000	1500	31:16	FCEIF	RTCCIF	FSCMIF	AD1IF	OC5IF	IC5IF	IC5EIF	T5IF	INT4IF	OC4IF	IC4IF	IC4EIF	
1030	IFS0	15:0	IC3EIF	T3IF	INT2IF	OC2IF	IC2IF	IC2EIF	T2IF	INT1IF	OC1IF	IC1IF	IC1EIF	T1IF	
1010	1504	31:16	DMA3IF	DMA2IF	DMA1IF	DMA0IF	CTMUIF	I2C2MIF	I2C2SIF	I2C2BIF	U2TXIF	U2RXIF	U2EIF	SPI2TX	
1040	IFS1	15:0	CNCIF	CNBIF	CNAIF	I2C1MIF	I2C1SIF	I2C1BIF	U1TXIF	U1RXIF	U1EIF	SPI1TXIF	SPI1RXIF	SPI1EI	
1060	IEC0	31:16	FCEIE	RTCCIE	FSCMIE	AD1IE	OC5IE	IC5IE	IC5EIE	T5IE	INT4IE	OC4IE	IC4IE	IC4EIE	
1000	IECU	15:0	IC3EIE	T3IE	INT2IE	OC2IE	IC2IE	IC2EIE	T2IE	INT1IE	OC1IE	IC1IE	IC1EIE	T1IE	
1070	IEC1	31:16	DMA3IE	DMA2IE	DMA1IE	DMA0IE	CTMUIE	I2C2MIE	I2C2SIE	I2C2BIE	U2TXIE	U2RXIE	U2EIE	SPI2TX	
1070	ILC1	15:0	CNCIE	CNBIE	CNAIE	I2C1MIE	I2C1SIE	I2C1BIE	U1TXIE	U1RXIE	U1EIE	SPI1TXIE	SPI1RXIE	SPI1EI	
1090	IPC0	31:16	—	_	—		INT0IP<2:0>		INTOIS	S<1:0>	—	—	—		
1030	11 00	15:0	—	_	—		CS0IP<2:0>		CSOIS	<1:0>		_	_		
10A0	IPC1	31:16	—	—	—		INT1IP<2:0>		INT1IS	S<1:0>	—	—	—		
10/10		15:0	—	—	—		IC1IP<2:0>		IC1IS	<1:0>	—	—	—		
10B0	IPC2	31:16	—	_	—		INT2IP<2:0>		INT2IS	S<1:0>		_	—		
IODO	11 02	15:0	—	—	—		IC2IP<2:0>		IC2IS	<1:0>	—	—	—		
10C0	IPC3	31:16	—	—	—		INT3IP<2:0>		INT3IS	S<1:0>	—	—	—		
1000	IF 03	15:0	—	_	—		IC3IP<2:0>		IC3IS	<1:0>		_	—		
10D0	IPC4	31:16	—	_	—	INT4IP<2:0>			INT4IS<1:0>			_	—		
IODO	11 04	15:0	—	_	—	IC4IP<2:0>		IC4IS	<1:0>	_	—	—			
10E0	IPC5	31:16	_	_	_		AD1IP<2:0>		AD1IS	<1:0>	_	_	—		
1020	1 00	15:0	_	_	_		IC5IP<2:0>			<1:0>	—	-	—		
10F0	IPC6	31:16	—	_	—	(CMP1IP<2:0	>	CMP1I	S<1:0>	_		_		
101.0	IF CO	15:0	_	—	—	F	RTCCIP<2:0	>	RTCCI	S<1:0>	—	—	_		

Legend:

x = unknown value on Reset; --- = unimplemented, read as '0'. Reset values are shown in hexadecimal.

With the exception of those noted, all registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4 0x SET and INV Registers" for more information. These bits are not available on PIC32MX1XX devices. This register does not have associated CLR, SET, INV registers. Note 1:

2:

3:

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28/12

27/11

SPI1IP<2:0>

CMP3IP<2:0>

PMPIP<2:0>

DMA1IP<2:0>

26/10

25/9

SPI1IS<1:0>

CMP3IS<1:0>

PMPIS<1:0>

DMA1IS<1:0>

INTERRUPT REGISTER MAP (CONTINUED)

29/13

1130

TABLE 7-2:

Register Name⁽¹⁾

IPC7

IPC8

IPC10

Bit Range

31:16

15:0

31:16

15:0

31/15

30/14

Virtual Address (BF88_#)

1100

1110

Legend: x = unknown value on Reset; - = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: With the exception of those noted, all registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4 0x SET and INV Registers" for more information.

Bits

23/7

22/6

_

21/5

_

20/4

24/8

2: These bits are not available on PIC32MX1XX devices.

3: This register does not have associated CLR, SET, INV registers.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	_	_	_	—	_	—		_
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	—	_	—	_	_	—	—	—
45.0	U-0	U-0	U-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
15:8	—	_	—	MVEC	—		TPC<2:0>	
7:0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
7:0	_	_		INT4EP	INT3EP	INT2EP	INT1EP	INT0EP

REGISTER 7-1: INTCON: INTERRUPT CONTROL REGISTER

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'				
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

bit 31-16 Unimplemented: Read as '0'

bit 15-13 Unimplemented: Read as '0'

- bit 12 MVEC: Multi Vector Configuration bit
 - 1 = Interrupt controller configured for Multi-vectored mode
 - 0 = Interrupt controller configured for Single-vectored mode

bit 11 Unimplemented: Read as '0'

- bit 10-8 **TPC<2:0>:** Interrupt Proximity Timer Control bits
 - 111 = Interrupts of group priority 7 or lower start the Interrupt Proximity timer
 - 110 = Interrupts of group priority 6 or lower start the Interrupt Proximity timer
 - 101 = Interrupts of group priority 5 or lower start the Interrupt Proximity timer
 - 100 = Interrupts of group priority 4 or lower start the Interrupt Proximity timer
 - 011 = Interrupts of group priority 3 or lower start the Interrupt Proximity timer
 - 010 = Interrupts of group priority 2 or lower start the Interrupt Proximity timer
 - 001 = Interrupts of group priority 1 start the Interrupt Proximity timer
 - 000 = Disables Interrupt Proximity timer

bit 7-5 Unimplemented: Read as '0'

- bit 4 INT4EP: External Interrupt 4 Edge Polarity Control bit
 - 1 = Rising edge

0 = Falling edge

- bit 3 INT3EP: External Interrupt 3 Edge Polarity Control bit
 - 1 = Rising edge
 - 0 = Falling edge
- bit 2 INT2EP: External Interrupt 2 Edge Polarity Control bit
 - 1 = Rising edge
 - 0 = Falling edge
- bit 1 INT1EP: External Interrupt 1 Edge Polarity Control bit
 - 1 = Rising edge
 - 0 = Falling edge
- bit 0 INTOEP: External Interrupt 0 Edge Polarity Control bit
 - 1 = Rising edge
 - 0 = Falling edge

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
21.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24		_						_
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	—	_		—	_	_	—	—
45.0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
15:8	_	—	—	—	_	S	RIPL<2:0>(1)	
7.0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
7:0	_				VEC	<5:0>(1)		

REGISTER 7-2: INTSTAT: INTERRUPT STATUS REGISTER

Legend:

0			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-11 Unimplemented: Read as '0'

- bit 10-8 SRIPL<2:0>: Requested Priority Level bits⁽¹⁾ 111-000 = The priority level of the latest interrupt presented to the CPU
- bit 7-6 **Unimplemented:** Read as '0'
- bit 5-0 VEC<5:0>: Interrupt Vector bits⁽¹⁾ 11111-00000 = The interrupt vector that is presented to the CPU
- **Note 1:** This value should only be used when the interrupt controller is configured for Single Vector mode.

REGISTER 7-3: IPTMR: INTERRUPT PROXIMITY TIMER REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
04.04	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
31:24		IPTMR<31:24>							
00.40	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
23:16	IPTMR<23:16>								
45.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
15:8	IPTMR<15:8>								
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
7:0	IPTMR<7:0>								

Legend:

Legend.				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 31-0 **IPTMR<31:0>:** Interrupt Proximity Timer Reload bits Used by the Interrupt Proximity Timer as a reload value when the Interrupt Proximity timer is triggered by an interrupt event.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
31:24	IFS31	IFS30	IFS29	IFS28	IFS27	IFS26	IFS25	IFS24
23:16	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
23.10	IFS23	IFS22	IFS21	IFS20	IFS19	IFS18	IFS17	IFS16
15:8	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
10.0	IFS15	IFS14	IFS13	IFS12	IFS11	IFS10	IFS09	IFS08
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	IFS07	IFS06	IFS05	IFS04	IFS03	IFS02	IFS01	IFS00

REGISTER 7-4: IFSx: INTERRUPT FLAG STATUS REGISTER

Legend:

Logonan				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 31-0 IFS31-IFS00: Interrupt Flag Status bits

1 = Interrupt request has occurred

0 = No interrupt request has occurred

Note: This register represents a generic definition of the IFSx register. Refer to Table 7-1 for the exact bit definitions.

REGISTER 7-5: IECx: INTERRUPT ENABLE CONTROL REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.04	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
31:24	IEC31	IEC30	IEC29	IEC28	IEC27	IEC26	IEC25	IEC24
23:16	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
23.10	IEC23	IEC22	IEC21	IEC20	IEC19	IEC18	IEC17	IEC16
15.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
15:8	IEC15	IEC14	IEC13	IEC12	IEC11	IEC10	IEC09	IEC08
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	IEC07	IEC06	IEC05	IEC04	IEC03	IEC02	IEC01	IEC00

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-0 IEC31-IEC00: Interrupt Enable bits

1 = Interrupt is enabled

0 = Interrupt is disabled

Note: This register represents a generic definition of the IECx register. Refer to Table 7-1 for the exact bit definitions.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0		
24.04	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
31:24	—	_	—		IP03<2:0>	IS03	IS03<1:0>			
23:16	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
25.10	—	_	—		IP02<2:0>	IS02	IS02<1:0>			
15:8	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
15.0	_	_	_		IP01<2:0>		IS01<1:0>			
7:0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
7.0			_	IP00<2:0>			IS00·	IS00<1:0>		

REGISTER 7-6: IPCx: INTERRUPT PRIORITY CONTROL REGISTER

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-29 Unimplemented: Read as '0'

bit 28-26 IP03<2:0>: Interrupt Priority bits 111 = Interrupt priority is 7 • 010 = Interrupt priority is 2 001 = Interrupt priority is 1 000 = Interrupt is disabled bit 25-24 IS03<1:0>: Interrupt Subpriority bits 11 = Interrupt subpriority is 3 10 = Interrupt subpriority is 2 01 = Interrupt subpriority is 1 00 = Interrupt subpriority is 0 bit 23-21 Unimplemented: Read as '0' bit 20-18 IP02<2:0>: Interrupt Priority bits 111 = Interrupt priority is 7 010 = Interrupt priority is 2 001 = Interrupt priority is 1 000 = Interrupt is disabled bit 17-16 IS02<1:0>: Interrupt Subpriority bits 11 = Interrupt subpriority is 3 10 = Interrupt subpriority is 2 01 = Interrupt subpriority is 1 00 = Interrupt subpriority is 0 bit 15-13 Unimplemented: Read as '0' bit 12-10 IP01<2:0>: Interrupt Priority bits 111 = Interrupt priority is 7 010 = Interrupt priority is 2 001 = Interrupt priority is 1 000 = Interrupt is disabled

This register represents a generic definition of the IPCx register. Refer to Table 7-1 for the exact bit Note: definitions.

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REGIST	ER 7-6: IPCx: INTERRUPT PRIORITY CONTROL REGISTER (CONTINUED)								
bit 9-8	IS01<1:0>: Interrupt Subpriority bits								
	11 = Interrupt subpriority is 3								
	10 = Interrupt subpriority is 2								
	01 = Interrupt subpriority is 1								
	00 = Interrupt subpriority is 0								
bit 7-5	Unimplemented: Read as '0'								
bit 4-2	IP00<2:0>: Interrupt Priority bits								
	111 = Interrupt priority is 7								
	•								
	010 = Interrupt priority is 2								
	001 = Interrupt priority is 1								
	000 = Interrupt is disabled								
bit 1-0	IS00<1:0>: Interrupt Subpriority bits								
	11 = Interrupt subpriority is 3								
	10 = Interrupt subpriority is 2								
	01 = Interrupt subpriority is 1								
	00 = Interrupt subpriority is 0								
Note:	This register represents a generic definition of the IPCx register. Refer to Table 7-1 for the exact bit								
	definitions.								

8.0 OSCILLATOR CONFIGURATION

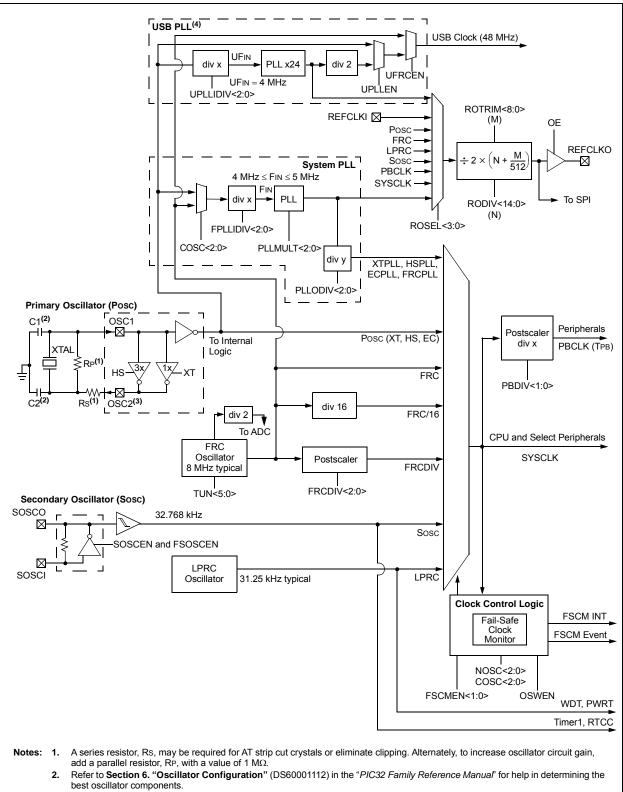
Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 6. "Oscillator Configuration" (DS60001112), which is available from the Documentation > Reference Manual section of the PIC32 Microchip web site (www.microchip.com/pic32).

The PIC32MX1XX/2XX 28/36/44-pin Family oscillator system has the following modules and features:

- Four external and internal oscillator options as clock sources
- On-Chip PLL with user-selectable input divider, multiplier and output divider to boost operating frequency on select internal and external oscillator sources
- On-Chip user-selectable divisor postscaler on select oscillator sources
- Software-controllable switching between various clock sources
- A Fail-Safe Clock Monitor (FSCM) that detects clock failure and permits safe application recovery or shutdown
- · Dedicated On-Chip PLL for USB peripheral

A block diagram of the oscillator system is provided in Figure 8-1.

FIGURE 8-1: OSCILLATOR DIAGRAM



- 3. The PBCLK out is only available on the OSC2 pin in certain clock modes.
- 4. The USB PLL is only available on PIC32MX2XX devices.

8.1 **Oscillator Control Regiters**

TABLE 8-1: **OSCILLATOR CONTROL REGISTER MAP**

ess		a)		Bits											
Virtual Address (BF80_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19
F000	F000 OSCCON 31:16			—	P	LLODIV<2:0)>	F	RCDIV<2:0)>	—	SOSCRDY	PBDIVRDY	PBDI	/<1:0
F000	USCCON	15:0	_	- COSC<2:0> -				NOSC<2:0> CLKLOCK			ULOCK ⁽³⁾	SLOCK	SLPEN	C	
F010	OSCTUN	31:16		-	_	_	_	_	_	_	—	_	—	-	1
FUIU	USCIUN	15:0		-	_	_	_	_	_	_	—	_			
	DEFOOD	31:16									RODIV<1	4:0>			
F020	REFOCON	15:0	ON	—	SIDL	OE	RSLP	—	DIVSWEN	ACTIVE	—	—	—	—	
5000	REFOTRIM	31:16				R	OTRIM<8:)>				_	_	_	-
F030	REFUTRIM	15:0	_	_	_	_	_	_	_	_	—	_	_	_	_
Legen	l d: x = u	Inknowi	n value on	n Reset; –	- = unimple	mented, rea	d as '0'. Re	set values	are shown	in hexade	cimal.				

All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See more information. Note 1:

2: Reset values are dependent on the DEVCFGx Configuration bits and the type of reset.

3: This bit is only available on PIC32MX2XX devices.

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Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
31:24	U-0	U-0	R/W-y	R/W-y	R/W-y	R/W-0	R/W-0	R/W-1	
	_	—	Р	LLODIV<2:0>	>	F	RCDIV<2:0>		
00.40	U-0	R-0	R-1	R/W-y	R/W-y	R/W-y	R/W-y	R/W-y	
23:16	—	SOSCRDY	PBDIVRDY	PBDI∖	/<1:0>	Р	LLMULT<2:0>	R/W-1	
45.0	U-0	R-0	R-0	R-0	U-0	R/W-y	R/W-y	R/W-y	
15:8	—		COSC<2:0>		—		NOSC<2:0>		
7.0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-y	R/W-0	
7:0	CLKLOCK	ULOCK ⁽¹⁾	SLOCK	SLPEN	CF	UFRCEN ⁽¹⁾	SOSCEN	OSWEN	

REGISTER 8-1: OSCCON: OSCILLATOR CONTROL REGISTER

Legend:	y = Value set from Config	juration bits on POR	
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-30 Unimplemented: Read as '0'

bit 29-27 **PLLODIV<2:0>:** Output Divider for PLL

- 111 = PLL output divided by 256
- 110 = PLL output divided by 64
- 101 = PLL output divided by 32
- 100 = PLL output divided by 16
- 011 = PLL output divided by 8
- 010 = PLL output divided by 4
- 001 = PLL output divided by 2
- 000 = PLL output divided by 1

bit 26-24 FRCDIV<2:0>: Internal Fast RC (FRC) Oscillator Clock Divider bits

- 111 = FRC divided by 256
- 110 = FRC divided by 64
- 101 = FRC divided by 32
- 100 = FRC divided by 16
- 011 = FRC divided by 8
- 010 = FRC divided by 4
- 001 = FRC divided by 2 (default setting)
- 000 = FRC divided by 1
- bit 23 Unimplemented: Read as '0'

bit 22 SOSCRDY: Secondary Oscillator (Sosc) Ready Indicator bit

- 1 = The Secondary Oscillator is running and is stable
 - 0 = The Secondary Oscillator is still warming up or is turned off
- bit 21 **PBDIVRDY:** Peripheral Bus Clock (PBCLK) Divisor Ready bit
 - 1 = PBDIV<1:0> bits can be written
 - 0 = PBDIV<1:0> bits cannot be written
- bit 20-19 **PBDIV<1:0>:** Peripheral Bus Clock (PBCLK) Divisor bits
 - 11 = PBCLK is SYSCLK divided by 8 (default)
 - 10 = PBCLK is SYSCLK divided by 4
 - 01 = PBCLK is SYSCLK divided by 2
 - 00 = PBCLK is SYSCLK divided by 1

Note 1: This bit is only available on PIC32MX2XX devices.

REGISTER 8-1: OSCCON: OSCILLATOR CONTROL REGISTER

bit 18-16 PLLMULT<2:0>: Phase-Locked Loop (PLL) Multiplier bits

- 111 = Clock is multiplied by 24
- 110 = Clock is multiplied by 21
- 101 = Clock is multiplied by 20
- 100 = Clock is multiplied by 19
- 011 =Clock is multiplied by 18
- 010 =Clock is multiplied by 17
- 001 =Clock is multiplied by 16
- 000 = Clock is multiplied by 15
- bit 15 Unimplemented: Read as '0'
- bit 14-12 COSC<2:0>: Current Oscillator Selection bits
 - 111 = Internal Fast RC (FRC) Oscillator divided by FRCDIV<2:0> bits (OSCCON<26:24>)
 - 110 = Internal Fast RC (FRC) Oscillator divided by 16
 - 101 = Internal Low-Power RC (LPRC) Oscillator
 - 100 = Secondary Oscillator (Sosc)
 - 011 = Primary Oscillator (Posc) with PLL module (XTPLL, HSPLL or ECPLL)
 - 010 = Primary Oscillator (Posc) (XT, HS or EC)
 - 001 = Internal Fast RC Oscillator with PLL module via Postscaler (FRCPLL)
 - 000 = Internal Fast RC (FRC) Oscillator
- bit 11 Unimplemented: Read as '0'
- bit 10-8 NOSC<2:0>: New Oscillator Selection bits
 - 111 = Internal Fast RC Oscillator (FRC) divided by OSCCON<FRCDIV> bits
 - 110 = Internal Fast RC Oscillator (FRC) divided by 16
 - 101 = Internal Low-Power RC (LPRC) Oscillator
 - 100 = Secondary Oscillator (Sosc)
 - 011 = Primary Oscillator with PLL module (XTPLL, HSPLL or ECPLL)
 - 010 = Primary Oscillator (XT, HS or EC)
 - 001 = Internal Fast Internal RC Oscillator with PLL module via Postscaler (FRCPLL)
 - 000 = Internal Fast Internal RC Oscillator (FRC)

On Reset, these bits are set to the value of the FNOSC Configuration bits (DEVCFG1<2:0>).

- bit 7 CLKLOCK: Clock Selection Lock Enable bit
 - If clock switching and monitoring is disabled (FCKSM<1:0> = 1x):
 - 1 = Clock and PLL selections are locked
 - 0 = Clock and PLL selections are not locked and may be modified

If clock switching and monitoring is enabled (FCKSM<1:0> = 0x): Clock and PLL selections are never locked and may be modified.

- bit 6 ULOCK: USB PLL Lock Status bit⁽¹⁾
 - 1 = The USB PLL module is in lock or USB PLL module start-up timer is satisfied
 - 0 =The USB PLL module is out of lock or USB PLL module start-up timer is in progress or the USB PLL is disabled
- bit 5 SLOCK: PLL Lock Status bit
 - 1 = The PLL module is in lock or PLL module start-up timer is satisfied
 - 0 = The PLL module is out of lock, the PLL start-up timer is running, or the PLL is disabled
- bit 4 **SLPEN:** Sleep Mode Enable bit
 - 1 = The device will enter Sleep mode when a WAIT instruction is executed
 - 0 = The device will enter Idle mode when a WAIT instruction is executed
- **Note 1:** This bit is only available on PIC32MX2XX devices.

REGISTER 8-1: OSCCON: OSCILLATOR CONTROL REGISTER

bit 3	CF: Clock Fail Detect bit
	1 = FSCM has detected a clock failure
	0 = No clock failure has been detected
bit 2	UFRCEN: USB FRC Clock Enable bit ⁽¹⁾
	1 = Enable the FRC as the clock source for the USB clock source
	0 = Use the Primary Oscillator or USB PLL as the USB clock source
bit 1	SOSCEN: Secondary Oscillator (Sosc) Enable bit
	1 = Enable the Secondary Oscillator
	0 = Disable the Secondary Oscillator
bit 0	OSWEN: Oscillator Switch Enable bit
	1 = Initiate an oscillator switch to selection specified by NOSC<2:0> bits
	0 = Oscillator switch is complete

Note 1: This bit is only available on PIC32MX2XX devices.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.04	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	-	_	_	-	_	-	-	—
00.40	U-0	R-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	—	_	_	_	_	_	_	—
45.0	U-0	R-0	U-0	U-0	U-0	U-0	U-0	U-0
15:8	—	_	_	_	_	_	_	_
7.0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
7:0					TUN<	5:0> ⁽¹⁾		

REGISTER 8-2: OSCTUN: FRC TUNING REGISTER

Legend:

bit 5-0

0			
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-6 Unimplemented: Read as '0'

Note 1: OSCTUN functionality has been provided to help customers compensate for temperature effects on the FRC frequency over a wide range of temperatures. The tuning step size is an approximation, and is neither characterized, nor tested.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0		
	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
31:24	— RODIV<14:8> ^(1,3)									
00.40	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
23:16	RODIV<7:0> ^(1,3)									
45.0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0, HC	R-0, HS, HC		
15:8	ON	_	SIDL	OE	RSLP ⁽²⁾		DIVSWEN	ACTIVE		
7.0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0		
7:0	_	_	_	_		ROSEL	<3:0> ⁽¹⁾			

REGISTER 8-3: REFOCON: REFERENCE OSCILLATOR CONTROL REGISTER

Legend:	HC = Hardware Clearable	HS = Hardware Settable	
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

- bit 31 Unimplemented: Read as '0'
- bit 30-16 **RODIV<14:0>** Reference Clock Divider bits^(1,3)
 - The value selects the reference clock divider bits. See Figure 8-1 for information.
- bit 15 **ON:** Output Enable bit
 - 1 = Reference Oscillator module is enabled
 - 0 = Reference Oscillator module is disabled
- bit 14 Unimplemented: Read as '0'
- bit 13 **SIDL:** Peripheral Stop in Idle Mode bit
 - 1 = Discontinue module operation when the device enters Idle mode
 - 0 = Continue module operation when the device enters Idle mode
- bit 12 **OE:** Reference Clock Output Enable bit
 - 1 = Reference clock is driven out on REFCLKO pin
 - 0 = Reference clock is not driven out on REFCLKO pin
- bit 11 **RSLP:** Reference Oscillator Module Run in Sleep bit⁽²⁾
 - 1 = Reference Oscillator module output continues to run in Sleep
 - 0 = Reference Oscillator module output is disabled in Sleep
- bit 10 Unimplemented: Read as '0'
- bit 9 DIVSWEN: Divider Switch Enable bit
 - 1 = Divider switch is in progress
 - 0 = Divider switch is complete
- bit 8 ACTIVE: Reference Clock Request Status bit
 - 1 = Reference clock request is active
 - 0 = Reference clock request is not active
- bit 7-4 Unimplemented: Read as '0'
- **Note 1:** The ROSEL and RODIV bits should not be written while the ACTIVE bit is '1', as undefined behavior may result.
 - **2:** This bit is ignored when the ROSEL<3:0> bits = 0000 or 0001.
 - 3: While the ON bit is set to '1', writes to these bits do not take effect until the DIVSWEN bit is also set to '1'.

REGISTER 8-3: REFOCON: REFERENCE OSCILLATOR CONTROL REGISTER

- bit 3-0 ROSEL<3:0>: Reference Clock Source Select bits⁽¹⁾
 - 1111 = Reserved; do not use

•

- • 1001 = Reserved; do not use 1000 = REFCLKI 0111 = System PLL output 0101 = USB PLL output 0101 = Sosc 0100 = LPRC 0011 = FRC 0010 = Posc 0001 = PBCLK 0000 = SYSCLK
- **Note 1:** The ROSEL and RODIV bits should not be written while the ACTIVE bit is '1', as undefined behavior may result.
 - 2: This bit is ignored when the ROSEL<3:0> bits = 0000 or 0001.
 - 3: While the ON bit is set to '1', writes to these bits do not take effect until the DIVSWEN bit is also set to '1'.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0		
04.04	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
31:24	ROTRIM<8:1>									
00.40	R/W-0	R-0	U-0	U-0	U-0	U-0	U-0	U-0		
23:16	ROTRIM<0>	_	—	_	—	_	—	—		
15:8	U-0	R-0	U-0	U-0	U-0	U-0	U-0	U-0		
10.0	_	-	—	-	—	-	-	—		
7.0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
7:0		_		_		_	_	—		

REGISTER 8-4: REFOTRIM: REFERENCE OSCILLATOR TRIM REGISTER

Legend:

bit 22-0

R = Readable bit	W = Writable bit	U = Unimplemented bit, r	ead as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 31-23 ROTRIM<8:0>: Reference Oscillator Trim bits

Note: While the ON (REFOCON<15>) bit is '1', writes to this register do not take effect until the DIVSWEN bit is also set to '1'.

9.0 DIRECT MEMORY ACCESS (DMA) CONTROLLER

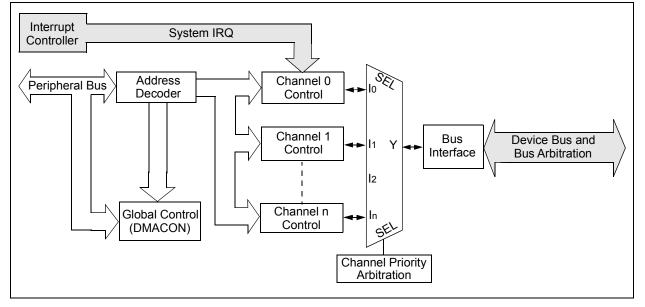
Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 31. "Direct Memory Access (DMA) Controller" (DS60001117), which is available from the Documentation > Reference Manual section of the Microchip PIC32 web site (www.microchip.com/pic32).

The PIC32 Direct Memory Access (DMA) controller is a bus master module useful for data transfers between different devices without CPU intervention. The source and destination of a DMA transfer can be any of the memory mapped modules existent in the PIC32, such as Peripheral Bus devices: SPI, UART, PMP, etc., or memory itself. Figure 9-1 show a block diagram of the DMA Controller module.

The DMA Controller module has the following key features:

- Four identical channels, each featuring:
 - Auto-increment source and destination address registers
 - Source and destination pointers
 - Memory to memory and memory to peripheral transfers
- · Automatic word-size detection:
 - Transfer granularity, down to byte level
 - Bytes need not be word-aligned at source and destination
- FIGURE 9-1: DMA BLOCK DIAGRAM

- Fixed priority channel arbitration
- Flexible DMA channel operating modes:
- Manual (software) or automatic (interrupt) DMA requests
- One-Shot or Auto-Repeat Block Transfer modes
- Channel-to-channel chaining
- Flexible DMA requests:
 - A DMA request can be selected from any of the peripheral interrupt sources
 - Each channel can select any (appropriate) observable interrupt as its DMA request source
 - A DMA transfer abort can be selected from any of the peripheral interrupt sources
 - Pattern (data) match transfer termination
- Multiple DMA channel status interrupts:
 - DMA channel block transfer complete
 - Source empty or half empty
 - Destination full or half full
 - DMA transfer aborted due to an external event
 - Invalid DMA address generated
- DMA debug support features:
 - Most recent address accessed by a DMA channel
 - Most recent DMA channel to transfer data
- · CRC Generation module:
 - CRC module can be assigned to any of the available channels
 - CRC module is highly configurable



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9.1 DMA Control Registers

TABLE 9-1: DMA GLOBAL REGISTER MAP

			Bits											
Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	
DMACON	31:16	_	_	—	-	-	_	—	—	-	_	—	—	
DIVIACON	15:0	ON	_	_	SUSPEND	DMABUSY	_	_	_	_	_	—	_	
	31:16	_	_	_	_	—	_	_	_	_	_	—	_	
DIVIASTAT	15:0	_	_	_	_	—	_	_	_	_	_	—	—	
3020 DMAADDR 31:16 15:0 DMAADDR<31:0>														
	DMACON DMASTAT	Image: margin base of the second se		B 31/15 30/14 DMACON 31:16 — — DMASTAT 15:0 ON — DMASTAT 31:16 — — DMAADDB 31:16 — —	월 2 描 31/15 30/14 29/13 DMACON 31:16 — — — DMASTAT 31:16 — — — DMASTAT 31:16 — — — DMAADDB 31:16 — — —			<u> <u> </u></u>	²	bring bring 31/15 30/14 29/13 28/12 27/11 26/10 25/9 24/8 DMACON 31:16 -	bring 31/15 30/14 29/13 28/12 27/11 26/10 25/9 24/8 23/7 DMACON 31:16 -	bring bring 31/15 30/14 29/13 28/12 27/11 26/10 25/9 24/8 23/7 22/6 DMACON 31:16 -	bring bring 31/15 30/14 29/13 28/12 27/11 26/10 25/9 24/8 23/7 22/6 21/5 DMACON 31:16 -	

Note 1: All registers in this table have corresponding CLR, SET and INV registers at its virtual address, plus an offset of 0x4, 0x8 and 0xC, respectively. See Sec information.

TABLE 9-2: DMA CRC REGISTER MAP

	0						Bits Bits							
Register Name ⁽¹⁾	Bit Rang	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	
DCBCCON	31:16	_	—	BYTO)<1:0>	WBO	_	—	BITO	—	—	_	_	
DURUUUN	15:0	—	—	_			PLEN<4:0>			CRCEN	CRCAPP	CRCTYP	—	
DCRCDATA	31:16 15:0		DCRCDATA<31:0>											
DCRCXOR	31:16 15:0	DCRCXOR<31:0>												
	DCRCCON DCRCDATA	DCRCCON 31:16 15:0 DCRCDATA 31:16 15:0 0 0 0 0 0 0 0 15:0	2 # 31/15 DCRCCON 31:16 15:0 DCRCDATA 31:16 DCRCXOR 31:16	문법 31/15 30/14 DCRCCON 31:16 — — 15:0 — — — DCRCDATA 31:16 — — DCRCXOR 31:16 — —	2 31/15 30/14 29/13 DCRCCON 31:16 — — BYTC 15:0 — — — — DCRCDATA 31:16 — — — DCRCXOR 31:16	22 31/15 30/14 29/13 28/12 DCRCCON 31:16 — — BYTO<1:0> DCRCDATA 31:16 — — — DCRCXOR 31:16	⊕ Ξ Ξ	2 31/15 30/14 29/13 28/12 2//11 26/10 DCRCCON 31:16 — — BYTO<1:0> WBO — DCRCDATA 31:16 — — — PLEN<4:0> DCRCDATA 31:16	2 3 31/15 30/14 29/13 28/12 27/11 26/10 25/9 DCRCCON 31:16 — — BYTO<1:0> WBO — — DCRCDATA 31:16 — — — PLEN<4:0> DCRCXOR 31:16	Brick 31/15 30/14 29/13 28/12 27/11 26/10 25/9 24/8 DCRCCON 31:16 BYTO<1:0> WBO BITO DCRCCDATA 31:16 PLEN<4:0> DCRCCDATA DCRCXOR 31:16 PLEN<	bring bring 31/15 30/14 29/13 28/12 27/11 26/10 25/9 24/8 23/7 DCRCCON 31:16 BYTO<1:0> WBO BITO DCRCCDATA 31:16 PLEN<4:0> CRCCDATA DCRCXOR 31:16 DCRCXOR DCRCXOR 0 BITO	brick brick 31/15 30/14 29/13 28/12 27/11 26/10 25/9 24/8 23/7 22/6 DCRCCON 31:16 BYTO<1:0> WBO BITO DCRCCON 31:16 PLEN<4:0> CRCEN CRCAPP DCRCCDATA 31:16 DCRCXOR 31:16 DCRCXOR DCRCXOR 31:16 DCRCXOR DCRCXOR DCRCXOR 31:0> <td>bring brind 31/15 30/14 29/13 28/12 27/11 26/10 25/9 24/8 23/7 22/6 21/5 DCRCCON 31:16 BYTO<1:0> WBO BITO DCRCDATA 31:0> DCRCDATA 31:10 DCRCDATA </td>	bring brind 31/15 30/14 29/13 28/12 27/11 26/10 25/9 24/8 23/7 22/6 21/5 DCRCCON 31:16 BYTO<1:0> WBO BITO DCRCDATA 31:0> DCRCDATA 31:10 DCRCDATA	

nd: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See more information.

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ess	1 1	a	L							Bi	lits			
Virtual Address (BF88_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4
		31:16				—	—		<u> </u>	—		<u> </u>	<u> </u>	<u> </u>
060	DCH0CON	15:0	CHBUSY		_	_			_	CHCHNS	CHEN	CHAED	CHCHN	CHAE
070	DCH0ECON	31:16	—						<u> </u>					CHA
0/0	DUHUEUUN	15:0	í <u> </u>			CHSIF	RQ<7:0>				CFORCE	CABORT	PATEN	SIRQE
200	DCH0INT	31:16				_	_				CHSDIE	CHSHIE	CHDDIE	CHDHI
3080	DCHUINT	15:0		<u> </u>		—	—	_	_		CHSDIF	CHSHIF	CHDDIF	CHDHI
3090	DCH0SSA	31:16	1							CHSS/	A<31:0>			
1000		15:0	<u> </u>							01100.	101.0			
30A0	DCH0DSA	31:16 15:0								CHDS	A<31:0>	_		_
	201100017	31:16	-	—		—	_		—	—			<u> </u>	
30B0	DCH0SSIZ	15:0								CHSSI	Z<15:0>			
		31:16	—	—	_		_		—	/	_	_		-
30C0	DCH0DSIZ	15:0								CHDSI	Z<15:0>			
		31:16		—		_			_	—		_		—
30DU	DCH0SPTR-	15:0	i							CHSPT	R<15:0>			
		31.16	_	—	_		_		_	—	Í _ /		[_ '	_
30EU	DCH0DPTR-	15:0								CHDPT	R<15:0>			
0		31:16	_	—	_		_		_	—	Í _ /	_	[_ '	_
30F0	DCH0CSIZ	15:0	i							CHCSI	Z<15:0>			
		31:16	_	—	_		_		_	—	Í _ /		[_ '	_
3100 1	DCH0CPTR	15:0	í							CHCPT	R<15:0>			
		31:16	_	—	_		_	[_]	_	_	Í _ /		[_ '	_
3110	DCH0DAT	15:0		-								1	·	CHI
	[31:16	- 1	_		_						_	[_ /	
3120	DCH1CON	15:0	CHBUSY		_	_	_	_	_	CHCHNS	CHEN	CHAED	CHCHN	CHAE
		31.16		_					-					CH
3130	DCH1ECON	15:0	· · · ·		1	CHSIF	RQ<7:0>				CFORCE	CABORT	PATEN	SIRQ
	r†	31:16		_							CHSDIE	CHSHIE	CHDDIE	CHDH
3140	DCH1INT	15:0	_	_					<u> </u>		CHSDIF	CHSHIF	CHDDIF	CHDF
3150	DCH1SSA	31:16 15:0								CHSS/	A<31:0>			
3160	DCH1DSA	31:16 15:0	4							CHDS/	A<31:0>			

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more information.

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ess										Bi	ts			
Virtual Address (BF88_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4
3170	DCH1SSIZ	31:16	—	_					_	_				
3170	DCHISSIZ	15:0								CHSSIZ	2<15:0>			
3180	DCH1DSIZ	31:16	—	—	—	—	-	—	_	—	_	—	—	—
3160	DCHIDSIZ	15:0			-				-	CHDSIZ	2<15:0>			-
3100	DCH1SPTR	31:16	_	_	—	—	—	—	—	—	_	—	—	_
5190	DOITIOFIK	15:0								CHSPTI	R<15:0>			
3140	DCH1DPTR	31:16	—	—	—	—	—	—	—	—	—	—	—	—
0 17 10		15:0								CHDPT	R<15:0>			
31B0	DCH1CSIZ	31:16	_	—	—	—	—	—	—	-	_	—	—	—
0100	DOITIOOL	15:0								CHCSIZ	2<15:0>			
31C0	DCH1CPTR	31:16	_	_		—	—	—	—	—	—	—	—	—
		15:0								CHCPT	R<15:0>			
31D0	DCH1DAT	31:16	-	_		_	_		_	-	—	—	—	_
0.00	50115/1	15:0	_	_	_	_	_	_	_	—				CHF
31E0	DCH2CON	31:16	_	_	_	_	_	—	_	—		—	—	
0.20	200120011	15:0	CHBUSY	_	—	—	_	—	_	CHCHNS	CHEN	CHAED	CHCHN	CHAE
31F0	DCH2ECON	31:16	_	_		—	—	—	—	—		I	I	CHA
		15:0				CHSIR	Q<7:0>				CFORCE	CABORT	PATEN	SIRQE
3200	DCH2INT	31:16	_	_	_	_	_	—	_	—	CHSDIE	CHSHIE	CHDDIE	CHDH
0200	DONEIN	15:0	_		_	_	—	—	_	—	CHSDIF	CHSHIF	CHDDIF	CHDH
3210	DCH2SSA	31:16 15:0								CHSSA	<31:0>			
3220	DCH2DSA	31:16 15:0								CHDSA	<31:0>			
		31:16	_	_	_	_	_	_	_	_	_	_	_	_
3230	DCH2SSIZ	15:0								CHSSIZ	2<15:0>			
	D.0110D.017	31:16	_	_	_	_	_	_	_	_	_	_	_	—
3240	DCH2DSIZ	15:0								CHDSIZ	2<15:0>			
0050	DOLIGODT	31:16	_	—	_	—	—				—			_
3250	DCH2SPTR	15:0								CHSPTI	R<15:0>			
		31:16	_	—	_	—	—				—			_
3260	DCH2DPTR	15:0								CHDPT	R<15:0>			
0070	DOLIDOC:7	31:16	_	—	_	—	—				—			_
3270	DCH2CSIZ	15:0								CHCSIZ	7<15:0>			

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All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See more information. Note 1:

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ess										Bi	ts			
Virtual Address (BF88_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4
2200	DCH2CPTR	31:16	—	_		—	—	—	-	—		—		—
3260	DUHZUPIR	15:0								CHCPTI	R<15:0>			
2200		31:16	_	_		_	_	_		_	_	_		_
3290	DCH2DAT	15:0	_	_	_	_	_	_	_	_			_	CHPDA
32A0	DCH3CON	31:16	_	_	_	_	_	_	_	_		_	_	_
52AU	DCH3CON	15:0	CHBUSY	—		_	_	-		CHCHNS	CHEN	CHAED	CHCHN	CHAEN
3280	DCH3ECON	31:16	_	_	—	—	—	—	—	—		-		CHAIRO
5200		15:0				CHSIR	Q<7:0>	-			CFORCE	CABORT	PATEN	SIRQEN
32C0	DCH3INT	31:16	-	_	_	—	—	—			CHSDIE	CHSHIE	CHDDIE	CHDHIE
5200	DOUISIN	15:0	_	_	—	—	—	—	—	—	CHSDIF	CHSHIF	CHDDIF	CHDHIF
32D0	DCH3SSA	31:16 15:0								CHSSA	<31:0>			
32E0	DCH3DSA	31:16 15:0								CHDSA	<31:0>			
2050		31:16	—		_	—	—	_		_	_	—		
32F0	DCH3SSIZ	15:0								CHSSIZ	2<15:0>			
3300	DCH3DSIZ	31:16	—	—		_	_	-		—		-		_
5500	DOLIODOIZ	15:0								CHDSIZ	2<15:0>			
3310	DCH3SPTR	31:16	_	_	_	—	—	—	_	—	_	—	_	—
0010	DOI 1001 TR	15:0					-			CHSPTI	R<15:0>			
3320	DCH3DPTR	31:16	—	_	—	—	—	—	—	—	—	—	—	—
0020		15:0								CHDPTI	R<15:0>			
3330	DCH3CSIZ	31:16	—	—	—	—	—	—	—	—	—	—	—	—
0000	DOLIDOOIZ	15:0								CHCSIZ	2<15:0>			
3340	DCH3CPTR	31:16	_	_	_	—	—	—	—	—	_	—	—	
0010		15:0								CHCPT	R<15:0>			
3350	DCH3DAT	31:16	_	_	_	—	—	—	_		_	—	—	
	_ 002.11	15:0	_	_	_	_		_	_	_				CHPDA

All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See more information. Note 1:

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	—	_	_	_	_	—	_	—
22.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	_	—	_	_		—	—	—
45.0	R/W-0	U-0	U-0	R/W-0	R/W-0	U-0	U-0	U-0
15:8	ON ⁽¹⁾	—	_	SUSPEND	DMABUSY	—	—	—
7.0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
7:0	_	_	_	_		_	—	_

REGISTER 9-1: DMACON: DMA CONTROLLER CONTROL REGISTER

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

- bit 15 **ON:** DMA On bit⁽¹⁾
 - 1 = DMA module is enabled
 - 0 = DMA module is disabled
- bit 14-13 Unimplemented: Read as '0'
- bit 12 **SUSPEND:** DMA Suspend bit
 - 1 = DMA transfers are suspended to allow CPU uninterrupted access to data bus0 = DMA operates normally
- bit 11 **DMABUSY:** DMA Module Busy bit
 - 1 = DMA module is active
 - 0 = DMA module is disabled and not actively transferring data
- bit 10-0 Unimplemented: Read as '0'
- **Note 1:** When using 1:1 PBCLK divisor, the user's software should not read/write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	_	_	-	-	—	_	—	—
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	_	_	_	_	—	_	—	—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
10.0	_	_	-	-	—	_	—	—
7.0	U-0	U-0	U-0	U-0	R-0	R-0	R-0	R-0
7:0	_	_	_	_	RDWR	Γ	DMACH<2:0>	

REGISTER 9-2: DMASTAT: DMA STATUS REGISTER

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, r	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-4 Unimplemented: Read as '0'

bit 3 **RDWR:** Read/Write Status bit 1 = Last DMA bus access was a read 0 = Last DMA bus access was a write

bit 2-0 **DMACH<2:0>:** DMA Channel bits These bits contain the value of the most recent active DMA channel.

REGISTER 9-3: DMAADDR: DMA ADDRESS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0				
04.04	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0				
31:24	DMAADDR<31:24>											
00.40	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0				
23:16	DMAADDR<23:16>											
45.0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0				
15:8	DMAADDR<15:8>											
7.0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0				
7:0				DMAADD	R<7:0>							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented b	it, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-0 DMAADDR<31:0>: DMA Module Address bits

These bits contain the address of the most recent DMA access.

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			0					
Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
04.04	U-0	U-0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0
31:24	—	_	BYTC	<1:0>	WBO ⁽¹⁾	_	_	BITO
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	—	_	_	_	_	_	_	_
45.0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
15:8	—	—	—			PLEN<4:0>		
7.0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0
7:0	CRCEN	CRCAPP ⁽¹⁾	CRCTYP	—	—	(CRCCH<2:0>	

REGISTER 9-4: DCRCCON: DMA CRC CONTROL REGISTER

Legend:

Logonan			
R = Readable bit	W = Writable bit	U = Unimplemented bit, r	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-30 Unimplemented: Read as '0'

- bit 29-28 BYTO<1:0>: CRC Byte Order Selection bits
 - 11 = Endian byte swap on half-word boundaries (i.e., source half-word order with reverse source byte order per half-word)
 - 10 = Swap half-words on word boundaries (i.e., reverse source half-word order with source byte order per half-word)
 - 01 = Endian byte swap on word boundaries (i.e., reverse source byte order)
 - 00 = No swapping (i.e., source byte order)
- bit 27 WBO: CRC Write Byte Order Selection bit⁽¹⁾
 - 1 = Source data is written to the destination re-ordered as defined by BYTO<1:0>
 - 0 = Source data is written to the destination unaltered
- bit 26-25 Unimplemented: Read as '0'
- bit 24 BITO: CRC Bit Order Selection bit

<u>When CRCTYP (DCRCCON<15>) = 1</u> (CRC module is in IP Header mode):

- 1 = The IP header checksum is calculated Least Significant bit (LSb) first (i.e., reflected)
- 0 = The IP header checksum is calculated Most Significant bit (MSb) first (i.e., not reflected)

When CRCTYP (DCRCCON<15>) = 0 (CRC module is in LFSR mode):

- 1 = The LFSR CRC is calculated Least Significant bit first (i.e., reflected)
- 0 = The LFSR CRC is calculated Most Significant bit first (i.e., not reflected)
- bit 23-13 Unimplemented: Read as '0'
- bit 12-8 **PLEN<4:0>:** Polynomial Length bits <u>When CRCTYP (DCRCCON<15>) = 1</u> (CRC module is in IP Header mode): These bits are unused.

When CRCTYP (DCRCCON<15>) = 0 (CRC module is in LFSR mode):

Denotes the length of the polynomial -1.

- bit 7 CRCEN: CRC Enable bit
 - 1 = CRC module is enabled and channel transfers are routed through the CRC module
 - 0 = CRC module is disabled and channel transfers proceed normally
- Note 1: When WBO = 1, unaligned transfers are not supported and the CRCAPP bit cannot be set.

REGISTER 9-4: DCRCCON: DMA CRC CONTROL REGISTER (CONTINUED)

- bit 6 CRCAPP: CRC Append Mode bit⁽¹⁾
 - 1 = The DMA transfers data from the source into the CRC but NOT to the destination. When a block transfer completes the DMA writes the calculated CRC value to the location given by CHxDSA
 - 0 = The DMA transfers data from the source through the CRC obeying WBO as it writes the data to the destination
- bit 5 CRCTYP: CRC Type Selection bit
 - 1 = The CRC module will calculate an IP header checksum
 - 0 = The CRC module will calculate a LFSR CRC
- bit 4-3 Unimplemented: Read as '0'
- bit 2-0 CRCCH<2:0>: CRC Channel Select bits
 - 111 = CRC is assigned to Channel 7
 - 110 = CRC is assigned to Channel 6
 - 101 = CRC is assigned to Channel 5
 - 100 = CRC is assigned to Channel 4
 - 011 = CRC is assigned to Channel 3
 - 010 = CRC is assigned to Channel 2
 - 001 = CRC is assigned to Channel 1
 - 000 = CRC is assigned to Channel 0
- **Note 1:** When WBO = 1, unaligned transfers are not supported and the CRCAPP bit cannot be set.

		SONODAIA.								
Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0		
04.04	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
31:24				DCRCDAT	A<31:24>					
00.40	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
23:16	DCRCDATA<23:16>									
45.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
15:8	DCRCDATA<15:8>									
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
7:0		·		DCRCDA	TA<7:0>					

REGISTER 9-5: DCRCDATA: DMA CRC DATA REGISTER

Legend:

Legena:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-0 DCRCDATA<31:0>: CRC Data Register bits

Writing to this register will seed the CRC generator. Reading from this register will return the current value of the CRC. Bits greater than PLEN will return '0' on any read.

<u>When CRCTYP (DCRCCON<15>) = 1</u> (CRC module is in IP Header mode): Only the lower 16 bits contain IP header checksum information. The upper 16 bits are always '0'. Data written to this register is converted and read back in 1's complement form (i.e., current IP header checksum value).

<u>When CRCTYP (DCRCCON<15>) = 0</u> (CRC module is in LFSR mode): Bits greater than PLEN will return '0' on any read.

REGISTER 9-6: DCRCXOR: DMA CRCXOR ENABLE REGISTER

		••••••••••				•						
Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0				
04.04	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
31:24		DCRCXOR<31:24>										
00.40	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
23:16	DCRCXOR<23:16>											
45.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
15:8		-		DCRCXO	R<15:8>							
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
7:0				DCRCXC	R<7:0>							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, r	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-0 DCRCXOR<31:0>: CRC XOR Register bits

<u>When CRCTYP (DCRCCON<15>) = 1</u> (CRC module is in IP Header mode): This register is unused.

When CRCTYP (DCRCCON<15>) = 0 (CRC module is in LFSR mode):

- 1 = Enable the XOR input to the Shift register
- 0 = Disable the XOR input to the Shift register; data is shifted in directly from the previous stage in the register

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	_	—	-	-	_	_	_	—
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	_	—	_	_	_	_	_	—
45.0	R/W-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
15:8	CHBUSY	—	_	—	_		—	CHCHNS ⁽¹⁾
7.0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	R-0	R/W-0	R/W-0
7:0	CHEN ⁽²⁾	CHAED	CHCHN	CHAEN		CHEDET	CHPF	RI<1:0>

REGISTER 9-7: DCHxCON: DMA CHANNEL 'x' CONTROL REGISTER

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

bit 15 **CHBUSY:** Channel Busy bit 1 = Channel is active or has been enabled

0 = Channel is inactive or has been disabled

bit 14-9 Unimplemented: Read as '0'

- CHCHNS: Chain Channel Selection bit(1) bit 8 1 = Chain to channel lower in natural priority (CH1 will be enabled by CH2 transfer complete) 0 = Chain to channel higher in natural priority (CH1 will be enabled by CH0 transfer complete) CHEN: Channel Enable bit⁽²⁾ bit 7 1 = Channel is enabled 0 = Channel is disabled bit 6 CHAED: Channel Allow Events If Disabled bit 1 = Channel start/abort events will be registered, even if the channel is disabled 0 = Channel start/abort events will be ignored if the channel is disabled bit CHCHN: Channel Chain Enable bit 1 = Allow channel to be chained 0 = Do not allow channel to be chained bit 4 CHAEN: Channel Automatic Enable bit 1 = Channel is continuously enabled, and not automatically disabled after a block transfer is complete 0 = Channel is disabled on block transfer complete bit 3 Unimplemented: Read as '0' bit 2 CHEDET: Channel Event Detected bit 1 = An event has been detected 0 = No events have been detected bit 1-0 CHPRI<1:0>: Channel Priority bits 11 = Channel has priority 3 (highest) 10 = Channel has priority 2 01 = Channel has priority 1 00 = Channel has priority 0 Note 1: The chain selection bit takes effect when chaining is enabled (i.e., CHCHN = 1).
 - 2: When the channel is suspended by clearing this bit, the user application should poll the CHBUSY bit (if available on the device variant) to see when the channel is suspended, as it may take some clock cycles to complete a current transaction before the channel is suspended.

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Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0		
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
31.24	—	_	_	—	—	—	_	—		
22:16	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1		
23:16	CHAIRQ<7:0> ⁽¹⁾									
45.0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1		
15:8				CHSIRQ	<7:0>(1)					
7:0	S-0	S-0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0		
7:0	CFORCE	CABORT	PATEN	SIRQEN	AIRQEN		_	_		

REGISTER 9-8: DCHxECON: DMA CHANNEL 'x' EVENT CONTROL REGISTER

Legend:	S = Settable bit		
R = Readable bit	W = Writable bit	U = Unimplemented b	vit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-24 Unimplemented: Read as '0'

	······
bit 23-16	CHAIRQ<7:0>: Channel Transfer Abort IRQ bits ⁽¹⁾
	11111111 = Interrupt 255 will abort any transfers in progress and set CHAIF flag
	•
	•
	•
	00000001 = Interrupt 1 will abort any transfers in progress and set CHAIF flag 00000000 = Interrupt 0 will abort any transfers in progress and set CHAIF flag
bit 15-8	CHSIRQ<7:0>: Channel Transfer Start IRQ bits ⁽¹⁾
	11111111 = Interrupt 255 will initiate a DMA transfer
	•
	•
	•
	00000001 = Interrupt 1 will initiate a DMA transfer
	0000000 = Interrupt 0 will initiate a DMA transfer
bit 7	CFORCE: DMA Forced Transfer bit
	 1 = A DMA transfer is forced to begin when this bit is written to a '1' 0 = This bit always reads '0'
bit 6	CABORT: DMA Abort Transfer bit
	 1 = A DMA transfer is aborted when this bit is written to a '1' 0 = This bit always reads '0'
bit 5	PATEN: Channel Pattern Match Abort Enable bit
	1 = Abort transfer and clear CHEN on pattern match
	0 = Pattern match is disabled
bit 4	SIRQEN: Channel Start IRQ Enable bit
	1 = Start channel cell transfer if an interrupt matching CHSIRQ occurs
	0 = Interrupt number CHSIRQ is ignored and does not start a transfer
bit 3	AIRQEN: Channel Abort IRQ Enable bit
	1 = Channel transfer is aborted if an interrupt matching CHAIRQ occurs

- 0 = Interrupt number CHAIRQ is ignored and does not terminate a transfer
- bit 2-0 Unimplemented: Read as '0'

Note 1: See Table 7-1: "Interrupt IRQ, Vector and Bit Location" for the list of available interrupt IRQ sources.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	—	_	_	_	_	_	-	_
00.40	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
23:16	CHSDIE	CHSHIE	CHDDIE	CHDHIE	CHBCIE	CHCCIE	CHTAIE	CHERIE
45.0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
15:8	—	_	_	_	_	_	_	_
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
7:0	CHSDIF	CHSHIF	CHDDIF	CHDHIF	CHBCIF	CHCCIF	CHTAIF	CHERIF

REGISTER 9-9: DCHxINT: DMA CHANNEL 'x' INTERRUPT CONTROL REGISTER

Legend:

R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 31-24 Unimplemented: Read as '0'

bit 23	CHSDIE: Channel Source Done Interrupt Enable bit
	1 = Interrupt is enabled
	0 = Interrupt is disabled
bit 22	CHSHIE: Channel Source Half Empty Interrupt Enable bit
	1 = Interrupt is enabled
	0 = Interrupt is disabled
bit 21	CHDDIE: Channel Destination Done Interrupt Enable bit
	1 = Interrupt is enabled
	0 = Interrupt is disabled
bit 20	CHDHIE: Channel Destination Half Full Interrupt Enable bit
	1 = Interrupt is enabled
	0 = Interrupt is disabled
bit 19	CHBCIE: Channel Block Transfer Complete Interrupt Enable bit
	1 = Interrupt is enabled
	0 = Interrupt is disabled
bit 18	CHCCIE: Channel Cell Transfer Complete Interrupt Enable bit
	1 = Interrupt is enabled
	0 = Interrupt is disabled
bit 17	CHTAIE: Channel Transfer Abort Interrupt Enable bit
	1 = Interrupt is enabled 0 = Interrupt is disabled
h:+ 40	•
bit 16	CHERIE: Channel Address Error Interrupt Enable bit
	1 = Interrupt is enabled 0 = Interrupt is disabled
bit 15-8	Unimplemented: Read as '0'
bit 7	-
	CHSDIF: Channel Source Done Interrupt Flag bit
	 1 = Channel Source Pointer has reached end of source (CHSPTR = CHSSIZ) 0 = No interrupt is pending
bit 6	CHSHIF: Channel Source Half Empty Interrupt Flag bit
DIT U	1 = Channel Source Pointer has reached midpoint of source (CHSPTR = CHSSIZ/2)
	0 = No interrupt is pending
bit 5	CHDDIF: Channel Destination Done Interrupt Flag bit
	1 = Channel Destination Pointer has reached end of destination (CHDPTR = CHDSIZ)
	0 = No interrupt is pending
	-

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REGISTER 9-9: DCHxINT: DMA CHANNEL 'x' INTERRUPT CONTROL REGISTER (CONTINUED)

- bit 4 CHDHIF: Channel Destination Half Full Interrupt Flag bit
 - 1 = Channel Destination Pointer has reached midpoint of destination (CHDPTR = CHDSIZ/2)
 - 0 = No interrupt is pending
- bit 3 CHBCIF: Channel Block Transfer Complete Interrupt Flag bit
 - 1 = A block transfer has been completed (the larger of CHSSIZ/CHDSIZ bytes has been transferred), or a pattern match event occurs
 - 0 = No interrupt is pending
- bit 2 CHCCIF: Channel Cell Transfer Complete Interrupt Flag bit
 - 1 = A cell transfer has been completed (CHCSIZ bytes have been transferred)
 - 0 = No interrupt is pending
- bit 1 CHTAIF: Channel Transfer Abort Interrupt Flag bit
 - 1 = An interrupt matching CHAIRQ has been detected and the DMA transfer has been aborted
 - 0 = No interrupt is pending
- bit 0 CHERIF: Channel Address Error Interrupt Flag bit
 - 1 = A channel address error has been detected (either the source or the destination address is invalid)

0 = No interrupt is pending

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0		
24.24	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
31:24				CHSSA<	31:24>					
00.40	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
23:16	CHSSA<23:16>									
45.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
15:8	CHSSA<15:8>									
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
7:0				CHSSA	<7:0>					

REGISTER 9-10: DCHxSSA: DMA CHANNEL 'x' SOURCE START ADDRESS REGISTER

Legend:

Lanandi

Legena:				
= Readable bit W = Writable bit		U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 31-0 CHSSA<31:0> Channel Source Start Address bits Channel source start address.

Note: This must be the physical address of the source.

REGISTER 9-11: DCHxDSA: DMA CHANNEL 'x' DESTINATION START ADDRESS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0		
21.24	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
31:24				CHDSA<	31:24>					
00.40	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
23:16	CHDSA<23:16>									
45.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
15:8	CHDSA<15:8>									
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
7:0				CHDSA	<7:0>					

Legena:			
R = Readable bit	W = Writable bit	it, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-0 **CHDSA<31:0>:** Channel Destination Start Address bits Channel destination start address.

Note: This must be the physical address of the destination.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0		
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
31:24	—	—	—	—	—	—	—	—		
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
23:16	—	—	—	—	—	—	—	—		
45.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
15:8	CHSSIZ<15:8>									
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
				CHSSIZ	<7:0>					

REGISTER 9-12: DCHxSSIZ: DMA CHANNEL 'x' SOURCE SIZE REGISTER

Legend:

R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 31-16 Unimplemented: Read as '0'

bit 15-0 CHSSIZ<15:0>: Channel Source Size bits 11111111111111 = 65,535 byte source size .

REGISTER 9-13: DCHxDSIZ: DMA CHANNEL 'x' DESTINATION SIZE REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
24.04	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
31:24	—	—	_	_	_	—	_	—	
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
23:16	—	—	—	—	_	—	_	—	
15:8	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
10.0	CHDSIZ<15:8>								
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
		-		CHDSIZ	<7:0>	-			

Legend:				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 31-16 Unimplemented: Read as '0'

bit 15-0 CHDSIZ<15:0>: Channel Destination Size bits

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
31.24		_	-	-	_		—	—	
22:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
23:16		_	_	_	_	_	—	—	
45.0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	
15:8	CHSPTR<15:8>								
7.0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	
7:0	CHSPTR<7:0>								

REGISTER 9-14: DCHxSPTR: DMA CHANNEL 'x' SOURCE POINTER REGISTER

Legend:

R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 31-16 Unimplemented: Read as '0'

bit 15-0 CHSPTR<15:0>: Channel Source Pointer bits

1111111111111111 = Points to byte 65,535 of the source

Note: When in Pattern Detect mode, this register is reset on a pattern detect.

REGISTER 9-15: DCHxDPTR: DMA CHANNEL 'x' DESTINATION POINTER REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0					
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0					
31:24	—	—	_	_	—	—	—	—					
00.10	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0					
23:16	—	-	_	_	—	-	—	—					
45.0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0					
15:8	CHDPTR<15:8>												
7.0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0					
7:0	CHDPTR<7:0>												

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, I	read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0					
04.04	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0					
31:24	—	—	—	—	_	—	—	—					
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0					
23:16	—	—	—	—	_	—	—	—					
45.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0					
15:8	CHCSIZ<15:8>												
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0					
7:0	CHCSIZ<7:0>												

REGISTER 9-16: DCHxCSIZ: DMA CHANNEL 'x' CELL-SIZE REGISTER

Legend:

Logona.			
R = Readable bit	W = Writable bit	U = Unimplemented bit, r	read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

bit 15-0 CHCSIZ<15:0>: Channel Cell Size bits

1111111111111111 = 65,535 bytes transferred on an event

REGISTER 9-17: DCHxCPTR: DMA CHANNEL 'x' CELL POINTER REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0				
21.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0				
31:24		—	_	_	—	-	—	—				
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0				
23:16	—	—	—	—	—	—	—	—				
15:0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0				
15:8				CHCPTR	<15:8>							
7:0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0				
7:0	CHCPTR<7:0>											

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bi	t, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

bit 15-0 CHCPTR<15:0>: Channel Cell Progress Pointer bits

111111111111111 = 65,535 bytes have been transferred since the last event

Note: When in Pattern Detect mode, this register is reset on a pattern detect.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0					
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0					
31.24		-	—	—	—	—	—	—					
22.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0					
23:16		_	—	—	—	-	—	—					
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0					
10.0		—	—	—	—	_	—	—					
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0					
7:0	CHPDAT<7:0>												

REGISTER 9-18: DCHxDAT: DMA CHANNEL 'x' PATTERN DATA REGISTER

Legend:

0				
R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 31-8 Unimplemented: Read as '0'

bit 7-0 **CHPDAT<7:0>:** Channel Data Register bits <u>Pattern Terminate mode:</u> Data to be matched must be stored in this register to allow a "terminate on match".

All other modes: Unused.

NOTES:

10.0 USB ON-THE-GO (OTG)

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 27. "USB On-The-Go (OTG)" (DS60001126), which is available from the Documentation > Reference Manual section of the Microchip PIC32 web site (www.microchip.com/pic32).

The Universal Serial Bus (USB) module contains analog and digital components to provide a USB 2.0 Full-Speed and Low-Speed embedded host, Full-Speed device or OTG implementation with a minimum of external components. This module in Host mode is intended for use as an embedded host and therefore does not implement a UHCI or OHCI controller.

The USB module consists of the clock generator, the USB voltage comparators, the transceiver, the Serial Interface Engine (SIE), a dedicated USB DMA controller, pull-up and pull-down resistors, and the register interface. A block diagram of the PIC32 USB OTG module is presented in Figure 10-1.

The clock generator provides the 48 MHz clock required for USB Full-Speed and Low-Speed communication. The voltage comparators monitor the voltage on the VBUS pin to determine the state of the bus. The transceiver provides the analog translation between the USB bus and the digital logic. The SIE is a state machine that transfers data to and from the endpoint buffers and generates the hardware protocol for data transfers. The USB DMA controller transfers data between the data buffers in RAM and the SIE. The integrated pull-up and pull-down resistors eliminate the need for external signaling components. The register interface allows the CPU to configure and communicate with the module. The PIC32 USB module includes the following features:

- · USB Full-Speed support for Host and Device
- Low-Speed Host support
- USB OTG support
- Integrated signaling resistors
- Integrated analog comparators for VBUS monitoring
- Integrated USB transceiver
- · Transaction handshaking performed by hardware
- Endpoint buffering anywhere in system RAM
- · Integrated DMA to access system RAM and Flash
- Note: The implementation and use of the USB specifications, as well as other third party specifications or technologies, may require licensing; including, but not limited to, USB Implementers Forum, Inc., also referred to as USB-IF (www.usb.org). The user is fully responsible for investigating and satisfying any applicable licensing obligations.

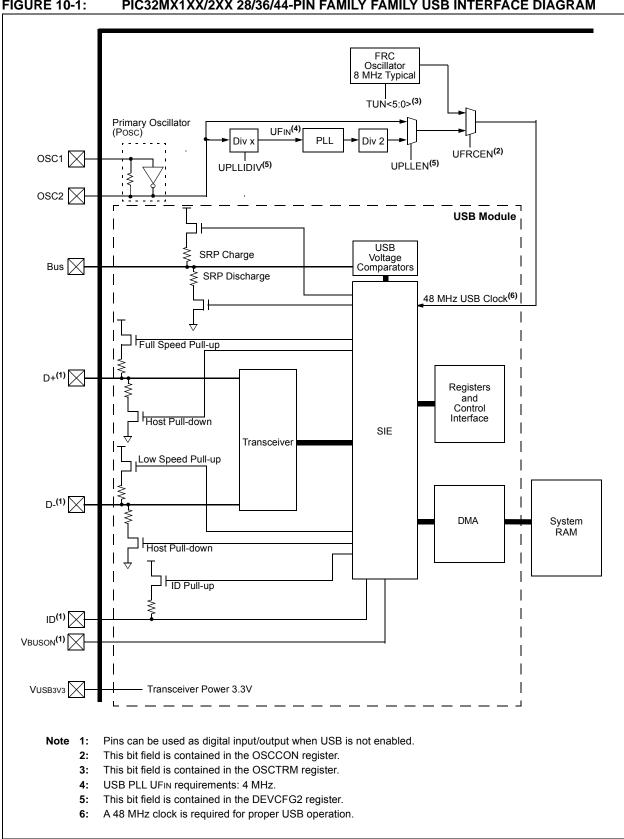


FIGURE 10-1: PIC32MX1XX/2XX 28/36/44-PIN FAMILY FAMILY USB INTERFACE DIAGRAM

USB Control Registers 10.1

-

ess											Bit	s			
Virtual Address (BF88_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	1
50.40	U1OTGIR ⁽²⁾	31:16	_		_	_				_	_	_	_	_	
5040	0101GIR-	15:0	_		_		_		_	—	IDIF	T1MSECIF	LSTATEIF	ACTVIF	SES
5050	U10TGIE	31:16	_		—	_	_	_		—	_	_	—	—	
5050	UIUIGIE	15:0	_		_	—	_			_	IDIE	T1MSECIE	LSTATEIE	ACTVIE	SES
5060	U1OTGSTAT ⁽³⁾	31:16	_		_	—	_			_	—		—	—	
5000	UIUIGSIAIO	15:0	_	_	_	_		_	_	_	ID	_	LSTATE	—	SE
5070	U10TGCON	31:16	—	_			_	_	_	_	—	_	_	-	-
5070	01010001	15:0	—	—	_	_	—	—	—	—	DPPULUP	DMPULUP	DPPULDWN	DMPULDWN	I VBL
5080	U1PWRC	31:16	—	—	—	—	—	—	—	—	—		—	_	-
0000	on mile	15:0	—	—	—	—	—	—	—	—	UACTPND ⁽⁴⁾		—	USLPGRD	USB
		31:16	—	—	—	_	—	—	—	—	—	—	—	—	-
5200	U1IR ⁽²⁾	15:0	_	—	—	_	_	—	_	—	STALLIF	ATTACHIF	RESUMEIF	IDLEIF	TR
		31:16	_	_	_	_	_	_	_	—	-	-	_	-	-
5210	U1IE	15:0	_	_	_	_	_	_	_	_	STALLIE	ATTACHIE	RESUMEIE	IDLEIE	TR
		31:16	_	_	_	_		_		_	—	—		—	-
5220	U1EIR ⁽²⁾	15:0	_	_			_	_	_	_	BTSEF	BMXEF	DMAEF	BTOEF	DFN
		31:16	_	_	_	_					_	_	_	_	
5230	U1EIE	15:0	_	_	_		_		_		BTSEE	BMXEE	DMAEE	BTOEE	DFN
		31:16	_		_	_	_	_	_	_	_	_	_	_	-
5240	U1STAT ⁽³⁾	15:0	_		_	_	_			_		ENDF	PT<3:0>		D
		31:16	_	_	_	_	_		—	_	_		_	_	-
5250	U1CON	15:0	_	_	_		_	_	_	_	JSTATE	SE0	PKTDIS TOKBUSY	USBRST	ноя
		31:16	_	_	_	_	_	_	_	_	_	_	_	_	
5260	0 U1ADDR	15:0	_	_	_	_	_	_	_	_	LSPDEN				EVADI
		31:16	_	_	_	_	_	_	_	_	_	_	_	_	<u> </u>
5270	U1BDTP1	15:0	_	_	_	_	_	_	_	_			BC	TPTRL<15:9	<u> </u>

With the exception of those noted, all registers in this table (except as noted) have corresponding CLR, SET and INV registers at their virtual address, See Section 11.2 "CLR, SET and INV Registers" for more information. Note 1:

2: This register does not have associated SET and INV registers.

3: This register does not have associated CLR, SET and INV registers.

4: Reset value for this bit is undefined.

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Legend:

Virtual Address (BF88_#)	Register Name ⁽¹⁾	Bit Range	Bits													
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	1	
5280	U1FRML ⁽³⁾	31:16	—	_	—	—	—	_	_	-	_	_		_	-	
		15:0	—	—	—	—	—	—	—	-				FRML<	:7:0>	
5290	U1FRMH ⁽³⁾	31:16	—	—				—	—	—	—	—	_		-	
		15:0	—	—	—	—	—	—	—	-	—	_	_			
52A0	U1TOK	31:16	—	—	—	—	—	—	—	—	—	_	—	_	-	
		15:0	_	—	—	—	—	—	—			PID	<3:0>	+		
52B0	U1SOF	31:16	_	—	—	—	—	_	_		_	-	_	_	-	
		15:0	—	—	_	_	_	_	_	—				CNT<	7:0>	
52C0	U1BDTP2	31:16	—	—	_	_	—	_	_	—	—	—	-	—	-	
		15:0	—	_	_	_	_			—				BDTPTR	H<7:0	
52D0	U1BDTP3	31:16	—	_	_	_	_			—	_	_		—	_	
		15:0	_	-	_	_	-	_	_	—				BDTPTR	U<7:0	
52E0	U1CNFG1	31:16	_	-	_	_	-	_	_	—	_	—	_	—	-	
		15:0	_	-	_	-	_	_	_	—	UTEYE	UOEMON	_	USBSIDL	-	
5300	U1EP0	31:16	_	-	_	-	_	_	_	—	_	—	_	_	-	
		15:0	_	_			_	_	_	_	LSPD	RETRYDIS	_	EPCONDIS	EPR	
5310	U1EP1	31:16		_						_	_	_	_	_	_	
		15:0	_	_			_	_	_	_	_	_	_	EPCONDIS	EPR	
5320	U1EP2	31:16		_						_	_	_	_	_	_	
		15:0	—	_				_	_	_	_	_		EPCONDIS	EPR	
5330	U1EP3	31:16	_	_			_	_	_	_	_	_		_	_	
		15:0	—	_				_	_	_	_	_		EPCONDIS	EPR	
5340	U1EP4	31:16	_	_			_	_	_	_	_	_		_	_	
		15:0	_	_			_	_	_	-	_	_	_	EPCONDIS	EPR	
5350	U1EP5	31:16	_	_	_	_	_	_	_	_	_	_	_	_	-	
		15:0	_	_				_	_	_	_	_	_	EPCONDIS	EPR	
5360	U1EP6	31:16	_	_				_		_	_	_	_	_	_	
		15:0	_	_	_	_	_	_	_	_	_	_	_	EPCONDIS	EPR	
5370	U1EP7	31:16	_	_			_	_	_	_	_	_	_	_	-	
		15:0	_	_	_	_	_	_	_	_	_	_		EPCONDIS	EPR	
5380	U1EP8	31:16	_	_	_	_	_	_	_	_	_	_	_	_	_	
		15:0								_	_	_	_	EPCONDIS	EPR	

x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal. With the exception of those noted, all registers in this table (except as noted) have corresponding CLR, SET and INV registers at their virtual address, See Section 11.2 "CLR, SET and INV Registers" for more information. This register does not have associated SET and INV registers. This register does not have associated CLR, SET and INV registers. Parent wide for this bit is undefined. Note 1:

2:

3:

4: Reset value for this bit is undefined.

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TABLE 10-1:

sse			Bits												
Virtual Addr (BF88_#)	Virtual Address (BF88_#) Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	1
5390	5390 U1EP9	31:16	_	—	—		—	_	—		_	_		—	
5390 UTEP9	UIEF9	15:0		_	_	_	_						_	EPCONDIS	EPF
53A0	53A0 U1EP10	31:16		_	_						-		_	—	-
55AU UIEFIU	UIEFIU	15:0	_	—	—	—	—	_		_	-	-	_	EPCONDIS	EPF
53B0	U1EP11	31:16		_	_						-		_	—	-
5560	UIEFII	15:0	_	—	—	—	—	_		_	-	-	_	EPCONDIS	EPF
53C0	U1EP12	31:16		_	_						-		_	—	-
5500	UIEF 12	15:0	_	—	—	—	—	_		_	-	-	_	EPCONDIS	EPR
53D0	U1EP13	31:16		_	_						-		_	—	-
5500	UIEF 13	15:0	_	—	—	—	—	_		_	-	-	_	EPCONDIS	EPF
5050		31:16	_	_	_	_	-	_	_	_	_	_	_	_	-
53E0	U1EP14	15:0	_	_	_	_	_	_	_	_	_	_		EPCONDIS	EPF
53F0		31:16	_	_	_	_	_	_	—	_	_	_	_	_	-
	U1EP15	15:0	_	_	—			_	_	_	_	_		EPCONDIS	EPF

x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal. With the exception of those noted, all registers in this table (except as noted) have corresponding CLR, SET and INV registers at their virtual address, See Section 11.2 "CLR, SET and INV Registers" for more information. This register does not have associated SET and INV registers. This register does not have associated CLR SET and INV registers. Note 1:

2:

This register does not have associated CLR, SET and INV registers. 3:

USB REGISTER MAP (CONTINUED)

4: Reset value for this bit is undefined.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0		
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
31.24	-	—				—	-	—		
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
23.10		_				—		—		
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
15.0	-	—				—	-	—		
7.0	R/WC-0, HS	U-0	R/WC-0, HS							
7:0	IDIF	T1MSECIF	LSTATEIF	ACTVIF	SESVDIF	SESENDIF		VBUSVDIF		

REGISTER 10-1: U1OTGIR: USB OTG INTERRUPT STATUS REGISTER

Legend:	WC = Write '1' to clear	HS = Hardware Settable b	pit
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-8 Unimplemented: Read as '0'

- bit 7 **IDIF:** ID State Change Indicator bit
 - 1 = A change in the ID state was detected
 - 0 = No change in the ID state was detected
- bit 6 T1MSECIF: 1 Millisecond Timer bit
 - 1 = 1 millisecond timer has expired
 - 0 = 1 millisecond timer has not expired
- bit 5 LSTATEIF: Line State Stable Indicator bit
 - 1 = USB line state has been stable for 1 ms, but different from last time
 - 0 = USB line state has not been stable for 1 ms
- bit 4 ACTVIF: Bus Activity Indicator bit
 - 1 = Activity on the D+, D-, ID or VBUS pins has caused the device to wake-up
 - 0 = Activity has not been detected
- bit 3 SESVDIF: Session Valid Change Indicator bit
 - 1 = VBUS voltage has dropped below the session end level
 - 0 = VBUS voltage has not dropped below the session end level
- bit 2 SESENDIF: B-Device VBUS Change Indicator bit
 - 1 = A change on the session end input was detected
 - 0 = No change on the session end input was detected
- bit 1 Unimplemented: Read as '0'
- bit 0 VBUSVDIF: A-Device VBUS Change Indicator bit
 - 1 = A change on the session valid input was detected
 - 0 = No change on the session valid input was detected

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	—	_	-	-	-	—		—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	—	_	-	-	-	—		—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
10.0	—	—	-	-	-	—	—	—
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0
7:0	IDIE	T1MSECIE	LSTATEIE	ACTVIE	SESVDIE	SESENDIE	_	VBUSVDIE

REGISTER 10-2: U1OTGIE: USB OTG INTERRUPT ENABLE REGISTER

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-8 Unimplemented: Read as '0'

- bit 7 **IDIE:** ID Interrupt Enable bit
 - 1 = ID interrupt is enabled
 - 0 = ID interrupt is disabled
- bit 6 **T1MSECIE:** 1 Millisecond Timer Interrupt Enable bit
 - 1 = 1 millisecond timer interrupt is enabled
 - 0 = 1 millisecond timer interrupt is disabled
- bit 5 LSTATEIE: Line State Interrupt Enable bit
 - 1 = Line state interrupt is enabled
 - 0 = Line state interrupt is disabled
- bit 4 ACTVIE: Bus Activity Interrupt Enable bit
 - 1 = Activity interrupt is enabled
 - 0 = Activity interrupt is disabled
- bit 3 SESVDIE: Session Valid Interrupt Enable bit
 - 1 = Session valid interrupt is enabled
 - 0 = Session valid interrupt is disabled
- bit 2 SESENDIE: B-Device Session End Interrupt Enable bit
 - 1 = B-Device session end interrupt is enabled
 - 0 = B-Device session end interrupt is disabled
- bit 1 Unimplemented: Read as '0'
- bit 0 VBUSVDIE: A-Device VBUS Valid Interrupt Enable bit
 - 1 = A-Device VBUS valid interrupt is enabled
 - 0 = A-Device VBUS valid interrupt is disabled

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
51.24	_	_	_	_	_	_	_	
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
25.10	—	_	_		_	-	-	—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
15.0	—	—	—		_	-	—	—
7:0	R-0	U-0	R-0	U-0	R-0	R-0	U-0	R-0
7:0	ID	_	LSTATE	_	SESVD	SESEND		VBUSVD

REGISTER 10-3: U1OTGSTAT: USB OTG STATUS REGISTER

Legend:

· J · · ·					
R = Readable bit	able bit W = Writable bit		U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 31-8 **Unimplemented:** Read as '0'

- bit 7 **ID:** ID Pin State Indicator bit
 - 1 = No cable is attached or a "type B" cable has been inserted into the USB receptacle
 - 0 = A "type A" OTG cable has been inserted into the USB receptacle

bit 6 Unimplemented: Read as '0'

- bit 5 LSTATE: Line State Stable Indicator bit
 - 1 = USB line state (SE0 (U1CON<6>) bit and JSTATE (U1CON<7>)) bit has been stable for previous 1 ms 0 = USB line state (SE0 and JSTATE) has not been stable for previous 1 ms

bit 4 Unimplemented: Read as '0'

- bit 3 **SESVD:** Session Valid Indicator bit
 - 1 = VBUS voltage is above Session Valid on the A or B device
 - 0 = VBUS voltage is below Session Valid on the A or B device

bit 2 SESEND: B-Device Session End Indicator bit

- 1 = VBUS voltage is below Session Valid on the B device
- 0 = VBUS voltage is above Session Valid on the B device

bit 1 Unimplemented: Read as '0'

- bit 0 VBUSVD: A-Device VBUS Valid Indicator bit
 - 1 = VBUS voltage is above Session Valid on the A device
 - 0 = VBUS voltage is below Session Valid on the A device

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	_	-		—	—		_	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	—	—	—	—	—	—	—	—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
10.0	—	_	—	—	—	_	—	—
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
7:0	DPPULUP	DMPULUP	DPPULDWN	DMPULDWN	VBUSON	OTGEN	VBUSCHG	VBUSDIS

REGISTER 10-4: U10TGCON: USB OTG CONTROL REGISTER

Legend:

D – Doodoblo bit	$\Lambda = \Lambda $	LI - Unimplemented bit	read as '0'	l
R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as 0	J
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	l

bit 31-8 Unimplemented: Read as '0'

bit 7	DPPULUP: D+ Pull-Up Enable bit
	 1 = D+ data line pull-up resistor is enabled 0 = D+ data line pull-up resistor is disabled
bit 6	DMPULUP: D- Pull-Up Enable bit
	 1 = D- data line pull-up resistor is enabled 0 = D- data line pull-up resistor is disabled
bit 5	DPPULDWN: D+ Pull-Down Enable bit
	 1 = D+ data line pull-down resistor is enabled 0 = D+ data line pull-down resistor is disabled
bit 4	DMPULDWN: D- Pull-Down Enable bit
	 1 = D- data line pull-down resistor is enabled 0 = D- data line pull-down resistor is disabled
bit 3	VBUSON: VBUS Power-on bit
	1 = VBUS line is powered0 = VBUS line is not powered
bit 2	OTGEN: OTG Functionality Enable bit
	 1 = DPPULUP, DMPULUP, DPPULDWN and DMPULDWN bits are under software control 0 = DPPULUP, DMPULUP, DPPULDWN and DMPULDWN bits are under USB hardware control
bit 1	VBUSCHG: VBUS Charge Enable bit
	 1 = VBUS line is charged through a pull-up resistor 0 = VBUS line is not charged through a resistor
bit 0	VBUSDIS: VBUS Discharge Enable bit
	1 - Vieus line is discharged through a pull down resistor

- 1 = VBUS line is discharged through a pull-down resistor
- 0 = VBUS line is not discharged through a resistor

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
51.24	_	_	—	—	_		—	_
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	_	_	—	—	_		—	_
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
15.0	_	_	—	—	_		—	_
7:0	R-0	U-0	U-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0
7:0	UACTPND			USLPGRD	USBBUSY ⁽¹⁾		USUSPEND	USBPWR

REGISTER 10-5: U1PWRC: USB POWER CONTROL REGISTER

Legend:

Logona.						
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'				
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

bit 31-8 Unimplemented: Read as '0'

- bit 7 UACTPND: USB Activity Pending bit
 - 1 = USB bus activity has been detected; however, an interrupt is pending, which has yet to be generated
 - 0 = An interrupt is not pending
- bit 6-5 Unimplemented: Read as '0'
- bit 4 USLPGRD: USB Sleep Entry Guard bit
 - 1 = Sleep entry is blocked if USB bus activity is detected or if a notification is pending
 - 0 = USB module does not block Sleep entry
- bit 3 USBBUSY: USB Module Busy bit⁽¹⁾
 - 1 = USB module is active or disabled, but not ready to be enabled
 - 0 = USB module is not active and is ready to be enabled
- bit 2 Unimplemented: Read as '0'
- bit 1 USUSPEND: USB Suspend Mode bit
 - 1 = USB module is placed in Suspend mode
 - (The 48 MHz USB clock will be gated off. The transceiver is placed in a low-power state.)
 - 0 = USB module operates normally
- bit 0 USBPWR: USB Operation Enable bit
 - 1 = USB module is turned on
 - 0 = USB module is disabled

(Outputs held inactive, device pins not used by USB, analog features are shut down to reduce power consumption.)

Note 1: When USBPWR = 0 and USBBUSY = 1, status from all other registers is invalid and writes to all USB module registers produce undefined results.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	—	—	—	—	—	—	—	—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
15.0	_	_	_		—	—	—	_
	R/WC-0, HS	R/WC-0, HS	R/WC-0, HS	R/WC-0, HS	R/WC-0, HS	R/WC-0, HS	R-0	R/WC-0, HS
7:0	STALLIF	ATTACHIF ⁽¹⁾	RESUMEIF ⁽²⁾	IDLEIF	TRNIF ⁽³⁾	SOFIF	UERRIF ⁽⁴⁾	URSTIF ⁽⁵⁾ DETACHIF ⁽⁶⁾

REGISTER 10-6: U1IR: USB INTERRUPT REGISTER

Legend: WC = Write '1' to clear		HS = Hardware Settable bit			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared x = Bit is unknown			

bit 31-8 Unimplemented: Read as '0'

bit 7	STALLIF: STALL Handshake Interrupt bit 1 = In Host mode a STALL handshake was received during the handshake phase of the transaction In Device mode a STALL handshake was transmitted during the handshake phase of the transaction 0 = STALL handshake has not been sent
bit 6	ATTACHIF: Peripheral Attach Interrupt bit ⁽¹⁾ 1 = Peripheral attachment was detected by the USB module 0 = Peripheral attachment was not detected
bit 5	RESUMEIF: Resume Interrupt bit ⁽²⁾ 1 = K-State is observed on the D+ or D- pin for 2.5 μs 0 = K-State is not observed
bit 4	IDLEIF: Idle Detect Interrupt bit 1 = Idle condition detected (constant Idle state of 3 ms or more) 0 = No Idle condition detected
bit 3	 TRNIF: Token Processing Complete Interrupt bit⁽³⁾ 1 = Processing of current token is complete; a read of the U1STAT register will provide endpoint information 0 = Processing of current token not complete
bit 2	SOFIF: SOF Token Interrupt bit 1 = SOF token received by the peripheral or the SOF threshold reached by the host 0 = SOF token was not received nor threshold reached
bit 1	UERRIF : USB Error Condition Interrupt bit ⁽⁴⁾ 1 = Unmasked error condition has occurred 0 = Unmasked error condition has not occurred
bit 0	 URSTIF: USB Reset Interrupt bit (Device mode)⁽⁵⁾ 1 = Valid USB Reset has occurred 0 = No USB Reset has occurred DETACHIF: USB Detach Interrupt bit (Host mode)⁽⁶⁾ 1 = Peripheral detachment was detected by the USB module 0 = Peripheral detachment was not detected
Note	 This bit is valid only if the HOSTEN bit is set (see Register 10-11), there is no activity on the USB for 2.5 µs, and the current bus state is not SE0. When not in Suspend mode, this interrupt should be disabled. Clearing this bit will cause the STAT FIFO to advance. Only error conditions enabled through the U1EIE register will set this bit. Device mode. Host mode.

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Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0						
31.24	—	—	—	—	—	—	—	—
23:16	U-0	U-0						
23.10	_	_	_	—	_	_	_	_
15:8	U-0	U-0						
15.0	_	_	_	—	_	_	_	_
	R/W-0	R/W-0						
7:0	STALLIE	ATTACHIE	RESUMEIE	IDLEIE	TRNIE	SOFIE	UERRIE ⁽¹⁾	URSTIE ⁽²⁾ DETACHIE ⁽³⁾

REGISTER 10-7: U1IE: USB INTERRUPT ENABLE REGISTER

Legend:

R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 31-8 Unimplemented: Read as '0'

bit 7	STALLIE: STALL Handshake Interrupt Enable bit
	1 = STALL interrupt is enabled

- 0 = STALL interrupt is disabled
- bit 6 **ATTACHIE:** ATTACH Interrupt Enable bit 1 = ATTACH interrupt is enabled
 - 0 = ATTACH interrupt is disabled
- bit 5 **RESUMEIE:** RESUME Interrupt Enable bit
 - 1 = RESUME interrupt is enabled
 - 0 = RESUME interrupt is disabled
- bit 4 IDLEIE: Idle Detect Interrupt Enable bit
 - 1 = Idle interrupt is enabled
 - 0 = Idle interrupt is disabled
- bit 3 TRNIE: Token Processing Complete Interrupt Enable bit
 - 1 = TRNIF interrupt is enabled
 - 0 = TRNIF interrupt is disabled
- bit 2 SOFIE: SOF Token Interrupt Enable bit
 - 1 = SOFIF interrupt is enabled
 - 0 = SOFIF interrupt is disabled
- bit 1 UERRIE: USB Error Interrupt Enable bit⁽¹⁾
 - 1 = USB Error interrupt is enabled
 - 0 = USB Error interrupt is disabled
- bit 0 URSTIE: USB Reset Interrupt Enable bit⁽²⁾ 1 = URSTIF interrupt is enabled 0 = URSTIF interrupt is disabled
 - **DETACHIE:** USB Detach Interrupt Enable bit⁽³⁾
 - 1 = DATTCHIF interrupt is enabled
 - 0 = DATTCHIF interrupt is disabled
- **Note 1:** For an interrupt to propagate USBIF, the UERRIE (U1IE<1>) bit must be set.
 - 2: Device mode.
 - 3: Host mode.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
01.04	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
31:24	—	_	—	_	_	_	—	_	
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
23.10	—	_	—	_	_	_	—	_	
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
15.0	—	-	—	-	-	-	—	_	
	R/WC-0, HS	R/WC-0, HS	R/WC-0, HS	R/WC-0, HS	R/WC-0, HS	R/WC-0, HS	R/WC-0, HS	R/WC-0, HS	
7:0	BTSEF	BMXEF	DMAEF ⁽¹⁾	BTOEF ⁽²⁾	DFN8EF	CRC16EF	CRC5EF ⁽⁴⁾	PIDEF	
	DIGEF	DIVIALE	DIVIALLY	BIUER	DENOEE	UNC IDEF	EOFEF ^(3,5)		

REGISTER 10-8: U1EIR: USB ERROR INTERRUPT STATUS REGISTER

Legend:	WC = Write '1' to clear	HS = Hardware Settable bit			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'			
n = Value at POR (1' = Bit is set		'0' = Bit is cleared	x = Bit is unknown		

bit 31-8 Unimplemented: Read as '0'

- bit 7 BTSEF: Bit Stuff Error Flag bit
 - 1 = Packet rejected due to bit stuff error
 - 0 = Packet accepted

bit 6 BMXEF: Bus Matrix Error Flag bit

- 1 = The base address, of the Buffer Descriptor Table, or the address of an individual buffer pointed to by a Buffer Descriptor Table entry, is invalid.
- 0 = No address error
- bit 5 **DMAEF:** DMA Error Flag bit⁽¹⁾
 - 1 = USB DMA error condition detected
 - 0 = No DMA error
- bit 4 **BTOEF:** Bus Turnaround Time-Out Error Flag bit⁽²⁾
 - 1 = Bus turnaround time-out has occurred
 - 0 = No bus turnaround time-out

bit 3 **DFN8EF:** Data Field Size Error Flag bit

- 1 = Data field received is not an integral number of bytes
- 0 = Data field received is an integral number of bytes

bit 2 CRC16EF: CRC16 Failure Flag bit

- 1 = Data packet rejected due to CRC16 error
- 0 = Data packet accepted
- **Note 1:** This type of error occurs when the module's request for the DMA bus is not granted in time to service the module's demand for memory, resulting in an overflow or underflow condition, and/or the allocated buffer size is not sufficient to store the received data packet causing it to be truncated.
 - **2:** This type of error occurs when more than 16-bit-times of Idle from the previous End-of-Packet (EOP) has elapsed.
 - **3:** This type of error occurs when the module is transmitting or receiving data and the SOF counter has reached zero.
 - 4: Device mode.
 - 5: Host mode.

REGISTER 10-8: U1EIR: USB ERROR INTERRUPT STATUS REGISTER (CONTINUED)

- bit 1 CRC5EF: CRC5 Host Error Flag bit⁽⁴⁾
 - 1 = Token packet rejected due to CRC5 error
 - 0 = Token packet accepted
 - EOFEF: EOF Error Flag bit^(3,5)
 - 1 = An EOF error condition was detected
 - 0 = No EOF error condition was detected
- bit 0 PIDEF: PID Check Failure Flag bit
 - 1 = PID check failed
 - 0 = PID check passed
- **Note 1:** This type of error occurs when the module's request for the DMA bus is not granted in time to service the module's demand for memory, resulting in an overflow or underflow condition, and/or the allocated buffer size is not sufficient to store the received data packet causing it to be truncated.
 - **2:** This type of error occurs when more than 16-bit-times of Idle from the previous End-of-Packet (EOP) has elapsed.
 - **3:** This type of error occurs when the module is transmitting or receiving data and the SOF counter has reached zero.
 - 4: Device mode.
 - 5: Host mode.

Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
—	_		—			_		
U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
—	_		—	—	—	_		
U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
—	_		—	—	—	_		
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
BTSEE	BMXEE		BTOFE		CRC16EE	CRC5EE ⁽¹⁾	PIDEE	
DIGLE	DIVIALL	DIVIAEE	DIOLL	DENOEE	CRUIDEE	EOFEE ⁽²⁾	PIDEE	
	Bit 31/23/15/7 U-0 U-0 U-0 U-0 U-0	Bit 31/23/15/7 Bit 30/22/14/6 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 H-0 U-0 H-0 U-0 H-0 U-0 H-0 H-0 H-0 H-0	Bit 31/23/15/7 Bit 30/22/14/6 Bit 29/21/13/5 U-0 U-0 U-0 H-0 H-0 H-0 H-0 H-0 H-0 H-0 H-0 H-0	Bit 31/23/15/7 Bit 30/22/14/6 Bit 29/21/13/5 Bit 28/20/12/4 U-0 U-0 U-0 H-0 H-0 H-0 H-0 H-0 H-0 H-0 H-0 H-0 H-0 H-0 H-0	Bit 31/23/15/7 Bit 30/22/14/6 Bit 29/21/13/5 Bit 28/20/12/4 Bit 27/19/11/3 U-0 U-0 U-0 U-0 U-0 H-0 H-0 H-0 H-0 H-0 H-0 RW-0 RW-0 RW-0 RW-0	Bit 31/23/15/7 Bit 30/22/14/6 Bit 29/21/13/5 Bit 28/20/12/4 Bit 27/19/11/3 Bit 26/18/10/2 U-0 U-0 U-0 U-0 U-0 U-0 H-0 U-0 U-0 U-0 U-0 U-0 H-0 U-0 U-0 U-0 U-0 U-0 U-0 H-0 H-0 H-0 H-0 H-0 H-0 H-0 H-0 H-0 H-0 H-0 H-0 H-0 H-0 H-0	Bit 31/23/15/7 Bit 30/22/14/6 Bit 29/21/13/5 Bit 28/20/12/4 Bit 27/19/11/3 Bit 26/18/10/2 Bit 25/17/9/1 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 RW-0 RW-0 RW-0	

REGISTER 10-9: U1EIE: USB ERROR INTERRUPT ENABLE REGISTER

Legend:

0					
R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 31-8 Unimplemented: Read as '0'

bit 7	BTSEE: Bit Stuff Error Interrupt Enable bit
	1 = BTSEF interrupt is enabled

- 0 = BTSEF interrupt is disabled
- bit 6 BMXEE: Bus Matrix Error Interrupt Enable bit
 - 1 = BMXEF interrupt is enabled
 - 0 = BMXEF interrupt is disabled
- bit 5 **DMAEE:** DMA Error Interrupt Enable bit
 - 1 = DMAEF interrupt is enabled
 - 0 = DMAEF interrupt is disabled
- bit 4 BTOEE: Bus Turnaround Time-out Error Interrupt Enable bit
 - 1 = BTOEF interrupt is enabled
 - 0 = BTOEF interrupt is disabled
- bit 3 **DFN8EE:** Data Field Size Error Interrupt Enable bit
 - 1 = DFN8EF interrupt is enabled
 - 0 = DFN8EF interrupt is disabled
- bit 2 CRC16EE: CRC16 Failure Interrupt Enable bit
 - 1 = CRC16EF interrupt is enabled
 - 0 = CRC16EF interrupt is disabled
- bit 1 CRC5EE: CRC5 Host Error Interrupt Enable bit⁽¹⁾
 - 1 = CRC5EF interrupt is enabled
 - 0 = CRC5EF interrupt is disabled
 - EOFEE: EOF Error Interrupt Enable bit⁽²⁾
 - 1 = EOF interrupt is enabled
 - 0 = EOF interrupt is disabled
- bit 0 PIDEE: PID Check Failure Interrupt Enable bit
 - 1 = PIDEF interrupt is enabled
 - 0 = PIDEF interrupt is disabled
- Note 1: Device mode.
 - 2: Host mode.

Note: For an interrupt to propagate the USBIF register, the UERRIE (U1IE<1>) bit must be set.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
51.24				—		_	-	—	
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
23.10				—		_	-	—	
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
15.0	-	-	-	—	-	_	—	—	
7:0	R-x	R-x	R-x	R-x	R-x	R-x	U-0	U-0	
7:0		ENDP	T<3:0>		DIR	PPBI		_	

REGISTER 10-10: U1STAT: USB STATUS REGISTER

Legend:

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, I	read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-8 Unimplemented: Read as '0'

- bit 7-4 ENDPT<3:0>: Encoded Number of Last Endpoint Activity bits (Represents the number of the Buffer Descriptor Table, updated by the last USB transfer.) 1111 = Endpoint 15 1110 = Endpoint 14 0001 = Endpoint 1 0000 = Endpoint 0 DIR: Last Buffer Descriptor Direction Indicator bit bit 3 1 = Last transaction was a transmit (TX) transfer 0 = Last transaction was a receive (RX) transfer bit 2 PPBI: Ping-Pong Buffer Descriptor Pointer Indicator bit 1 = The last transaction was to the ODD Buffer Descriptor bank 0 = The last transaction was to the EVEN Buffer Descriptor bank
- bit 1-0 Unimplemented: Read as '0'

The U1STAT register is a window into a 4-byte FIFO maintained by the USB module. U1STAT value is only Note: valid when the TRNIF (U1IR<3>) bit is active. Clearing the TRNIF bit advances the FIFO. Data in register is invalid when the TRNIF bit = 0.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	_	_	_	_	_	_	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	_	_	—	—	_	_	—	—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
15.6			_	—	_	—	—	—
	R-x	R-x	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
7:0			PKTDIS ⁽⁴⁾	- USBRST	HOSTEN ⁽²⁾	RESUME ⁽³⁾	PPBRST	USBEN ⁽⁴⁾
	JSTATE		TOKBUSY ^(1,5)		HUSTEN 7	RESUME ?	PPBR51	SOFEN ⁽⁵⁾

REGISTER 10-11: U1CON: USB CONTROL REGISTER

Legend:	
---------	--

Logonal			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-8 Unimplemented: Read as '0'

bit 7	JSTATE: Live Differential Receiver JSTATE flag bit
	1 = JSTATE was detected on the USB
	0 = No JSTATE was detected

bit 6 **SE0:** Live Single-Ended Zero flag bit 1 = Single-Ended Zero was detected on the USB

0 = No Single-Ended Zero was detected

bit 5 **PKTDIS:** Packet Transfer Disable bit⁽⁴⁾

1 = Token and packet processing is disabled (set upon SETUP token received)

0 = Token and packet processing is enabled

- TOKBUSY: Token Busy Indicator bit^(1,5)
- 1 = Token is being executed by the USB module
- 0 = No token is being executed
- bit 4 USBRST: Module Reset bit⁽⁵⁾
 - 1 = USB reset generated
 - 0 = USB reset terminated
- bit 3 HOSTEN: Host Mode Enable bit⁽²⁾
 - 1 = USB host capability is enabled
 - 0 = USB host capability is disabled
- bit 2 **RESUME:** RESUME Signaling Enable bit⁽³⁾
 - 1 = RESUME signaling is activated
 - 0 = RESUME signaling is disabled
- **Note 1:** Software is required to check this bit before issuing another token command to the U1TOK register (see Register 10-15).
 - 2: All host control logic is reset any time that the value of this bit is toggled.
 - 3: Software must set RESUME for 10 ms if the part is a function, or for 25 ms if the part is a host, and then clear it to enable remote wake-up. In Host mode, the USB module will append a Low-Speed EOP to the RESUME signaling when this bit is cleared.
 - 4: Device mode.
 - 5: Host mode.

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REGISTER 10-11: U1CON: USB CONTROL REGISTER (CONTINUED)

- bit 1 **PPBRST:** Ping-Pong Buffers Reset bit
 - 1 = Reset all Even/Odd buffer pointers to the EVEN Buffer Descriptor banks
 - 0 = Even/Odd buffer pointers are not Reset
- bit 0 USBEN: USB Module Enable bit⁽⁴⁾
 - 1 = USB module and supporting circuitry is enabled
 - 0 = USB module and supporting circuitry is disabled

SOFEN: SOF Enable bit⁽⁵⁾

- 1 = SOF token is sent every 1 ms
- 0 = SOF token is disabled
- **Note 1:** Software is required to check this bit before issuing another token command to the U1TOK register (see Register 10-15).
 - 2: All host control logic is reset any time that the value of this bit is toggled.
 - **3:** Software must set RESUME for 10 ms if the part is a function, or for 25 ms if the part is a host, and then clear it to enable remote wake-up. In Host mode, the USB module will append a Low-Speed EOP to the RESUME signaling when this bit is cleared.
 - 4: Device mode.
 - 5: Host mode.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	-	_	-	-	-	-	-	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	-	_	_	-	-	_	-	—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
15.6								—
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
7:0	LSPDEN			D	EVADDR<6:0	>		

REGISTER 10-12: U1ADDR: USB ADDRESS REGISTER

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-8 Unimplemented: Read as '0'

- bit 7 LSPDEN: Low-Speed Enable Indicator bit
 - 1 = Next token command to be executed at Low-Speed
 - 0 = Next token command to be executed at Full-Speed
- bit 6-0 **DEVADDR<6:0>:** 7-bit USB Device Address bits

REGISTER 10-13: U1FRML: USB FRAME NUMBER LOW REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	_	—	—	—	—	_	-	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	_	—	—	—	—	_	-	—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
15.0		—	—	—	—			—
7:0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
7:0				FRML	<7:0>			

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-8 Unimplemented: Read as '0'

bit 7-0 **FRML<7:0>:** The 11-bit Frame Number Lower bits The register bits are updated with the current frame number whenever a SOF TOKEN is received.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	—	_	-	-	_	-	-	_
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	—	_	_	_	_	_	_	_
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
10.0	—	_	_	-	_	_	-	—
7:0	U-0	U-0	U-0	U-0	U-0	R-0	R-0	R-0
				_	_		FRMH<2:0>	

REGISTER 10-14: U1FRMH: USB FRAME NUMBER HIGH REGISTER

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, r	read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-3 Unimplemented: Read as '0'

bit 2-0 **FRMH<2:0>:** The Upper 3 bits of the Frame Numbers bits The register bits are updated with the current frame number whenever a SOF TOKEN is received.

REGISTER 10-15: U1TOK: USB TOKEN REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
21.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
31:24	-	_	-	-	-	-	—	—	
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
23.10	-	_			-	-	_	—	
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
10.0	_	_	-	-	_	_	—	—	
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
		PID<3	3:0> (1)		EP<3:0>				

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-8 Unimplemented: Read as '0'

bit 7-4 PID<3:0>: Token Type Indicator bits⁽¹⁾

- 1101 = SETUP (TX) token type transaction
 - 1001 = IN (RX) token type transaction
 - 0001 = OUT (TX) token type transaction
 - Note: All other values are reserved and must not be used.

bit 3-0 **EP<3:0>:** Token Command Endpoint Address bits The four bit value must specify a valid endpoint.

Note 1: All other values are reserved and must not be used.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
21.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	_	-	-	-	-	_	-	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	—	_	—	_	—	_	-	—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
15.6	_	_	_		_			—
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
				CNT	<7:0>			

REGISTER 10-16: U1SOF: USB SOF THRESHOLD REGISTER

Legend:

R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 31-8 Unimplemented: Read as '0'

bit 7-0 **CNT<7:0>:** SOF Threshold Value bits Typical values of the threshold are: 01001010 = 64-byte packet 00101010 = 32-byte packet 00011010 = 16-byte packet 00010010 = 8-byte packet

REGISTER 10-17: U1BDTP1: USB BUFFER DESCRIPTOR TABLE PAGE 1 REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	-	-	-	-	-	—	-	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10		-				—		—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
10.0		-	-			—	-	—
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0
7:0			B	DTPTRL<15:9)>			—

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-8 Unimplemented: Read as '0'

bit 7-1 **BDTPTRL<15:9>:** Buffer Descriptor Table Base Address bits This 7-bit value provides address bits 15 through 9 of the Buffer Descriptor Table base address, which defines the starting location of the Buffer Descriptor Table in system memory. The 32-bit Buffer Descriptor Table base address is 512-byte aligned.

bit 0 Unimplemented: Read as '0'

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
51.24	-		-	—	-	—	-	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	_	-	—	—	-	—	-	—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
15.0	_		_	—		—		—
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
7:0				BDTPTR	H<23:16>			

REGISTER 10-18: U1BDTP2: USB BUFFER DESCRIPTOR TABLE PAGE 2 REGISTER

Legend:

0				
R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 31-8 Unimplemented: Read as '0'

bit 7-0 **BDTPTRH<23:16>:** Buffer Descriptor Table Base Address bits This 8-bit value provides address bits 23 through 16 of the Buffer Descriptor Table base address, which defines the starting location of the Buffer Descriptor Table in system memory.

The 32-bit Buffer Descriptor Table base address is 512-byte aligned.

NEGIO								
Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
21.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	-	—	_	-	—	_	-	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	_	—	_	_	_	_	-	—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
15.0	-	—	_	-	_	_	-	—
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
				BDTPTR	U<31:24>			

REGISTER 10-19: U1BDTP3: USB BUFFER DESCRIPTOR TABLE PAGE 3 REGISTER

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-8 Unimplemented: Read as '0'

bit 7-0 **BDTPTRU<31:24>:** Buffer Descriptor Table Base Address bits This 8-bit value provides address bits 31 through 24 of the Buffer Descriptor Table base address, defines the starting location of the Buffer Descriptor Table in system memory. The 32-bit Buffer Descriptor Table base address is 512-byte aligned.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24			_	_				—
22:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	_	-	—	—	-	-	—	—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
15.0			_	_			_	—
7.0	R/W-0	R/W-0	U-0	R/W-0	U-0	U-0	U-0	R/W-0
7:0	UTEYE	UOEMON	_	USBSIDL				UASUSPND

REGISTER 10-20: U1CNFG1: USB CONFIGURATION 1 REGISTER

Legend:

R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 31-8 Unimplemented: Read as '0'

- bit 7 UTEYE: USB Eye-Pattern Test Enable bit
 - 1 = Eye-Pattern Test is enabled
 - 0 = Eye-Pattern Test is disabled
- bit 6 **UOEMON:** USB OE Monitor Enable bit
 - 1 = OE signal is active; it indicates intervals during which the D+/D- lines are driving
 0 = OE signal is inactive
- bit 5 Unimplemented: Read as '0'
- bit 4 **USBSIDL:** Stop in Idle Mode bit
 - 1 = Discontinue module operation when the device enters Idle mode
 - 0 = Continue module operation when the device enters Idle mode
- bit 3-1 Unimplemented: Read as '0'

bit 0 UASUSPND: Automatic Suspend Enable bit

- 1 = USB module automatically suspends upon entry to Sleep mode. See the USUSPEND bit (U1PWRC<1>) in Register 10-5.
- 0 = USB module does not automatically suspend upon entry to Sleep mode. Software must use the USUSPEND bit (U1PWRC<1>) to suspend the module, including the USB 48 MHz clock.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	-	_	-	_		-	-	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	-	—	—	—	—	-	—	—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
10.0		—	_	—	_		_	—
7:0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
7:0	LSPD	RETRYDIS		EPCONDIS	EPRXEN	EPTXEN	EPSTALL	EPHSHK

REGISTER 10-21: U1EP0-U1EP15: USB ENDPOINT CONTROL REGISTER

Legend:

bit 6

R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-8 Unimplemented: Read as '0'

- bit 7 LSPD: Low-Speed Direct Connection Enable bit (Host mode and U1EP0 only)
 - 1 = Direct connection to a Low-Speed device enabled
 - 0 = Direct connection to a Low-Speed device disabled; hub required with PRE_PID
 - RETRYDIS: Retry Disable bit (Host mode and U1EP0 only)
 - 1 = Retry NAKed transactions disabled
 - 0 = Retry NAKed transactions enabled; retry done in hardware

bit 5 Unimplemented: Read as '0'

- bit 4 EPCONDIS: Bidirectional Endpoint Control bit
 - If EPTXEN = 1 and EPRXEN = 1:

1 = Disable Endpoint n from Control transfers; only TX and RX transfers allowed

- 0 = Enable Endpoint n for Control (SETUP) transfers; TX and RX transfers also allowed Otherwise, this bit is ignored.
- bit 3 **EPRXEN:** Endpoint Receive Enable bit
 - 1 = Endpoint n receive is enabled
 - 0 = Endpoint n receive is disabled
- bit 2 EPTXEN: Endpoint Transmit Enable bit
 - 1 = Endpoint n transmit is enabled
 - 0 = Endpoint n transmit is disabled
- bit 1 EPSTALL: Endpoint Stall Status bit
 - 1 = Endpoint n was stalled
 - 0 = Endpoint n was not stalled
- bit 0 EPHSHK: Endpoint Handshake Enable bit
 - 1 = Endpoint Handshake is enabled
 - 0 = Endpoint Handshake is disabled (typically used for isochronous endpoints)

11.0 I/O PORTS

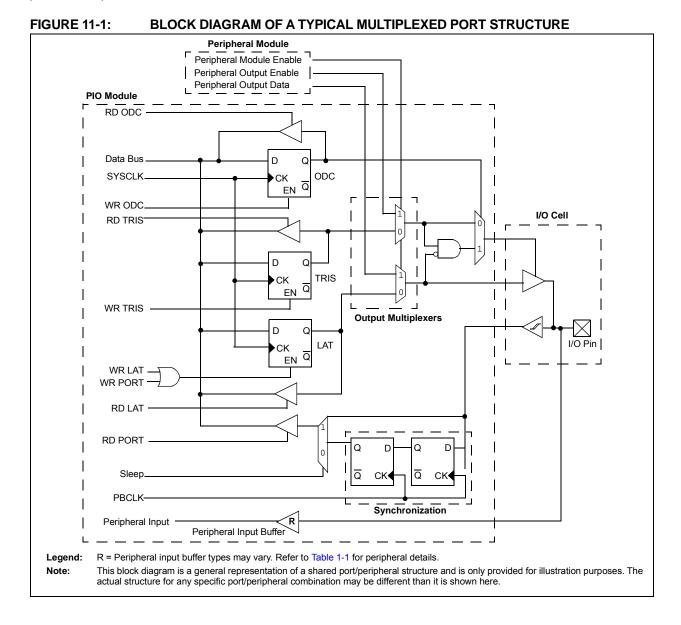
Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 12. "I/O Ports" (DS60001120), which is available from the *Documentation* > *Reference Manual* section of the Microchip PIC32 web site (www.microchip.com/pic32).

General purpose I/O pins are the simplest of peripherals. They allow the PIC[®] MCU to monitor and control other devices. To add flexibility and functionality, some pins are multiplexed with alternate functions. These functions depend on which peripheral features are on the device. In general, when a peripheral is functioning, that pin may not be used as a general purpose I/O pin.

Key features of this module include:

- · Individual output pin open-drain enable/disable
- · Individual input pin weak pull-up and pull-down
- Monitor selective inputs and generate interrupt when change in pin state is detected
- Operation during Sleep and Idle modes
- Fast bit manipulation using CLR, SET, and INV registers

Figure 11-1 illustrates a block diagram of a typical multiplexed I/O port.



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11.1 Parallel I/O (PIO) Ports

All port pins have 10 registers directly associated with their operation as digital I/O. The data direction register (TRISx) determines whether the pin is an input or an output. If the data direction bit is a '1', then the pin is an input. All port pins are defined as inputs after a Reset. Reads from the latch (LATx) read the latch. Writes to the latch write the latch. Reads from the port (PORTx) read the port pins, while writes to the port pins write the latch.

11.1.1 OPEN-DRAIN CONFIGURATION

In addition to the PORTx, LATx, and TRISx registers for data control, some port pins can also be individually configured for either digital or open-drain output. This is controlled by the Open-Drain Control register, ODCx, associated with each port. Setting any of the bits configures the corresponding pin to act as an open-drain output.

The open-drain feature allows the generation of outputs higher than VDD (e.g., 5V) on any desired 5V-tolerant pins by using external pull-up resistors. The maximum open-drain voltage allowed is the same as the maximum VIH specification.

See the **"Pin Diagrams"** section for the available pins and their functionality.

11.1.2 CONFIGURING ANALOG AND DIGITAL PORT PINS

The ANSELx register controls the operation of the analog port pins. The port pins that are to function as analog inputs must have their corresponding ANSEL and TRIS bits set. In order to use port pins for I/O functionality with digital modules, such as Timers, UARTs, etc., the corresponding ANSELx bit must be cleared.

The ANSELx register has a default value of 0xFFFF; therefore, all pins that share analog functions are analog (not digital) by default.

If the TRIS bit is cleared (output) while the ANSELx bit is set, the digital output level (VOH or VOL) is converted by an analog peripheral, such as the ADC module or Comparator module.

When the PORT register is read, all pins configured as analog input channels are read as cleared (a low level).

Pins configured as digital inputs do not convert an analog input. Analog levels on any pin defined as a digital input (including the ANx pins) can cause the input buffer to consume current that exceeds the device specifications.

11.1.3 I/O PORT WRITE/READ TIMING

One instruction cycle is required between a port direction change or port write operation and a read operation of the same port. Typically this instruction would be a NOP.

11.1.4 INPUT CHANGE NOTIFICATION

The input change notification function of the I/O ports allows the PIC32MX1XX/2XX 28/36/44-pin Family devices to generate interrupt requests to the processor in response to a change-of-state on selected input pins. This feature can detect input change-of-states even in Sleep mode, when the clocks are disabled. Every I/O port pin can be selected (enabled) for generating an interrupt request on a change-of-state.

Five control registers are associated with the CN functionality of each I/O port. The CNENx registers contain the CN interrupt enable control bits for each of the input pins. Setting any of these bits enables a CN interrupt for the corresponding pins.

The CNSTATx register indicates whether a change occurred on the corresponding pin since the last read of the PORTx bit.

Each I/O pin also has a weak pull-up and a weak pull-down connected to it. The pull-ups act as a current source or sink source connected to the pin, and eliminate the need for external resistors when push-button or keypad devices are connected. The pull-ups and pull-downs are enabled separately using the CNPUx and the CNPDx registers, which contain the control bits for each of the pins. Setting any of the control bits enables the weak pull-ups and/or pull-downs for the corresponding pins.

Note:	Pull-ups and pull-downs on change notifi-
	cation pins should always be disabled
	when the port pin is configured as a digital
	output.

An additional control register (CNCONx) is shown in Register 11-3.

11.2 CLR, SET and INV Registers

Every I/O module register has a corresponding CLR (clear), SET (set) and INV (invert) register designed to provide fast atomic bit manipulations. As the name of the register implies, a value written to a SET, CLR or INV register effectively performs the implied operation, but only on the corresponding base register and only bits specified as '1' are modified. Bits specified as '0' are not modified.

Reading SET, CLR and INV registers returns undefined values. To see the affects of a write operation to a SET, CLR, or INV register, the base register must be read.

11.3 Peripheral Pin Select

A major challenge in general purpose devices is providing the largest possible set of peripheral features while minimizing the conflict of features on I/O pins. The challenge is even greater on low pin-count devices. In an application where more than one peripheral needs to be assigned to a single pin, inconvenient workarounds in application code or a complete redesign may be the only option.

The Peripheral Pin Select (PPS) configuration provides an alternative to these choices by enabling peripheral set selection and their placement on a wide range of I/O pins. By increasing the pinout options available on a particular device, users can better tailor the device to their entire application, rather than trimming the application to fit the device.

The PPS configuration feature operates over a fixed subset of digital I/O pins. Users may independently map the input and/or output of most digital peripherals to these I/O pins. PPS is performed in software and generally does not require the device to be reprogrammed. Hardware safeguards are included that prevent accidental or spurious changes to the peripheral mapping once it has been established.

11.3.1 AVAILABLE PINS

The number of available pins is dependent on the particular device and its pin count. Pins that support the PPS feature include the designation "RPn" in their full pin designation, where "RP" designates a remappable peripheral and "n" is the remappable port number.

11.3.2 AVAILABLE PERIPHERALS

The peripherals managed by the PPS are all digitalonly peripherals. These include general serial communications (UART and SPI), general purpose timer clock inputs, timer-related peripherals (input capture and output compare) and interrupt-on-change inputs.

In comparison, some digital-only peripheral modules are never included in the PPS feature. This is because the peripheral's function requires special I/O circuitry on a specific port and cannot be easily connected to multiple pins. These modules include I²C among others. A similar requirement excludes all modules with analog inputs, such as the Analog-to-Digital Converter (ADC).

A key difference between remappable and non-remappable peripherals is that remappable peripherals are not associated with a default I/O pin. The peripheral must always be assigned to a specific I/O pin before it can be used. In contrast, non-remappable peripherals are always available on a default pin, assuming that the peripheral is active and not conflicting with another peripheral.

When a remappable peripheral is active on a given I/O pin, it takes priority over all other digital I/O and digital communication peripherals associated with the pin.

Priority is given regardless of the type of peripheral that is mapped. Remappable peripherals never take priority over any analog functions associated with the pin.

11.3.3 CONTROLLING PERIPHERAL PIN SELECT

PPS features are controlled through two sets of SFRs: one to map peripheral inputs, and one to map outputs. Because they are separately controlled, a particular peripheral's input and output (if the peripheral has both) can be placed on any selectable function pin without constraint.

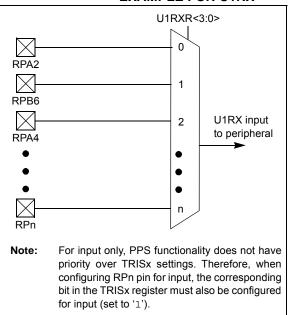
The association of a peripheral to a peripheral-selectable pin is handled in two different ways, depending on whether an input or output is being mapped.

11.3.4 INPUT MAPPING

The inputs of the PPS options are mapped on the basis of the peripheral. That is, a control register associated with a peripheral dictates the pin it will be mapped to. The [*pin name*]R registers, where [*pin name*] refers to the peripheral pins listed in Table 11-1, are used to configure peripheral input mapping (see Register 11-1). Each register contains sets of 4 bit fields. Programming these bit fields with an appropriate value maps the RPn pin with the corresponding value to that peripheral. For any given device, the valid range of values for any bit field is shown in Table 11-1.

For example, Figure 11-2 illustrates the remappable pin selection for the U1RX input.

FIGURE 11-2: REMAPPABLE INPUT EXAMPLE FOR U1RX



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TABLE 11-1: INPUT PIN SELECTION

Peripheral Pin	[pin name]R SFR	[pin name]R bits	[<i>pin name</i>]R Value to RPn Pin Selection
INT4	INT4R	INT4R<3:0>	0000 = RPA0 0001 = RPB3
T2CK	T2CKR	T2CKR<3:0>	0010 = RPB4 0011 = RPB15 0100 = RPB7
IC4	IC4R	IC4R<3:0>	0101 = RPC7 ⁽²⁾ 0110 = RPC0 ⁽¹⁾ 0111 = RPC5 ⁽²⁾
SS1	SS1R	SS1R<3:0>	1000 = Reserved
REFCLKI	REFCLKIR	REFCLKIR<3:0>	· 1111 = Reserved
INT3	INT3R	INT3R<3:0>	0000 = RPA1 0001 = RPB5
ТЗСК	T3CKR	T3CKR<3:0>	0010 = RPB1 0011 = RPB11
IC3	IC3R	IC3R<3:0>	0100 = RPB8 0101 = RPA8 ⁽²⁾
U1CTS	U1CTSR	U1CTSR<3:0>	0110 = RPC8 ⁽²⁾ 0111 = RPA9 ⁽²⁾
U2RX	U2RXR	U2RXR<3:0>	1000 = Reserved
SDI1	SDI1R	SDI1R<3:0>	• 1111 = Reserved
INT2	INT2R	INT2R<3:0>	0000 = RPA2
T4CK	T4CKR	T4CKR<3:0>	
IC1	IC1R	IC1R<3:0>	0011 = RPB13 0100 = RPB2
IC5	IC5R	IC5R<3:0>	0101 = RPC6 ⁽²⁾
U1RX	U1RXR	U1RXR<3:0>	0110 = RPC1 ⁽¹⁾ 0111 = RPC3 ⁽¹⁾
U2CTS	U2CTSR	U2CTSR<3:0>	1000 = Reserved
SDI2	SDI2R	SDI2R<3:0>	
OCFB	OCFBR	OCFBR<3:0>	• 1111 = Reserved
INT1	INT1R	INT1R<3:0>	0000 = RPA3 0001 = RPB14
T5CK	T5CKR	T5CKR<3:0>	0010 = RPB0 0011 = RPB10 0100 = RPB9
IC2	IC2R	IC2R<3:0>	0101 = RPC9 ⁽¹⁾ 0110 = RPC2 ⁽²⁾ 0111 = RPC4 ⁽²⁾
SS2	SS2R	SS2R<3:0>	1000 = Reserved
OCFA	OCFAR	OCFAR<3:0>	• • 1111 = Reserved

Note 1: This pin is not available on 28-pin devices.

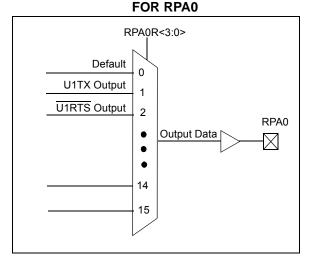
2: This pin is only available on 44-pin devices.

11.3.5 OUTPUT MAPPING

In contrast to inputs, the outputs of the PPS options are mapped on the basis of the pin. In this case, a control register associated with a particular pin dictates the peripheral output to be mapped. The RPnR registers (Register 11-2) are used to control output mapping. Like the [*pin name*]R registers, each register contains sets of 4 bit fields. The value of the bit field corresponds to one of the peripherals, and that peripheral's output is mapped to the pin (see Table 11-2 and Figure 11-3).

A null output is associated with the output register reset value of '0'. This is done to ensure that remappable outputs remain disconnected from all output pins by default.

FIGURE 11-3: EXAMPLE OF MULTIPLEXING OF REMAPPABLE OUTPUT



11.3.6 CONTROLLING CONFIGURATION CHANGES

Because peripheral remapping can be changed during run time, some restrictions on peripheral remapping are needed to prevent accidental configuration changes. PIC32 devices include two features to prevent alterations to the peripheral map:

- Control register lock sequence
- Configuration bit select lock

11.3.6.1 Control Register Lock Sequence

Under normal operation, writes to the RPnR and [*pin name*]R registers are not allowed. Attempted writes appear to execute normally, but the contents of the registers remain unchanged. To change these registers, they must be unlocked in hardware. The register lock is controlled by the Configuration bit, IOLOCK (CFGCON<13>). Setting IOLOCK prevents writes to the control registers; clearing IOLOCK allows writes.

To set or clear the IOLOCK bit, an unlock sequence must be executed. Refer to **Section 6. "Oscillator"** (DS60001112) in the *"PIC32 Family Reference Manual"* for details.

11.3.6.2 Configuration Bit Select Lock

As an additional level of safety, the device can be configured to prevent more than one write session to the RPnR and [*pin name*]R registers. The Configuration bit, IOL1WAY (DEVCFG3<29>), blocks the IOLOCK bit from being cleared after it has been set once. If IOLOCK remains set, the register unlock procedure does not execute, and the PPS control registers cannot be written to. The only way to clear the bit and reenable peripheral remapping is to perform a device Reset.

In the default (unprogrammed) state, IOL1WAY is set, restricting users to one write session.

TABLE 11-2: OUTPUT PIN SELECTION

RPn Port Pin	RPnR SFR	RPnR bits	RPnR Value to Peripheral Selection
RPA0	RPA0R	RPA0R<3:0>	0000 = No Connect
RPB3	RPB3R	RPB3R<3:0>	
RPB4	RPB4R	RPB4R<3:0>	0011 = SS1
RPB15	RPB15R	RPB15R<3:0>	
RPB7	RPB7R	RPB7R<3:0>	0110 = Reserved 0111 = C2OUT
RPC7	RPC7R	RPC7R<3:0>	1000 = Reserved
RPC0	RPC0R	RPC0R<3:0>	
RPC5	RPC5R	RPC5R<3:0>	• 1111 = Reserved
RPA1	RPA1R	RPA1R<3:0>	0000 = No Connect
RPB5	RPB5R	RPB5R<3:0>	0001 = Reserved 0010 = Reserved
RPB1	RPB1R	RPB1R<3:0>	0011 = SDO1
RPB11	RPB11R	RPB11R<3:0>	0100 = SDO2 0101 = OC2
RPB8	RPB8R	RPB8R<3:0>	0110 = Reserved
RPA8	RPA8R	RPA8R<3:0>	0111 = C3OUT
RPC8	RPC8R	RPC8R<3:0>	•
RPA9	RPA9R	RPA9R<3:0>	1111 = Reserved
RPA2	RPA2R	RPA2R<3:0>	0000 = No Connect 0001 = Reserved
RPB6	RPB6R	RPB6R<3:0>	0010 = Reserved
RPA4	RPA4R	RPA4R<3:0>	0011 = SDO1 0100 = SDO2
RPB13	RPB13R	RPB13R<3:0>	0101 = OC4
RPB2	RPB2R	RPB2R<3:0>	0110 = OC5 0111 = REFCLKO
RPC6	RPC6R	RPC6R<3:0>	1000 = Reserved
RPC1	RPC1R	RPC1R<3:0>] :
RPC3	RPC3R	RPC3R<3:0>	1111 = Reserved
RPA3	RPA3R	RPA3R<3:0>	0000 = No Connect
RPB14	RPB14R	RPB14R<3:0>	
RPB0	RPB0R	RPB0R<3:0>	0011 = <u>Reserved</u> 0100 = SS2
RPB10	RPB10R	RPB10R<3:0>	0101 = OC3
RPB9	RPB9R	RPB9R<3:0>	0110 = Reserved 0111 = C1OUT
RPC9	RPC9R	RPC9R<3:0>	1000 = Reserved
RPC2	RPC2R	RPC2R<3:0>	∃:
RPC4	RPC4R	RPC4R<3:0>	 1111 = Reserved

11.4 Ports Control Registers

TABI	LE 11-3:	: F	PORTA	REGIS	STER N	/IAP									
ess		0								Bits	6				
Virtual Address (BF88_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	
6000	ANSELA	31:16	_		—	_	_	—	—	—	_	_	—	_	
0000	/ INOLL/	15:0	—	_		—		—	—	—	_		—	—	
6010	TRISA	31:16	—	_		—		—	—	—	_		—	—	
0010	-	15:0	—	—	—	—	_	TRISA10 ⁽²⁾	TRISA9 ⁽²⁾	TRISA8 ⁽²⁾	TRISA7 ⁽²⁾	—	—	TRISA4	TF
6020	PORTA	31:16	—	—	—	—	_	—	—	—		—	—		
0020	TORMA	15:0	—	_		—		RA10 ⁽²⁾	RA9 ⁽²⁾	RA8 ⁽²⁾	RA7 ⁽²⁾		—	RA4	
6030	LATA	31:16	—	_		—		—	—	—	_		—	—	
0000	L/(//(15:0	—	_		—		LATA10 ⁽²⁾	LATA9 ⁽²⁾	LATA8 ⁽²⁾	LATA7 ⁽²⁾		—	LATA4	L
6040	ODCA	31:16	—	_		—		—	—	—	_		—	—	
00+0		15:0	—	—	—	—	—	ODCA10 ⁽²⁾	ODCA9 ⁽²⁾	ODCA8 ⁽²⁾	ODCA7 ⁽²⁾	—	—	ODCA4	0
6050	CNPUA	31:16	—	_		—		—	—	—	_		—	—	
0030	CINFUA	15:0	—	_		—		CNPUA10 ⁽²⁾	CNPUA9 ⁽²⁾	CNPUA8 ⁽²⁾	CNPUA7 ⁽²⁾		—	CNPUA4	CN
6060	CNPDA	31:16	—	_	_	—	_	—	_		_	_	—	—	
0000	CINFDA	15:0	—	_	_	—	_	CNPDA10 ⁽²⁾	CNPDA9 ⁽²⁾	CNPDA8 ⁽²⁾	CNPDA7 ⁽²⁾	_	—	CNPDA4	CN
6070	CNCONA	31:16	—	_	_	—	_	—	_		_	_	—	—	
0070	CINCOINA	15:0	ON	_	SIDL	—	_	—	—	—	_	_	_	—	
6080	CNENA	31:16	—		—	—	_	_	—		_		—	—	
0000	CINEINA	15:0	—	_	—	—	_	CNIEA10 ⁽²⁾	CNIEA9 ⁽²⁾	CNIEA8 ⁽²⁾	CNIEA7 ⁽²⁾	_	—	CNIEA4	CI
6000	CNSTATA	31:16	_		—	—	-	—	—		1	-		—	
0090	GNOTAIA	15:0	_	_	—	_	-	CNSTATA10(2)	CNSTATA9(2)	CNSTATA8 ⁽²⁾	CNSTATA7 ⁽²⁾		_	CNSTATA4	CN
Legen	d: x =	unknov	wn value o	on Reset;	— = unim	plemented	d, read as	'0'. Reset value	es are shown in	n hexadecimal.					

All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See more information. Note 1:

2: This bit is only available on 44-pin devices.

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TABLE 11-4: PORTB REGISTER MAP

ess										Bits				
Virtual Address (BF88_#)	Register Name	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4
0400		31:16	_	_	_	_	_	_	—	_	—	_	—	_
6100	ANSELB	15:0	ANSB15	ANSB14	ANSB13	ANSB12 ⁽²⁾		_	_		_	_	_	_
6110	TRISB	31:16	_	—	—	-		-	—	-	-	-	-	
0110	IRISB	15:0	TRISB15	TRISB14	TRISB13	TRISB12 ⁽²⁾	TRISB11	TRISB10	TRISB9	TRISB8	TRISB7	TRISB6 ⁽²⁾	TRISB5	TRISB
6120	PORTB	31:16		_	_	_	_	_	_		_	_	_	
0120	FURID	15:0	RB15	RB14	RB13	RB12 ⁽²⁾	RB11	RB10	RB9	RB8	RB7	RC6 ⁽²⁾	RB5	RB4
6130	LATB	31:16	_	—	_	-			_			-		_
0130	LAID	15:0	LATB15	LATB14	LATB13	LATB12 ⁽²⁾	LATB11	LATB10	LATB9	LATB8	LATB7	LATB6 ⁽²⁾	LATB5	LATB4
6140	ODCB	31:16	_	—	_	-			_			-		
0140	ODCB	15:0	ODCB15	ODCB14	ODCB13	ODCB12 ⁽²⁾	ODCB11	ODCB10	ODCB9	ODCB8	ODCB7	ODCB6	ODCB5	ODCB4
6150	CNPUB	31:16	_	_	_	1								
0150	CINFUB	15:0	CNPUB15	CNPUB14	CNPUB13	CNPUB12 ⁽²⁾	CNPUB11	CNPUB10	CNPUB9	CNPUB8	CNPUB7	CNPUB6 ⁽²⁾	CNPUB5	CNPUE
6160	CNPDB	31:16	_	_	_	_	_	_	—	-	—	_	—	—
0100	_		CNPDB15	CNPDB14	CNPDB13	CNPDB12 ⁽²⁾	CNPDB11	CNPDB10	CNPDB9	CNPDB8	CNPDB7	CNPDB6 ⁽²⁾	CNPDB5	CNPDE
6170	CNCONB	31:16	—	—	—	_	_	_	—	—	_	_	_	_
0170		15:0	ON	—	SIDL	_	_	—	—	_	—	—	—	_
6180	CNENB	31:16	_	—	—	—	_	—	—	_	—	_	—	_
0100	_	15:0	CNIEB15	CNIEB14	CNIEB13	CNIEB11 ⁽²⁾	CNIEB11	CNIEB10	CNIEB9	CNIEB8	CNIEB7	CNIEB6 ⁽²⁾	CNIEB5	CNIEB
		31:16	—	—	—	_	—	—	—	_	—	—	—	—
6190	CNSTATB	15:0	CN STATB15	CN STATB14	CN STATB13	CN STATB12 ⁽²⁾	CN STATB11	CN STATB10	CN STATB9	CN STATB8	CN STATB7	CN STATB6 ⁽²⁾	CN STATB5	CN STATB

Note

1:

All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See more information. This bit is not available on PIC32MX2XX devices. The reset value for the TRISB register when this bit is not available is 0x0000EFBF. 2:

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TABLE 11-5: PORTC REGISTER MAP

ess												Bits			
Virtual Address (BF88_#)	Register Name ^(1,2)	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	1
6200	ANSELC	31:16	_			_	_	_	I	—	_	—	_	_	-
0200	ANSELC	15:0	Ι			—	_	—	—	—	_	—	_	_	ANS
6210	TRISC	31:16	_			—				—	—	—	—	—	-
0210	IRISC	15:0	Ι			—	_	—	TRISC9	TRISC8 ⁽³⁾	TRISC7(3)	TRISC6 ⁽³⁾	TRISC5 ⁽³⁾	TRISC4 ⁽³⁾	TRI
6220	PORTC	31:16		_	_	_	-	_	—	—	_	—	_		
0220	PURIC	15:0	Ι	_	_	—	_	-	RC9	RC8 ⁽³⁾	RC7 ⁽³⁾	RC6 ⁽³⁾	RC5 ⁽³⁾	RC4 ⁽³⁾	R
6230	LATC	31:16	_	_	_	—	_	—	—	—	—	—	_	—	-
6230	LAIC	15:0	Ι	—	—	—	_		LATC9	LATC8 ⁽³⁾	LATC7 ⁽³⁾	LATC6 ⁽³⁾	LATC5 ⁽³⁾	LATC4 ⁽³⁾	LA
0040	0000	31:16	_			—				—	—	—	—	—	-
6240	ODCC	15:0	Ι			—	_	—	ODCC9	ODCC8 ⁽³⁾	ODCC7 ⁽³⁾	ODCC6 ⁽³⁾	ODCC5 ⁽³⁾	ODCC4 ⁽³⁾	OD
0050	CNPUC	31:16	Ι	_	_	—	—	_	—	—	—	—	—	—	-
6250	CNPUC	15:0	Ι	_	_	—	—	_	CNPUC9	CNPUC8 ⁽³⁾	CNPUC7 ⁽³⁾	CNPUC6 ⁽³⁾	CNPUC5 ⁽³⁾	CNPUC4 ⁽³⁾	CNF
0000		31:16	Ι	_	_	—	—	_	—	—	—	—	—	—	-
6260	CNPDC	15:0	Ι	_	_	—	—	_	CNPDC9	CNPDC8 ⁽³⁾	CNPDC7 ⁽³⁾	CNPDC6 ⁽³⁾	CNPDC5 ⁽³⁾	CNPDC4 ⁽³⁾	CNF
0070	onoono	31:16		_	_	_		_	—	—	_	—	_	—	-
¢∠70	CNCONC	15:0	ON	—	SIDL	—	—	_	_	_	_	—	_		-
0000		31:16		_	—	—	_	_	_		_	_	_	_	-
6280	CNENC	15:0		_	—	—	_	_	CNIEC9	CNIEC8 ⁽³⁾	CNIEC7 ⁽³⁾	CNIEC6 ⁽³⁾	CNIEC5 ⁽³⁾	CNIEC4 ⁽³⁾	CN
	01107170	31:16	_	_	_	_	_	_	—	—	—	—	—	_	-
6290	CNSTATC	15:0	_	_	_	—	_	_	CNSTATC9	CNSTATC8(3)	CNSTATC7(3)	CNSTATC6(3)	CNSTATC5(3)	CNSTATC4(3)	CNS

x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal. Legend:

Note All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See 1: more information.

2:

PORTC is not available on 28-pin devices. This bit is only available on 44-pin devices. 3:

4: This bit is only available on USB-enabled devices with 36 or 44 pins.

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ess	l									В	its			
Virtual Address (BF80_#)	Register Name	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	2
		31:16	_	_	—	_	_	—	_	_	—	_	_	
FA04	INT1R	15:0	_		—	_	_	_		_	_	_	_	
		31:16	_		—	_	_	_			_	—	—	-
FA08	INT2R	15:0	—	_	—	—	—	—	-	_	—	—	—	
FA0C	INT3R	31:16	—	-	—	—	—	—	-	-	—	—	—	-
FAUC	INTOR	15:0	—	—	_		—	_	—	—		—	-	-
FA10	INT4R	31:16	—	—	—	—	—	—	—	—	—	—	-	-
FAIU		15:0	—	_	—	—	—	—	—	_	—	-	-	-
FA18	T2CKR	31:16	—	_	—	—	—	—	_	_	—	—	—	
TAIO	120101	15:0	—	_	—	—	—	_	_	_	—	—	—	-
FA1C	T3CKR	31:16	_	_	—	—	—	—	_	_	—	—	—	-
TAIC	TOORIX	15:0	_	_	—	—	—	—	_	_	—	—	—	-
FA20	T4CKR	31:16	_	_	_	_	_	—	_	_	—	-	-	-
1720		15:0	_	_	—	—	—	—	_	_	—	—	—	-
FA24	T5CKR	31:16	—	—	—	—	—	—	_	_	—	—	—	-
1.727		15:0	—	—	—	—	—	—	_	—	—	_	_	
FA28	IC1R	31:16	—	_	—	—	—	—	_	_	—	_	_	
1 720		15:0	—	_	—	—	—	—	_	_	—	—	—	
FA2C	IC2R	31:16	—	—	—	—	—	—	_	—	—	_	—	
1740	10213	15:0		—	—	—	—	—	—	—	—	-	—	
FA30	IC3R	31:16	—	_	—	—	—	—	_	—	—	_	—	
17.00		15:0	—	_	—	_	_	_		_	_	_	_	
FA34	IC4R	31:16	—	_	—	—	—	—	_	—	—	_	—	
17.04		15:0	—	_	—	_	_	_			_	_	-	-
FA38	IC5R	31:16	—	_	—	_	_	_		_	_	_	_	
17.00	1001	15:0	—	_	—	—	—	—	_	—	—	_	—	
FA48	OCFAR	31:16	—	—	—	—	—	—	—	—	—	-	—	
17-10	001743	15:0	—	_	—	—	—	—	_	_	—	_	_	
FA4C	OCFBR	31:16	—	—	—	—	—	—	_	_	—	—	—	
		15:0	_	_	_	—	—	—	_	_	_	-	-	
FA50	U1RXR	31:16	—	_	—	—	—	—	_	_	—	—	—	
FAGU	UINAN	15:0	—	—	_	_	_	_	—	—	—	_	_	

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TABL	E 11-6:	PEF	RIPHER	AL PIN	SELEC	T INPU	T REGIS	STER M	IAP (CC	NTINU	ED)				
ess										В	its				
Virtual Address (BF80_#)	Register Name	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	
FA54	U1CTSR	31:16		—	—	—		—	—	—		—	—	—	
FA94	UICISK	15:0		—	—	—		_	—	—	_	_	_	_	
FA58	U2RXR	31:16		-	-	_	_	_	—	-		_	—	—	
FA30	UZRAR	15:0		—	—	—		—	—	—	_	—	_	—	
EAEC.	U2CTSR	LIPCTER	31:16		—	—	—		—	—	—	_	—	_	—
FA5C	02015R	15:0		—	—	—		—	—	—	_	—	_	—	
FA84	SDI1R	31:16		—	—	—		—	—	—	_	—	_	—	
FA04	SDIR	15:0		—	—	—		—	-	—	-	—	—	—	
FA88	SS1R	31:16	_	_	_	_	_	_	_	_	_	_	_	—	
FA88	391K	15:0	-	—	—	—	_	_	_	—		_	_	—	
FA00	SDI2R	31:16	-	—	_	—	_	_	_	—		_	_	_	
FA90	SUIZR	15:0	-	_	—	—	_	_	_	_	_	_	_	_	
FA94	SS2R	31:16	-	—	—	—	_	_	_	—		_	_	—	
FA94	397k	15:0	_	-	-	_	_	_	—	-		_	—	—	
FAB8	REFCLKIR	31:16		—	—	—	-	_	_	—	_	_	_	—	
FAB8	REFULKIR	15:0	-	—	—	—	_	_	_	—		_	_	_	

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x = unknown value on Reset; - = unimplemented, read as '0'. Reset values are shown in hexadecimal. Legend:

—

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PERIPHERAL PIN SELECT OUTPUT REGISTER MAP

28/12

27/11

26/10

25/9

—

—

—

29/13

Bits

23/7

22/6

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21/5

20/4

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24/8

1: 2:

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This register is only available on 44-pin devices. This register is only available on PIC32MX1XX devices. This register is only available on 36-pin and 44-pin devices. 3:

Note

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-

31:16 RPA1R FB04 15:0 31:16 FB08 RPA2R 15:0 31:16 RPA3R FB0C 15:0 31:16 FB10 RPA4R 15:0 31:16 RPA8R⁽¹⁾ FB20 15:0 31:16 RPA9R⁽¹⁾ FB24

15:0 31:16

15:0 31:16

15:0 31:16

15:0 31:16

15:0 31:16

15:0 31:16

15:0

31:16

15:0

31:16

15:0

Bit Range

31:16

15:0

31/15

30/14

Virtual Address (BF80_#)

FB00

FB2C

FB30

FB34

FB38

FB3C

FB40

FB44

FB48

RPB0R

RPB1R

RPB2R

RPB3R

RPB4R

RPB5R

RPB6R(2)

RPB7R

TABLE 11-7:

Register Name

RPA0R

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Legend: x = unknown value on Reset; - = unimplemented, read as '0'. Reset values are shown in hexadecimal.

This register is only available on 44-pin devices. 1:

2: This register is only available on PIC32MX1XX devices.

3: This register is only available on 36-pin and 44-pin devices.

FB80 RPC5R⁽¹⁾ 15:0 31:16 FB84 RPC6R⁽¹⁾ 15:0 31:16 FB88 RPC7R⁽¹⁾ 15:0

PERIPHERAL PIN SELECT OUTPUT REGISTER MAP (CONTINUED)

27/11

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26/10

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25/9

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28/12

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29/13

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23/7

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24/8

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22/6

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21/5

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20/4

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FB58 RPB11R FB60 RPB13R FB64 RPB14R FB68 RPB15R

TABLE 11-7:

Register Name

RPB8R

RPB9R

RPB10R

RPC0R⁽³⁾

RPC1R⁽³⁾

RPC2R⁽¹⁾

RPC3R⁽³⁾

RPC4R⁽¹⁾

Bit Range

31:16

15:0

31:16

15:0

31:16

15:0

31:16

15:0

31:16

15:0

31:16

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Virtual Address (BF80_#)

FB4C

FB50

FB54

FB6C

FB70

FB74

FB78

FB7C

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TABLE 11-7: PERIPHERAL PIN SELECT OUTPUT REGISTER MAP (CONTINUED)

SSS			Bits												
Virtual Address (BF80_#)	Register Name	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	
FB8C	RPC8R ⁽¹⁾	31:16	—	—	—	—	—	—	—	—	—	—	—	—	
FB8C	RPC8R**	C RPC8R**	15:0	—	—	—	—	—	—	—	—	—	—	—	—
5000 5	RPC9R ⁽³⁾	31:16	—	—	—	_	—	_	—	—	_	—	—	—	
FB90	KPC9R**	15:0	_	_	_	_	—	_	—	—	_	—	—	_	

x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal. This register is only available on 44-pin devices. This register is only available on PIC32MX1XX devices. This register is only available on 36-pin and 44-pin devices. Legend: Note 1

1: 2: 3:

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Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	-	_	_	_	_		—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	_	_	_	_	_		—	—
45.0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
15:8	-	_	_	_	_		—	—
7.0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
7:0						[pin name	e]R<3:0>	

REGISTER 11-1: [pin name]R: PERIPHERAL PIN SELECT INPUT REGISTER

Legend:

0			
R = Readable bit	Readable bit W = Writable bit		ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-4 Unimplemented: Read as '0'

bit 3-0 [*pin name*]R<3:0>: Peripheral Pin Select Input bits Where [*pin name*] refers to the pins that are used to configure peripheral input mapping. See Table 11-1 for input pin selection values.

Note: Register values can only be changed if the Configuration bit, IOLOCK (CFGCON<13>), = 0.

REGISTER 11-2: RPnR: PERIPHERAL PIN SELECT OUTPUT REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	_	_	—	_			_
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:10	—	—	—	—	_	—	-	—
45.0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
15:8	—	_	_	—	_			_
7:0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
		_				RPnR	<3:0>	

Legend:

0				
R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 31-4 Unimplemented: Read as '0'

bit 3-0 **RPnR<3:0>:** Peripheral Pin Select Output bits See Table 11-2 for output pin selection values.

Note: Register values can only be changed if the Configuration bit, IOLOCK (CFGCON<13>), = 0.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
04.04	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	_	_	—	_	_	-	_	_
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	-	_		_	_		_	_
15.0	R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
15:8	ON	_	SIDL	_	_	—	_	_
7.0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
7:0	_		_					_

REGISTER 11-3: CNCONX: CHANGE NOTICE CONTROL FOR PORTX REGISTER (X = A, B, C)

Legend:

R = Readable bit	= Readable bit W = Writable bit		ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

- bit 15 **ON:** Change Notice (CN) Control ON bit
 - 1 = CN is enabled
 - 0 = CN is disabled
- bit 14 Unimplemented: Read as '0'
- bit 13 **SIDL:** Stop in Idle Control bit
 - 1 = Idle mode halts CN operation
 - 0 = Idle does not affect CN operation
- bit 12-0 Unimplemented: Read as '0'

12.0 TIMER1

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 14. "Timers" (DS60001105), which is available from the Documentation > Reference Manual section of the Microchip PIC32 web site (www.microchip.com/pic32).

This family of PIC32 devices features one synchronous/asynchronous 16-bit timer that can operate as a free-running interval timer for various timing applications and counting external events. This timer can also be used with the Low-Power Secondary Oscillator (Sosc) for Real-Time Clock (RTC) applications.

FIGURE 12-1: TIMER1 BLOCK DIAGRAM

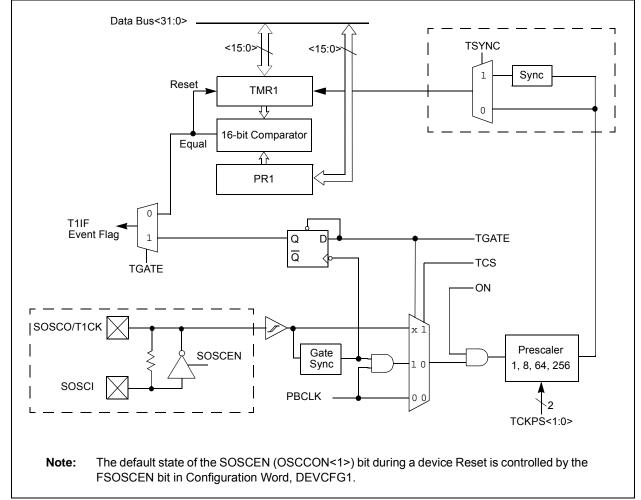
The following modes are supported:

- Synchronous Internal Timer
- · Synchronous Internal Gated Timer
- Synchronous External Timer
- Asynchronous External Timer

12.1 Additional Supported Features

- Selectable clock prescaler
- Timer operation during CPU Idle and Sleep mode
- Fast bit manipulation using CLR, SET and INV registers
- Asynchronous mode can be used with the Sosc to function as a Real-Time Clock (RTC)

Figure 12-1 illustrates a general block diagram of Timer1.



12.2 Timer1 Control Registers

TABLE 12-1: TIMER1 REGISTER MAP

		••													
ess		â								Bi	its				
Virtual Address (BF80_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	
	T1CON	31:16	_	_	_	_	—	_	_	—	_	_	_	—	
0600	TICON	15:0	ON	_	SIDL	TWDIS	TWIP	—	—	_	TGATE	—	TCKP	S<1:0>	
0610	TMR1	31:16	_	_	_	—	_	—	—	_	_	—	—	_	
0010		15:0								TMR1	<15:0>				
0620	PR1	31:16	—	—	—	_	—	—	—	—	—	—	—	—	
0020		15:0								PR1<	15:0>				
Lorona	1.					monted rea				بالمعالمة والم					

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See more information. Note 1:

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Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
21.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	-	—	—		—	—	-	—
22:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	—	—	—	—	—	—	-	—
15.0	R/W-0	U-0	R/W-0	R/W-0	R-0	U-0	U-0	U-0
15:8	ON ⁽¹⁾	—	SIDL	TWDIS	TWIP	_		
7:0	R/W-0	U-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	U-0
7:0	TGATE		TCKPS	S<1:0>		TSYNC	TCS	_

REGISTER 12-1: T1CON: TYPE A TIMER CONTROL REGISTER

Legend:

0						
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'				
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

bit 31-16 **Unimplemented:** Read as '0'

bit 15	ON: Timer On bit ⁽¹⁾
	1 = Timer is enabled
	0 = Timer is disabled
bit 14	Unimplemented: Read as '0'
bit 13	SIDL: Stop in Idle Mode bit
	1 = Discontinue module operation when the device enters Idle mode0 = Continue module operation when the device enters Idle mode
bit 12	TWDIS: Asynchronous Timer Write Disable bit
	 1 = Writes to Timer1 are ignored until pending write operation completes 0 = Back-to-back writes are enabled (Legacy Asynchronous Timer functionality)
bit 11	TWIP: Asynchronous Timer Write in Progress bit
	In Asynchronous Timer mode: 1 = Asynchronous write to the Timer1 register in progress 0 = Asynchronous write to Timer1 register is complete
	In Synchronous Timer mode: This bit is read as '0'.
bit 10-8	Unimplemented: Read as '0'
bit 7	TGATE: Timer Gated Time Accumulation Enable bit
	When TCS = 1: This bit is ignored.
	When TCS = 0:
	1 = Gated time accumulation is enabled 0 = Gated time accumulation is disabled
bit 6	Unimplemented: Read as '0'
bit 5-4	TCKPS<1:0>: Timer Input Clock Prescale Select bits
	11 = 1:256 prescale value
	10 = 1:64 prescale value
	01 = 1:8 prescale value
	00 = 1:1 prescale value
Noto 1.	When using 1:1 DPCmLK divisor the user's software should not read/write the periph

Note 1: When using 1:1 PBCmLK divisor, the user's software should not read/write the peripheral SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.

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REGISTER 12-1: T1CON: TYPE A TIMER CONTROL REGISTER (CONTINUED)

- bit 3
 Unimplemented: Read as '0'

 bit 2
 TSYNC: Timer External Clock Input Synchronization Selection bit

 When TCS = 1:
 1 = External clock input is synchronized

 0 = External clock input is not synchronized
 When TCS = 0:

 This bit is ignored.
 TCS: Timer Clock Source Select bit
- 1 = External clock from TxCKI pin 0 = Internal peripheral clock
- bit 0 Unimplemented: Read as '0'
- **Note 1:** When using 1:1 PBCmLK divisor, the user's software should not read/write the peripheral SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.

13.0 TIMER2/3, TIMER4/5

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 14. "Timers" (DS60001105), which is available from the Documentation > Reference Manual section of the Microchip PIC32 web site (www.microchip.com/pic32).

This family of PIC32 devices features four synchronous 16-bit timers (default) that can operate as a freerunning interval timer for various timing applications and counting external events. The following modes are supported:

- · Synchronous internal 16-bit timer
- Synchronous internal 16-bit gated timer
- · Synchronous external 16-bit timer

Two 32-bit synchronous timers are available by combining Timer2 with Timer3 and Timer4 with Timer5. The 32-bit timers can operate in three modes:

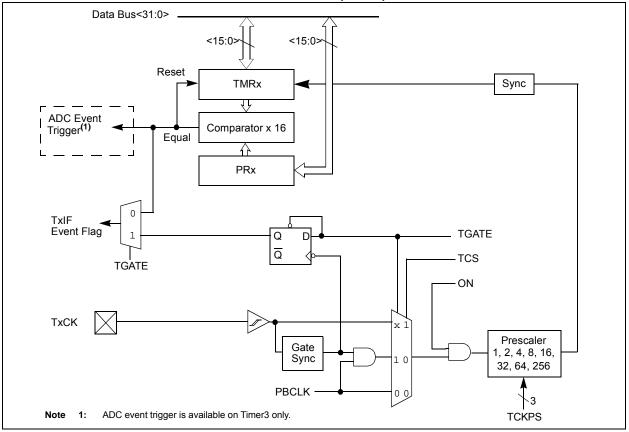
- Synchronous internal 32-bit timer
- Synchronous internal 32-bit gated timer
- Synchronous external 32-bit timer
- Note: In this chapter, references to registers, TxCON, TMRx and PRx, use 'x' to represent Timer2 through Timer5 in 16-bit modes. In 32-bit modes, 'x' represents Timer2 or Timer4 and 'y' represents Timer3 or Timer5.

13.1 Additional Supported Features

- · Selectable clock prescaler
- Timers operational during CPU idle
- Time base for Input Capture and Output Compare modules (Timer2 and Timer3 only)
- ADC event trigger (Timer3 in 16-bit mode, Timer2/3 in 32-bit mode)
- Fast bit manipulation using CLR, SET and INV registers

Figure 13-1 and Figure 13-2 illustrate block diagrams of Timer2/3 and Timer4/5.

FIGURE 13-1: TIMER2-TIMER5 BLOCK DIAGRAM (16-BIT)



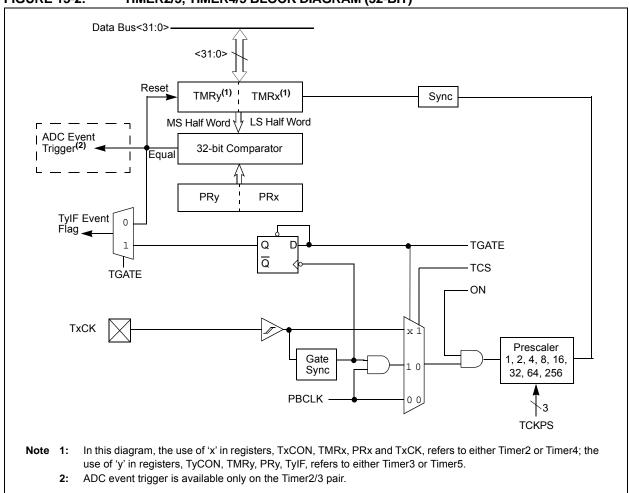


FIGURE 13-2: TIMER2/3, TIMER4/5 BLOCK DIAGRAM (32-BIT)

13.2 Timer Control Registers

BLE 13-1: TIMER2-TIMER5 REGISTER MAP

TABL	E 13-	1:	TIMER2	IMER2-TIMER5 REGISTER MAP													
ess										В	its						
Virtual Address (BF80_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4			
0800	T2CON	31:16	_	—	—	—	-	—	_	—	—	_	—	-			
0000		15:0	ON	—	SIDL	_	—	—	_	—	TGATE	1	CKPS<2:0	>			
0810	TMR2	31:16	—	—	—	—	—	—	—	—	—	—	—	—			
0010	111111	15:0								TMR2	<15:0>						
0820	PR2	31:16	_	—	_	—	_	—	—	—	_	—	—	—			
0010		15:0								PR2<	:15:0>				_		
0A00	T3CON	31:16	_	_	—	_	_	_	_	_	_	_	—	—			
		15:0	ON	_	SIDL	_	_	—	_		TGATE	−					
0A10	TMR3	31:16	—	—	—	—	—	—	—	—	—	—					
		15:0								TMR3	<15:0>						
0A20	PR3	31:16	—	—	—	—	—	—	—	—	—	—	—	—			
		15:0								PR3<	:15:0>						
0C00	T4CON	31:16	-	_	-			_	_		—		—				
-		15:0	ON	_	SIDL	—	_	_	_		TGATE		CKPS<2:0	>			
0C10	TMR4	31:16	—	_	_		_	_	_	-	-	_		_			
		15:0								TMR4	<15:0>				-		
0C20	PR4	31:16 15:0	-	—	—	_	—	_	—		:15:0>	—	_	_			
		31:16	_	_		_	_	_	_	PR4<	15.0>	_					
0E00 T5CON						TGATE											
		31:16	_							_	-	_	TCKPS<2:0>				
0E10	TMR5	15:0								TMR5							
		31:16	_				_	_	_	_		_					
0E20	PR5	15:0						-			:15:0>						
		10.0								110	10.0						

Legend:

d: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See more information.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	—	—	-	-	_	-	-	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	—	—	-	-	—	_	-	—
45.0	R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
15:8	ON ^(1,3)	—	SIDL ⁽⁴⁾	_	—	_	_	—
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	U-0
7:0	TGATE ⁽³⁾	Т	CKPS<2:0>(3)	T32 ⁽²⁾		TCS ⁽³⁾	—

REGISTER 13-1: TXCON: TYPE B TIMER CONTROL REGISTER

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 **Unimplemented:** Read as '0'

- bit 15 ON: Timer On bit^(1,3)

 = Module is enabled
 = Module is disabled

 bit 14 Unimplemented: Read as '0'
 bit 13 SIDL: Stop in Idle Mode bit⁽⁴⁾

 = Discontinue module operation when the device enters Idle mode
 = Continue module operation when the device enters Idle mode

 bit 12-8 Unimplemented: Read as '0'
 bit 12-8 Unimplemented: Read as '0'
 bit 7 TGATE: Timer Gated Time Accumulation Enable bit⁽³⁾
 When TCS = 1:
 - This bit is ignored and is read as '0'.

When TCS = 0:

1 = Gated time accumulation is enabled

0 = Gated time accumulation is disabled

bit 6-4 TCKPS<2:0>: Timer Input Clock Prescale Select bits⁽³⁾

- 111 = 1:256 prescale value
- 110 = 1:64 prescale value
- 101 = 1:32 prescale value
- 100 = 1:16 prescale value
- 011 = 1:8 prescale value
- 010 = 1:4 prescale value
- 001 = 1:2 prescale value
- 000 = 1:1 prescale value
- **Note 1:** When using 1:1 PBCLK divisor, the user's software should not read/write the peripheral SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.
 - 2: This bit is available only on even numbered timers (Timer2 and Timer4).
 - **3:** While operating in 32-bit mode, this bit has no effect for odd numbered timers (Timer3, and Timer5). All timer functions are set through the even numbered timers.
 - 4: While operating in 32-bit mode, this bit must be cleared on odd numbered timers to enable the 32-bit timer in Idle mode.

REGISTER 13-1: TXCON: TYPE B TIMER CONTROL REGISTER (CONTINUED)

- bit 3 T32: 32-Bit Timer Mode Select bit⁽²⁾
 - 1 = Odd numbered and even numbered timers form a 32-bit timer
 - 0 = Odd numbered and even numbered timers form a separate 16-bit timer
- bit 2 Unimplemented: Read as '0'
- bit 1 TCS: Timer Clock Source Select bit⁽³⁾
 - 1 = External clock from TxCK pin
 - 0 = Internal peripheral clock
- bit 0 Unimplemented: Read as '0'
- **Note 1:** When using 1:1 PBCLK divisor, the user's software should not read/write the peripheral SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.
 - 2: This bit is available only on even numbered timers (Timer2 and Timer4).
 - **3:** While operating in 32-bit mode, this bit has no effect for odd numbered timers (Timer3, and Timer5). All timer functions are set through the even numbered timers.
 - 4: While operating in 32-bit mode, this bit must be cleared on odd numbered timers to enable the 32-bit timer in Idle mode.

NOTES:

14.0 WATCHDOG TIMER (WDT)

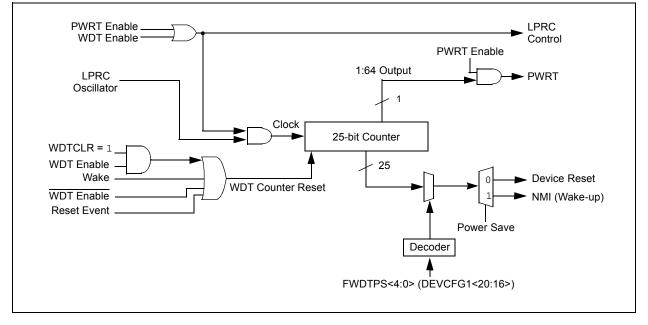
Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 9. "Watchdog, Deadman, and Power-up Timers" (DS60001114), which are available from the Documentation > Reference Manual section of the Microchip PIC32 web site (www.microchip.com/pic32). The WDT, when enabled, operates from the internal Low-Power Oscillator (LPRC) clock source and can be used to detect system software malfunctions by resetting the device if the WDT is not cleared periodically in software. Various WDT time-out periods can be selected using the WDT postscaler. The WDT can also be used to wake the device from Sleep or Idle mode.

The following are some of the key features of the WDT module:

- Configuration or software controlled
- User-configurable time-out period
- Can wake the device from Sleep or Idle mode

Figure 14-1 illustrates a block diagram of the WDT and Power-up timer.

FIGURE 14-1: WATCHDOG TIMER AND POWER-UP TIMER BLOCK DIAGRAM



Watchdog Timer Control Registers 14.1

WATCHDOG TIMER CONTROL REGISTER MAP TABLE 14-1:

ess		0									Bits				
Virtual Address (BF80_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	3/7 22/6 21/5 20	20/4	19	
0000	WDTCON	31:16	—	—	_	—	—	—	_	_	—	_	—	—	-
0000	WDICON	15:0	ON	_	_	_	_	_	_	-	_		SI	NDTPS<4:	0>
Legen	Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.														

x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See more information. Note 1:

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Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	—	—	—	—	—	—	—	—
22:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	—	—	—	_	_	—	—	—
45.0	R/W-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
15:8	ON ^(1,2)	—	—	_	—	—	—	—
7:0	U-0	R-y	R-y	R-y	R-y	R-y	R/W-0	R/W-0
7:0			S	WDTPS<4:0	>		WDTWINEN	WDTCLR

REGISTER 14-1: WDTCON: WATCHDOG TIMER CONTROL REGISTER

Legend:	y = Values set from Configuration bits on POR					
R = Readable bit	W = Writable bit U = Unimplemented bit, read as '0'					
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

bit 31-16 Unimplemented: Read as '0'

- bit 15 **ON:** Watchdog Timer Enable bit^(1,2) 1 = Enables the WDT if it is not enabled by the device configuration
 - 0 = Disables the WDT if it was enabled by the deviation of the software
- bit 14-7 **Unimplemented:** Read as '0'
- bit 6-2 **SWDTPS<4:0>:** Shadow Copy of Watchdog Timer Postscaler Value from Device Configuration bits On reset, these bits are set to the values of the WDTPS <4:0> of Configuration bits.
- bit 1 WDTWINEN: Watchdog Timer Window Enable bit
 - 1 = Enable windowed Watchdog Timer
 - 0 = Disable windowed Watchdog Timer
- bit 0 WDTCLR: Watchdog Timer Reset bit
 - 1 = Writing a '1' will clear the WDT
 - 0 = Software cannot force this bit to a '0'
- **Note 1:** A read of this bit results in a '1' if the Watchdog Timer is enabled by the device configuration or software.
 - 2: When using the 1:1 PBCLK divisor, the user's software should not read or write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.

NOTES:

15.0 INPUT CAPTURE

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 15. "Input Capture" (DS60001122), which is available from the *Documentation* > *Reference Manual* section of the Microchip PIC32 web site (www.microchip.com/pic32).

The Input Capture module is useful in applications requiring frequency (period) and pulse measurement.

The Input Capture module captures the 16-bit or 32-bit value of the selected Time Base registers when an event occurs at the ICx pin. The following events cause capture events:

- Simple capture event modes:
 - Capture timer value on every rising and falling edge of input at ICx pin
 - Capture timer value on every edge (rising and falling)
 - Capture timer value on every edge (rising and falling), specified edge first.

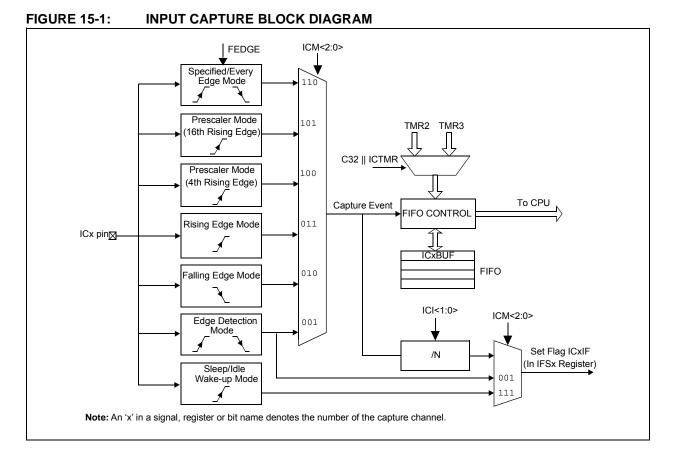
- Prescaler capture event modes:
 - Capture timer value on every 4th rising edge of input at ICx pin
 - Capture timer value on every 16th rising edge of input at ICx pin

Each input capture channel can select between one of two 16-bit timers (Timer2 or Timer3) for the time base, or two 16-bit timers (Timer2 and Timer3) together to form a 32-bit timer. The selected timer can use either an internal or external clock.

Other operational features include:

- Device wake-up from capture pin during Sleep and Idle modes
- · Interrupt on input capture event
- 4-word FIFO buffer for capture values (interrupt optionally generated after 1, 2, 3, or 4 buffer locations are filled)
- Input capture can also be used to provide additional sources of external interrupts

Figure 15-1 illustrates a general block diagram of the Input Capture module.



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Input Capture Control Registers 15.1

TABLE 15-1: INPUT CAPTURE 1-INPUT CAPTURE 5 REGISTER MAP

ess		c)								Bi	ts			
Virtual Address (BF80_#)	Register Name	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4
2000	IC1CON ⁽¹⁾	31:16		—	—	—	—	-	—	_	—	_	_	—
2000	ICTCON.	15:0	ON	—	SIDL	—	—	-	FEDGE	C32	ICTMR	ICI<	1:0>	ICOV
2010	IC1BUF	31:16 15:0								IC1BUF	<31:0>			
2200	IC2CON ⁽¹⁾	31:16	—	_	_	—	_	_	—	_	_	—	_	—
2200	IC2CON"	15:0	ON	—	SIDL	—	—		FEDGE	C32	ICTMR	ICI<	1:0>	ICOV
2210	IC2BUF	31:16 15:0								IC2BUF	<31:0>			
2400	IC3CON ⁽¹⁾	31:16	—	_	_	—	_	_	—	_	_	—	_	—
2400	IC3CON 7	15:0	ON	-	SIDL	-	-		FEDGE	C32	ICTMR	ICI<	1:0>	ICOV
2410	IC3BUF	31:16 15:0								IC3BUF	<31:0>			
2600	IC4CON ⁽¹⁾	31:16		—		—	—	_	—	_	—	—	—	—
2000	1040011	15:0	ON	—	SIDL	—	_		FEDGE	C32	ICTMR	ICI<	1:0>	ICOV
2610	IC4BUF	31:16 15:0								IC4BUF	<31:0>			
2800	IC5CON ⁽¹⁾	31:16	_	—	—	—	—	_	—	_	—	—	—	_
2000 ICSCON* 15:0 ON - SIDL FEDGE C32 ICTMR ICI<1:0> IC						ICOV								
2810	IC5BUF	31:16 15:0												



x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal. Note 1:

This register has corresponding CLR, SET and INV registers at its virtual address, plus an offset of 0x4, 0x8 and 0xC, respectively. See Section 11.2 "C

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Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	—		_	_	_		-	_
00:40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	—	-	_	_	_	_	_	_
15.0	R/W-0	U-0	R/W-0	U-0	U-0	U-0	R/W-0	R/W-0
15:8	ON ⁽¹⁾	-	SIDL	-	—	_	FEDGE	C32
7.0	R/W-0	R/W-0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0
7:0	ICTMR	ICI<	1:0>	ICOV	ICBNE		ICM<2:0>	

REGISTER 15-1: ICXCON: INPUT CAPTURE 'x' CONTROL REGISTER

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit	
-n = Bit Value at POR: ('0', '1', x = unk	nown)	P = Programmable bit	r = Reserved bit

bit 31-16	Unimplemented: Read as	'0'
		_

bit 15	ON: Input Capture Module Enable bit ⁽¹⁾
	1 = Module is enabled
	0 = Disable and reset module, disable clocks, disable interrupt generation and allow SFR modifications
bit 14	Unimplemented: Read as '0'
bit 13	SIDL: Stop in Idle Control bit
	1 = Halt in Idle mode
	0 = Continue to operate in Idle mode
bit 12-10	Unimplemented: Read as '0'
bit 9	FEDGE: First Capture Edge Select bit (only used in mode 6, ICM<2:0> = 110)
	1 = Capture rising edge first
	0 = Capture falling edge first
bit 8	C32: 32-bit Capture Select bit
	1 = 32-bit timer resource capture
	0 = 16-bit timer resource capture
bit 7	ICTMR: Timer Select bit (Does not affect timer selection when C32 (ICxCON<8>) is '1')
	0 = Timer3 is the counter source for capture
	1 = Timer2 is the counter source for capture
bit 6-5	ICI<1:0>: Interrupt Control bits
	11 = Interrupt on every fourth capture event
	10 = Interrupt on every third capture event 01 = Interrupt on every second capture event
	00 = Interrupt on every capture event
bit 4	ICOV: Input Capture Overflow Status Flag bit (read-only)
	1 = Input capture overflow has occurred
	0 = No input capture overflow has occurred
bit 3	ICBNE: Input Capture Buffer Not Empty Status bit (read-only)
	1 = Input capture buffer is not empty; at least one more capture value can be read
	0 = Input capture buffer is empty
Note 1:	When using 1:1 PBCLK divisor, the user's software should not read/write the peripheral's SFRs in the

SYSCLK cycle immediately following the instruction that clears the module's ON bit.

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REGISTER 15-1: ICXCON: INPUT CAPTURE 'x' CONTROL REGISTER (CONTINUED)

- bit 2-0 ICM<2:0>: Input Capture Mode Select bits
 - 111 = Interrupt-Only mode (only supported while in Sleep mode or Idle mode)
 - 110 = Simple Capture Event mode every edge, specified edge first and every edge thereafter
 - 101 = Prescaled Capture Event mode every sixteenth rising edge
 - 100 = Prescaled Capture Event mode every fourth rising edge
 - 011 = Simple Capture Event mode every rising edge
 - 010 = Simple Capture Event mode every falling edge
 - 001 = Edge Detect mode every edge (rising and falling)
 - 000 = Input Capture module is disabled
- **Note 1:** When using 1:1 PBCLK divisor, the user's software should not read/write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.

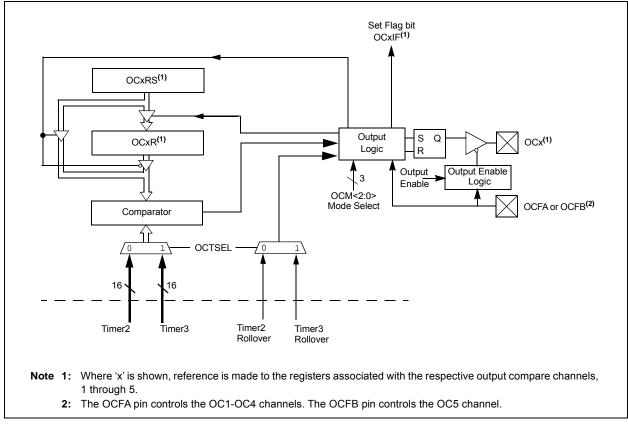
16.0 OUTPUT COMPARE

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 16. "Output Compare" (DS60001111), which is available from the *Documentation* > *Reference Manual* section of the Microchip PIC32 web site (www.microchip.com/pic32).

The Output Compare module is used to generate a single pulse or a train of pulses in response to selected time base events. For all modes of operation, the Output Compare module compares the values stored in the OCxR and/or the OCxRS registers to the value in the selected timer. When a match occurs, the Output Compare module generates an event based on the selected mode of operation. The following are some of the key features:

- · Multiple Output Compare Modules in a device
- Programmable interrupt generation on compare event
- Single and Dual Compare modes
- · Single and continuous output pulse generation
- Pulse-Width Modulation (PWM) mode
- Hardware-based PWM Fault detection and automatic output disable
- Can operate from either of two available 16-bit time bases or a single 32-bit time base





16.1 Output Compare Control Registers

TABLE 16-1: OUTPUT COMPARE 1-OUTPUT COMPARE 5 REGISTER MAP

ess										Bi	its			
Virtual Address (BF80_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4
3000	OC1CON	31:16 15:0	— ON	_	— SIDL	_	_	_	_	_	_	_	— OC32	— OCFLT
3010	OC1R	31:16 15:0	on		OIDE					OC1R	<31:0>		0002	UUL
3020	OC1RS	31:16 15:0		•						OC1R8	6<31:0>	•		
3200	OC2CON	31:16 15:0	 ON		— SIDL	_	_	_	_	_	_	_	— OC32	— OCFLT
3210	OC2R	31:16 15:0	UN		SIDL	_	_	_	_	OC2R		_	0032	OCFLI
3220	OC2RS	31:16 15:0		_						OC2RS	S<31:0>		-	-
3400	OC3CON	31:16 15:0	ON		— SIDL				_				— OC32	
3410	OC3R	31:16 15:0	011		OIDE					OC3R	<31:0>		0002	0012
3420	OC3RS	31:16 15:0								OC3R8	6<31:0>			
3600	OC4CON	31:16 15:0	— ON		— SIDL				_	_			— OC32	
3610	OC4R	31:16 15:0								OC4R	<31:0>			
3620	OC4RS	31:16 15:0								OC4RS	6<31:0>			-
3800	OC5CON	15:0	— ON	-	— SIDL				-	_ _			— OC32	
3810	OC5R	31:16 15:0								OC5R	<31:0>			
3820	OC5RS	31:16 15:0								OC5RS	\$<31:0>			



Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See more information.

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Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24			_	_	_	_	—	—
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	_	_	_	-	_	_	—	—
45.0	R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
15:8	0N ⁽¹⁾	_	SIDL	_	_	_	—	—
7.0	U-0	U-0	R/W-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0
7:0	_		OC32	OCFLT ⁽²⁾	OCTSEL		OCM<2:0>	

REGISTER 16-1: OCxCON: OUTPUT COMPARE 'x' CONTROL REGISTER

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

- bit 15 **ON:** Output Compare Peripheral On bit⁽¹⁾
 - 1 = Output Compare peripheral is enabled
 - 0 = Output Compare peripheral is disabled
- bit 14 Unimplemented: Read as '0'
- bit 13 **SIDL:** Stop in Idle Mode bit
 - 1 = Discontinue module operation when the device enters Idle mode
 - 0 = Continue module operation when the device enters Idle mode

bit 12-6 Unimplemented: Read as '0'

- bit 5 OC32: 32-bit Compare Mode bit
 - 1 = OCxR<31:0> and/or OCxRS<31:0> are used for comparisons to the 32-bit timer source 0 = OCxR<15:0> and OCxRS<15:0> are used for comparisons to the 16-bit timer source
- bit 4 **OCFLT:** PWM Fault Condition Status bit⁽²⁾
 - 1 = PWM Fault condition has occurred (cleared in hardware only)
- 0 = No PWM Fault condition has occurred
- bit 3 OCTSEL: Output Compare Timer Select bit
 - 1 = Timer3 is the clock source for this Output Compare module
 - 0 = Timer2 is the clock source for this Output Compare module
- bit 2-0 OCM<2:0>: Output Compare Mode Select bits
 - 111 = PWM mode on OCx; Fault pin enabled
 - 110 = PWM mode on OCx; Fault pin disabled
 - 101 = Initialize OCx pin low; generate continuous output pulses on OCx pin
 - 100 = Initialize OCx pin low; generate single output pulse on OCx pin
 - 011 = Compare event toggles OCx pin
 - 010 = Initialize OCx pin high; compare event forces OCx pin low
 - 001 = Initialize OCx pin low; compare event forces OCx pin high
 - 000 = Output compare peripheral is disabled but continues to draw current

Note 1: When using 1:1 PBCLK divisor, the user's software should not read/write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.

2: This bit is only used when OCM<2:0> = '111'. It is read as '0' in all other modes.

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NOTES:

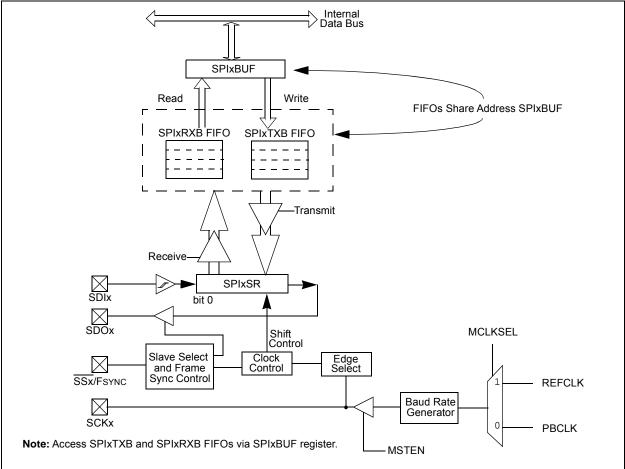
17.0 SERIAL PERIPHERAL INTERFACE (SPI)

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 23. "Serial Peripheral Interface (SPI)" (DS60001106), which is available from the Documentation > Reference Manual section of the Microchip PIC32 web site (www.microchip.com/pic32).

The SPI module is a synchronous serial interface that is useful for communicating with external peripherals and other microcontrollers. These peripheral devices may be Serial EEPROMs, Shift registers, display drivers, Analog-to-Digital Converters (ADC), etc. The PIC32 SPI module is compatible with Motorola[®] SPI and SIOP interfaces. Some of the key features of the SPI module are:

- · Master mode and Slave mode support
- · Four clock formats
- · Enhanced Framed SPI protocol support
- User-configurable 8-bit, 16-bit and 32-bit data width
- Separate SPI FIFO buffers for receive and transmit
 FIFO buffers act as 4/8/16-level deep FIFOs
- FIFO builders act as 476 ho-level deep FIFOS
 based on 32/16/8-bit data width
- Programmable interrupt event on every 8-bit, 16-bit and 32-bit data transfer
- Operation during Sleep and Idle modes
- Audio Codec Support:
 - I²S protocol
 - Left-justified
 - Right-justified
 - PCM

FIGURE 17-1: SPI MODULE BLOCK DIAGRAM



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SPI Control Registers 17.1

TABLE 17-1: SPI1 AND SPI2 REGISTER MAP

ess										Bi	s			
Virtual Address (BF80_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4
5000	SPI1CON	31:16	FRMEN	FRMSYNC	FRMPOL	MSSEN	FRMSYPW	Ff	RMCNT<2:()>	MCLKSEL	—		—
5600	SPITCON	15:0	ON	—	SIDL	DISSDO	MODE32	MODE16	SMP	CKE	SSEN	CKP	MSTEN	DISSDI
5040	CDI1CTAT	31:16	—	—	—		RXE	BUFELM<4:	0>		—	—	_	
5810	SPI1STAT	15:0	—	—	—	FRMERR	SPIBUSY	—	—	SPITUR	SRMT	SPIROV	SPIRBE	—
5820	SPI1BUF	31:16 15:0				DATA<31:0>								
		31:16	_	_	_	_	—	_	_	_	—	—	_	_
5830	SPI1BRG	15:0	_	_	_						E	3RG<12:0>		
		31:16	—	—	—	_		—	—	—	_	_	—	—
5840	SPI1CON2	15:0	SPI SGNEXT	_	Ι	FRM ERREN	SPI ROVEN	SPI TUREN	IGNROV	IGNTUR	AUDEN	_	-	—
		31:16	FRMEN	FRMSYNC	FRMPOL	MSSEN	FRMSYPW	Ff	RMCNT<2:0)>	MCLKSEL	_	_	_
5A00	SPI2CON	15:0	ON	—	SIDL	DISSDO	MODE32	MODE16	SMP	CKE	SSEN	CKP	MSTEN	DISSDI
5440		31:16	_	—	_		RXE	BUFELM<4:	0>		_	_	_	
5A10	SPI2STAT	15:0	_	_	-	FRMERR	SPIBUSY	_	_	SPITUR	SRMT	SPIROV	SPIRBE	_
5A20	SPI2BUF	31:16 15:0								DATA<	31:0>			
5400		31:16	-	_	—	—	—	_	_	_	_	_	_	—
5A30	SPI2BRG	15:0	_	_	_						E	3RG<12:0>		
		31:16	_	—	_	_	_	_	_	_	_	_	_	_
5A40	SPI2CON2	15:0	SPI SGNEXT	_	_	FRM ERREN	SPI ROVEN	SPI TUREN	IGNROV	IGNTUR	AUDEN	_	_	—

Legend:

x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

All registers in this table except SPIxBUF have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, n Registers" for more information. Note 1:

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Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0		
24.24	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
31:24	FRMEN	FRMSYNC	FRMPOL	MSSEN	FRMSYPW	F	FRMCNT<2:0>			
00.40	R/W-0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0		
23:16	MCLKSEL ⁽²⁾	_		—	_	_	SPIFE	ENHBUF ⁽²⁾		
45.0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
15:8	ON ⁽¹⁾		SIDL	DISSDO	MODE32	MODE16	SMP	CKE ⁽³⁾		
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
7:0	SSEN	CKP ⁽⁴⁾	MSTEN	DISSDI	STXISE	L<1:0>	SRXIS	EL<1:0>		

REGISTER 17-1: SPIxCON: SPI CONTROL REGISTER

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 31 FRMEN: Framed SPI Support bit

- 1 = Framed SPI support is enabled (SSx pin used as FSYNC input/output)
 - 0 = Framed SPI support is disabled
- bit 30 **FRMSYNC:** Frame Sync Pulse Direction Control on SSx pin bit (Framed SPI mode only) 1 = Frame sync pulse input (Slave mode)
 - 0 = Frame sync pulse output (Master mode)
- bit 29 **FRMPOL:** Frame Sync Polarity bit (Framed SPI mode only)
 - 1 = Frame pulse is active-high
 - 0 = Frame pulse is active-low
- bit 28 **MSSEN:** Master Mode Slave Select Enable bit
 - 1 = Slave select SPI support enabled. The SS pin is automatically driven during transmission in Master mode. Polarity is determined by the FRMPOL bit.
 - 0 = Slave select SPI support is disabled.
- bit 27 FRMSYPW: Frame Sync Pulse Width bit
 - 1 = Frame sync pulse is one character wide
 - 0 = Frame sync pulse is one clock wide
- bit 26-24 **FRMCNT<2:0>:** Frame Sync Pulse Counter bits. Controls the number of data characters transmitted per pulse. This bit is only valid in FRAMED_SYNC mode.
 - 111 = Reserved; do not use
 - 110 = Reserved; do not use
 - 101 = Generate a frame sync pulse on every 32 data characters
 - 100 = Generate a frame sync pulse on every 16 data characters
 - 011 = Generate a frame sync pulse on every 8 data characters
 - 010 = Generate a frame sync pulse on every 4 data characters
 - 001 = Generate a frame sync pulse on every 2 data characters
 - 000 = Generate a frame sync pulse on every data character
- bit 23 MCLKSEL: Master Clock Enable bit⁽²⁾
 - 1 = REFCLK is used by the Baud Rate Generator
 - 0 = PBCLK is used by the Baud Rate Generator
- bit 22-18 Unimplemented: Read as '0'
- **Note 1:** When using the 1:1 PBCLK divisor, the user's software should not read or write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.
 - 2: This bit can only be written when the ON bit = 0.
 - **3:** This bit is not used in the Framed SPI mode. The user should program this bit to '0' for the Framed SPI mode (FRMEN = 1).
 - 4: When AUDEN = 1, the SPI module functions as if the CKP bit is equal to '1', regardless of the actual value of CKP.

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REGISTI	ER 17-1: SPIxCON: S	PI CONTROL REGISTER (CONTINUED)							
bit 17		e Edge Select bit (Framed SPI mode only)							
		on pulse coincides with the first bit clock							
bit 16	 Frame synchronization pulse precedes the first bit clock ENHBUF: Enhanced Buffer Enable bit⁽²⁾ 								
	1 = Enhanced Buffer mode is enabled								
	0 = Enhanced Buffer mod								
bit 15	ON: SPI Peripheral On bit								
	1 = SPI Peripheral is ena0 = SPI Peripheral is disa								
bit 14	Unimplemented: Read as								
bit 13	SIDL: Stop in Idle Mode b								
		operation when the device enters Idle mode							
h:: 40		ration when the device enters Idle mode							
bit 12	DISSDO: Disable SDOx p 1 = SDOx pin is not used	by the module. Pin is controlled by associated PORT register							
	0 = SDOx pin is controlle								
bit 11-10	-	Communication Select bits							
	When AUDEN = 1:								
	MODE32 MODE16	Communication 24-bit Data, 32-bit FIFO, 32-bit Channel/64-bit Frame							
	1 0	32-bit Data, 32-bit FIFO, 32-bit Channel/64-bit Frame							
	0 1	16-bit Data, 16-bit FIFO, 32-bit Channel/64-bit Frame							
	0 0	16-bit Data, 16-bit FIFO, 16-bit Channel/32-bit Frame							
	When AUDEN = 0:								
	MODE32 MODE16	Communication							
	1 x	32-bit							
	0 1	16-bit							
bit 9	0 0 SMP: SPI Data Input Sam	8-bit							
bit 5	Master mode (MSTEN = 1								
	1 = Input data sampled a	t end of data output time							
	0 = Input data sampled a Slave mode (MSTEN = 0)	t middle of data output time							
		<u>.</u> n SPI is used in Slave mode. The module always uses SMP = 0.							
	To write a '1' to this bit, the	e MSTEN value = 1 must first be written.							
bit 8	CKE: SPI Clock Edge Sel								
		anges on transition from active clock state to Idle clock state (see the CKP bit) anges on transition from Idle clock state to active clock state (see the CKP bit)							
bit 7	SSEN: Slave Select Enab								
bit i	$1 = \overline{SSx}$ pin used for Slav								
		Slave mode, pin controlled by port function.							
bit 6	CKP: Clock Polarity Select								
		a high level; active state is a low level a low level; active state is a high level							
Note 1:	-	K divisor, the user's software should not read or write the peripheral's SFRs in							
n .	This bit can only be writte	diately following the instruction that clears the module's ON bit.							
2: 3:	•	Framed SPI mode. The user should program this bit to '0' for the Framed SPI							
5.	mode (FRMEN = 1).								
4:		PI module functions as if the CKP bit is equal to '1', regardless of the actual value							
	of CKP.								

REGISTER 17-1: SPIxCON: SPI CONTROL REGISTER (CONTINUED)

- bit 5 MSTEN: Master Mode Enable bit
 - 1 = Master mode
 - 0 = Slave mode
- bit 4 **DISSDI:** Disable SDI bit
 - 1 = SDI pin is not used by the SPI module (pin is controlled by PORT function)0 = SDI pin is controlled by the SPI module
- bit 3-2 STXISEL<1:0>: SPI Transmit Buffer Empty Interrupt Mode bits
 - 11 = Interrupt is generated when the buffer is not full (has one or more empty elements)
 - 10 = Interrupt is generated when the buffer is empty by one-half or more
 - 01 = Interrupt is generated when the buffer is completely empty
 - 00 = Interrupt is generated when the last transfer is shifted out of SPISR and transmit operations are complete
- bit 1-0 SRXISEL<1:0>: SPI Receive Buffer Full Interrupt Mode bits
 - 11 = Interrupt is generated when the buffer is full
 - 10 = Interrupt is generated when the buffer is full by one-half or more
 - 01 = Interrupt is generated when the buffer is not empty
 - 00 = Interrupt is generated when the last word in the receive buffer is read (i.e., buffer is empty)
- **Note 1:** When using the 1:1 PBCLK divisor, the user's software should not read or write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.
 - **2:** This bit can only be written when the ON bit = 0.
 - 3: This bit is not used in the Framed SPI mode. The user should program this bit to '0' for the Framed SPI mode (FRMEN = 1).
 - 4: When AUDEN = 1, the SPI module functions as if the CKP bit is equal to '1', regardless of the actual value of CKP.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	_	_	—	—	—			—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	—	—	—	—	—		—	—
15:8	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
15.0	SPISGNEXT	—	—	FRMERREN	SPIROVEN	SPITUREN	IGNROV	IGNTUR
7:0	R/W-0	U-0	U-0	U-0	R/W-0	U-0	R/W-0	R/W-0
7:0	AUDEN ⁽¹⁾		_		AUDMONO ^(1,2)	_	AUDMOD)<1:0> ^(1,2)

REGISTER 17-2: SPIxCON2: SPI CONTROL REGISTER 2

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read	as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

- bit 15 **SPISGNEXT:** Sign Extend Read Data from the RX FIFO bit
 - 1 = Data from RX FIFO is sign extended
 - 0 = Data from RX FIFO is not sign extended
- bit 14-13 Unimplemented: Read as '0'
- bit 12 FRMERREN: Enable Interrupt Events via FRMERR bit
 - 1 = Frame Error overflow generates error events
 - 0 = Frame Error does not generate error events
- bit 11 SPIROVEN: Enable Interrupt Events via SPIROV bit
- 1 = Receive overflow generates error events0 = Receive overflow does not generate error events
- bit 10 SPITUREN: Enable Interrupt Events via SPITUR bit
 - 1 = Transmit underrun generates error events
 - 0 = Transmit underrun does not generate error events
- bit 9 IGNROV: Ignore Receive Overflow bit (for Audio Data Transmissions)
 - 1 = A ROV is not a critical error; during ROV data in the FIFO is not overwritten by receive data
 - 0 = A ROV is a critical error that stops SPI operation
- bit 8 IGNTUR: Ignore Transmit Underrun bit (for Audio Data Transmissions)
 - 1 = A TUR is not a critical error and zeros are transmitted until the SPIxTXB is not empty
 - 0 = A TUR is a critical error that stops SPI operation
- bit 7 AUDEN: Enable Audio CODEC Support bit⁽¹⁾
 - 1 = Audio protocol enabled
 - 0 = Audio protocol disabled

bit 6-5 **Unimplemented:** Read as '0'

- bit 3 AUDMONO: Transmit Audio Data Format bit^(1,2)
 - 1 = Audio data is mono (Each data word is transmitted on both left and right channels)
 - 0 = Audio data is stereo
- bit 2 Unimplemented: Read as '0'
- bit 1-0 AUDMOD<1:0>: Audio Protocol Mode bit^(1,2)
 - 11 = PCM/DSP mode
 - 10 = Right-Justified mode
 - 01 = Left-Justified mode
 - $00 = I^2S \mod$
- **Note 1:** This bit can only be written when the ON bit = 0.
 - **2:** This bit is only valid for AUDEN = 1.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0		
21.24	U-0	U-0	U-0	R-0	R-0	R-0	R-0	R-0		
31:24	_	—	_	RXBUFELM<4:0>						
00.40	U-0	U-0	U-0	R-0	R-0	R-0	R-0	R-0		
23:16	_	—	_	TXBUFELM<4:0>						
15.0	U-0	U-0	U-0	R/C-0, HS	R-0	U-0	U-0	R-0		
15:8	—	—	_	FRMERR	SPIBUSY	-	—	SPITUR		
7.0	R-0	R/W-0	R-0	U-0	R-1	U-0	R-0	R-0		
7:0	SRMT	SPIROV	SPIRBE		SPITBE		SPITBF	SPIRBF		

REGISTER 17-3: SPIxSTAT: SPI STATUS REGISTER

Legend:	C = Clearable bit	HS = Set in hardware		
R = Readable bit	W = Writable bit	U = Unimplemented bit, r	read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

- bit 31-29 Unimplemented: Read as '0'
- bit 28-24 **RXBUFELM<4:0>:** Receive Buffer Element Count bits (valid only when ENHBUF = 1)
- bit 23-21 Unimplemented: Read as '0'
- bit 20-16 **TXBUFELM<4:0>:** Transmit Buffer Element Count bits (valid only when ENHBUF = 1)
- bit 15-13 Unimplemented: Read as '0'
- bit 12 FRMERR: SPI Frame Error status bit
 - 1 = Frame error detected
 - 0 = No Frame error detected
 - This bit is only valid when FRMEN = 1.
- bit 11 SPIBUSY: SPI Activity Status bit
 - 1 = SPI peripheral is currently busy with some transactions 0 = SPI peripheral is currently idle
 - Unimplemented: Read as '0'
- bit 10-9 bit 8
 - SPITUR: Transmit Under Run bit
 - 1 = Transmit buffer has encountered an underrun condition
 - 0 = Transmit buffer has no underrun condition
 - This bit is only valid in Framed Sync mode; the underrun condition must be cleared by disabling (ON bit = 0) and re-enabling (ON bit = 1) the module, or writing a '0' to SPITUR.
- bit 7 SRMT: Shift Register Empty bit (valid only when ENHBUF = 1)
 - 1 = When SPI module shift register is empty
 - 0 = When SPI module shift register is not empty
- bit 6 SPIROV: Receive Overflow Flag bit
 - 1 = A new data is completely received and discarded. The user software has not read the previous data in the SPIxBUF register.
 - 0 = No overflow has occurred

This bit is set in hardware; can bit only be cleared by disabling (ON bit = 0) and re-enabling (ON bit = 1) the module, or by writing a '0' to SPIROV.

- bit 5 **SPIRBE:** RX FIFO Empty bit (valid only when ENHBUF = 1) 1 = RX FIFO is empty (CRPTR = SWPTR)
 - 0 = RX FIFO is not empty (CRPTR \neq SWPTR)
- bit 4 Unimplemented: Read as '0'

REGISTER 17-3: SPIxSTAT: SPI STATUS REGISTER

bit 3	SPITBE: SPI Transmit Buffer Empty Status bit
	1 = Transmit buffer, SPIxTXB is empty
	0 = Transmit buffer, SPIxTXB is not empty
	Automatically set in hardware when SPI transfers data from SPIxTXB to SPIxSR.
	Automatically cleared in hardware when SPIxBUF is written to, loading SPIxTXB.
bit 2	Unimplemented: Read as '0'
bit 1	SPITBF: SPI Transmit Buffer Full Status bit
	1 = Transmit not yet started, SPITXB is full
	0 = Transmit buffer is not full
	Standard Buffer Mode:
	Automatically set in hardware when the core writes to the SPIBUF location, loading SPITXB. Automatically cleared in hardware when the SPI module transfers data from SPITXB to SPISR.
	Enhanced Buffer Mode:
	Set when CWPTR + 1 = SRPTR; cleared otherwise
bit 0	SPIRBF: SPI Receive Buffer Full Status bit
	1 = Receive buffer, SPIxRXB is full
	0 = Receive buffer, SPIxRXB is not full
	Standard Buffer Mode:
	Automatically set in hardware when the SPI module transfers data from SPIxSR to SPIxRXB. Automatically cleared in hardware when SPIxBUF is read from, reading SPIxRXB.

Enhanced Buffer Mode:

Set when SWPTR + 1 = CRPTR; cleared otherwise

18.0 INTER-INTEGRATED CIRCUIT (I²C)

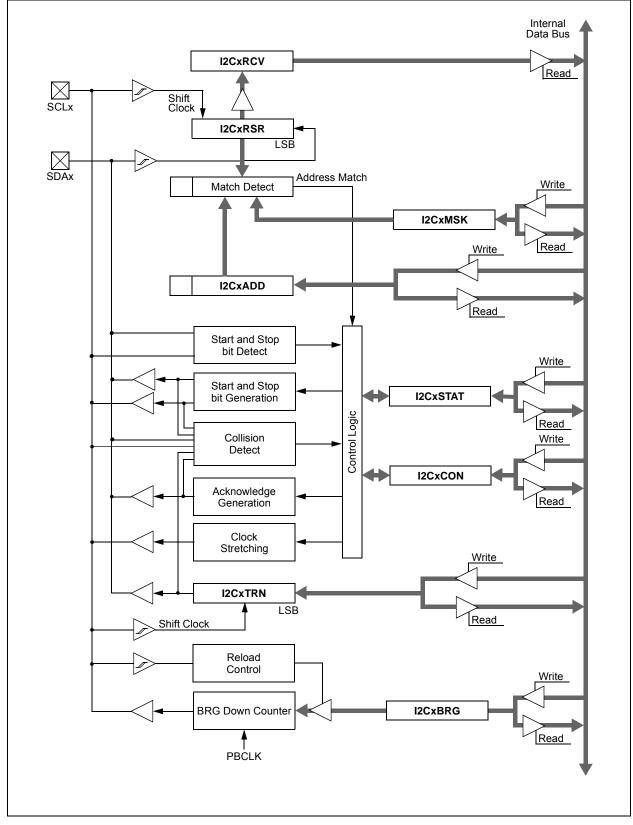
Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 24. "Inter-Integrated Circuit (I²C)" (DS60001116), which is available from the *Documentation* > *Reference Manual* section of the Microchip PIC32 web site (www.microchip.com/pic32). The I²C module provides complete hardware support for both Slave and Multi-Master modes of the I²C serial communication standard. Figure 18-1 illustrates the I²C module block diagram.

Each I^2C module has a 2-pin interface: the SCLx pin is clock and the SDAx pin is data.

Each I²C module offers the following key features:

- I²C interface supporting both master and slave operation
- I²C Slave mode supports 7-bit and 10-bit addressing
- I²C Master mode supports 7-bit and 10-bit addressing
- I²C port allows bidirectional transfers between master and slaves
- Serial clock synchronization for the I²C port can be used as a handshake mechanism to suspend and resume serial transfer (SCLREL control)
- I²C supports multi-master operation; detects bus collision and arbitrates accordingly
- Provides support for address bit masking





18.1 I2C Control Registers

ABLE 18-1: I2C1 AND I2C2 REGISTER MAP

TABI	LE 18-1:	12	C1 AND) I2C2 R	EGISTE	ER MAP								
ess										В	its			
Virtual Address (BF80_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4
5000	1004000	31:16		—	_	_	_	_	_	_	_	—		_
5000	I2C1CON	15:0	ON	—	SIDL	SCLREL	STRICT	A10M	DISSLW	SMEN	GCEN	STREN	ACKDT	ACKEN
5010	I2C1STAT	31:16	—	—				_	_		_	—	—	_
5010	120 13 IAI	15:0	ACKSTAT	TRSTAT	-	-		BCL	GCSTAT	ADD10	IWCOL	I2COV	D_A	Р
5020	I2C1ADD	31:16	—	_				-	_		_	—	—	—
3020	IZCIADD	15:0	—	—	_	_		—				-	Address	Register
5030	I2C1MSK	31:16	—	—	_	_	_		—	—	—	—	—	—
0000		15:0	—	—	_	_	_	—					Address Ma	ask Register
5040	I2C1BRG	31:16	—	—	—	—	—	—	—	—	—	—	—	—
00.0	1201010	15:0	—	—	_	_					Bau	id Rate Gei	nerator Reg	ister
5050	I2C1TRN	31:16	—	_	_	_			—		—	—	—	—
	-	15:0	—	—	_	_	_	—	—	_		-		Transmit R
5060	I2C1RCV	31:16	—	—	_	_	_	—	—	_	—	—	—	_
		15:0	_	-	_	_	_	_	_	_				Receive R
5100	I2C2CON	31:16	-	—	-	—	—	—	—	—	—	-	—	—
		15:0	ON	_	SIDL	SCLREL	STRICT	A10M	DISSLW	SMEN	GCEN	STREN	ACKDT	ACKEN
5110	I2C2STAT	31:16 15:0			_	_	_	-	-	-	-	-	—	-
		31:16	ACKSTAT	TRSTAT		_		BCL	GCSTAT	ADD10	IWCOL	I2COV	D_A	Р
5120	I2C2ADD	15:0							_			_		Register
		31:16								_	_	_	Address	
5130	I2C2MSK	15:0											Address M	ask Register
		31:16								_		_		
5140	I2C2BRG	15:0				_					l Bai	I Id Rate Gei	L Derator Reg	ister
		31:16			_	_					_			_
5150	I2C2TRN	15:0	_		_	_	_	_						Transmit R
		31:16	_	_	_	_	_	_	_	_	_	—	_	
5160	I2C2RCV	15:0	_	_	_	_	_	_	_	_				Receive R
Lananda —									l					

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table except I2CxRCV have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, registers" for more information.

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Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24		—	_	_	—	_	_	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	_	_	—	_	_	—
45.0	R/W-0	U-0	R/W-0	R/W-1, HC	R/W-0	R/W-0	R/W-0	R/W-0
15:8	0N ⁽¹⁾	—	SIDL	SCLREL	STRICT	A10M	DISSLW	SMEN
7.0	R/W-0	R/W-0	R/W-0	R/W-0, HC	R/W-0, HC	R/W-0, HC	R/W-0, HC	R/W-0, HC
7:0	GCEN	STREN	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN

REGISTER 18-1: I2CxCON: I²C CONTROL REGISTER

Legend:	HC = Cleared in Hardware			
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ead as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 31-16 **Unimplemented:** Read as '0'

- bit 15 **ON:** I²C Enable bit⁽¹⁾
 - 1 = Enables the I^2C module and configures the SDA and SCL pins as serial port pins
 - 0 = Disables the I²C module; all I²C pins are controlled by PORT functions
- bit 14 Unimplemented: Read as '0'
- bit 13 **SIDL:** Stop in Idle Mode bit
 - 1 = Discontinue module operation when the device enters Idle mode
 - 0 = Continue module operation when the device enters Idle mode
 - SCLREL: SCLx Release Control bit (when operating as I²C slave)
 - 1 = Release SCLx clock
 - 0 = Hold SCLx clock low (clock stretch)
 - If STREN = 1:

bit 12

Bit is R/W (i.e., software can write '0' to initiate stretch and write '1' to release clock). Hardware clear at beginning of slave transmission. Hardware clear at end of slave reception.

If STREN = 0:

Bit is R/S (i.e., software can only write '1' to release clock). Hardware clear at beginning of slave transmission.

bit 11 STRICT: Strict I²C Reserved Address Rule Enable bit

- 1 = Strict reserved addressing is enforced. Device does not respond to reserved address space or generate addresses in reserved address space.
- 0 = Strict I²C Reserved Address Rule not enabled

bit 10 A10M: 10-bit Slave Address bit

- 1 = I2CxADD is a 10-bit slave address
- 0 = I2CxADD is a 7-bit slave address
- bit 9 DISSLW: Disable Slew Rate Control bit
 - 1 = Slew rate control disabled
 - 0 = Slew rate control enabled
- bit 8 SMEN: SMBus Input Levels bit
 - 1 = Enable I/O pin thresholds compliant with SMBus specification
 - 0 = Disable SMBus input thresholds
- **Note 1:** When using 1:1 PBCLK divisor, the user's software should not read/write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.

REGISTE	ER 18-1: I2CxCON: I ² C CONTROL REGISTER (CONTINUED)
bit 7	GCEN: General Call Enable bit (when operating as I ² C slave)
	 1 = Enable interrupt when a general call address is received in the I2CxRSR (module is enabled for reception) 0 = General call address is disabled
bit 6	STREN: SCLx Clock Stretch Enable bit (when operating as I ² C slave) Used in conjunction with SCLREL bit. 1 = Enable software or receive clock stretching 0 = Disable software or receive clock stretching
bit 5	ACKDT: Acknowledge Data bit (when operating as I ² C master, applicable during master receive) Value that is transmitted when the software initiates an Acknowledge sequence. 1 = Send a NACK during an Acknowledge sequence 0 = Send an ACK during an Acknowledge sequence
bit 4	ACKEN: Acknowledge Sequence Enable bit (when operating as I^2C master, applicable during master receive)
	 1 = Initiate Acknowledge sequence on SDAx and SCLx pins and transmit ACKDT data bit. Hardware clear at end of master Acknowledge sequence. 0 = Acknowledge sequence not in progress
bit 3	RCEN: Receive Enable bit (when operating as I ² C master)
	 1 = Enables Receive mode for I²C. Hardware clear at end of eighth bit of master receive data byte. 0 = Receive sequence not in progress
bit 2	PEN: Stop Condition Enable bit (when operating as I ² C master)
	1 = Initiate Stop condition on SDAx and SCLx pins. Hardware clear at end of master Stop sequence.0 = Stop condition not in progress
bit 1	RSEN: Repeated Start Condition Enable bit (when operating as I ² C master)
	 1 = Initiate Repeated Start condition on SDAx and SCLx pins. Hardware clear at end of master Repeated Start sequence. 0 = Repeated Start condition pot in progress.
bit 0	 0 = Repeated Start condition not in progress SEN: Start Condition Enable bit (when operating as I²C master)
	 1 = Initiate Start condition on SDAx and SCLx pins. Hardware clear at end of master Start sequence. 0 = Start condition not in progress

Note 1: When using 1:1 PBCLK divisor, the user's software should not read/write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
04.04	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	—	_	_	—	—	_	_	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
		_		-	-	_	-	-
45.0	R-0, HSC	R-0, HSC	U-0	U-0	U-0	R/C-0, HS	R-0, HSC	R-0, HSC
15:8	ACKSTAT	TRSTAT		_	_	BCL	GCSTAT	ADD10
7.0	R/C-0, HS	R/C-0, HS	R-0, HSC	R/C-0, HSC	R/C-0, HSC	R-0, HSC	R-0, HSC	R-0, HSC
7:0	IWCOL	I2COV	D_A	Р	S	R_W	RBF	TBF

REGISTER 18-2: I2CxSTAT: I²C STATUS REGISTER

Legend:	HS = Set in hardware	HSC = Hardware set/c	leared
R = Readable bit	W = Writable bit	U = Unimplemented b	it, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	C = Clearable bit

bit 31-16 Unimplemented: Read as '0'

01-10	Unimplemented: Read as 0
bit 15	ACKSTAT: Acknowledge Status bit (when operating as I ² C master, applicable to master transmit operation)
	1 = Acknowledge was not received from slave
	0 = Acknowledge was received from slave
	Hardware set or clear at end of slave Acknowledge.
bit 14	TRSTAT: Transmit Status bit (when operating as I ² C master, applicable to master transmit operation)
	1 = Master transmit is in progress (8 bits + ACK)
	 0 = Master transmit is not in progress Hardware set at beginning of master transmission. Hardware clear at end of slave Acknowledge.
bit 13-11	
bit 10	BCL: Master Bus Collision Detect bit
	1 = A bus collision has been detected during a master operation
	0 = No collision
	Hardware set at detection of bus collision. This condition can only be cleared by disabling (ON bit = 0) and
	re-enabling (ON bit = 1) the module.
bit 9	GCSTAT: General Call Status bit
	1 = General call address was received
	 0 = General call address was not received Hardware set when address matches general call address. Hardware clear at Stop detection.
bit 8	ADD10: 10-bit Address Status bit
DILO	1 = 10-bit address was matched
	0 = 10-bit address was not matched
	Hardware set at match of 2nd byte of matched 10-bit address. Hardware clear at Stop detection.
bit 7	IWCOL: Write Collision Detect bit
	1 = An attempt to write the I2CxTRN register failed because the I^2C module is busy
	0 = No collision
	Hardware set at occurrence of write to I2CxTRN while busy (cleared by software).
bit 6	I2COV: Receive Overflow Flag bit
	1 = A byte was received while the I2CxRCV register is still holding the previous byte
	 0 = No overflow Hardware set at attempt to transfer I2CxRSR to I2CxRCV (cleared by software).
bit 5	D_A: Data/Address bit (when operating as I^2C slave)
DIL J	1 = Indicates that the last byte received was data
	0 = Indicates that the last byte received was device address
	Hardware clear at device address match. Hardware set by reception of slave byte.

I2CxSTAT: I²C STATUS REGISTER (CONTINUED) **REGISTER 18-2:** bit 4 P: Stop bit 1 = Indicates that a Stop bit has been detected last 0 = Stop bit was not detected last Hardware set or clear when Start, Repeated Start or Stop detected. bit 3 S: Start bit 1 = Indicates that a Start (or Repeated Start) bit has been detected last 0 = Start bit was not detected last Hardware set or clear when Start, Repeated Start or Stop detected. bit 2 **R_W:** Read/Write Information bit (when operating as I²C slave) 1 = Read – indicates data transfer is output from slave 0 = Write – indicates data transfer is input to slave Hardware set or clear after reception of I²C device address byte. bit 1 RBF: Receive Buffer Full Status bit 1 = Receive complete, I2CxRCV is full 0 = Receive not complete, I2CxRCV is empty Hardware set when I2CxRCV is written with received byte. Hardware clear when software reads I2CxRCV. bit 0 TBF: Transmit Buffer Full Status bit 1 = Transmit in progress, I2CxTRN is full

0 = Transmit complete, I2CxTRN is empty
 Hardware set when software writes I2CxTRN. Hardware clear at completion of data transmission.

NOTES:

19.0 UNIVERSAL ASYNCHRONOUS RECEIVER TRANSMITTER (UART)

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 21. "Universal Asynchronous Receiver Transmitter (UART)" (DS60001107), which is available from the Documentation > Reference Manual section of the Microchip PIC32 web site (www.microchip.com/pic32).

The UART module is one of the serial I/O modules available in PIC32MX1XX/2XX 28/36/44-pin Family devices. The UART is a full-duplex, asynchronous communication channel that communicates with peripheral devices and personal computers through protocols, such as RS-232, RS-485, LIN, and IrDA[®]. The UART module also supports the hardware flow control option, with UXCTS and UXRTS pins, and also includes an IrDA encoder and decoder.

Key features of the UART module include:

- · Full-duplex, 8-bit or 9-bit data transmission
- Even, Odd or No Parity options (for 8-bit data)
- · One or two Stop bits
- · Hardware auto-baud feature
- · Hardware flow control option
- Fully integrated Baud Rate Generator (BRG) with 16-bit prescaler
- Baud rates ranging from 38 bps to 12.5 Mbps at 50 MHz
- 8-level deep First In First Out (FIFO) transmit data buffer
- · 8-level deep FIFO receive data buffer
- Parity, framing and buffer overrun error detection
- Support for interrupt-only on address detect (9th bit = 1)
- Separate transmit and receive interrupts
- Loopback mode for diagnostic support
- · LIN protocol support
- IrDA encoder and decoder with 16x baud clock output for external IrDA encoder/decoder support

Figure 19-1 illustrates a simplified block diagram of the UART module.

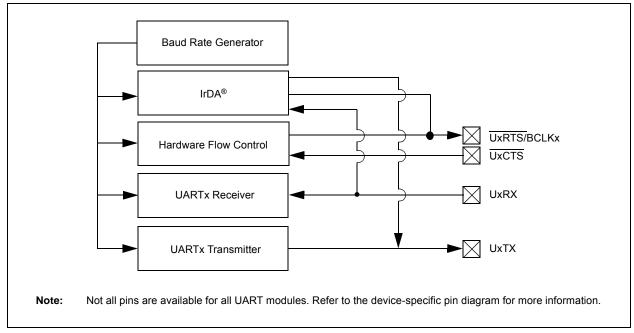


FIGURE 19-1: UART SIMPLIFIED BLOCK DIAGRAM

UART Control Registers 19.1

TABLE 19-1: UART1 AND UART2 REGISTER MAP

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. ess										Bi	ts						
Virtual Address (BF80_#)	Register Name	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4			
6000	U1MODE ⁽¹⁾	31:16	_	—	—	_	—		—		_	—	_	_			
0000	OTWODE	15:0	ON	—	SIDL	IREN	RTSMD	_	UEN	<1:0>	WAKE	LPBACK	ABAUD	RXINV			
6010	U1STA ⁽¹⁾	31:16	_	—	—		—	_	—	ADM_EN				ADD			
0010	0101A	15:0	UTXISI	EL<1:0>	UTXINV	URXEN	UTXBRK	UTXEN	UTXBF	TRMT	URXISI	EL<1:0>	ADDEN	RIDLE			
6020	U1TXREG	31:16	_	—	—	-	—	-	_	—	_	—	_	_			
0020	UTIAREG	15:0	_	—	_		_		_				Tra	insmit Reg			
6030	U1RXREG	31:16	_	—	_		_		_	—	_	_					
0030	UTRAREG	15:0	_	—	_		_		_				Re	ceive Reg			
6040	U1BRG ⁽¹⁾	31:16	_	—	—	-	—	-	—	—	_	—	_	_			
00+0	U IDIXO.	15:0							Bau	d Rate Gene	erator Pres	caler					
6200	U2MODE ⁽¹⁾	31:16	_	—	—	-	—	-	—	—	_	—	_	_			
0200	OZINODE	15:0	ON	—	SIDL	IREN	RTSMD	-	UEN	<1:0>	WAKE	LPBACK	ABAUD	RXINV			
6210	U2STA ⁽¹⁾	31:16	_	-	—		_	-	—	ADM_EN				ADD			
5210	0201A. /	15:0	UTXIS	EL<1:0>	UTXINV	URXEN	UTXBRK	UTXEN	UTXBF	TRMT	URXIS	EL<1:0>	ADDEN	RIDLE			
6220	U2TXREG	31:16	—	—	—		_		-	_	_	_	-				
0220	UZ IANEG	15:0	_	—	—	-	_	-	_				Tra	insmit Reg			
6230	U2RXREG	31:16	_	_	—	_	—	_	_	—	_	-	_	_			
0230	02NANEG	15:0	_	_	_	-	_		_				Re	ceive Reg			
6240	U2BRG ⁽¹⁾	31:16	—	_	—	_	_	_	_	—	_	_	_	_			
0240	UZDRG"	15:0						Baud Rate Generator Prescaler									



Note 1: This register has corresponding CLR, SET and INV registers at its virtual address, plus an offset of 0x4, 0x8 and 0xC, respectively. See Section 11.2 "C

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
21.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	_	_	_	-	—	_	_	—
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	_	_	_	_	—	-	_	—
45.0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0
15:8	R/W-0 ON ⁽¹⁾ R/W-0	_	SIDL	IREN	RTSMD	-	UEN	<1:0>
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
7:0	WAKE	LPBACK	ABAUD	RXINV	BRGH	PDSEL	<1:0>	STSEL

REGISTER 19-1: UxMODE: UARTx MODE REGISTER

Legend:

5				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 31-16 **Unimplemented:** Read as '0'

- bit 15 **ON:** UARTx Enable bit⁽¹⁾
 - 1 = UARTx is enabled. UARTx pins are controlled by UARTx as defined by the UEN<1:0> and UTXEN control bits.
 - UARTx is disabled. All UARTx pins are controlled by corresponding bits in the PORTx, TRISx and LATx registers; UARTx power consumption is minimal.
- bit 14 Unimplemented: Read as '0'

bit 13 **SIDL:** Stop in Idle Mode bit

- 1 = Discontinue module operation when the device enters Idle mode
- 0 = Continue module operation when the device enters Idle mode
- bit 12 IREN: IrDA Encoder and Decoder Enable bit
 - 1 = IrDA is enabled
 - 0 = IrDA is disabled
- bit 11 **RTSMD:** Mode Selection for UxRTS Pin bit
 - $1 = \overline{\text{UxRTS}}$ pin is in Simplex mode
 - $0 = \overline{\text{UxRTS}}$ pin is in Flow Control mode
- bit 10 Unimplemented: Read as '0'
- bit 9-8 UEN<1:0>: UARTx Enable bits
 - 11 = UxTX, UxRX and UxBCLK pins are enabled and used; UxCTS pin is controlled by corresponding bits in the PORTx register
 - 10 = UxTX, UxRX, \overline{UxCTS} and \overline{UxRTS} pins are enabled and used
 - 01 = UxTX, UxRX and UxRTS pins are enabled and used; UxCTS pin is controlled by corresponding bits in the PORTx register
 - 00 = UxTX and UxRX pins are enabled and used; UxCTS and UxRTS/UxBCLK pins are controlled by corresponding bits in the PORTx register
- bit 7 WAKE: Enable Wake-up on Start bit Detect During Sleep Mode bit
 - 1 = Wake-up enabled
 - 0 = Wake-up disabled
- bit 6 LPBACK: UARTx Loopback Mode Select bit
 - Loopback mode is enabled
 - 0 = Loopback mode is disabled
- **Note 1:** When using 1:1 PBCLK divisor, the user software should not read/write the peripheral SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.

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REGISTER 19-1: UXMODE: UARTX MODE REGISTER (CONTINUED)

- bit 5 **ABAUD:** Auto-Baud Enable bit
 - 1 = Enable baud rate measurement on the next character requires reception of Sync character (0x55); cleared by hardware upon completion
 - 0 = Baud rate measurement disabled or completed
- bit 4 RXINV: Receive Polarity Inversion bit
- 1 = UxRX Idle state is '0'
 - 0 = UxRX Idle state is '1'
- bit 3 BRGH: High Baud Rate Enable bit
 - 1 = High-Speed mode 4x baud clock enabled
 - 0 = Standard Speed mode 16x baud clock enabled
- bit 2-1 PDSEL<1:0>: Parity and Data Selection bits
 - 11 = 9-bit data, no parity
 - 10 = 8-bit data, odd parity
 - 01 = 8-bit data, even parity
 - 00 = 8-bit data, no parity
- bit 0 STSEL: Stop Selection bit
 - 1 = 2 Stop bits
 - 0 = 1 Stop bit
- **Note 1:** When using 1:1 PBCLK divisor, the user software should not read/write the peripheral SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0		
24.04	U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0		
31:24	—	_	_	_	_	_	_	ADM_EN		
00.40	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
23:16	ADDR<7:0>									
45.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-0	R-1		
15:8	UTXISE	L<1:0>	UTXINV	URXEN	UTXBRK	UTXEN	UTXBF	TRMT		
7.0	R/W-0	R/W-0	R/W-0	R-1	R-0	R-0	R/W-0	R-0		
7:0	URXISE	L<1:0>	ADDEN	RIDLE	PERR	FERR	OERR	URXDA		

REGISTER 19-2: UxSTA: UARTx STATUS AND CONTROL REGISTER

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, r	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-25 Unimplemented: Read as '0'

- bit 24 ADM_EN: Automatic Address Detect Mode Enable bit
 - 1 = Automatic Address Detect mode is enabled
 - 0 = Automatic Address Detect mode is disabled

bit 23-16 ADDR<7:0>: Automatic Address Mask bits

When the ADM_EN bit is '1', this value defines the address character to use for automatic address detection.

bit 15-14 UTXISEL<1:0>: TX Interrupt Mode Selection bits

- 11 = Reserved, do not use
- 10 = Interrupt is generated and asserted while the transmit buffer is empty
- 01 = Interrupt is generated and asserted when all characters have been transmitted
- 00 = Interrupt is generated and asserted while the transmit buffer contains at least one empty space

bit 13 UTXINV: Transmit Polarity Inversion bit

- If IrDA mode is disabled (i.e., IREN (UxMODE<12>) is '0'):
- 1 = UxTX Idle state is '0'
- 0 = UxTX Idle state is '1'

If IrDA mode is enabled (i.e., IREN (UxMODE<12>) is '1'):

- 1 = IrDA encoded UxTX Idle state is '1'
- 0 = IrDA encoded UxTX Idle state is '0'
- bit 12 URXEN: Receiver Enable bit
 - 1 = UARTx receiver is enabled. UxRX pin is controlled by UARTx (if ON = 1)
 - 0 = UARTx receiver is disabled. UxRX pin is ignored by the UARTx module. UxRX pin is controlled by port.

bit 11 UTXBRK: Transmit Break bit

- 1 = Send Break on next transmission. Start bit followed by twelve '0' bits, followed by Stop bit; cleared by hardware upon completion
- 0 = Break transmission is disabled or completed
- bit 10 UTXEN: Transmit Enable bit
 - 1 = UARTx transmitter is enabled. UxTX pin is controlled by UARTx (if ON = 1).
 - 0 = UARTx transmitter is disabled. Any pending transmission is aborted and buffer is reset. UxTX pin is controlled by port.
- bit 9 UTXBF: Transmit Buffer Full Status bit (read-only)
 - 1 = Transmit buffer is full
 - 0 = Transmit buffer is not full, at least one more character can be written

bit 8 **TRMT:** Transmit Shift Register is Empty bit (read-only)

- 1 = Transmit shift register is empty and transmit buffer is empty (the last transmission has completed)
- 0 = Transmit shift register is not empty, a transmission is in progress or queued in the transmit buffer

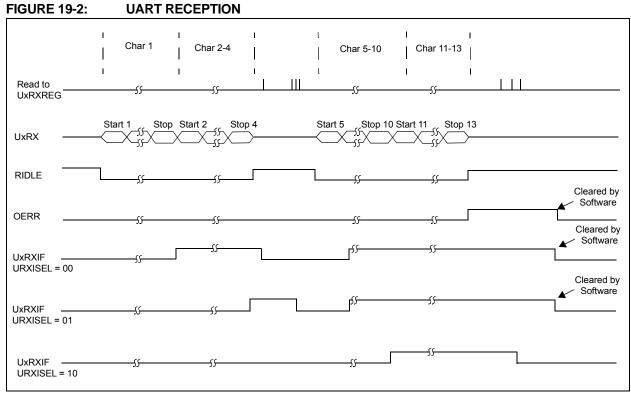
REGISTER 19-2: UxSTA: UARTx STATUS AND CONTROL REGISTER (CONTINUED)

URXISEL<1:0>: Receive Interrupt Mode Selection bit bit 7-6 11 = Reserved; do not use 10 = Interrupt flag bit is asserted while receive buffer is 3/4 or more full (i.e., has 6 or more data characters) 01 = Interrupt flag bit is asserted while receive buffer is 1/2 or more full (i.e., has 4 or more data characters) 00 = Interrupt flag bit is asserted while receive buffer is not empty (i.e., has at least 1 data character) ADDEN: Address Character Detect bit (bit 8 of received data = 1) bit 5 1 = Address Detect mode is enabled. If 9-bit mode is not selected, this control bit has no effect. 0 = Address Detect mode is disabled RIDLE: Receiver Idle bit (read-only) bit 4 1 = Receiver is Idle 0 = Data is being received **PERR:** Parity Error Status bit (read-only) bit 3 1 = Parity error has been detected for the current character 0 = Parity error has not been detected FERR: Framing Error Status bit (read-only) bit 2 1 = Framing error has been detected for the current character 0 = Framing error has not been detected bit 1 **OERR:** Receive Buffer Overrun Error Status bit.

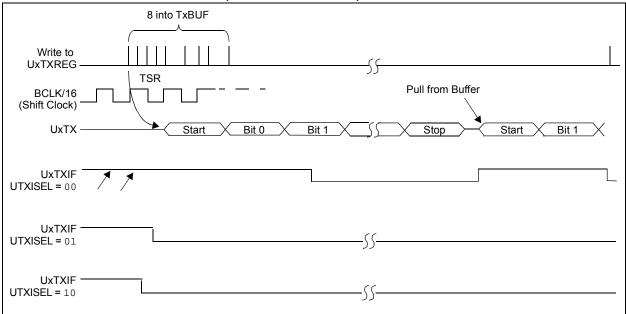
This bit is set in hardware and can only be cleared (= 0) in software. Clearing a previously set OERR bit resets the receiver buffer and the RSR to an empty state.

- 1 = Receive buffer has overflowed
- 0 = Receive buffer has not overflowed
- bit 0 URXDA: Receive Buffer Data Available bit (read-only)
 - 1 = Receive buffer has data, at least one more character can be read
 - 0 = Receive buffer is empty

Figure 19-2 and Figure 19-3 illustrate typical receive and transmit timing for the UART module.







NOTES:

20.0 PARALLEL MASTER PORT (PMP)

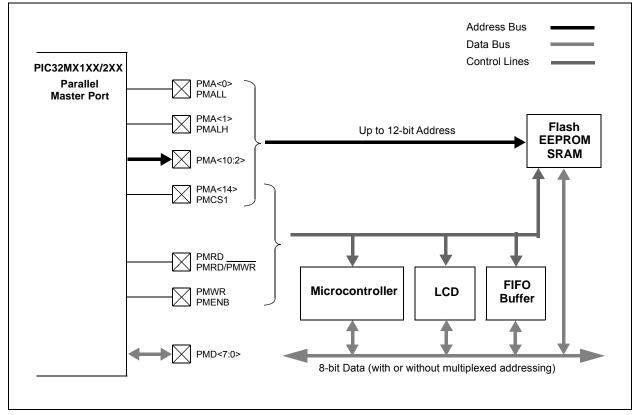
Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 13. "Parallel Master Port (PMP)" (DS60001128), which is available from the Documentation Reference Manual section of the > Microchip PIC32 web site (www.microchip.com/pic32).

The PMP is a parallel 8-bit input/output module specifically designed to communicate with a wide variety of parallel devices, such as communications peripherals, LCDs, external memory devices and microcontrollers. Because the interface to parallel peripherals varies significantly, the PMP module is highly configurable. Key features of the PMP module include:

- Fully multiplexed address/data mode
- Demultiplexed or partially multiplexed address/ data mode
 - up to 11 address lines with single Chip Select
 - up to 12 address lines without Chip Select
- One Chip Select line
- Programmable strobe options
 - Individual read and write strobes or;
- Read/write strobe with enable strobe
- Address auto-increment/auto-decrement
- Programmable address/data multiplexing
- · Programmable polarity on control signals
- Legacy parallel slave port support
- Enhanced parallel slave support
 - Address support
 - 4-byte deep auto-incrementing buffer
- Programmable Wait states
- · Selectable input voltage levels

Figure 20-1 illustrates the PMP module block diagram.

FIGURE 20-1: PMP MODULE PINOUT AND CONNECTIONS TO EXTERNAL DEVICES



20.1 PMP Control Registers

TABLE 20-1: PARALLEL MASTER PORT REGISTER MAP

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ess										Bi	ts			
Virtual Address (BF80_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4
7000	PMCON	31:16	_	_	_	—	—		—	_	_	—	—	—
7000	FINCON	15:0	ON	—	SIDL	ADRMU	JX<1:0>	PMPTTL	PTWREN	PTRDEN	CSF<	<1:0>	ALP	_
7010		31:16	_	—	_	_	_	—	—	_	-	_	-	_
7010	7010 PMMODE	15:0	BUSY	IRQM	<1:0>	INCM	<1:0>	—	MODE	<1:0>	WAITE	3<1:0>		WAITM
		31:16	_	—	_	_	_	—	—	_	-	_	-	_
7020	PMADDR	15:0	_	CS1 ADDR14	-	_	-					Α	DDR<10:0	>
7030	PMDOUT	31:16 15:0								DATAOU	T<31:0>			
7040	PMDIN	31:16 15:0								DATAIN	<31:0>			
7050		31:16	_	—	_		—	—	—	—	—	—	—	—
7050	PMAEN	15:0	_	PTEN14	_	_	_					F	PTEN<10:0	>
7060	DMOTAT	31:16	_	—	_	_	_	—	—	—	—	—	—	—
7060 PMSTAT	FINISTAT	15:0	IBF	IBOV			IB3F	IB2F	IB1F	IB0F	OBE	OBUF	_	

L

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See more information.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	-	—	_	-	—	_	_	—
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	_	—	_	_	—	_	_	—
45.0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
15:8	ON ⁽¹⁾	—	SIDL	ADRML	JX<1:0>	PMPTTL	U-0 U-0 — — U-0 U-0 — — U-0 U-0 — — RW-0 RW-0 MPTTL PTWREN U-0 RW-0	PTRDEN
7.0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	U-0	R/W-0	R/W-0
7:0	CSF<	1:0> (2)	ALP ⁽²⁾	-	CS1P ⁽²⁾	_	WRSP	RDSP

REGISTER 20-1: PMCON: PARALLEL PORT CONTROL REGISTER

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, r	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

bit 15 **ON:** Parallel Master Port Enable bit⁽¹⁾

1 = PMP enabled

- 0 = PMP disabled, no off-chip access performed
- bit 14 Unimplemented: Read as '0'
- bit 13 **SIDL:** Stop in Idle Mode bit
 - 1 = Discontinue module operation when the device enters Idle mode
 - 0 = Continue module operation when the device enters Idle mode
- bit 12-11 ADRMUX<1:0>: Address/Data Multiplexing Selection bits
 - 11 = Lower 8 bits of address are multiplexed on PMD<7:0> pins; upper 8 bits are not used
 - 10 = All 16 bits of address are multiplexed on PMD<7:0> pins
 - 01 = Lower 8 bits of address are multiplexed on PMD<7:0> pins, upper bits are on PMA<10:8> and PMA<14>
 - 00 = Address and data appear on separate pins
- bit 10 PMPTTL: PMP Module TTL Input Buffer Select bit
 - 1 = PMP module uses TTL input buffers
 - 0 = PMP module uses Schmitt Trigger input buffer
- bit 9 PTWREN: Write Enable Strobe Port Enable bit
 - 1 = PMWR/PMENB port enabled
 - 0 = PMWR/PMENB port disabled
- bit 8 **PTRDEN:** Read/Write Strobe Port Enable bit
 - 1 = PMRD/PMWR port enabled
 - 0 = PMRD/PMWR port disabled
- bit 7-6 CSF<1:0>: Chip Select Function bits⁽²⁾
 - 11 = Reserved
 - 10 = PMCS1 functions as Chip Select
 - 01 = PMCS1 functions as PMA<14>
 - 00 = PMCS1 functions as PMA<14>
- bit 5 ALP: Address Latch Polarity bit⁽²⁾
 - 1 = Active-high (PMALL and PMALH)
 - $0 = \text{Active-low} (\overline{\text{PMALL}} \text{ and } \overline{\text{PMALH}})$
 - **Note 1:** When using 1:1 PBCLK divisor, the user's software should not read/write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON control bit.
 - 2: These bits have no effect when their corresponding pins are used as address lines.

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REGISTER 20-1: PMCON: PARALLEL PORT CONTROL REGISTER (CONTINUED)

- bit 4 Unimplemented: Read as '0' bit 3 CS1P: Chip Select 0 Polarity bit⁽²⁾ 1 = Active-high (PMCS1) 0 = Active-low (PMCS1)
- bit 2 Unimplemented: Read as '0'
- bit 1 WRSP: Write Strobe Polarity bit

For Slave Modes and Master mode 2 (MODE<1:0> = 00,01,10):

- 1 = Write strobe active-high (PMWR)
- 0 =Write strobe active-low (\overline{PMWR})

For Master mode 1 (MODE<1:0> = 11):

- 1 = Enable strobe active-high (PMENB)
- 0 = Enable strobe active-low (PMENB)
- bit 0 RDSP: Read Strobe Polarity bit
 - For Slave modes and Master mode 2 (MODE<1:0> = 00,01,10):
 - 1 = Read Strobe active-high (PMRD)
 - 0 = Read Strobe active-low (PMRD)
 - For Master mode 1 (MODE<1:0> = 11):
 - 1 = Read/write strobe active-high (PMRD/ \overline{PMWR})
 - 0 = Read/write strobe active-low (PMRD/PMWR)
 - **Note 1:** When using 1:1 PBCLK divisor, the user's software should not read/write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON control bit.
 - 2: These bits have no effect when their corresponding pins are used as address lines.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	-	-	_	-	-	-	_	—
00.10	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	-	_	_	_	_	_	_	—
45.0	R-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0
15:8	BUSY	IRQM	<1:0>	INCM	<1:0>	_	MODE	=<1:0>
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
7:0	WAITB	<1:0> ⁽¹⁾		WAITM	WAITE<1:0> ⁽¹⁾			

REGISTER 20-2: PMMODE: PARALLEL PORT MODE REGISTER

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

bit 15 **BUSY:** Busy bit (Master mode only)

1 = Port is busy

0 = Port is not busy

bit 14-13 IRQM<1:0>: Interrupt Request Mode bits

- 11 = Reserved, do not use
- 10 = Interrupt generated when Read Buffer 3 is read or Write Buffer 3 is written (Buffered PSP mode) or on a read or write operation when PMA<1:0> =11 (Addressable Slave mode only)
- 01 = Interrupt generated at the end of the read/write cycle
- 00 = No Interrupt generated

bit 12-11 INCM<1:0>: Increment Mode bits

- 11 = Slave mode read and write buffers auto-increment (MODE<1:0> = 00 only)
- 10 = Decrement ADDR<10:2> and ADDR<14> by 1 every read/write cycle⁽²⁾
- 01 = Increment ADDR<10:2> and ADDR<14> by 1 every read/write cycle⁽²⁾
- 00 = No increment or decrement of address
- bit 10 Unimplemented: Read as '0'
- bit 9-8 MODE<1:0>: Parallel Port Mode Select bits
 - 11 = Master mode 1 (PMCS1, PMRD/PMWR, PMENB, PMA<x:0>, and PMD<7:0>)
 - 10 = Master mode 2 (PMCS1, PMRD, PMWR, PMA<x:0>, and PMD<7:0>)
 - 01 = Enhanced Slave mode, control signals (PMRD, PMWR, PMCS1, PMD<7:0>, and PMA<1:0>)
 - 00 = Legacy Parallel Slave Port, control signals (PMRD, PMWR, PMCS1, and PMD<7:0>)

bit 7-6 WAITB<1:0>: Data Setup to Read/Write Strobe Wait States bits⁽¹⁾

- 11 = Data wait of 4 TPB; multiplexed address phase of 4 TPB
 - 10 = Data wait of 3 TPB; multiplexed address phase of 3 TPB
 - 01 = Data wait of 2 TPB; multiplexed address phase of 2 TPB
 - 00 = Data wait of 1 TPB; multiplexed address phase of 1 TPB (default)

bit 5-2 WAITM<3:0>: Data Read/Write Strobe Wait States bits⁽¹⁾

1111 = Wait of 16 Трв .

0001 = Wait of 2 Трв

0000 = Wait of 1 TPB (default)

- **Note 1:** Whenever WAITM<3:0> = 0000, WAITB and WAITE bits are ignored and forced to 1 TPBCLK cycle for a write operation; WAITB = 1 TPBCLK cycle, WAITE = 0 TPBCLK cycles for a read operation.
 - 2: Address bit A14 is not subject to auto-increment/decrement if configured as Chip Select CS1.

REGISTER 20-2: PMMODE: PARALLEL PORT MODE REGISTER (CONTINUED)

bit 1-0 WAITE<1:0>: Data Hold After Read/Write Strobe Wait States bits⁽¹⁾

- 11 = Wait of 4 Трв
- 10 = Wait of 3 TPB
- 01 = Wait of 2 TPB
- 00 = Wait of 1 TPB (default)

For Read operations:

- 11 = Wait of 3 TPB
- 10 = Wait of 2 TPB
- 01 = Wait of 1 TPB
- 00 = Wait of 0 TPB (default)
- **Note 1:** Whenever WAITM<3:0> = 0000, WAITB and WAITE bits are ignored and forced to 1 TPBCLK cycle for a write operation; WAITB = 1 TPBCLK cycle, WAITE = 0 TPBCLK cycles for a read operation.
 - 2: Address bit A14 is not subject to auto-increment/decrement if configured as Chip Select CS1.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0		
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
31.24		—		_	—	—	_	—		
00.10	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
23:16		—	_	_	—	—	_	—		
	U-0	R/W-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0		
15:8		CS1 ⁽¹⁾			28/20/12/4 27/19/11/3 26/18/10/2 25/17/9/1 24/16/8/0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0					
	—	ADDR14 ⁽²⁾	—	—						
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
	ADDR<7:0>									

REGISTER 20-3: PMADDR: PARALLEL PORT ADDRESS REGISTER

Legend:

0				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 31-15 Unimplemented: Read as '0'

- bit 14 **CS1:** Chip Select 1 bit⁽¹⁾
 - 1 = Chip Select 1 is active
 - 0 = Chip Select 1 is inactive
- bit 14 ADDR<14>: Destination Address bit 14⁽²⁾
- bit 13-11 Unimplemented: Read as '0'
- bit 10-0 ADDR<10:0>: Destination Address bits
- Note 1: When the CSF<1:0> bits (PMCON<7:6>) = 10.
 - **2:** When the CSF<1:0> bits (PMCON<7:6>) = 00 or 01.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	—	—	—	—	—	—	—	—
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	_	_	_	_	_	_	_	—
45.0	U-0	R/W-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
15:8	_	PTEN14	_	_	_		PTEN<10:8>	
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
				PTEN	<7:0>			

REGISTER 20-4: PMAEN: PARALLEL PORT PIN ENABLE REGISTER

Legend:

Legena.			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

- bit 31-15 Unimplemented: Read as '0'
- bit 15-14 PTEN14: PMCS1 Address Port Enable bits
 - 1 = PMA14 functions as either PMA14 or PMCS1⁽¹⁾
 - 0 = PMA14 functions as port I/O
- bit 13-11 Unimplemented: Read as '0'
- bit 10-2 PTEN<10:2>: PMP Address Port Enable bits
 - 1 = PMA<10:2> function as PMP address lines
 - 0 = PMA<10:2> function as port I/O
- bit 1-0 PTEN<1:0>: PMALH/PMALL Address Port Enable bits
 - 1 = PMA1 and PMA0 function as either PMA<1:0> or PMALH and PMALL⁽²⁾
 - 0 = PMA1 and PMA0 pads functions as port I/O
 - Note 1: The use of this pin as PMA14 or CS1 is selected by the CSF<1:0> bits in the PMCON register.
 - 2: The use of these pins as PMA1/PMA0 or PMALH/PMALL depends on the Address/Data Multiplex mode selected by bits ADRMUX<1:0> in the PMCON register.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	-	—	_	_	_	_	_	—
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	-	_	_	_	_	_	_	—
45.0	R-0	R/W-0, HS, SC	U-0	U-0	R-0	R-0	R-0	R-0
15:8	IBF	IBOV		_	IB3F	IB2F	IB1F	IB0F
7.0	R-1	R/W-0, HS, SC	U-0	U-0	R-1	R-1	R-1	R-1
7:0	OBE	OBUF		_	OB3E	OB2E	OB1E	OB0E

REGISTER 20-5: PMSTAT: PARALLEL PORT STATUS REGISTER (SLAVE MODES ONLY)

Legend: HS = Hardware		SC = Cleared by Software
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

- bit 15 **IBF:** Input Buffer Full Status bit
 - 1 = All writable input buffer registers are full
 - 0 = Some or all of the writable input buffer registers are empty
- bit 14 IBOV: Input Buffer Overflow Status bit
 - 1 = A write attempt to a full input byte buffer occurred (must be cleared in software)
 - 0 = No overflow occurred
- bit 13-12 Unimplemented: Read as '0'
- bit 11-8 IBxF: Input Buffer 'x' Status Full bits
 - 1 = Input Buffer contains data that has not been read (reading buffer will clear this bit)
 - 0 = Input Buffer does not contain any unread data
- bit 7 **OBE:** Output Buffer Empty Status bit
 - 1 = All readable output buffer registers are empty
 - 0 = Some or all of the readable output buffer registers are full
- bit 6 **OBUF:** Output Buffer Underflow Status bit
 - 1 = A read occurred from an empty output byte buffer (must be cleared in software)
 - 0 = No underflow occurred
- bit 5-4 Unimplemented: Read as '0'
- bit 3-0 **OBxE:** Output Buffer 'x' Status Empty bits
 - 1 = Output buffer is empty (writing data to the buffer will clear this bit)
 - 0 = Output buffer contains data that has not been transmitted

NOTES:

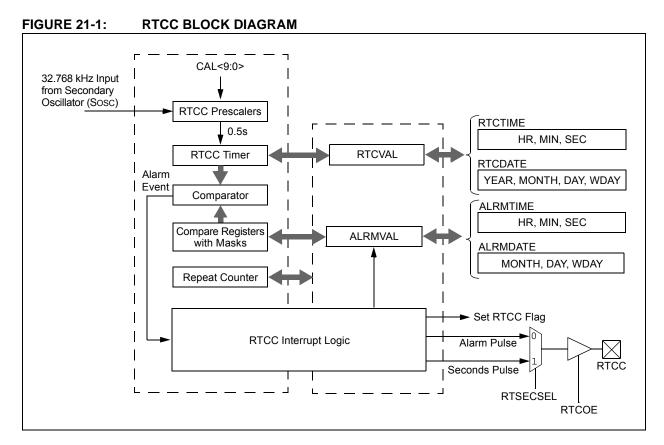
21.0 REAL-TIME CLOCK AND CALENDAR (RTCC)

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 29. "Real-Time Clock and Calendar (RTCC)" (DS60001125), which is available from the Documentation > Reference Manual section of the Microchip PIC32 web site (www.microchip.com/pic32).

The PIC32 RTCC module is intended for applications in which accurate time must be maintained for extended periods of time with minimal or no CPU intervention. Low-power optimization provides extended battery lifetime while keeping track of time.

Following are some of the key features of this module:

- Time: hours, minutes and seconds
- 24-hour format (military time)
- · Visibility of one-half second period
- · Provides calendar: day, date, month and year
- Alarm intervals are configurable for half of a second, one second, 10 seconds, one minute, 10 minutes, one hour, one day, one week, one month and one year
- · Alarm repeat with decrementing counter
- Alarm with indefinite repeat: Chime
- Year range: 2000 to 2099
- · Leap year correction
- BCD format for smaller firmware overhead
- · Optimized for long-term battery operation
- · Fractional second synchronization
- User calibration of the clock crystal frequency with auto-adjust
- Calibration range: ±0.66 seconds error per month
- Calibrates up to 260 ppm of crystal error
- Requirements: External 32.768 kHz clock crystal
- Alarm pulse or seconds clock output on RTCC pin



RTCC Control Registers 21.1

TABLE 21-1: RTCC REGISTER MAP

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			Bits										
Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4
PTCCON	31:16	—	—		—	_	—					CAL	<9:0>
RICCON	15:0	ON	—	SIDL	—	—	—	—	-	RTSECSEL	RTCCLKON	—	— F
	31:16	—	_	—	-	—	_	—	—	—	—	_	—
	15:0	ALRMEN	CHIME	PIV	ALRMSYNC	AMASK<3:0>						ARPT<	
DTOTIME	31:16	—	_	HR1	0<1:0>	HR01<3:0>			—	М	IN10<2:0>	•	
RICTIVIE	15:0	—		SEC10<2:	0>	SEC01<3:0>			—	—	_	—	
DTODATE	31:16		YEAR	10<3:0>			YEAR01<3:0>			_	_	_	MONTH10
RICDAIE	15:0	_	_	DAY1	10<1:0>	DAY01<3:0>		_	_	_	_		
	31:16	—	_	HR1	0<1:0>		HR01	<3:0>		—	М	IN10<2:0>	•
	15:0	—		SEC10<2:0	0>		SEC0	1<3:0>		_	_	_	_
	31:16	—	_	—	—	_	_	_	—	_	_	_	MONTH10
0250 ALRMDATE	15:0		DAY1	0<3:0>	•		DAY0	1<3:0>		_	_	_	_
	RTCCON RTCALRM RTCTIME RTCDATE ALRMTIME	bit Bit RTCCON 31:16 RTCALRM 31:16 RTCALRM 31:16 RTCTIME 31:16 RTCDATE 31:16 RTCDATE 31:16 15:0 31:16 RTCDATE 31:16 15:0 31:16 ALRMTIME 31:16 ALRMDATE 31:16	bit bit 31/15 RTCCON 31:16 15:0 ON RTCALRM 31:16 15:0 ALRMEN RTCTIME 31:16 RTCDATE 31:16 RTCDATE 31:16 RTCDATE 31:16 ALRMTIME 31:16 ALRMDATE 15:0 ALRMDATE 31:16	bit bit bit 31/15 30/14 RTCCON 31:16 RTCALRM 31:16 RTCALRM 31:16 RTCALRM 31:16 RTCTIME 31:16 RTCDATE 31:16 RTCDATE 31:16 ALRMTIME 31:16 ALRMDATE 31:16	brice brice <th< td=""><td>BUT BUT BUT</td></th<> <td>bring bring 31/15 30/14 29/13 28/12 27/11 RTCCON 31:16 -</td> <td>bring brind 31/15 30/14 29/13 28/12 27/11 26/10 RTCCON 31:16 -</td> <td>bring bring brin bring bring <thb< td=""><td>bring bring state <th< td=""><td>break break Bits Bits Bits</td><td>bit Bits bit 31/15 30/14 29/13 28/12 27/11 26/10 25/9 24/8 23/7 22/6 RTCCON 31:16 -</td><td>by by 31/15 30/14 29/13 28/12 27/11 26/10 25/9 24/8 23/7 22/6 21/5 RTCCON 31.16 - - - - - CAL <td< td=""></td<></td></th<></td></thb<></td>	BUT BUT	bring bring 31/15 30/14 29/13 28/12 27/11 RTCCON 31:16 -	bring brind 31/15 30/14 29/13 28/12 27/11 26/10 RTCCON 31:16 -	bring brin bring bring <thb< td=""><td>bring bring state <th< td=""><td>break break Bits Bits Bits</td><td>bit Bits bit 31/15 30/14 29/13 28/12 27/11 26/10 25/9 24/8 23/7 22/6 RTCCON 31:16 -</td><td>by by 31/15 30/14 29/13 28/12 27/11 26/10 25/9 24/8 23/7 22/6 21/5 RTCCON 31.16 - - - - - CAL <td< td=""></td<></td></th<></td></thb<>	bring bring state state <th< td=""><td>break break Bits Bits Bits</td><td>bit Bits bit 31/15 30/14 29/13 28/12 27/11 26/10 25/9 24/8 23/7 22/6 RTCCON 31:16 -</td><td>by by 31/15 30/14 29/13 28/12 27/11 26/10 25/9 24/8 23/7 22/6 21/5 RTCCON 31.16 - - - - - CAL <td< td=""></td<></td></th<>	break break Bits Bits Bits	bit Bits bit 31/15 30/14 29/13 28/12 27/11 26/10 25/9 24/8 23/7 22/6 RTCCON 31:16 -	by by 31/15 30/14 29/13 28/12 27/11 26/10 25/9 24/8 23/7 22/6 21/5 RTCCON 31.16 - - - - - CAL CAL <td< td=""></td<>

Legend:

x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal. All registers in this table have corresponding CLR, SET and INV registers at its virtual address, plus an offset of 0x4, 0x8 and 0xC, respectively. See Se information. Note 1:

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0			
21.24	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0			
31:24	—	_	—	—	—	—	CAL<9):8>			
00.40	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
23:16	CAL<7:0>										
45.0	R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0			
15:8	ON ^(1,2)	—	SIDL	—	—	—	—	_			
7.0	R/W-0	R-0	U-0	U-0	R/W-0	R-0	R-0	R/W-0			
7:0	RTSECSEL ⁽³⁾	RTCCLKON	_	_	RTCWREN ⁽⁴⁾	RTCSYNC	HALFSEC ⁽⁵⁾	RTCOE			

REGISTER 21-1: RTCCON: RTC CONTROL REGISTER

Legend:

R = Readable bit	= Readable bit W = Writable bit		ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-26 Unimplemented: Read as '0'

bit 25-16	CAL<9:0>: RTC Drift Calibration bits, which contain a signed 10-bit integer value
	0111111111 = Maximum positive adjustment, adds 511 RTC clock pulses every one minute
	000000001 = Minimum positive adjustment, adds 1 RTC clock pulse every one minute 0000000000 = No adjustment
	1111111111 = Minimum negative adjustment, subtracts 1 RTC clock pulse every one minute
	•
	100000000 = Maximum negative adjustment, subtracts 512 clock pulses every one minute
bit 15	ON: RTCC On bit ^(1,2)
	1 = RTCC module is enabled
	0 = RTCC module is disabled
bit 14	Unimplemented: Read as '0'
bit 13	SIDL: Stop in Idle Mode bit
	1 = Disables the PBCLK to the RTCC when the device enters Idle mode
bit 12-8	0 = Continue normal operation when the device enters Idle mode
	Unimplemented: Read as '0' RTSECSEL: RTCC Seconds Clock Output Select bit ⁽³⁾
bit 7	1 = RTCC Seconds Clock is selected for the RTCC pin
	0 = RTCC Alarm Pulse is selected for the RTCC pin
bit 6	RTCCLKON: RTCC Clock Enable Status bit
	1 = RTCC Clock is actively running
	0 = RTCC Clock is not running
Note 1:	The ON bit is only writable when RTCWREN = 1.
2:	When using the 1:1 PBCLK divisor, the user's software should not read/write the peripheral's SFRs in the
	SYSCLK cycle immediately following the instruction that clears the module's ON bit.
3:	Requires $RTCOE = 1$ (RTCCON<0>) for the output to be active.
4:	The RTCWREN bit can be set only when the write sequence is enabled.
5:	This bit is read-only. It is cleared to '0' on a write to the seconds bit fields (RTCTIME<14:8>).

Note: This register is reset only on a Power-on Reset (POR).

REGISTER 21-1: RTCCON: RTC CONTROL REGISTER (CONTINUED)

bit 5-4	Unimplemented: Read as '0'
bit 3	RTCWREN: RTC Value Register

- 3 **RTCWREN:** RTC Value Registers Write Enable bit⁽⁴⁾
 - 1 = RTC Value registers can be written to by the user
 - 0 = RTC Value registers are locked out from being written to by the user
- bit 2 RTCSYNC: RTCC Value Registers Read Synchronization bit
 - 1 = RTC Value registers can change while reading, due to a rollover ripple that results in an invalid data read If the register is read twice and results in the same data, the data can be assumed to be valid
 - 0 = RTC Value registers can be read without concern about a rollover ripple
- bit 1 HALFSEC: Half-Second Status bit⁽⁵⁾
 - 1 = Second half period of a second
 - 0 = First half period of a second
- bit 0 RTCOE: RTCC Output Enable bit
 - 1 = RTCC clock output enabled clock presented onto an I/O
 - 0 = RTCC clock output disabled
- **Note 1:** The ON bit is only writable when RTCWREN = 1.
 - 2: When using the 1:1 PBCLK divisor, the user's software should not read/write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.
 - **3:** Requires RTCOE = 1 (RTCCON<0>) for the output to be active.
 - 4: The RTCWREN bit can be set only when the write sequence is enabled.
 - 5: This bit is read-only. It is cleared to '0' on a write to the seconds bit fields (RTCTIME<14:8>).

Note: This register is reset only on a Power-on Reset (POR).

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
04.04	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
31:24	—	_	—	—	_	_	—	_	
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
23:16	—	—	—	—	—	—	—	_	
45.0	R/W-0	R/W-0	R/W-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0	
15:8	ALRMEN ^(1,2)	CHIME ⁽²⁾	PIV ⁽²⁾	ALRMSYNC ⁽³⁾		AMASK	<3:0> ⁽²⁾		
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
7:0	ARPT<7:0> ⁽²⁾								

REGISTER 21-2: RTCALRM: RTC ALARM CONTROL REGISTER

Legend:

Logona.			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

- bit 15 ALRMEN: Alarm Enable bit^(1,2)
 - 1 = Alarm is enabled
 - 0 = Alarm is disabled
- bit 14 **CHIME:** Chime Enable bit⁽²⁾
 - 1 = Chime is enabled ARPT<7:0> is allowed to rollover from 0x00 to 0xFF
 - 0 = Chime is disabled ARPT<7:0> stops once it reaches 0x00

bit 13 **PIV:** Alarm Pulse Initial Value bit⁽²⁾

When ALRMEN = 0, PIV is writable and determines the initial value of the Alarm Pulse. When ALRMEN = 1, PIV is read-only and returns the state of the Alarm Pulse.

bit 12 ALRMSYNC: Alarm Sync bit⁽³⁾

- 1 = ARPT<7:0> and ALRMEN may change as a result of a half second rollover during a read. The ARPT must be read repeatedly until the same value is read twice. This must be done since multiple bits may be changing, which are then synchronized to the PB clock domain
- 0 = ARPT<7:0> and ALRMEN can be read without concerns of rollover because the prescaler is > 32 RTC clocks away from a half-second rollover

bit 11-8 AMASK<3:0>: Alarm Mask Configuration bits⁽²⁾

- 0000 = Every half-second
- 0001 = Every second
- 0010 = Every 10 seconds
- 0011 = Every minute
- 0100 = Every 10 minutes
- 0101 = Every hour
- 0110 = Once a day
- 0111 = Once a week
- 1000 = Once a month
- 1001 = Once a year (except when configured for February 29, once every four years)
- 1010 = Reserved; do not use
- 1011 = Reserved; do not use
- 11xx = Reserved; do not use
- **Note 1:** Hardware clears the ALRMEN bit anytime the alarm event occurs, when ARPT<7:0> = 00 and CHIME = 0.
 - 2: This field should not be written when the RTCC ON bit = '1' (RTCCON<15>) and ALRMSYNC = 1.
 - **3:** This assumes a CPU read will execute in less than 32 PBCLKs.

Note: This register is reset only on a Power-on Reset (POR).

REGISTER 21-2: RTCALRM: RTC ALARM CONTROL REGISTER (CONTINUED)

bit 7-0 ARPT<7:0>: Alarm Repeat Counter Value bits⁽²⁾
11111111 = Alarm will trigger 256 times
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- 2: This field should not be written when the RTCC ON bit = '1' (RTCCON<15>) and ALRMSYNC = 1.
- 3: This assumes a CPU read will execute in less than 32 PBCLKs.

Note: This register is reset only on a Power-on Reset (POR).

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
31:24	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	
		_	— HR10<1:0>			HR01	<3:0>		
00.40	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	
23:16	—		MIN10<2:0>		MIN01<3:0>				
45.0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	
15:8	—		SEC10<2:0>		SEC01<3:0>				
7.0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
7:0	—	_	_	—	_	_	_	_	
-									
Legend:	Legend:								
R = Readable bit			W = Writable bit		U = Unimplemented bit, read as '0'				

REGISTER 21-3: RTCTIME: RTC TIME VALUE REGISTER

Legena.						
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'				
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

bit 31-30 Unimplemented: Read as '0'

bit 29-28 HR10<1:0>: Binary-Coded Decimal Value of Hours bits, 10s place digit; contains a value from 0 to 2 bit 27-24 HR01<3:0>: Binary-Coded Decimal Value of Hours bits, 1s place digit; contains a value from 0 to 9 bit 23 Unimplemented: Read as '0'

bit 22-20 MIN10<2:0>: Binary-Coded Decimal Value of Minutes bits, 10s place digit; contains a value from 0 to 5

bit 19-16 MIN01<3:0>: Binary-Coded Decimal Value of Minutes bits, 1s place digit; contains a value from 0 to 9 bit 15 Unimplemented: Read as '0'

bit 14-12 SEC10<2:0>: Binary-Coded Decimal Value of Seconds bits, 10s place digit; contains a value from 0 to 5

bit 11-8 SEC01<3:0>: Binary-Coded Decimal Value of Seconds bits, 1s place digit; contains a value from 0 to 9

bit 7-0 Unimplemented: Read as '0'

Note: This register is only writable when RTCWREN = 1 (RTCCON<3>).

		-	-					
Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
04.04	R/W-x	R/W-x R/W-x		R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
31:24		YEAR1	0<3:0>			YEAR0	1<3:0>	
00.40	U-0	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
23:16	_	_	_	MONTH10	MONTH01<3:0>			
15:8	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
15:8		—	DAY10)<1:0>	DAY01<3:0>			
7.0	U-0	U-0	U-0	U-0	U-0	R/W-x	R/W-x	R/W-x
7:0	_	—	_	—	_	- WDAY01<2:0>		
Legend:								
R = Read	able bit		W = Writable	e bit	U = Unimple	emented bit, re	ead as '0'	
-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unki					known			

REGISTER 21-4: **RTCDATE: RTC DATE VALUE REGISTER**

Legend:					
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 31-28 YEAR10<3:0>: Binary-Coded Decimal Value of Years bits, 10s place digit; contains a value from 0 to 9

bit 27-24 YEAR01<3:0>: Binary-Coded Decimal Value of Years bits, 1s place digit; contains a value from 0 to 9 bit 23-21 Unimplemented: Read as '0'

bit 20 MONTH10: Binary-Coded Decimal Value of Months bits, 10s place digit; contains a value of 0 or 1

bit 19-16 MONTH01<3:0>: Binary-Coded Decimal Value of Months bits, 1s place digit; contains a value from 0 to 9 bit 15-14 Unimplemented: Read as '0'

bit 13-12 DAY10<1:0>: Binary-Coded Decimal Value of Days bits, 10s place digit; contains a value of 0 to 3

bit 11-8 DAY01<3:0>: Binary-Coded Decimal Value of Days bits, 1s place digit; contains a value from 0 to 9 bit 7-3 Unimplemented: Read as '0'

bit 2-0 WDAY01<2:0>: Binary-Coded Decimal Value of Weekdays bits; contains a value from 0 to 6

Note: This register is only writable when RTCWREN = 1 (RTCCON<3>).

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
31:24	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	
31:24	—	—	HR10	<1:0>		HR01	<3:0>		
00.40	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	
23:16	—		MIN10<2:0>			MIN01<3:0>			
45.0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	
15:8	—		SEC10<2:0>			SEC01<3:0>			
7.0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
7:0	—	—	—	—		—	—	_	
Legend:									
R = Read	able bit		W = Writable bit		U = Unimplemented bit, read as '0'				
-n = Value at POR			'1' = Bit is se	t	'0' = Bit is cleared x = Bit is unknown				

REGISTER 21-5: ALRMTIME: ALARM TIME VALUE REGISTER

bit 31-30 Unimplemented: Read as '0'

bit 29-28 **HR10<1:0>:** Binary Coded Decimal value of hours bits, 10s place digit; contains a value from 0 to 2 bit 27-24 **HR01<3:0>:** Binary Coded Decimal value of hours bits, 1s place digit; contains a value from 0 to 9 bit 22.

bit 23 Unimplemented: Read as '0'

bit 22-20 **MIN10<2:0>:** Binary Coded Decimal value of minutes bits, 10s place digit; contains a value from 0 to 5 bit 19-16 **MIN01<3:0>:** Binary Coded Decimal value of minutes bits, 1s place digit; contains a value from 0 to 9

bit 15 Unimplemented: Read as '0'

bit 14-12 SEC10<2:0>: Binary Coded Decimal value of seconds bits, 10s place digit; contains a value from 0 to 5

bit 11-8 **SEC01<3:0>:** Binary Coded Decimal value of seconds bits, 1s place digit; contains a value from 0 to 9

bit 7-0 Unimplemented: Read as '0'

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
04.04	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	_	—	_	_	_	_	—	—
00.40	U-0	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
23:16	—	—	_	MONTH10		MONTH01<3:0>		
45.0	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
15:8	_	_	DAY1	0<1:0>	DAY01<3:0>			
7.0	U-0	U-0	U-0	U-0	U-0	R/W-x	R/W-x	R/W-x
7:0	_	_	_	_		WDAY01<2:0>		

REGISTER 21-6: ALRMDATE: ALARM DATE VALUE REGISTER

Legend:

- J					
R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 31-21 Unimplemented: Read as '0'

bit 20 MONTH10: Binary Coded Decimal value of months bits, 10s place digit; contains a value of 0 or 1

bit 19-16 **MONTH01<3:0>:** Binary Coded Decimal value of months bits, 1s place digit; contains a value from 0 to 9 bit 15-14 **Unimplemented:** Read as '0'

bit 13-12 DAY10<1:0>: Binary Coded Decimal value of days bits, 10s place digit; contains a value from 0 to 3

bit 11-8 **DAY01<3:0>:** Binary Coded Decimal value of days bits, 1s place digit; contains a value from 0 to 9

bit 7-3 Unimplemented: Read as '0'

bit 2-0 WDAY01<2:0>: Binary Coded Decimal value of weekdays bits; contains a value from 0 to 6

22.0 10-BIT ANALOG-TO-DIGITAL CONVERTER (ADC)

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 17. "10-bit Analog-to-Digital Converter (ADC)" (DS60001104), which is available from the Documentation > Reference Manual section of the Microchip PIC32 web site (www.microchip.com/pic32).

The 10-bit Analog-to-Digital Converter (ADC) includes the following features:

- Successive Approximation Register (SAR) conversion
- Up to 1 Msps conversion speed

- Up to 13 analog input pins
- External voltage reference input pins
- One unipolar, differential Sample and Hold Amplifier (SHA)
- Automatic Channel Scan mode
- Selectable conversion trigger source
- · 16-word conversion result buffer
- Selectable buffer fill modes
- · Eight conversion result format options
- · Operation during Sleep and Idle modes

A block diagram of the 10-bit ADC is illustrated in Figure 22-1. Figure 22-2 illustrates a block diagram of the ADC conversion clock period. The 10-bit ADC has up to 13 analog input pins, designated AN0-AN12. In addition, there are two analog input pins for external voltage reference connections. These voltage reference inputs may be shared with other analog input pins and may be common to other analog module references.

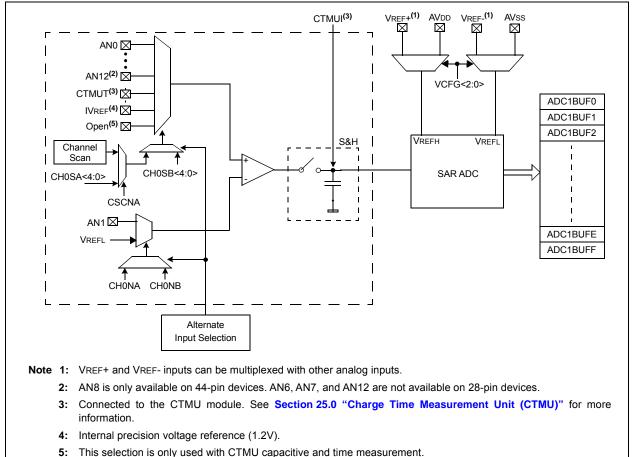
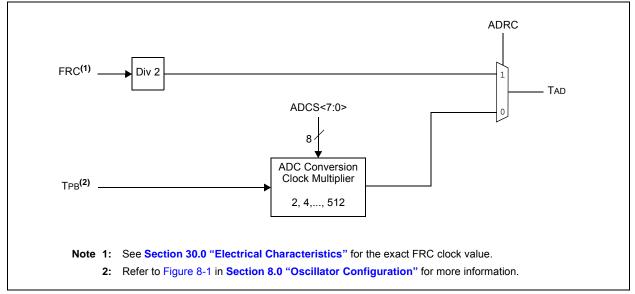


FIGURE 22-1: ADC1 MODULE BLOCK DIAGRAM

FIGURE 22-2: ADC CONVERSION CLOCK PERIOD BLOCK DIAGRAM



22.1 **ADC Control Registers**

ess)		e								Bi	its			
Virtual Address (BF80_#)	Register Name	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4
	· = 10 0 1 1 (1)	31:16	-	_	_	_	_	-	-	_	_	_	_	-
000	AD1CON1 ⁽¹⁾	15:0	ON	_	SIDL	_	_		ORM<2:0	>		SSRC<2:0>		CLRASAM
2010	AD1CON2 ⁽¹⁾	31:16	_			_	_							
010		15:0		VCFG<2:0>	>	OFFCAL	_	CSCNA	_	_	BUFS			SMP
1020	AD1CON3 ⁽¹⁾	31:16	—	—	—					-		-		—
/020		15:0	ADRC	—	—		:	SAMC<4:0>	•					ADCS
9040	AD1CHS ⁽¹⁾	31:16	CH0NB	—	—	_		CHOSE	3<3:0>		CH0NA	—	_	—
20.0		15:0	_	—	—	_	_	_	_	_	_	_	_	—
9050	AD1CSSL ⁽¹⁾	31:16	_	—	—	—	—	—	—	—	—	—	—	—
		15:0	CSSL15	CSSL14	CSSL13	CSSL12	CSSL11	CSSL10	CSSL9	CSSL8	CSSL7	CSSL6	CSSL5	CSSL4
070	ADC1BUF0	31:16 15:0	ADC Result Word 0 (ADC1BUF0<31:0>)											
080	ADC1BUF1	31:16 15:0	ADC Result Word 1 (ADC1BUF1<31:0>)											
9090	ADC1BUF2	31:16 15:0							ADC Re:	sult Word 2	(ADC1BUF	2<31:0>)		
90A0	ADC1BUF3	31:16 15:0							ADC Res	sult Word 3	(ADC1BUF	3<31:0>)		
90B0	ADC1BUF4	31:16 15:0							ADC Res	sult Word 4	(ADC1BUF	4<31:0>)		
0C0	ADC1BUF5	31:16 15:0							ADC Res	sult Word 5	(ADC1BUF	5<31:0>)		
0D0	ADC1BUF6	31:16 15:0							ADC Res	sult Word 6	(ADC1BUF	6<31:0>)		
90E0	ADC1BUF7	31:16 15:0							ADC Res	sult Word 7	(ADC1BUF	7<31:0>)		
90F0	ADC1BUF8	31:16 15:0		ADC Result Word 8 (ADC1BUF8<31:0>)										
9100	ADC1BUF9	31:16 15:0							ADC Res	sult Word 9	(ADC1BUF	9<31:0>)		
9110	ADC1BUFA	31:16 15:0	ADC Result Word A (ADC1BUFA<31:0>)											

Note 1: This register has corresponding CLR, SET and INV registers at its virtual address, plus offsets of 0x4, 0x8 and 0xC, respectively. See Section 11.2 "C

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TABLE 22-1: ADC REGISTER MAP (CONTINUED)

ess		0		Bits										
Virtual Address (BF80_#)	Register Name	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4
9120	ADC1BUFB	31:16 15:0		ADC Result Word B (ADC1BUFB<31:0>)										
9130	ADC1BUFC	31:16 15:0		ADC Result Word C (ADC1BUFC<31:0>)										
9140	ADC1BUFD	31:16 15:0							ADC Res	ult Word D	(ADC1BUF	D<31:0>)		
9150	ADC1BUFE	31:16 15:0		ADC Result Word E (ADC1BUFE<31:0>)										
9160	ADC1BUFF	31:16 15:0		ADC Result Word F (ADC1BUFF<31:0>)										

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

This register has corresponding CLR, SET and INV registers at its virtual address, plus offsets of 0x4, 0x8 and 0xC, respectively. See Section 11.2 "C Note 1:

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	U-0	U-0						
31:24		—	_	_	_		—	
00.40	U-0	U-0						
23:16		-	_	_	_		—	
45.0	R/W-0	U-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0
15:8	0N ⁽¹⁾	_	SIDL	_	_	F		
7.0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0, HSC	R/C-0, HSC
7:0	SSRC<2:0>			CLRASAM		ASAM	SAMP ⁽²⁾	DONE ⁽³⁾

REGISTER 22-1: AD1CON1: ADC CONTROL REGISTER 1

Legend:

0			
R = Readable bit	W = Writable bit	it U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

- bit 15 **ON:** ADC Operating Mode bit⁽¹⁾
 - 1 = ADC module is operating
 - 0 = ADC module is not operating
- bit 14 Unimplemented: Read as '0'
- bit 13 **SIDL:** Stop in Idle Mode bit
 - 1 = Discontinue module operation when device enters Idle mode
 - 0 = Continue module operation when the device enters Idle mode
- bit 12-11 Unimplemented: Read as '0'
- bit 10-8 **FORM<2:0>:** Data Output Format bits
 - 111 = Signed Fractional 32-bit (DOUT = sddd dddd dd00 0000 0000 0000 0000)
 - 110 = Fractional 32-bit (DOUT = dddd dddd dd00 0000 0000 0000 0000)
 - 101 = Signed Integer 32-bit (DOUT = ssss ssss ssss ssss ssss sssd dddd dddd)
 - 100 = Integer 32-bit (DOUT = 0000 0000 0000 0000 0000 00dd dddd dddd)
 - 011 = Signed Fractional 16-bit (DOUT = 0000 0000 0000 0000 sddd ddd0 0000)
 - 010 = Fractional 16-bit (DOUT = 0000 0000 0000 0000 dddd dddd dd00 0000)

 - 000 =Integer 16-bit (DOUT = 0000 0000 0000 0000 0000 00dd dddd dddd)

bit 7-5 **SSRC<2:0>:** Conversion Trigger Source Select bits

- 111 = Internal counter ends sampling and starts conversion (auto convert)
- 110 = Reserved
- 101 = Reserved
- 100 = Reserved
- 011 = CTMU ends sampling and starts conversion
- 010 = Timer 3 period match ends sampling and starts conversion
- 001 = Active transition on INT0 pin ends sampling and starts conversion
- 000 = Clearing SAMP bit ends sampling and starts conversion
- **Note 1:** When using 1:1 PBCLK divisor, the user's software should not read/write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.
 - 2: If ASAM = 0, software can write a '1' to start sampling. This bit is automatically set by hardware if ASAM = 1. If SSRC = 0, software can write a '0' to end sampling and start conversion. If SSRC ≠ '0', this bit is automatically cleared by hardware to end sampling and start conversion.
 - **3:** This bit is automatically set by hardware when analog-to-digital conversion is complete. Software can write a '0' to clear this bit (a write of '1' is not allowed). Clearing this bit does not affect any operation already in progress. This bit is automatically cleared by hardware at the start of a new conversion.

REGISTER 22-1: AD1CON1: ADC CONTROL REGISTER 1 (CONTINUED) CLRASAM: Stop Conversion Sequence bit (when the first ADC interrupt is generated) bit 4 1 = Stop conversions when the first ADC interrupt is generated. Hardware clears the ASAM bit when the ADC interrupt is generated. 0 = Normal operation, buffer contents will be overwritten by the next conversion sequence bit 3 Unimplemented: Read as '0' bit 2 ASAM: ADC Sample Auto-Start bit 1 = Sampling begins immediately after last conversion completes; SAMP bit is automatically set. 0 = Sampling begins when SAMP bit is set SAMP: ADC Sample Enable bit⁽²⁾ bit 1 1 = The ADC sample and hold amplifier is sampling 0 = The ADC sample/hold amplifier is holding When ASAM = 0, writing '1' to this bit starts sampling. When SSRC = 000, writing '0' to this bit will end sampling and start conversion. DONE: Analog-to-Digital Conversion Status bit⁽³⁾ bit 0 1 = Analog-to-digital conversion is done 0 = Analog-to-digital conversion is not done or has not started Clearing this bit will not affect any operation in progress. Note 1: When using 1:1 PBCLK divisor, the user's software should not read/write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit. 2: If ASAM = 0, software can write a '1' to start sampling. This bit is automatically set by hardware if

- ASAM = 1. If SSRC = 0, software can write a '0' to end sampling and start conversion. If SSRC ≠ '0', this bit is automatically cleared by hardware to end sampling and start conversion.
 3: This bit is automatically set by hardware when analog-to-digital conversion is complete. Software can
- 3: I his bit is automatically set by hardware when analog-to-digital conversion is complete. Software can write a '0' to clear this bit (a write of '1' is not allowed). Clearing this bit does not affect any operation already in progress. This bit is automatically cleared by hardware at the start of a new conversion.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	—	—	—	—	_	-	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	—	—	—	—	_	-	—	—
15.0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	U-0	U-0
15:8		VCFG<2:0>		OFFCAL	—	CSCNA	—	—
7:0	R-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
7:0	BUFS — SMPI<3:0>						BUFM	ALTS

REGISTER 22-2: AD1CON2: ADC CONTROL REGISTER 2

Legend:

	9				
R = Readable bit W = Writat		W = Writable bit	U = Unimplemented bit, read as '0'		
	-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 31-16 Unimplemented: Read as '0'

bit 15-13 VCFG<2:0>: Voltage Reference Configuration bits

	VREFH	VREFL
000	AVDD	AVss
001	External VREF+ pin	AVss
010	AVDD	External VREF- pin
011	External VREF+ pin	External VREF- pin
1xx	AVDD	AVss

bit 12 **OFFCAL:** Input Offset Calibration Mode Select bit

1 = Enable Offset Calibration mode

Positive and negative inputs of the sample and hold amplifier are connected to VREFL

0 = Disable Offset Calibration mode

The inputs to the sample and hold amplifier are controlled by AD1CHS or AD1CSSL

bit 11 Unimplemented: Read as '0'

bit 10 **CSCNA:** Input Scan Select bit

1 = Scan inputs

0 = Do not scan inputs

bit 9-8 Unimplemented: Read as '0'

- bit 7 BUFS: Buffer Fill Status bit
 - Only valid when BUFM = 1.
 - 1 = ADC is currently filling buffer 0x8-0xF, user should access data in 0x0-0x7
 - 0 = ADC is currently filling buffer 0x0-0x7, user should access data in 0x8-0xF

bit 6 Unimplemented: Read as '0'

bit 5-2 SMPI<3:0>: Sample/Convert Sequences Per Interrupt Selection bits
1111 = Interrupts at the completion of conversion for each 16th sample/convert sequence
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bit 0 ALTS: Alternate Input Sample Mode Select bit

1 = Uses Sample A input multiplexer settings for first sample, then alternates between Sample B and Sample A input multiplexer settings for all subsequent samples

0 = Always use Sample A input multiplexer settings

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
04-04	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	—	_	_	_	_	—	—	—
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	_	_	_	_	_		—	_
45.0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
15:8	ADRC	_	_	SAMC<4:0> ⁽¹⁾				
RW-0 RW-0 RW-0 RW-0 RW-0 RW-0					R/W-0	R/W	R/W-0	
7:0								

REGISTER 22-3: AD1CON3: ADC CONTROL REGISTER 3

Legend:

R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 31-16 Unimplemented: Read as '0'

bit 15	ADRC: ADC Conversion Clock Source bit
	1 = Clock derived from FRC
	0 = Clock derived from Peripheral Bus Clock (PBCLK)
bit 14-13	Unimplemented: Read as '0'
bit 12-8	SAMC<4:0>: Auto-Sample Time bits ⁽¹⁾
	11111 = 31 TAD
	•
	•
	•
	00001 = 1 TAD

00000 = 0 TAD (Not allowed)

bit 7-0 ADCS<7:0>: ADC Conversion Clock Select bits⁽²⁾

- 11111111 =TPB 2 (ADCS<7:0> + 1) = 512 TPB = TAD
 - • • 00000001 =TPB • 2 • (ADCS<7:0> + 1) = 4 • TPB = TAD
 - 00000000 =TPB 2 (ADCS<7:0> + 1) = 2 TPB = TAD
- **Note 1:** This bit is only used if the SSRC<2:0> bits (AD1CON1<7:5>) = 111.
 - 2: This bit is not used if the ADRC (AD1CON3<15>) bit = 1.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
04.04	R/W-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
31:24	CH0NB	_	_	_	CH0SB<3:0>			
00.40	R/W-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
23:16	CH0NA	—	_	_	CH0SA<3:0>			
45.0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
15:8	_	_	_	_	—		—	—
7.0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
7:0	—						_	—

REGISTER 22-4: AD1CHS: ADC INPUT SELECT REGISTER

CHONB: Negative Input Select bit for Sample B

Legend:

bit 31

R = Readable bit	Readable bit W = Writable bit		U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

		 1 = Channel 0 negative input is AN1 0 = Channel 0 negative input is VREFL
bit 30	-28	Unimplemented: Read as '0'
bit 27	-24	CH0SB<3:0>: Positive Input Select bits for Sample B 1111 = Channel 0 positive input is Open ⁽¹⁾ 1110 = Channel 0 positive input is IVREF ⁽²⁾ 1101 = Channel 0 positive input is CTMU temperature sensor (CTMUT) ⁽³⁾ 1100 = Channel 0 positive input is AN12 ⁽⁴⁾
		•
		• 0001 = Channel 0 positive input is AN1 0000 = Channel 0 positive input is AN0
bit 23		CHONA: Negative Input Select bit for Sample A Multiplexer Setting ⁽²⁾ 1 = Channel 0 negative input is AN1 0 = Channel 0 negative input is VREFL
bit 22	-20	Unimplemented: Read as '0'
bit 19	-16	CH0SA<3:0>: Positive Input Select bits for Sample A Multiplexer Setting 1111 = Channel 0 positive input is Open ⁽¹⁾ 1110 = Channel 0 positive input is IVREF ⁽²⁾ 1101 = Channel 0 positive input is CTMU temperature (CTMUT) ⁽³⁾ 1100 = Channel 0 positive input is AN12 ⁽⁴⁾
		•
		0001 = Channel 0 positive input is AN1 0000 = Channel 0 positive input is AN0
bit 15	-0	Unimplemented: Read as '0'
Note	1: 2:	This selection is only used with CTMU capacitive and time measurement. See Section 24.0 "Comparator Voltage Reference (CVREF)" for more information.
	3:	See Section 25.0 "Charge Time Measurement Unit (CTMU)" for more information.
	4:	AN12 is only available on 44-pin devices. AN6-AN8 are not available on 28-pin devices.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
04.04	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	—	—	—	_	—	—	—	—
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	—	—	—	-	—	—	—	—
45.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
15:8	CSSL15	CSSL14	CSSL13	CSSL12	CSSL11	CSSL10	CSSL9	CSSL8
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
7:0	CSSL7	CSSL6	CSSL5	CSSL4	CSSL3	CSSL2	CSSL1	CSSL0

REGISTER 22-5: AD1CSSL: ADC INPUT SCAN SELECT REGISTER

Legend:

R = Readable bit W = W		V = Writable bit U = Unimplemented bit, read as '		ad as '0'
	-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

bit 15-0 CSSL<15:0>: ADC Input Pin Scan Selection bits^(1,2)

1 = Select ANx for input scan

0 = Skip ANx for input scan

- **Note 1:** CSSL = ANx, where 'x' = 0-12; CSSL13 selects CTMU input for scan; CSSL14 selects IVREF for scan; CSSL15 selects Vss for scan.
 - 2: On devices with less than 13 analog inputs, all CSSLx bits can be selected; however, inputs selected for scan without a corresponding input on the device will convert to VREFL.

23.0 COMPARATOR

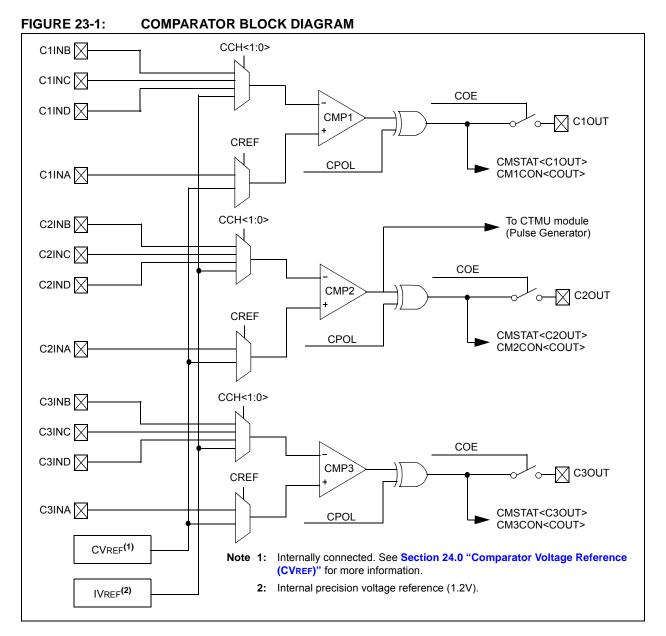
Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data Section sheet. refer to 19. "Comparator" (DS60001110), which is available from the Documentation > Reference Manual section of the PIC32 Microchip web site (www.microchip.com/pic32).

The Analog Comparator module contains three comparators that can be configured in a variety of ways.

Following are some of the key features of this module:

- Selectable inputs available include:
 - Analog inputs multiplexed with I/O pins
 - On-chip internal absolute voltage reference (IVREF)
 - Comparator voltage reference (CVREF)
- · Outputs can be Inverted
- Selectable interrupt generation

A block diagram of the comparator module is provided in Figure 23-1.



Comparator Control Registers 23.1

TABLE 23-1: COMPARATOR REGISTER MAP

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ess	1		1							Bi	ts			
Virtual Address (BF80_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4
A 000	A000 CM1CON	31:16		(<u> </u>	—		<u> </u>	· - '		—		—	—
A000	CMICON	15:0	ON	COE	CPOL	—			_	COUT	EVPO	L<1:0>		CREF
A010	CM2CON	31:16	—	<u> </u>	<u> </u>	—		<u> </u>			—	—	—	—
AUTU	CM2CON	15:0	ON	COE	CPOL	—		<u> </u>	—	COUT	EVPO	L<1:0>	—	CREF
A020	CM3CON	31:16	—	<u> </u>	<u> </u>	—		<u> </u>			—	—	—	—
A020	CIVISCON	15:0	ON	COE	CPOL	—		<u> </u>		COUT	EVPO	L<1:0>	—	CREF
A060	CMSTAT	31:16	- 7	<u> </u>	<u> </u>	—					—	_	—	_
A060	CINISTAT	15:0	_	_	SIDL	—					—	—	_	—
Legend	d: x = u	nknowr	n value on '	Reset; — =	unimplemer	nted, read a	as '0'. Rese	t values are	shown in ł	nexadecima	Ι.			

x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See more information. Note 1:

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24		_	_	_	_	—	_	—
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	_	_	_	_	_		_	_
45.0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0	U-0	R-0
15:8	0N ⁽¹⁾	COE	CPOL ⁽²⁾	_	_	—	_	COUT
7.0	R/W-1	R/W-1	U-0	R/W-0	U-0	U-0	R/W-1	R/W-1
7:0	EVPOL	_<1:0>	_	CREF	_	_	CCH	<1:0>

REGISTER 23-1: CMXCON: COMPARATOR CONTROL REGISTER

Legend:

5								
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'						
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown					

bit 31-16 **Unimplemented:** Read as '0'

- bit 15 **ON:** Comparator ON bit⁽¹⁾
 - 1 = Module is enabled. Setting this bit does not affect the other bits in this register
 - 0 = Module is disabled and does not consume current. Clearing this bit does not affect the other bits in this register
- bit 14 **COE:** Comparator Output Enable bit
 - 1 = Comparator output is driven on the output CxOUT pin
 - 0 = Comparator output is not driven on the output CxOUT pin

bit 13 **CPOL:** Comparator Output Inversion bit⁽²⁾

- 1 = Output is inverted
- 0 = Output is not inverted
- bit 12-9 Unimplemented: Read as '0'

bit 8 **COUT:** Comparator Output bit

- 1 = Output of the Comparator is a '1'
- 0 =Output of the Comparator is a '0'

bit 7-6 **EVPOL<1:0>:** Interrupt Event Polarity Select bits

- 11 = Comparator interrupt is generated on a low-to-high or high-to-low transition of the comparator output
- 10 = Comparator interrupt is generated on a high-to-low transition of the comparator output
- 01 = Comparator interrupt is generated on a low-to-high transition of the comparator output
- 00 = Comparator interrupt generation is disabled

bit 5 Unimplemented: Read as '0'

- bit 4 **CREF:** Comparator Positive Input Configure bit
 - 1 = Comparator non-inverting input is connected to the internal CVREF
 - 0 = Comparator non-inverting input is connected to the CXINA pin
- bit 3-2 Unimplemented: Read as '0'
- bit 1-0 CCH<1:0>: Comparator Negative Input Select bits for Comparator
 - 11 = Comparator inverting input is connected to the IVREF
 - 10 = Comparator inverting input is connected to the CxIND pin
 - 01 = Comparator inverting input is connected to the CxINC pin
 - 00 = Comparator inverting input is connected to the CxINB pin
- **Note 1:** When using the 1:1 PBCLK divisor, the user's software should not read/write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.
 - **2:** Setting this bit will invert the signal to the comparator interrupt generator as well. This will result in an interrupt being generated on the opposite edge from the one selected by EVPOL<1:0>.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	—	—		_	_	_	-	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	—	—	—	—	—	—	—	24/16/8/0 U-0 —
15:8	U-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
10.0	—	—	SIDL		_	_		—
7:0	U-0	U-0	U-0	U-0	U-0	R-0	R-0	R-0
7:0		_	_			C3OUT	C2OUT	C10UT

REGISTER 23-2: CMSTAT: COMPARATOR STATUS REGISTER

Legend:

bit 2

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'				
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

bit 31-14 Unimplemented: Read as '0'

bit 13	SIDL:	Stop	in	Idle	Control bit
	0.0	otop		iuio	00111101 011

1 = All Comparator modules are disabled when the device enters Idle mode

0 = All Comparator modules continue to operate when the device enters Idle mode

bit 12-3 Unimplemented: Read as '0'

- C3OUT: Comparator Output bit
 - 1 = Output of Comparator 3 is a '1'
 - 0 = Output of Comparator 3 is a '0'

bit 1 C2OUT: Comparator Output bit

- 1 = Output of Comparator 2 is a '1'
- 0 = Output of Comparator 2 is a '0'

bit 0 C1OUT: Comparator Output bit

- 1 = Output of Comparator 1 is a '1'
- 0 = Output of Comparator 1 is a '0'

24.0 COMPARATOR VOLTAGE **REFERENCE (CVREF)**

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 20. "Comparator Voltage Reference (CVREF)" (DS60001109), which is available from the Documentation > Reference Manual section of the Microchip PIC32 web site (www.microchip.com/pic32).

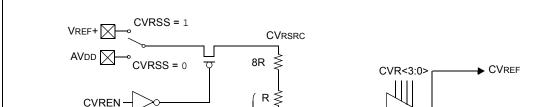
The CVREF module is a 16-tap, resistor ladder network that provides a selectable reference voltage. Although its primary purpose is to provide a reference for the analog comparators, it also may be used independently of them.

The resistor ladder is segmented to provide two ranges of voltage reference values and has a power-down function to conserve power when the reference is not being used. The module's supply reference can be provided from either device VDD/VSS or an external voltage reference. The CVREF output is available for the comparators and typically available for pin output.

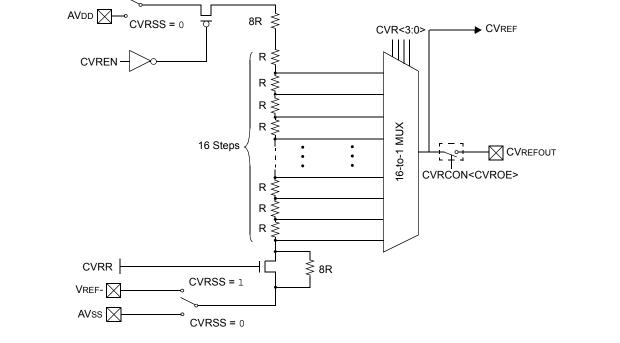
The comparator voltage reference has the following features:

- · High and low range selection
- · Sixteen output levels available for each range
- · Internally connected to comparators to conserve device pins
- · Output can be connected to a pin

A block diagram of the module is shown in Figure 24-1.







24.1 Comparator Voltage Reference Control Register

TABLE 24-1: COMPARATOR VOLTAGE REFERENCE REGISTER MAP

ess		e	Bits											
Virtual Address (BF80_#)	Virtual Addre (BF80_#) Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4
0000	CVRCON	31:16	_	—		_	_	_	_	_	_	_	_	—
9600	CVRCON	15:0	ON	—	_	_	_	_	_	_	_	CVROE	CVRR	CVRSS

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See more information.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24		—	_	_	_		_	—
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	—	—	_	-	_	_	_	1 24/16/8/0 U-0 —
45.0	R/W-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
15:8	0N ⁽¹⁾	_	_	_	_	—	_	—
7.0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
7:0	_	CVROE	CVRR	CVRSS		CVR<	<3:0>	5/17/9/1 24/16/8/0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 M-0 U-0 R/W-0 R/W-0

REGISTER 24-1: CVRCON: COMPARATOR VOLTAGE REFERENCE CONTROL REGISTER

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, I	t, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

Unimplemented: Read as '0'
ON: Comparator Voltage Reference On bit ⁽¹⁾
 1 = Module is enabled Setting this bit does not affect other bits in the register. 0 = Module is disabled and does not consume current. Clearing this bit does not affect the other bits in the register.
Unimplemented: Read as '0'
CVROE: CVREFOUT Enable bit
1 = Voltage level is output on CVREFOUT pin0 = Voltage level is disconnected from CVREFOUT pin
CVRR: CVREF Range Selection bit
1 = 0 to 0.67 CVRSRC, with CVRSRC/24 step size 0 = 0.25 CVRSRC to 0.75 CVRSRC, with CVRSRC/32 step size
CVRSS: CVREF Source Selection bit
1 = Comparator voltage reference source, CVRSRC = (VREF+) – (VREF-) 0 = Comparator voltage reference source, CVRSRC = AVDD – AVSS
CVR<3:0>: CVREF Value Selection $0 \le$ CVR<3:0> \le 15 bits
$\frac{\text{When CVRR} = 1:}{\text{CVREF} = (\text{CVR}<3:0>/24) \bullet (\text{CVRSRC})}$
$\frac{\text{When CVRR} = 0:}{\text{CVREF} = 1/4 \bullet (\text{CVRsRc}) + (\text{CVR}<3:0>/32) \bullet (\text{CVRsRc})}$

Note 1: When using 1:1 PBCLK divisor, the user's software should not read/write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.

NOTES:

25.0 CHARGE TIME MEASUREMENT UNIT (CTMU)

Note:	This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 37. "Charge Time
	Measurement Unit (CTMU)" (DS60001167), which is available from the Documentation > Reference Manual section of the Microchip PIC32 web site (www.microchip.com/pic32).

The Charge Time Measurement Unit (CTMU) is a flexible analog module that has a configurable current source with a digital configuration circuit built around it. The CTMU can be used for differential time measurement between pulse sources and can be used for generating an asynchronous pulse. By working with other on-chip analog modules, the CTMU can be used for high resolution time measurement, measure capacitance, measure relative changes in capacitance or generate output pulses with a specific time delay. The CTMU is ideal for interfacing with capacitive-based sensors. The CTMU module includes the following key features:

- Up to 13 channels available for capacitive or time measurement input
- On-chip precision current source
- 16-edge input trigger sources
- · Selection of edge or level-sensitive inputs
- Polarity control for each edge source
- · Control of edge sequence
- Control of response to edges
- · High precision time measurement
- Time delay of external or internal signal asynchronous to system clock
- · Integrated temperature sensing diode
- · Control of current source during auto-sampling
- · Four current source ranges
- Time measurement resolution of one nanosecond

A block diagram of the CTMU is shown in Figure 25-1.

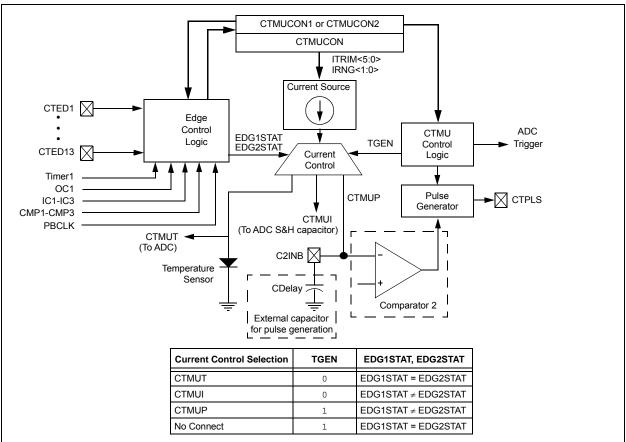


FIGURE 25-1: CTMU BLOCK DIAGRAM

CTMU Control Registers 25.1

TABLE 25-1: **CTMU REGISTER MAP**

ess	Virtual Address (BF80_#) Register Name ⁽¹⁾	е		Bits											
rtual Add (BF80_		Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	
1200	стмисом	31:16	EDG1MOD	EDG1POL		EDG1SEL<3:0>				EDG1STAT	EDG2MOD	EDG2POL		EDG	
A200	CIMUCON	15:0	ON	_	CTMUSIDL	TGEN	EDGEN	EDGSEQEN	IDISSEN	CTTRIG			ITRIM•	<5:0>	

Legend:

 x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

 All registers in this table have corresponding CLR, SET and INV registers at its virtual address, plus an offset of 0x4, 0x8 and 0xC, respectively. See S more information.

 Note 1:

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
31.24	EDG1MOD	EDG1POL		EDG1S	EDG2STAT	EDG1STAT		
23:16	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0
23.10	EDG2MOD	EDG2POL		EDG2S	—	—		
15:8	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
15.0	ON	_	CTMUSIDL	TGEN ⁽¹⁾	EDGEN	EDGSEQEN	IDISSEN ⁽²⁾	CTTRIG
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
7.0		IRNG<1:0>						

REGISTER 25-1: CTMUCON: CTMU CONTROL REGISTER

Legend:

Legena.			
R = Readable bit	W = Writable bit	U = Unimplemented b	oit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31 EDG1MOD: Edge1 Edge Sampling Select bit

- 1 = Input is edge-sensitive
- 0 = Input is level-sensitive
- bit 30 EDG1POL: Edge 1 Polarity Select bit
 - 1 = Edge1 programmed for a positive edge response
 - 0 = Edge1 programmed for a negative edge response
- bit 29-26 EDG1SEL<3:0>: Edge 1 Source Select bits
 - 1111 = C3OUT pin is selected
 - 1110 = C2OUT pin is selected
 - 1101 = C1OUT pin is selected
 - 1100 = IC3 Capture Event is selected
 - 1011 = IC2 Capture Event is selected
 - 1010 = IC1 Capture Event is selected
 - 1001 = CTED8 pin is selected
 - 1000 = CTED7 pin is selected
 - 0111 = CTED6 pin is selected
 - 0110 = CTED5 pin is selected
 - 0101 = CTED4 pin is selected
 - 0100 = CTED3 pin is selected
 - 0011 = CTED1 pin is selected
 - 0010 = CTED2 pin is selected
 - 0001 = OC1 Compare Event is selected
 - 0000 = Timer1 Event is selected

bit 25 EDG2STAT: Edge2 Status bit

Indicates the status of Edge2 and can be written to control edge source

- 1 = Edge2 has occurred
- 0 = Edge2 has not occurred
- Note 1: When this bit is set for Pulse Delay Generation, the EDG2SEL<3:0> bits must be set to '1110' to select C2OUT.
 - 2: The ADC module Sample and Hold capacitor is not automatically discharged between sample/conversion cycles. Software using the ADC as part of a capacitive measurement, must discharge the ADC capacitor before conducting the measurement. The IDISSEN bit, when set to '1', performs this function. The ADC module must be sampling while the IDISSEN bit is active to connect the discharge sink to the capacitor array.
 - 3: Refer to the CTMU Current Source Specifications (Table 30-41) in Section 30.0 "Electrical Characteristics" for current values.
 - 4: This bit setting is not available for the CTMU temperature diode.

REGISTER 25-1: CTMUCON: CTMU CONTROL REGISTER (CONTINUED) EDG1STAT: Edge1 Status bit bit 24 Indicates the status of Edge1 and can be written to control edge source 1 = Edge1 has occurred 0 = Edge1 has not occurred bit 23 EDG2MOD: Edge2 Edge Sampling Select bit 1 = Input is edge-sensitive 0 = Input is level-sensitive bit 22 EDG2POL: Edge 2 Polarity Select bit 1 = Edge2 programmed for a positive edge response 0 = Edge2 programmed for a negative edge response bit 21-18 EDG2SEL<3:0>: Edge 2 Source Select bits 1111 = C3OUT pin is selected 1110 = C2OUT pin is selected 1101 = C1OUT pin is selected 1100 = PBCLK clock is selected 1011 = IC3 Capture Event is selected 1010 = IC2 Capture Event is selected 1001 = IC1 Capture Event is selected 1000 = CTED13 pin is selected 0111 = CTED12 pin is selected 0110 = CTED11 pin is selected 0101 = CTED10 pin is selected 0100 = CTED9 pin is selected 0011 = CTED1 pin is selected 0010 = CTED2 pin is selected 0001 = OC1 Compare Event is selected 0000 = Timer1 Event is selected bit 17-16 Unimplemented: Read as '0' bit 15 **ON:** ON Enable bit 1 = Module is enabled 0 = Module is disabled bit 14 Unimplemented: Read as '0' bit 13 CTMUSIDL: Stop in Idle Mode bit 1 = Discontinue module operation when the device enters Idle mode 0 = Continue module operation when the device enters Idle mode TGEN: Time Generation Enable bit⁽¹⁾ bit 12 1 = Enables edge delay generation 0 = Disables edge delay generation bit 11 EDGEN: Edge Enable bit 1 = Edges are not blocked

- 1 = Euges are not blocke
- 0 = Edges are blocked
- Note 1: When this bit is set for Pulse Delay Generation, the EDG2SEL<3:0> bits must be set to '1110' to select C2OUT.
 - 2: The ADC module Sample and Hold capacitor is not automatically discharged between sample/conversion cycles. Software using the ADC as part of a capacitive measurement, must discharge the ADC capacitor before conducting the measurement. The IDISSEN bit, when set to '1', performs this function. The ADC module must be sampling while the IDISSEN bit is active to connect the discharge sink to the capacitor array.
 - 3: Refer to the CTMU Current Source Specifications (Table 30-41) in Section 30.0 "Electrical Characteristics" for current values.
 - 4: This bit setting is not available for the CTMU temperature diode.

REGISTER 25-1: CTMUCON: CTMU CONTROL REGISTER (CONTINUED)

bit 10 EDGSEQEN: Edge Sequence Enable bit						
	1 = Edge1 must occur before Edge2 can occur0 = No edge sequence is needed					
bit 9	IDISSEN: Analog Current Source Control bit ⁽²⁾					
	1 = Analog current source output is grounded0 = Analog current source output is not grounded					
bit 8	CTTRIG: Trigger Control bit					
	1 = Trigger output is enabled					
	0 = Trigger output is disabled					
bit 7-2	ITRIM<5:0>: Current Source Trim bits					
	011111 = Maximum positive change from nominal current 011110					
	•					
	•					
	 000001 = Minimum positive change from nominal current 000000 = Nominal current output specified by IRNG<1:0> 111111 = Minimum negative change from nominal current 					
	•					
	• 100010					
	100001 = Maximum negative change from nominal current					
bit 1-0	IRNG<1:0>: Current Range Select bits ⁽³⁾					
	11 = 100 times base current 10 = 10 times base current					
	01 = Base current level					

- $00 = 1000 \text{ times base current}^{(4)}$
- Note 1: When this bit is set for Pulse Delay Generation, the EDG2SEL<3:0> bits must be set to '1110' to select C2OUT.
 - 2: The ADC module Sample and Hold capacitor is not automatically discharged between sample/conversion cycles. Software using the ADC as part of a capacitive measurement, must discharge the ADC capacitor before conducting the measurement. The IDISSEN bit, when set to '1', performs this function. The ADC module must be sampling while the IDISSEN bit is active to connect the discharge sink to the capacitor array.
 - 3: Refer to the CTMU Current Source Specifications (Table 30-41) in Section 30.0 "Electrical Characteristics" for current values.
 - 4: This bit setting is not available for the CTMU temperature diode.

NOTES:

26.0 POWER-SAVING FEATURES

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 10. "Power-Saving Features" (DS60001130), which is available from the Documentation > Reference Manual section of the PIC32 Microchip web site (www.microchip.com/pic32).

This section describes power-saving features for the PIC32MX1XX/2XX 28/36/44-pin Family. The PIC32 devices offer a total of nine methods and modes, organized into two categories, that allow the user to balance power consumption with device performance. In all of the methods and modes described in this section, power-saving is controlled by software.

26.1 Power Saving with CPU Running

When the CPU is running, power consumption can be controlled by reducing the CPU clock frequency, lowering the PBCLK and by individually disabling modules. These methods are grouped into the following categories:

- FRC Run mode: the CPU is clocked from the FRC clock source with or without postscalers
- LPRC Run mode: the CPU is clocked from the LPRC clock source
- Sosc Run mode: the CPU is clocked from the Sosc clock source

In addition, the Peripheral Bus Scaling mode is available where peripherals are clocked at the programmable fraction of the CPU clock (SYSCLK).

26.2 CPU Halted Methods

The device supports two power-saving modes, Sleep and Idle, both of which Halt the clock to the CPU. These modes operate with all clock sources, as follows:

- Posc Idle mode: the system clock is derived from the Posc. The system clock source continues to operate. Peripherals continue to operate, but can optionally be individually disabled.
- FRC Idle mode: the system clock is derived from the FRC with or without postscalers. Peripherals continue to operate, but can optionally be individually disabled.
- Sosc Idle mode: the system clock is derived from the Sosc. Peripherals continue to operate, but can optionally be individually disabled.

- LPRC Idle mode: the system clock is derived from the LPRC. Peripherals continue to operate, but can optionally be individually disabled. This is the lowest power mode for the device with a clock running.
- Sleep mode: the CPU, the system clock source and any peripherals that operate from the system clock source are Halted. Some peripherals can operate in Sleep using specific clock sources. This is the lowest power mode for the device.

26.3 Power-Saving Operation

Peripherals and the CPU can be Halted or disabled to further reduce power consumption.

26.3.1 SLEEP MODE

Sleep mode has the lowest power consumption of the device power-saving operating modes. The CPU and most peripherals are Halted. Select peripherals can continue to operate in Sleep mode and can be used to wake the device from Sleep. See the individual peripheral module sections for descriptions of behavior in Sleep.

Sleep mode includes the following characteristics:

- The CPU is halted
- The system clock source is typically shutdown. See Section 26.3.3 "Peripheral Bus Scaling Method" for specific information.
- There can be a wake-up delay based on the oscillator selection
- The Fail-Safe Clock Monitor (FSCM) does not operate during Sleep mode
- The BOR circuit remains operative during Sleep mode
- The WDT, if enabled, is not automatically cleared prior to entering Sleep mode
- Some peripherals can continue to operate at limited functionality in Sleep mode. These peripherals include I/O pins that detect a change in the input signal, WDT, ADC, UART and peripherals that use an external clock input or the internal LPRC oscillator (e.g., RTCC, Timer1 and Input Capture).
- I/O pins continue to sink or source current in the same manner as they do when the device is not in Sleep
- The USB module can override the disabling of the Posc or FRC. Refer to the USB section for specific details.
- Modules can be individually disabled by software prior to entering Sleep in order to further reduce consumption

The processor will exit, or 'wake-up', from Sleep on one of the following events:

- On any interrupt from an enabled source that is operating in Sleep. The interrupt priority must be greater than the current CPU priority.
- · On any form of device Reset
- On a WDT time-out

If the interrupt priority is lower than or equal to the current priority, the CPU will remain Halted, but the PBCLK will start running and the device will enter into Idle mode.

26.3.2 IDLE MODE

In Idle mode, the CPU is Halted but the System Clock (SYSCLK) source is still enabled. This allows peripherals to continue operation when the CPU is Halted. Peripherals can be individually configured to Halt when entering Idle by setting their respective SIDL bit. Latency, when exiting Idle mode, is very low due to the CPU oscillator source remaining active.

- Note 1: Changing the PBCLK divider ratio requires recalculation of peripheral timing. For example, assume the UART is configured for 9600 baud with a PB clock ratio of 1:1 and a Posc of 8 MHz. When the PB clock divisor of 1:2 is used, the input frequency to the baud clock is cut in half; therefore, the baud rate is reduced to 1/2 its former value. Due to numeric truncation in calculations (such as the baud rate divisor), the actual baud rate may be a tiny percentage different than expected. For this reason, any timing calculation required for a peripheral should be performed with the new PB clock frequency instead of scaling the previous value based on a change in the PB divisor ratio.
 - 2: Oscillator start-up and PLL lock delays are applied when switching to a clock source that was disabled and that uses a crystal and/or the PLL. For example, assume the clock source is switched from Posc to LPRC just prior to entering Sleep in order to save power. No oscillator startup delay would be applied when exiting Idle. However, when switching back to Posc, the appropriate PLL and/or oscillator start-up/lock delays would be applied.

The device enters Idle mode when the SLPEN (OSCCON<4>) bit is clear and a WAIT instruction is executed.

The processor will wake or exit from Idle mode on the following events:

- On any interrupt event for which the interrupt source is enabled. The priority of the interrupt event must be greater than the current priority of the CPU. If the priority of the interrupt event is lower than or equal to current priority of the CPU, the CPU will remain Halted and the device will remain in Idle mode.
- · On any form of device Reset
- · On a WDT time-out interrupt

26.3.3 PERIPHERAL BUS SCALING METHOD

Most of the peripherals on the device are clocked using the PBCLK. The Peripheral Bus can be scaled relative to the SYSCLK to minimize the dynamic power consumed by the peripherals. The PBCLK divisor is controlled by PBDIV<1:0> (OSCCON<20:19>), allowing SYSCLK to PBCLK ratios of 1:1, 1:2, 1:4 and 1:8. All peripherals using PBCLK are affected when the divisor is changed. Peripherals such as the USB, Interrupt Controller, DMA, and the bus matrix are clocked directly from SYSCLK. As a result, they are not affected by PBCLK divisor changes.

Changing the PBCLK divisor affects:

- The CPU to peripheral access latency. The CPU has to wait for next PBCLK edge for a read to complete. In 1:8 mode, this results in a latency of one to seven SYSCLKs.
- The power consumption of the peripherals. Power consumption is directly proportional to the frequency at which the peripherals are clocked. The greater the divisor, the lower the power consumed by the peripherals.

To minimize dynamic power, the PB divisor should be chosen to run the peripherals at the lowest frequency that provides acceptable system performance. When selecting a PBCLK divider, peripheral clock requirements, such as baud rate accuracy, should be taken into account. For example, the UART peripheral may not be able to achieve all baud rate values at some PBCLK divider depending on the SYSCLK value.

26.4 Peripheral Module Disable

The Peripheral Module Disable (PMD) registers provide a method to disable a peripheral module by stopping all clock sources supplied to that module. When a peripheral is disabled using the appropriate PMD control bit, the peripheral is in a minimum power consumption state. The control and status registers associated with the peripheral are also disabled, so writes to those registers do not have effect and read values are invalid. To disable a peripheral, the associated PMDx bit must be set to '1'. To enable a peripheral, the associated PMDx bit must be cleared (default). See Table 26-1 for more information.

Note: Disabling a peripheral module while it's ON bit is set, may result in undefined behavior. The ON bit for the associated peripheral module must be cleared prior to disable a module via the PMDx bits.

Peripheral ⁽¹⁾	PMDx bit Name ⁽¹⁾	Register Name and Bit Location
ADC1	AD1MD	PMD1<0>
СТМИ	CTMUMD	PMD1<8>
Comparator Voltage Reference	CVRMD	PMD1<12>
Comparator 1	CMP1MD	PMD2<0>
Comparator 2	CMP2MD	PMD2<1>
Comparator 3	CMP3MD	PMD2<2>
Input Capture 1	IC1MD	PMD3<0>
Input Capture 2	IC2MD	PMD3<1>
Input Capture 3	IC3MD	PMD3<2>
Input Capture 4	IC4MD	PMD3<3>
Input Capture 5	IC5MD	PMD3<4>
Output Compare 1	OC1MD	PMD3<16>
Output Compare 2	OC2MD	PMD3<17>
Output Compare 3	OC3MD	PMD3<18>
Output Compare 4	OC4MD	PMD3<19>
Output Compare 5	OC5MD	PMD3<20>
Timer1	T1MD	PMD4<0>
Timer2	T2MD	PMD4<1>
Timer3	T3MD	PMD4<2>
Timer4	T4MD	PMD4<3>
Timer5	T5MD	PMD4<4>
UART1	U1MD	PMD5<0>
UART2	U2MD	PMD5<1>
SPI1	SPI1MD	PMD5<8>
SPI2	SPI2MD	PMD5<9>
I2C1	I2C1MD	PMD5<16>
I2C2	I2C2MD	PMD5<17>
USB ⁽²⁾	USBMD	PMD5<24>
RTCC	RTCCMD	PMD6<0>
Reference Clock Output	REFOMD	PMD6<1>
PMP	PMPMD	PMD6<16>

Note 1: Not all modules and associated PMDx bits are available on all devices. See TABLE 1: "PIC32MX1XX 28/36/44-Pin General Purpose Family Features" and TABLE 2: "PIC32MX2XX 28/36/44-pin USB Family Features" for the lists of available peripherals.

2: The module must not be busy after clearing the associated ON bit and prior to setting the USBMD bit.

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26.4.1 CONTROLLING CONFIGURATION CHANGES

Because peripherals can be disabled during run time, some restrictions on disabling peripherals are needed to prevent accidental configuration changes. PIC32 devices include two features to prevent alterations to enabled or disabled peripherals:

- · Control register lock sequence
- · Configuration bit select lock

26.4.1.1 Control Register Lock

Under normal operation, writes to the PMDx registers are not allowed. Attempted writes appear to execute normally, but the contents of the registers remain unchanged. To change these registers, they must be unlocked in hardware. The register lock is controlled by the Configuration bit, PMDLOCK (CFGCON<12>). Setting PMDLOCK prevents writes to the control registers; clearing PMDLOCK allows writes.

To set or clear PMDLOCK, an unlock sequence must be executed. Refer to **Section 6. "Oscillator"** (DS60001112) in the *"PIC32 Family Reference Manual"* for details.

26.4.1.2 Configuration Bit Select Lock

As an additional level of safety, the device can be configured to prevent more than one write session to the PMDx registers. The Configuration bit, PMDL1WAY (DEVCFG3<28>), blocks the PMDLOCK bit from being cleared after it has been set once. If PMDLOCK remains set, the register unlock procedure does not execute, and the peripheral pin select control registers cannot be written to. The only way to clear the bit and re-enable PMD functionality is to perform a device Reset.

0
20
2
-20
8
Microchip
Technology
Inc.

ess			Bits												
Virtual Address (BF80_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19
F240	PMD1	31:16	_	—	—	—	_		_	—	—		_	—	-
F240		15:0	_	_	_	CVRMD	_	_	—	CTMUMD	_	_	_	_	-
5050		31:16	_	_	_	_	_		_	—	_	_		—	_
F250	PMD2	15:0	_	_	_	_	_		_	—	_	_		—	-
5000		31:16	_	_	-	_	-	_	_	—	_		_	OC5MD	OC4
F260	PMD3	15:0	_	_	_	_	_	_	_	—	_		_	IC5MD	IC4
	DMD4	31:16	_	_	_	_	_	_	_	—	_		_	_	-
F270	PMD4	15:0	_	_	_	_	_	_	_	—	_		_	T5MD	T4
	DMDE	31:16	_	_	_	_	_	_	-	USB1MD	_		_	_	-
F280	PMD5	15:0	_	_	_	_	_	_	SPI2MD	SPI1MD	_		_	_	-
5000	DMDC	31:16	_	_	_	_	_	_	_	_	_	_	_	_	-
F290	PMD6	15:0	_	_	_	_	_	_	_	_	_	_	_	_	-
Legend	Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.														

TABLE 26-2: PERIPHERAL MODULE DISABLE REGISTER MAP

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See more information.

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NOTES:

27.0 SPECIAL FEATURES

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. However, it is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to 32. "Configuration" Section (DS60001124) and Section 33. "Programming and **Diagnostics**" (DS60001129), which are available from the Documentation > Reference Manual section of the Microchip PIC32 web site (www.microchip.com/pic32).

PIC32MX1XX/2XX 28/36/44-pin Family devices include the following features intended to maximize application flexibility, reliability and minimize cost through elimination of external components.

- Flexible device configuration
- Joint Test Action Group (JTAG) interface
- In-Circuit Serial Programming[™] (ICSP[™])

27.1 Configuration Bits

The Configuration bits can be programmed using the following registers to select various device configurations.

- DEVCFG0: Device Configuration Word 0
- DEVCFG1: Device Configuration Word 1
- DEVCFG2: Device Configuration Word 2
- DEVCFG3: Device Configuration Word 3
- CFGCON: Configuration Control Register

In addition, the DEVID register (Register 27-6) provides device and revision information.

27.2 Configuration Registers

TABLE 27-1: **DEVCFG: DEVICE CONFIGURATION WORD SUMMARY**

S6	
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ge	
24	
N	

ess		0								Bits				
Virtual Address (BFC0_#)	Register Name	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4
	DEVCFG3	31:16	FVBUSONIO	FUSBIDIO	IOL1WAY	PMDL1WAY		—	—		—	_	—	-
UDFU	DEVCEGS	15:0			USERID<15:0>									
	DEVCFG2	31:16	—	—	—	_	—	—	_	—	—	—	—	—
0054	DEVCFGZ	15:0	UPLLEN ⁽¹⁾	—	—	_	—	UPL	LIDIV<2:0	_{>} (1)	—	FPLLMUL<2:0>		
	DEVCFG1	31:16	—	—	—	_	—	—	FWDTWI	NSZ<1:0>	FWDTEN	WINDIS	—	
UDFO	DEVCEGI	15:0	FCKSM	<1:0>	FPBD	IV<1:0>	—	OSCIOFNC	POSCM	OD<1:0>	IESO	—	FSOSCEN	—
	DEVCFG0	31:16	_	—	_	CP	—	_	_	BWP		—	—	—
UDFC	DEVCEGO	15:0			PWP<	<5:0>				_		—	_	ICESEL
Legen	egend: x = unknown value on Reset: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.													

This bit is only available on PIC32MX2XX devices. Note 1:

PWP<8:7> are only available on devices with 256 KB of Flash. 2:

DEVICE ID, REVISION, AND CONFIGURATION SUMMARY **TABLE 27-2:**

ess	ess									Bi	ts			
Virtual Address (BF80_#)	Register Name	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4
F220	31.			VER	<3:0>		DEVID<27:16>							
F220	DEVID	15:0					DEVID<15:0>							
5000		31:16	_									_		
F200	CFGCON	15:0	_	_	IOLOCK	PMDLOCK	-	-	_	_	_	_	_	_
5000	SYSKEY(3)	31:16								SYSKE	/~21.0>			
F230	SISKER	15:0								STSKET	1<31.0>			
Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.														

x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal. Reset values are dependent on the device variant. Note 1:

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
31:24	r-0	r-1	r-1	R/P	r-1	r-1	r-1	R/P	
31.24	—	—	—	CP	_	—	—	BWP	
22:16	r-1	r-1	r-1	r-1	r-1	R/P	R/P	R/P	
23:16	—						PWP<8:6> ⁽³⁾		
15:8	R/P	R/P	R/P	R/P	R/P	R/P	r-1	r-1	
10.0		—	—						
7:0	r-1	r-1	r-1	R/P	R/P	R/P	R/P	R/P	
7:0	_	— — ICESEL<1:0				JTAGEN ⁽¹⁾ DEBUG<1:0>			

REGISTER 27-1: DEVCFG0: DEVICE CONFIGURATION WORD 0

Legend:	r = Reserved bit	P = Programmable bit	
R = Readable bit	W = Writable bit	U = Unimplemented b	it, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

- bit 31 Reserved: Write '0'
- bit 30-29 Reserved: Write '1'
- bit 28 **CP:** Code-Protect bit
 - Prevents boot and program Flash memory from being read or modified by an external programming device. 1 = Protection is disabled
 - 0 = Protection is enabled
- bit 27-25 Reserved: Write '1'
- bit 24 BWP: Boot Flash Write-Protect bit
 - Prevents boot Flash memory from being modified during code execution.
 - 1 = Boot Flash is writable
 - 0 = Boot Flash is not writable
- bit 23-19 Reserved: Write '1'
- **Note 1:** This bit sets the value for the JTAGEN bit in the CFGCON register.
 - 2: The PGEC4/PGED4 pin pair is not available on all devices. Refer to the "Pin Diagrams" section for availability.
 - 3: The PWP<8:7> bits are only available on devices with 256 KB Flash.

REGISTER 27-1: DEVCFG0: DEVICE CONFIGURATION WORD 0 (CONTINUED)

bit 18-10 **PWP<8:0>:** Program Flash Write-Protect bits⁽³⁾

	Prevents selected program Flash memory pages from being modified during code execution. 11111111 = Disabled 11111110 = Memory below 0x0400 address is write-protected 11111101 = Memory below 0x0600 address is write-protected 11111010 = Memory below 0x0000 (4K) address is write-protected 11111010 = Memory below 0x1000 (4K) address is write-protected 11111010 = Memory below 0x1000 address is write-protected 11111010 = Memory below 0x1000 address is write-protected 11111000 = Memory below 0x1000 address is write-protected 11111010 = Memory below 0x1000 address is write-protected 11111010 = Memory below 0x1000 address is write-protected 1111010 = Memory below 0x2000 (8K) address is write-protected 1111010 = Memory below 0x2000 address is write-protected 11110101 = Memory below 0x2000 address is write-protected 1111001 = Memory below 0x2000 address is write-protected 1111001 = Memory below 0x3000 address is write-protected 1111000 = Memory below 0x3000 address is write-protected 1111000 = Memory below 0x3000 address is write-protected 11110001 = Memory below 0x3000 address is write-protected 11110001 = Memory below 0x3000 address is write-protected 11110001 = Memory below 0x3000 address is write-protected 11110011 = Memory below 0x3000 address is write-protected 11110111 = Memory below 0x4000 (16K) address is write-protected
	• 00000000 = All possible memory is write-protected
bit 9-5	Reserved: Write '1'
bit 4-3	ICESEL<1:0>: In-Circuit Emulator/Debugger Communication Channel Select bits ⁽²⁾ 11 = PGEC1/PGED1 pair is used 10 = PGEC2/PGED2 pair is used 01 = PGEC3/PGED3 pair is used 00 = PGEC4/PGED4 pair is used ⁽²⁾
bit 2	JTAGEN: JTAG Enable bit ⁽¹⁾ 1 = JTAG is enabled 0 = JTAG is disabled
bit 1-0	DEBUG<1:0>: Background Debugger Enable bits (forced to '11' if code-protect is enabled) 11 = Debugger is disabled 0x = Debugger is enabled
Note 1:	This bit sets the value for the JTAGEN bit in the CFGCON register.

- 2: The PGEC4/PGED4 pin pair is not available on all devices. Refer to the "Pin Diagrams" section for availability.
- 3: The PWP<8:7> bits are only available on devices with 256 KB Flash.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
21.24	r-1	r-1	r-1	r-1	r-1	r-1	R/P	R/P
31:24		_	_	-	—	—	FWDTWI	NSZ<1:0>
00.40	R/P	R/P	r-1	R/P	R/P	R/P	R/P	R/P
23:16	FWDTEN	WINDIS	_	WDTPS<4:0>				
45.0	R/P	R/P	R/P	R/P	r-1	R/P	R/P	R/P
15:8	FCKSM<1:0>		FPBDIV<1:0>		—	OSCIOFNC	POSCM	OD<1:0>
7.0	R/P	r-1	R/P	r-1	r-1	R/P	R/P	R/P
7:0	IESO		FSOSCEN		— — FNOSC<2:0>			

REGISTER 27-2: DEVCFG1: DEVICE CONFIGURATION WORD 1

Legend:	r = Reserved bit	P = Programmable bit	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-26 Reserved: Write '1'

bit 25-24 FWDTWINSZ<1:0>: Watchdog Timer Window Size bits

- 11 = Window size is 25%
- 10 = Window size is 37.5%
- 01 = Window size is 50%
- 00 = Window size is 75%

bit 23 FWDTEN: Watchdog Timer Enable bit

- 1 = Watchdog Timer is enabled and cannot be disabled by software
- 0 = Watchdog Timer is not enabled; it can be enabled in software

bit 22 WINDIS: Watchdog Timer Window Enable bit

- 1 = Watchdog Timer is in non-Window mode
- 0 = Watchdog Timer is in Window mode

bit 21 Reserved: Write '1'

bit 20-16 WDTPS<4:0>: Watchdog Timer Postscale Select bits

10100 = 1:1048576
10011 = 1:524288
10010 = 1:262144
10001 = 1:131072
10000 = 1:65536
01111 = 1:32768
01110 = 1:16384
01101 = 1:8192
01100 = 1:4096
01011 = 1:2048
01010 = 1:1024
01001 = 1:512
01000 = 1:256
00111 = 1:128
00110 = 1:64
00101 = 1:32
00100 = 1:16
00011 = 1:8
00010 = 1:4
00001 = 1:2
00000 = 1:1
All other combinations not shown result in operation = 10100

Note 1: Do not disable the Posc (POSCMOD = 11) when using this oscillator source.

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REGISTER 27-2: DEVCFG1: DEVICE CONFIGURATION WORD 1 (CONTINUED)

bit 15-14 FCKSM<1:0>: Clock Switching and Monitor Selection Configuration bits

- 1x = Clock switching is disabled, Fail-Safe Clock Monitor is disabled
- 01 = Clock switching is enabled, Fail-Safe Clock Monitor is disabled

00 = Clock switching is enabled, Fail-Safe Clock Monitor is enabled

- bit 13-12 FPBDIV<1:0>: Peripheral Bus Clock Divisor Default Value bits
 - 11 = PBCLK is SYSCLK divided by 8
 - 10 = PBCLK is SYSCLK divided by 4
 - 01 = PBCLK is SYSCLK divided by 2
 - 00 = PBCLK is SYSCLK divided by 1
- bit 11 Reserved: Write '1'
- bit 10 OSCIOFNC: CLKO Enable Configuration bit
 - 1 = CLKO output disabled
 - 0 = CLKO output signal active on the OSCO pin; Primary Oscillator must be disabled or configured for the External Clock mode (EC) for the CLKO to be active (POSCMOD<1:0> = 11 or 00)
- bit 9-8 **POSCMOD<1:0>:** Primary Oscillator Configuration bits
 - 11 = Primary Oscillator is disabled
 - 10 = HS Oscillator mode is selected
 - 01 = XT Oscillator mode is selected
 - 00 = External Clock mode is selected
- bit 7 IESO: Internal External Switchover bit
 - 1 = Internal External Switchover mode is enabled (Two-Speed Start-up is enabled)
 - 0 = Internal External Switchover mode is disabled (Two-Speed Start-up is disabled)
- bit 6 Reserved: Write '1'
- bit 5 **FSOSCEN:** Secondary Oscillator Enable bit
 - 1 = Enable Secondary Oscillator
 - 0 = Disable Secondary Oscillator
- bit 4-3 Reserved: Write '1'
- bit 2-0 **FNOSC<2:0>:** Oscillator Selection bits
 - 111 = Fast RC Oscillator with divide-by-N (FRCDIV)
 - 110 = FRCDIV16 Fast RC Oscillator with fixed divide-by-16 postscaler
 - 101 = Low-Power RC Oscillator (LPRC)
 - 100 = Secondary Oscillator (Sosc)
 - 011 = Primary Oscillator (Posc) with PLL module (XT+PLL, HS+PLL, EC+PLL)
 - 010 = Primary Oscillator (XT, HS, EC)⁽¹⁾
 - 001 = Fast RC Oscillator with divide-by-N with PLL module (FRCDIV+PLL)
 - 000 = Fast RC Oscillator (FRC)
- **Note 1:** Do not disable the POSC (POSCMOD = 11) when using this oscillator source.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	r-1	r-1	r-1	r-1	r-1	r-1	r-1	r-1
31.24	—	_	—	-	_		-	—
00.10	r-1	r-1	r-1	r-1	r-1	R/P	R/P	R/P
23:16	-	_	—	-	_	FPLLODIV<2:0>		
45.0	R/P	r-1	r-1	r-1	r-1	R/P	R/P	R/P
15:8	UPLLEN ⁽¹⁾	_	—	-	—	UPLLIDIV<2:0> ⁽¹⁾		
7.0	r-1	R/P-1	R/P	R/P-1	r-1	R/P	R/P	R/P
7:0	—	FPLLMUL<2:0>			_	F	PLLIDIV<2:0	>

REGISTER 27-3: DEVCFG2: DEVICE CONFIGURATION WORD 2

Legend: r = Reserved		P = Programmable bit	t
R = Readable bit	W = Writable bit	U = Unimplemented b	it, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-19 Reserved: Write '1'

bit 18-16 **FPLLODIV<2:0>:** Default PLL Output Divisor bits

111 = PLL output divided by 256 110 = PLL output divided by 64 101 = PLL output divided by 32 100 = PLL output divided by 16 011 = PLL output divided by 8 010 = PLL output divided by 4 001 = PLL output divided by 2 000 = PLL output divided by 1 **UPLLEN:** USB PLL Enable bit⁽¹⁾ bit 15 1 = Disable and bypass USB PLL 0 = Enable USB PLL bit 14-11 Reserved: Write '1' bit 10-8 UPLLIDIV<2:0>: USB PLL Input Divider bits⁽¹⁾ 111 = 12x divider 110 = 10x divider 101 = 6x divider 100 = 5x divider011 = 4x divider 010 = 3x divider 010 = 3x divider 001 = 2x divider 000 = 1x divider bit 7 Reserved: Write '1' bit 6-4 FPLLMUL<2:0>: PLL Multiplier bits 111 = 24x multiplier 110 = 21x multiplier 101 = 20x multiplier 100 = 19x multiplier 011 = 18x multiplier 010 = 17x multiplier 001 = 16x multiplier 000 = 15x multiplier bit 3 Reserved: Write '1'

Note 1: This bit is only available on PIC32MX2XX devices.

REGISTER 27-3: DEVCFG2: DEVICE CONFIGURATION WORD 2 (CONTINUED)

bit 2-0 FPLLIDIV<2:0>: PLL Input Divider bits

- 111 = 12x divider
- 110 = 10x divider
- 101 = 6x divider
- 100 = 5x divider
- 011 = 4x divider
- 010 = 3x divider
- 001 = 2x divider
- 000 = 1x divider
- Note 1: This bit is only available on PIC32MX2XX devices.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
04.04	R/P	R/P	R/P	R/P	r-1	r-1	r-1	r-1	
31:24	FVBUSONIO	FUSBIDIO	IOL1WAY	PMDL1WAY	_	—	-	-	
00.40	r-1	r-1	r-1	r-1	r-1	r-1	r-1	r-1	
23:16	—	—	—	—	_	—	_	—	
45.0	R/P	R/P	R/P	R/P	R/P	R/P	R/P	R/P	
15:8	USERID<15:8>								
7:0	R/P	R/P	R/P	R/P	R/P	R/P	R/P	R/P	
				USERID<	7:0>				

REGISTER 27-4: DEVCFG3: DEVICE CONFIGURATION WORD 3

Legend:	r = Reserved bit	P = Programmable bit		
R = Readable bit	W = Writable bit	U = Unimplemented b	oit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 31 FVBUSONIO: USB VBUSON Selection bit

- 1 = VBUSON pin is controlled by the USB module
- 0 = VBUSON pin is controlled by the port function

bit 30 FUSBIDIO: USB USBID Selection bit

- 1 = USBID pin is controlled by the USB module
- 0 = USBID pin is controlled by the port function
- bit 29 **IOL1WAY:** Peripheral Pin Select Configuration bit
 - 1 = Allow only one reconfiguration
 - 0 = Allow multiple reconfigurations
- bit 28 PMDI1WAY: Peripheral Module Disable Configuration bit
 - 1 = Allow only one reconfiguration
 - 0 = Allow multiple reconfigurations
- bit 27-16 Reserved: Write '1'
- bit 15-0 USERID<15:0>: User ID bits

This is a 16-bit value that is user-defined and is readable via ICSP[™] and JTAG.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	_	_	-	_	_	_	_	—
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	_	_	-	_	_	-	-	—
45.0	U-0	U-0	R/W-0	R/W-0	U-0	U-0	U-0	U-0
15:8	_	_	IOLOCK ⁽¹⁾	PMDLOCK ⁽¹⁾	—	_	_	_
7.0	U-0	U-0	U-0	U-0	R/W-1	U-0	U-1	R/W-1
7:0	_			_	JTAGEN			TDOEN

REGISTER 27-5: CFGCON: CONFIGURATION CONTROL REGISTER

Legend:

9						
R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'				
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

bit 31-14 Unimplemented: Read as '0'

- bit 13 IOLOCK: Peripheral Pin Select Lock bit⁽¹⁾
 1 = Peripheral Pin Select is locked. Writes to PPS registers is not allowed.
 0 = Peripheral Pin Select is not locked. Writes to PPS registers is allowed.

bit 12 **PMDLOCK:** Peripheral Module Disable bit⁽¹⁾

- 1 = Peripheral module is locked. Writes to PMD registers is not allowed.
- 0 = Peripheral module is not locked. Writes to PMD registers is allowed.

bit 11-4 Unimplemented: Read as '0'

bit 3 JTAGEN: JTAG Port Enable bit

- 1 = Enable the JTAG port
 - 0 = Disable the JTAG port

bit 2-1 Unimplemented: Read as '1'

- bit 0 **TDOEN:** TDO Enable for 2-Wire JTAG bit
 - 1 = 2-wire JTAG protocol uses TDO
 - 0 = 2-wire JTAG protocol does not use TDO
- Note 1: To change this bit, the unlock sequence must be performed. Refer to Section 6. "Oscillator" (DS60001112) in the "PIC32 Family Reference Manual" for details.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
24.24	R	R	R	R	R	R	R	R	
31:24	VER<3:0>(1)					DEVID<	27:24>(1)		
00.40	R	R	R	R	R	R	R	R	
23:16	DEVID<23:16> ⁽¹⁾								
45.0	R	R	R	R	R	R	R	R	
15:8	DEVID<15:8> ⁽¹⁾								
7.0	R	R	R	R	R	R	R	R	
7:0				DEVID-	<7:0> ⁽¹⁾				

REGISTER 27-6: DEVID: DEVICE AND REVISION ID REGISTER

Legend:

Logona.					
R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 31-28 VER<3:0>: Revision Identifier bits⁽¹⁾

bit 27-0 DEVID<27:0>: Device ID bits⁽¹⁾

Note 1: See the *"PIC32 Flash Programming Specification"* (DS60001145) for a list of Revision and Device ID values.

27.3 On-Chip Voltage Regulator

All PIC32MX1XX/2XX 28/36/44-pin Family devices' core and digital logic are designed to operate at a nominal 1.8V. To simplify system designs, most devices in the PIC32MX1XX/2XX 28/36/44-pin Family family incorporate an on-chip regulator providing the required core logic voltage from VDD.

A low-ESR capacitor (such as tantalum) must be connected to the VCAP pin (see Figure 27-1). This helps to maintain the stability of the regulator. The recommended value for the filter capacitor is provided in Section 30.1 "DC Characteristics".

Note: It is important that the low-ESR capacitor is placed as close as possible to the VCAP pin.

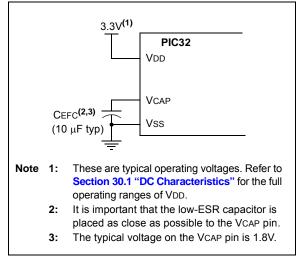
27.3.1 ON-CHIP REGULATOR AND POR

It takes a fixed delay for the on-chip regulator to generate an output. During this time, designated as T_{PU} , code execution is disabled. T_{PU} is applied every time the device resumes operation after any power-down, including Sleep mode.

27.3.2 ON-CHIP REGULATOR AND BOR

PIC32MX1XX/2XX 28/36/44-pin Family devices also have a simple brown-out capability. If the voltage supplied to the regulator is inadequate to maintain a regulated level, the regulator Reset circuitry will generate a Brown-out Reset. This event is captured by the BOR flag bit (RCON<1>). The brown-out voltage levels are specific in Section 30.1 "DC Characteristics".

FIGURE 27-1: CONNECTIONS FOR THE ON-CHIP REGULATOR



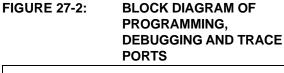
27.4 Programming and Diagnostics

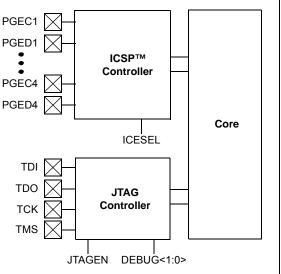
PIC32MX1XX/2XX 28/36/44-pin Family devices provide a complete range of programming and diagnostic features that can increase the flexibility of any application using them. These features allow system designers to include:

- Simplified field programmability using two-wire In-Circuit Serial Programming[™] (ICSP[™]) interfaces
- Debugging using ICSP
- Programming and debugging capabilities using the EJTAG extension of JTAG
- JTAG boundary scan testing for device and board diagnostics

PIC32 devices incorporate two programming and diagnostic modules, and a trace controller, that provide a range of functions to the application developer.

Figure 27-2 illustrates a block diagram of the programming, debugging, and trace ports.





28.0 INSTRUCTION SET

The PIC32MX1XX/2XX family instruction set complies with the MIPS32[®] Release 2 instruction set architecture. The PIC32 device family does not support the following features:

- · Core extend instructions
- Coprocessor 1 instructions
- Coprocessor 2 instructions

Note: Refer to "MIPS32[®] Architecture for Programmers Volume II: The MIPS32[®] Instruction Set" at www.imgtec.com for more information.

NOTES:

29.0 DEVELOPMENT SUPPORT

The PIC[®] microcontrollers (MCU) and dsPIC[®] digital signal controllers (DSC) are supported with a full range of software and hardware development tools:

- · Integrated Development Environment
- MPLAB[®] X IDE Software
- Compilers/Assemblers/Linkers
 - MPLAB XC Compiler
 - MPASM[™] Assembler
 - MPLINK[™] Object Linker/ MPLIB[™] Object Librarian
 - MPLAB Assembler/Linker/Librarian for Various Device Families
- Simulators
 - MPLAB X SIM Software Simulator
- Emulators
 - MPLAB REAL ICE™ In-Circuit Emulator
- In-Circuit Debuggers/Programmers
 - MPLAB ICD 3
 - PICkit™ 3
- Device Programmers
 - MPLAB PM3 Device Programmer
- Low-Cost Demonstration/Development Boards, Evaluation Kits and Starter Kits
- Third-party development tools

29.1 MPLAB X Integrated Development Environment Software

The MPLAB X IDE is a single, unified graphical user interface for Microchip and third-party software, and hardware development tool that runs on Windows[®], Linux and Mac OS[®] X. Based on the NetBeans IDE, MPLAB X IDE is an entirely new IDE with a host of free software components and plug-ins for high-performance application development and debugging. Moving between tools and upgrading from software simulators to hardware debugging and programming tools is simple with the seamless user interface.

With complete project management, visual call graphs, a configurable watch window and a feature-rich editor that includes code completion and context menus, MPLAB X IDE is flexible and friendly enough for new users. With the ability to support multiple tools on multiple projects with simultaneous debugging, MPLAB X IDE is also suitable for the needs of experienced users.

Feature-Rich Editor:

- · Color syntax highlighting
- Smart code completion makes suggestions and provides hints as you type
- Automatic code formatting based on user-defined rules
- · Live parsing

User-Friendly, Customizable Interface:

- Fully customizable interface: toolbars, toolbar buttons, windows, window placement, etc.
- · Call graph window

Project-Based Workspaces:

- Multiple projects
- Multiple tools
- Multiple configurations
- · Simultaneous debugging sessions

File History and Bug Tracking:

- · Local file history feature
- · Built-in support for Bugzilla issue tracker

29.2 MPLAB XC Compilers

The MPLAB XC Compilers are complete ANSI C compilers for all of Microchip's 8, 16, and 32-bit MCU and DSC devices. These compilers provide powerful integration capabilities, superior code optimization and ease of use. MPLAB XC Compilers run on Windows, Linux or MAC OS X.

For easy source level debugging, the compilers provide debug information that is optimized to the MPLAB X IDE.

The free MPLAB XC Compiler editions support all devices and commands, with no time or memory restrictions, and offer sufficient code optimization for most applications.

MPLAB XC Compilers include an assembler, linker and utilities. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. MPLAB XC Compiler uses the assembler to produce its object file. Notable features of the assembler include:

- · Support for the entire device instruction set
- · Support for fixed-point and floating-point data
- Command-line interface
- · Rich directive set
- Flexible macro language
- MPLAB X IDE compatibility

29.3 MPASM Assembler

The MPASM Assembler is a full-featured, universal macro assembler for PIC10/12/16/18 MCUs.

The MPASM Assembler generates relocatable object files for the MPLINK Object Linker, Intel[®] standard HEX files, MAP files to detail memory usage and symbol reference, absolute LST files that contain source lines and generated machine code, and COFF files for debugging.

The MPASM Assembler features include:

- Integration into MPLAB X IDE projects
- User-defined macros to streamline
 assembly code
- Conditional assembly for multipurpose source files
- Directives that allow complete control over the assembly process

29.4 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK Object Linker combines relocatable objects created by the MPASM Assembler. It can link relocatable objects from precompiled libraries, using directives from a linker script.

The MPLIB Object Librarian manages the creation and modification of library files of precompiled code. When a routine from a library is called from a source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications.

The object linker/library features include:

- Efficient linking of single libraries instead of many smaller files
- Enhanced code maintainability by grouping related modules together
- Flexible creation of libraries with easy module listing, replacement, deletion and extraction

29.5 MPLAB Assembler, Linker and Librarian for Various Device Families

MPLAB Assembler produces relocatable machine code from symbolic assembly language for PIC24, PIC32 and dsPIC DSC devices. MPLAB XC Compiler uses the assembler to produce its object file. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. Notable features of the assembler include:

- · Support for the entire device instruction set
- · Support for fixed-point and floating-point data
- · Command-line interface
- · Rich directive set
- · Flexible macro language
- MPLAB X IDE compatibility

29.6 MPLAB X SIM Software Simulator

The MPLAB X SIM Software Simulator allows code development in a PC-hosted environment by simulating the PIC MCUs and dsPIC DSCs on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a comprehensive stimulus controller. Registers can be logged to files for further run-time analysis. The trace buffer and logic analyzer display extend the power of the simulator to record and track program execution, actions on I/O, most peripherals and internal registers.

The MPLAB X SIM Software Simulator fully supports symbolic debugging using the MPLAB XC Compilers, and the MPASM and MPLAB Assemblers. The software simulator offers the flexibility to develop and debug code outside of the hardware laboratory environment, making it an excellent, economical software development tool.

29.7 MPLAB REAL ICE In-Circuit Emulator System

The MPLAB REAL ICE In-Circuit Emulator System is Microchip's next generation high-speed emulator for Microchip Flash DSC and MCU devices. It debugs and programs all 8, 16 and 32-bit MCU, and DSC devices with the easy-to-use, powerful graphical user interface of the MPLAB X IDE.

The emulator is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with either a connector compatible with in-circuit debugger systems (RJ-11) or with the new high-speed, noise tolerant, Low-Voltage Differential Signal (LVDS) interconnection (CAT5).

The emulator is field upgradable through future firmware downloads in MPLAB X IDE. MPLAB REAL ICE offers significant advantages over competitive emulators including full-speed emulation, run-time variable watches, trace analysis, complex breakpoints, logic probes, a ruggedized probe interface and long (up to three meters) interconnection cables.

29.8 MPLAB ICD 3 In-Circuit Debugger System

The MPLAB ICD 3 In-Circuit Debugger System is Microchip's most cost-effective, high-speed hardware debugger/programmer for Microchip Flash DSC and MCU devices. It debugs and programs PIC Flash microcontrollers and dsPIC DSCs with the powerful, yet easy-to-use graphical user interface of the MPLAB IDE.

The MPLAB ICD 3 In-Circuit Debugger probe is connected to the design engineer's PC using a highspeed USB 2.0 interface and is connected to the target with a connector compatible with the MPLAB ICD 2 or MPLAB REAL ICE systems (RJ-11). MPLAB ICD 3 supports all MPLAB ICD 2 headers.

29.9 PICkit 3 In-Circuit Debugger/ Programmer

The MPLAB PICkit 3 allows debugging and programming of PIC and dsPIC Flash microcontrollers at a most affordable price point using the powerful graphical user interface of the MPLAB IDE. The MPLAB PICkit 3 is connected to the design engineer's PC using a fullspeed USB interface and can be connected to the target via a Microchip debug (RJ-11) connector (compatible with MPLAB ICD 3 and MPLAB REAL ICE). The connector uses two device I/O pins and the Reset line to implement in-circuit debugging and In-Circuit Serial Programming[™] (ICSP[™]).

29.10 MPLAB PM3 Device Programmer

The MPLAB PM3 Device Programmer is a universal, CE compliant device programmer with programmable voltage verification at VDDMIN and VDDMAX for maximum reliability. It features a large LCD display (128 x 64) for menus and error messages, and a modular, detachable socket assembly to support various package types. The ICSP cable assembly is included as a standard item. In Stand-Alone mode, the MPLAB PM3 Device Programmer can read, verify and program PIC devices without a PC connection. It can also set code protection in this mode. The MPLAB PM3 connects to the host PC via an RS-232 or USB cable. The MPLAB PM3 has high-speed communications and optimized algorithms for quick programming of large memory devices, and incorporates an MMC card for file storage and data applications.

29.11 Demonstration/Development Boards, Evaluation Kits, and Starter Kits

A wide variety of demonstration, development and evaluation boards for various PIC MCUs and dsPIC DSCs allows quick application development on fully functional systems. Most boards include prototyping areas for adding custom circuitry and provide application firmware and source code for examination and modification.

The boards support a variety of features, including LEDs, temperature sensors, switches, speakers, RS-232 interfaces, LCD displays, potentiometers and additional EEPROM memory.

The demonstration and development boards can be used in teaching environments, for prototyping custom circuits and for learning about various microcontroller applications.

In addition to the PICDEM[™] and dsPICDEM[™] demonstration/development board series of circuits, Microchip has a line of evaluation kits and demonstration software for analog filter design, KEELOQ[®] security ICs, CAN, IrDA[®], PowerSmart battery management, SEEVAL[®] evaluation system, Sigma-Delta ADC, flow rate sensing, plus many more.

Also available are starter kits that contain everything needed to experience the specified device. This usually includes a single application and debug capability, all on one board.

Check the Microchip web page (www.microchip.com) for the complete list of demonstration, development and evaluation kits.

29.12 Third-Party Development Tools

Microchip also offers a great collection of tools from third-party vendors. These tools are carefully selected to offer good value and unique functionality.

- Device Programmers and Gang Programmers from companies, such as SoftLog and CCS
- Software Tools from companies, such as Gimpel and Trace Systems
- Protocol Analyzers from companies, such as Saleae and Total Phase
- Demonstration Boards from companies, such as MikroElektronika, Digilent[®] and Olimex
- Embedded Ethernet Solutions from companies, such as EZ Web Lynx, WIZnet and IPLogika[®]

30.0 ELECTRICAL CHARACTERISTICS

This section provides an overview of the PIC32MX1XX/2XX 28/36/44-pin Family electrical characteristics for devices that operate at 40 MHz. Refer to **Section 31.0** "50 MHz Electrical Characteristics" for additional specifications for operations at higher frequency. Additional information will be provided in future revisions of this document as it becomes available.

Absolute maximum ratings for the PIC32MX1XX/2XX 28/36/44-pin Family devices are listed below. Exposure to these maximum rating conditions for extended periods may affect device reliability. Functional operation of the device at these or any other conditions, above the parameters indicated in the operation listings of this specification, is not implied.

Absolute Maximum Ratings

(See Note 1)

Ambient temperature under bies	40°C to ±105°C
Ambient temperature under bias	
Storage temperature	
Voltage on VDD with respect to Vss	0.3V to +4.0V
Voltage on any pin that is not 5V tolerant, with respect to Vss (Note 3)	0.3V to (VDD + 0.3V)
Voltage on any 5V tolerant pin with respect to Vss when $VDD \ge 2.3V$ (Note 3)	0.3V to +5.5V
Voltage on any 5V tolerant pin with respect to Vss when VDD < 2.3V (Note 3)	0.3V to +3.6V
Voltage on D+ or D- pin with respect to VUSB3V3	0.3V to (VUSB3V3 + 0.3V)
Voltage on VBUS with respect to VSS	-0.3V to +5.5V
Maximum current out of Vss pin(s)	
Maximum current into VDD pin(s) (Note 2)	
Maximum output current sunk by any I/O pin	15 mA
Maximum output current sourced by any I/O pin	15 mA
Maximum current sunk by all ports	200 mA
Maximum current sourced by all ports (Note 2)	200 mA

Note 1: Stresses above those listed under "**Absolute Maximum Ratings**" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions, above those indicated in the operation listings of this specification, is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

2: Maximum allowable current is a function of device maximum power dissipation (see Table 30-2).

3: See the "Pin Diagrams" section for the 5V tolerant pins.

30.1 DC Characteristics

TABLE 30-1: OPERATING MIPS VS. VOLTAGE

Characteristic	VDD Range	Temp. Range	Max. Frequency
Characteristic	(in Volts) ⁽¹⁾	(in °C)	PIC32MX1XX/2XX 28/36/44-pin Family
DC5	2.3-3.6V	-40°C to +85°C	40 MHz
DC5b	2.3-3.6V	-40°C to +105°C	40 MHz

Note 1: Overall functional device operation at VBORMIN < VDD < VDDMIN is tested, but not characterized. All device Analog modules, such as ADC, etc., will function, but with degraded performance below VDDMIN. Refer to parameter BO10 in Table 30-11 for BOR values.

TABLE 30-2: THERMAL OPERATING CONDITIONS

Rating	Symbol	Min.	Typical	Max.	Unit
Industrial Temperature Devices					
Operating Junction Temperature Range	TJ	-40	—	+125	°C
Operating Ambient Temperature Range	TA	-40	—	+85	°C
V-temp Temperature Devices					
Operating Junction Temperature Range	TJ	-40	_	+140	°C
Operating Ambient Temperature Range	TA	-40	—	+105	°C
Power Dissipation: Internal Chip Power Dissipation: PINT = VDD x (IDD – S IOH)	PD		PINT + PI/C)	w
I/O Pin Power Dissipation: I/O = S (({VDD – VOH} x IOH) + S (VOL x IOL))					
Maximum Allowed Power Dissipation	PDMAX	(TJ – TA)/θJ	JA	W

TABLE 30-3: THERMAL PACKAGING CHARACTERISTICS

Characteristics	Symbol	Typical	Max.	Unit	Notes
Package Thermal Resistance, 28-pin SSOP	θJA	71	_	°C/W	1
Package Thermal Resistance, 28-pin SOIC	θJA	50	_	°C/W	1
Package Thermal Resistance, 28-pin SPDIP	θJA	42	_	°C/W	1
Package Thermal Resistance, 28-pin QFN	θJA	35	_	°C/W	1
Package Thermal Resistance, 36-pin VTLA	θJA	31	_	°C/W	1
Package Thermal Resistance, 44-pin QFN	θJA	32	_	°C/W	1
Package Thermal Resistance, 44-pin TQFP	θJA	45	_	°C/W	1
Package Thermal Resistance, 44-pin VTLA	θJA	30	_	°C/W	1

Note 1: Junction to ambient thermal resistance, Theta-JA (θ JA) numbers are achieved by package simulations.

TABLE 30-4: DC TEMPERATURE AND VOLTAGE SPECIFICATIONS

DC CHA	$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industria} \\ & -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temperature} \\ \end{array}$						
Param. No.	Symbol	Characteristics	Min.	Тур.	Max.	Units	Conditions
Operati	ng Voltag	e					
DC10	Vdd	Supply Voltage (Note 2)	2.3		3.6	V	—
DC12	Vdr	RAM Data Retention Voltage (Note 1)	1.75	_	—	V	—
DC16	VPOR	VDD Start Voltage to Ensure Internal Power-on Reset Signal	1.75	_	2.1	V	_
DC17	SVDD	VDD Rise Rate to Ensure Internal Power-on Reset Signal	0.00005		0.115	V/µs	_

Note 1: This is the limit to which VDD can be lowered without losing RAM data.

2: Overall functional device operation at VBORMIN < VDD < VDDMIN is tested, but not characterized. All device Analog modules, such as ADC, etc., will function, but with degraded performance below VDDMIN. Refer to parameter BO10 in Table 30-11 for BOR values.

DC CHARA	CTERISTICS	3	$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ & -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$				
Parameter No.	Typical ⁽³⁾	Max.	Units Conditions				
Operating (Current (IDD)	(Notes 1, 2, 5)				
DC20	2	3	mA	4 M⊦	lz (Note 4)		
DC21	7	10.5	mA	1	0 MHz		
DC22	10	15	mA	20 Mł	Hz (Note 4)		
DC23	15	23	mA	30 MHz (Note 4)			
DC24	20	30	mA	40 MHz			
DC25	100	150	μA	+25°C, 3.3V LPRC (31 kHz) (Note 4)			

TABLE 30-5: DC CHARACTERISTICS: OPERATING CURRENT (IDD)

Note 1: A device's IDD supply current is mainly a function of the operating voltage and frequency. Other factors, such as PBCLK (Peripheral Bus Clock) frequency, number of peripheral modules enabled, internal code execution pattern, execution from Program Flash memory vs. SRAM, I/O pin loading and switching rate, oscillator type, as well as temperature, can have an impact on the current consumption.

- 2: The test conditions for IDD measurements are as follows:
 - Oscillator mode is EC (for 8 MHz and below) and EC+PLL (for above 8 MHz) with OSC1 driven by external square wave from rail-to-rail, (OSC1 input clock input over/undershoot < 100 mV required)
 - OSC2/CLKO is configured as an I/O input pin
 - USB PLL oscillator is disabled if the USB module is implemented, PBCLK divisor = 1:8
 - CPU, Program Flash, and SRAM data memory are operational, SRAM data memory Wait states = 1
 - No peripheral modules are operating, (ON bit = 0), but the associated PMD bit is cleared
 - WDT, Clock Switching, Fail-Safe Clock Monitor, and Secondary Oscillator are disabled
 - · All I/O pins are configured as inputs and pulled to Vss
 - MCLR = VDD
 - CPU executing while(1) statement from Flash
 - RTCC and JTAG are disabled
- **3:** Data in "Typical" column is at 3.3V, 25°C at specified operating frequency unless otherwise stated. Parameters are for design guidance only and are not tested.
- 4: This parameter is characterized, but not tested in manufacturing.
- **5:** IPD electrical characteristics for devices with 256 KB Flash are only provided as Preliminary information.

DC CHARACT	ERISTICS		$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ & -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$					
Parameter No.	Typical ⁽²⁾	Max.	Units Conditions					
Idle Current (II	DLE): Core Of	f, Clock on I	Base Current	(Notes 1, 4)				
DC30a	1	1.5	mA		4 MHz (Note 3)			
DC31a	2	3	mA		10 MHz			
DC32a	4	6	mA		20 MHz (Note 3)			
DC33a	5.5	8	mA		30 MHz (Note 3)			
DC34a	7.5	11	mA		40 MHz			
DC37a	100	—	μA	-40°C		LPRC (31 kHz)		
DC37b	250	—	μA			(Note 3)		
DC37c	380	_	μΑ	+85°C				

TABLE 30-6: DC CHARACTERISTICS: IDLE CURRENT (IIDLE)

Note 1: The test conditions for IIDLE current measurements are as follows:

Oscillator mode is EC (for 8 MHz and below) and EC+PLL (for above 8 MHz) with OSC1 driven by external square wave from rail-to-rail, (OSC1 input clock input over/undershoot < 100 mV required)

- OSC2/CLKO is configured as an I/O input pin

• USB PLL oscillator is disabled if the USB module is implemented, PBCLK divisor = 1:8

• CPU is in Idle mode (CPU core Halted), and SRAM data memory Wait states = 1

• No peripheral modules are operating, (ON bit = 0), but the associated PMD bit is cleared

• WDT, Clock Switching, Fail-Safe Clock Monitor, and Secondary Oscillator are disabled

· All I/O pins are configured as inputs and pulled to Vss

- MCLR = VDD
- RTCC and JTAG are disabled
- 2: Data in the "Typical" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.
- 3: This parameter is characterized, but not tested in manufacturing.
- 4: IIDLE electrical characteristics for devices with 256 KB Flash are only provided as Preliminary information.

DC CHARACTERISTICS			$\label{eq:standard} \begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V (unless otherwise stated)} \\ \mbox{Operating temperature} & -40^\circ C \leq TA \leq +85^\circ C \mbox{ for Industrial} \\ -40^\circ C \leq TA \leq +105^\circ C \mbox{ for V-temp} \end{array}$						
Param. No.	Typical ⁽²⁾	Max.	Units		Conditions				
Power-D	Down Curre	nt (IPD) (No	otes 1, 5)						
DC40k	44	70	μA	-40°C					
DC40I	44	70	μA	+25°C	Base Dever Deve Current				
DC40n	168	259	μA	+85°C	Base Power-Down Current				
DC40m	335	536	μA	+105°C					
Module	Differential	Current	•		•				
DC41e	5	20	μA	3.6V	Watchdog Timer Current: ΔIWDT (Note 3)				
DC42e	23	50	μA	3.6V	RTCC + Timer1 w/32 kHz Crystal: ΔIRTCC (Note 3)				
DC43d	1000	1100	μA	3.6V ADC: ∆IADC (Notes 3,4)					

TABLE 30-7: DC CHARACTERISTICS: POWER-DOWN CURRENT (IPD)

Note 1: The test conditions for IPD current measurements are as follows:

 Oscillator mode is EC (for 8 MHz and below) and EC+PLL (for above 8 MHz) with OSC1 driven by external square wave from rail-to-rail, (OSC1 input clock input over/undershoot < 100 mV required)

- OSC2/CLKO is configured as an I/O input pin
- USB PLL oscillator is disabled if the USB module is implemented, PBCLK divisor = 1:8
- CPU is in Sleep mode, and SRAM data memory Wait states = 1
- No peripheral modules are operating, (ON bit = 0), but the associated PMD bit is set
- WDT, Clock Switching, Fail-Safe Clock Monitor, and Secondary Oscillator are disabled
- · All I/O pins are configured as inputs and pulled to Vss
- MCLR = VDD
- RTCC and JTAG are disabled
- 2: Data in the "Typical" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.
- 3: The ∆ current is the additional current consumed when the module is enabled. This current should be added to the base IPD current.
- 4: Test conditions for ADC module differential current are as follows: Internal ADC RC oscillator enabled.
- 5: IPD electrical characteristics for devices with 256 KB Flash are only provided as Preliminary information.

DC CHA	ARACTER	RISTICS	Standard Opera stated) Operating tempe	•			7 (unless otherwise C for Industrial	
			$-40^{\circ}C \le TA \le +105^{\circ}C$ for V-temp					
Param. No.	Symbol	Characteristics	Min. Typical ⁽¹⁾ Max.				Conditions	
	VIL	Input Low Voltage						
DI10		I/O Pins with PMP	Vss	—	0.15 Vdd	V		
		I/O Pins	Vss	—	0.2 Vdd	V		
DI18		SDAx, SCLx	Vss	_	0.3 VDD	V	SMBus disabled (Note 4)	
DI19		SDAx, SCLx	Vss	_	0.8	V	SMBus enabled (Note 4)	
	VIH	Input High Voltage						
DI20		I/O Pins not 5V-tolerant ⁽⁵⁾	0.65 VDD	_	Vdd	V	(Note 4,6)	
		I/O Pins 5V-tolerant with PMP ⁽⁵⁾	0.25 VDD + 0.8V	_	5.5	V	(Note 4,6)	
		I/O Pins 5V-tolerant ⁽⁵⁾	0.65 VDD	—	5.5	V		
DI28		SDAx, SCLx	0.65 VDD	_	5.5	V	SMBus disabled (Note 4,6)	
DI29		SDAx, SCLx	2.1	_	5.5	V	SMBus enabled, 2.3V ≤ VPIN ≤ 5.5 (Note 4,6)	
DI30	ICNPU	Change Notification Pull-up Current	_	—	-50	μA	VDD = 3.3V, VPIN = VSS (Note 3,6)	
DI31	ICNPD	Change Notification Pull-down Current ⁽⁴⁾	—	—	-50	μA	VDD = 3.3V, VPIN = VDD	
	lı∟	Input Leakage Current (Note 3)						
DI50		I/O Ports	_	_	<u>+</u> 1	μA	$Vss \le VPIN \le VDD$, Pin at high-impedance	
DI51		Analog Input Pins	-	_	<u>+</u> 1	μA	$Vss \le VPIN \le VDD$, Pin at high-impedance	
DI55		MCLR(2)	_	_	<u>+</u> 1	μA	$VSS \le VPIN \le VDD$	
DI56		OSC1	_	_	_ <u>+</u> 1	μΑ	$Vss \le VPIN \le VDD,$ XT and HS modes	

TABLE 30-8: DC CHARACTERISTICS: I/O PIN INPUT SPECIFICATIONS

Note 1: Data in "Typical" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

- 3: Negative current is defined as current sourced by the pin.
- 4: This parameter is characterized, but not tested in manufacturing.
- 5: See the "Pin Diagrams" section for the 5V-tolerant pins.
- 6: The VIH specifications are only in relation to externally applied inputs, and not with respect to the userselectable internal pull-ups. External open drain input signals utilizing the internal pull-ups of the PIC32 device are guaranteed to be recognized only as a logic "high" internally to the PIC32 device, provided that the external load does not exceed the minimum value of ICNPU. For External "input" logic inputs that require a pull-up source, to guarantee the minimum VIH of those components, it is recommended to use an external pull-up resistor rather than the internal pull-ups of the PIC32 device.

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TABLE 30-9: DC CHARACTERISTICS: I/O PIN INPUT INJECTION CURRENT SPECIFICATIONS

DC CHA	RACTER	ISTICS	$\begin{array}{l} \mbox{Standard Operating Conditions: } 2.3V \mbox{ to } 3.6V \mbox{ (unless otherwise of the conditions)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$				
Param. No.	Symbol	Characteristics	Min.	Тур. ⁽¹⁾	Max.	Units	Conditions
DI60a	licl	Input Low Injection Current	0		₋₅ (2,5)	mA	This parameter applies to all pins, with the exception of the power pins.
DI60b	ІІСН	Input High Injection Current	0	—	+5(3,4,5)	mA	This parameter applies to all pins, with the exception of all 5V tolerant pins, and the SOSCI, SOSCO, OSC1, D+, and D- pins.
DI60c	∑IICT	Total Input Injection Current (sum of all I/O and Control pins)	-20 ⁽⁶⁾		+20 (6)	mA	Absolute instantaneous sum of all ± input injection currents from all I/O pins (IICL + IICH) $\leq \sum$ IICT)

Note 1: Data in "Typical" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: VIL source < (VSS - 0.3). Characterized but not tested.

3: VIH source > (VDD + 0.3) for non-5V tolerant pins only.

4: Digital 5V tolerant pins do not have an internal high side diode to VDD, and therefore, cannot tolerate any "positive" input injection current.

5: Injection currents > | 0 | can affect the ADC results by approximately 4 to 6 counts (i.e., VIH Source > (VDD + 0.3) or VIL source < (VSS - 0.3)).

6: Any number and/or combination of I/O pins not excluded under IICL or IICH conditions are permitted provided the "absolute instantaneous" sum of the input injection currents from all pins do not exceed the specified limit. If Note 2, IICL = (((Vss - 0.3) - VIL source) / Rs). If Note 3, IICH = ((IICH source - (VDD + 0.3)) / RS). RS = Resistance between input source voltage and device pin. If (Vss - 0.3) ≤ VSOURCE ≤ (VDD + 0.3), injection current = 0.

DC CHARACTERISTICS		$\begin{array}{llllllllllllllllllllllllllllllllllll$					
Param.	Symbol	Characteristic	Min.	Тур.	Max.	Units	Conditions
DO10	Vol	Output Low Voltage	_	_	0.4	V	$\text{Iol} \leq 10 \text{ mA, Vdd} = 3.3 \text{V}$
		Output High Voltage	1.5 ⁽¹⁾	_	_		IOH \ge -14 mA, VDD = 3.3V
DO20	Mou	I/O Pins	2.0 ⁽¹⁾	_	_	V	IOH \ge -12 mA, VDD = 3.3V
DO20 Voh	VOH		2.4	_	_	V	IOH \ge -10 mA, VDD = 3.3V
			3.0 ⁽¹⁾	—	—		IOH \geq -7 mA, VDD = 3.3V

TABLE 30-10: DC CHARACTERISTICS: I/O PIN OUTPUT SPECIFICATIONS

Note 1: Parameters are characterized, but not tested.

TABLE 30-11: ELECTRICAL CHARACTERISTICS: BOR

DC CHA	DC CHARACTERISTICS			$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$					
Param. No.	Symbol	Characteristics	Min. ⁽¹⁾ Typical Max. Units Conditions				Conditions		
BO10	VBOR	BOR Event on VDD transition high-to-low ⁽²⁾	2.0	_	2.3	V	—		

Note 1: Parameters are for design guidance only and are not tested in manufacturing.

2: Overall functional device operation at VBORMIN < VDD < VDDMIN is tested, but not characterized. All device Analog modules, such as ADC, etc., will function, but with degraded performance below VDDMIN.

DC CHARACTERISTICS			$\begin{array}{ll} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ & -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$							
Param. No.	Symbol	Characteristics	Min.	Typical ⁽¹⁾	Max.	Units	Conditions			
		Program Flash Memory ⁽³⁾								
D130	Eр	Cell Endurance	20,000	—	—	E/W	—			
D131	Vpr	VDD for Read	2.3	—	3.6	V	—			
D132	VPEW	VDD for Erase or Write	2.3	—	3.6	V	—			
D134	TRETD	Characteristic Retention	20	—	—	Year	Provided no other specifications are violated			
D135	IDDP	Supply Current during Programming	_	10	_	mA	_			
	Tww	Word Write Cycle Time	—	411	—	es	See Note 4			
D136	Trw	Row Write Cycle Time	—	6675	—	Cycles	See Note 2,4			
D137	Тре	Page Erase Cycle Time	—	20011	—	FRC 0	See Note 4			
	TCE	Chip Erase Cycle Time		80180		Ц Ц	See Note 4			

TABLE 30-12: DC CHARACTERISTICS: PROGRAM MEMORY

Note 1: Data in "Typical" column is at 3.3V, 25°C unless otherwise stated.

2: The minimum SYSCLK for row programming is 4 MHz. Care should be taken to minimize bus activities during row programming, such as suspending any memory-to-memory DMA operations. If heavy bus loads are expected, selecting Bus Matrix Arbitration mode 2 (rotating priority) may be necessary. The default Arbitration mode is mode 1 (CPU has lowest priority).

3: Refer to the *"PIC32 Flash Programming Specification"* (DS60001145) for operating conditions during programming and erase cycles.

4: This parameter depends on FRC accuracy (See Table 30-19) and FRC tuning values (See Register 8-2).

DC CHA	DC CHARACTERISTICS			$\begin{array}{l} \mbox{Standard Operating Conditions (see Note 4): 2.3V to 3.6V \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ & -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$						
Param. No.	Symbol	Characteristics	Min.	Typical	Max.	Units	Comments			
D300	VIOFF	Input Offset Voltage	-	±7.5	±25	mV	AVDD = VDD, AVSS = VSS			
D301	VICM	Input Common Mode Voltage	0		Vdd	V	AVDD = VDD, AVss = Vss (Note 2)			
D302	CMRR	Common Mode Rejection Ratio	55	—	_	dB	Max VICM = (VDD - 1)V (Note 2)			
D303A	Tresp	Large Signal Response Time	—	150	400	ns	AVDD = VDD, AVSS = VSS (Note 1,2)			
D303B	TSRESP	Small Signal Response Time	-	1	_	μS	This is defined as an input step of 50 mV with 15 mV of overdrive (Note 2)			
D304	ON2ov	Comparator Enabled to Output Valid	—	—	10	μs	Comparator module is configured before setting the comparator ON bit (Note 2)			
D305	IVREF	Internal Voltage Reference	1.14	1.2	1.26	V	—			
D312	TSET	Internal Comparator Voltage DRC Reference Setting time	_	—	10	μs	(Note 3)			

TABLE 30-13: COMPARATOR SPECIFICATIONS

Note 1: Response time measured with one comparator input at (VDD – 1.5)/2, while the other input transitions from Vss to VDD.

2: These parameters are characterized but not tested.

3: Settling time measured while CVRR = 1 and CVR<3:0> transitions from '0000' to '1111'. This parameter is characterized, but not tested in manufacturing.

4: The Comparator module is functional at VBORMIN < VDD < VDDMIN, but with degraded performance. Unless otherwise stated, module functionality is tested, but not characterized.

DC CHA	DC CHARACTERISTICS			$\begin{array}{llllllllllllllllllllllllllllllllllll$						
Param. No.	Symbol	Characteristics	Min.	Тур.	Max.	Units	Comments			
D312	TSET	Internal 4-bit DAC Comparator Reference Settling time	_	_	10	μs	See Note 1			
D313		CVREF Input Voltage Reference Range	AVss	_	AVDD	V	CVRSRC with CVRSS = 0			
			VREF-	_	VREF+	V	CVRSRC with CVRSS = 1			
D314	DVREF	CVREF Programmable Output Range	0		0.625 x DACREFH	V	0 to 0.625 DACREFH with DACREFH/24 step size			
			0.25 x DACREFH	—	0.719 x DACREFH	V	0.25 x DACREFH to 0.719 DACREFH with DACREFH/32 step size			
D315	DACRES	Resolution	—	_	DACREFH/24	_	CVRCON <cvrr> = 1</cvrr>			
			—		DACREFH/32	_	CVRCON <cvrr> = 0</cvrr>			
D316	DACACC	ACC Absolute Accuracy ⁽²⁾	—	_	1/4	LSB	DACREFH/24, CVRCON <cvrr> = 1</cvrr>			
			—	_	1/2	LSB	DACREFH/32, CVRCON <cvrr> = 0</cvrr>			

TABLE 30-14: COMPARATOR VOLTAGE REFERENCE SPECIFICATIONS

Note 1: Settling time was measured while CVRR = 1 and CVR<3:0> transitions from '0000' to '1111'. This parameter is characterized, but is not tested in manufacturing.

2: These parameters are characterized but not tested.

TABLE 30-15: INTERNAL VOLTAGE REGULATOR SPECIFICATIONS

DC CHARACTERISTICS			$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$					
Param. No.	Symbol Characteristics		Min.	Typical	Max.	Units	Comments	
D321	Cefc	External Filter Capacitor Value	8	10	_	μF	Capacitor must be low series resistance (1 ohm). Typical voltage on the VCAP pin is 1.8V.	

30.2 AC Characteristics and Timing Parameters

The information contained in this section defines PIC32MX1XX/2XX 28/36/44-pin Family AC characteristics and timing parameters.

FIGURE 30-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS

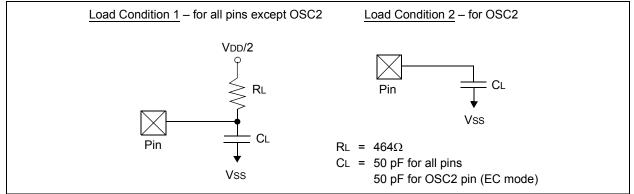
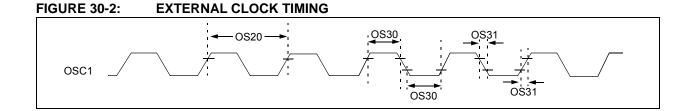


TABLE 30-16: CAPACITIVE LOADING REQUIREMENTS ON OUTPUT PINS

AC CHARACTERISTICS			$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$					
Param. No.	Symbol	Characteristics	Min.	Conditions				
DO50	Cosco	OSC2 Pin	—	—	15	pF	In XT ans HS modes, when exter- nal crystal is used to drive OSC1	
DO56	Сю	All I/O pins and OSC2	_	—	50	pF	EC mode	
DO58	Св	SCLx, SDAx	400 pF In I ² C mode					

Note 1: Data in "Typical" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.



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АС СНА	RACTERI	ISTICS	$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ & -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$							
Param. No.	Symbol	Characteristics	Min.	Typical ⁽¹⁾	Max.	Units	Conditions			
OS10	(External clocks allowed only in EC and ECPLL modes)		DC 4		40 40	MHz MHz	EC (Note 4) ECPLL (Note 3)			
OS11		Oscillator Crystal Frequency	3	—	10	MHz	XT (Note 4)			
OS12			4	_	10	MHz	XTPLL (Notes 3,4)			
OS13			10	_	25	MHz	HS (Note 5)			
OS14			10	—	25	MHz	HSPLL (Notes 3,4)			
OS15			32	32.768	100	kHz	Sosc (Note 4)			
OS20	Tosc	Tosc = 1/Fosc = Tcy (Note 2)	—	—	_	_	See parameter OS10 for Fosc value			
OS30	TosL, TosH	External Clock In (OSC1) High or Low Time	0.45 x Tosc	—	_	ns	EC (Note 4)			
OS31	TosR, TosF	External Clock In (OSC1) Rise or Fall Time	—	—	0.05 x Tosc	ns	EC (Note 4)			
OS40	Тоѕт	Oscillator Start-up Timer Period (Only applies to HS, HSPLL, XT, XTPLL and Sosc Clock Oscillator modes)	_	1024	_	Tosc	(Note 4)			
OS41	TFSCM	Primary Clock Fail Safe Time-out Period	—	2	—	ms	(Note 4)			
OS42	Gм	External Oscillator Transconductance (Primary Oscillator only)	_	12	_	mA/V	VDD = 3.3V, TA = +25°C (Note 4)			

TABLE 30-17: EXTERNAL CLOCK TIMING REQUIREMENTS

Note 1: Data in "Typical" column is at 3.3V, 25°C unless otherwise stated. Parameters are characterized but are not tested.

- 2: Instruction cycle period (TCY) equals the input oscillator time base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKI pin.
- 3: PLL input requirements: 4 MHz \leq FPLLIN \leq 5 MHz (use PLL prescaler to reduce Fosc). This parameter is characterized, but tested at 10 MHz only at manufacturing.
- 4: This parameter is characterized, but not tested in manufacturing.

TABLE 30-18: PLL CLOCK TIMING SPECIFICATIONS

AC CHARACTERISTICS			(unless of	$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^\circ C \leq TA \leq +85^\circ C \mbox{ for Industrial} \\ -40^\circ C \leq TA \leq +105^\circ C \mbox{ for V-temp} \end{array}$					
Param. No. Symbol Characteristi			cs ⁽¹⁾	Min.	Typical	Max.	Units	Conditions	
OS50	Fplli	PLL Voltage Controlled Oscillator (VCO) Input Frequency Range		3.92	_	5	MHz	ECPLL, HSPLL, XTPLL, FRCPLL modes	
OS51	Fsys	On-Chip VCO System Frequency		60	_	120	MHz	_	
OS52	TLOCK	PLL Start-up Time (L	ock Time)	_	_	2	ms	—	
OS53	DCLK	CLKO Stability ⁽²⁾ Period Jitter or Cumulative)		-0.25	_	+0.25	%	Measured over 100 ms period	

Note 1: These parameters are characterized, but not tested in manufacturing.

2: This jitter specification is based on clock-cycle by clock-cycle measurements. To get the effective jitter for individual time-bases on communication clocks, use the following formula:

EffectiveJitter
$$\frac{D_{CLK}}{\sqrt{\frac{SYSCLK}{CommunicationClock}}}$$

For example, if SYSCLK = 40 MHz and SPI bit rate = 20 MHz, the effective jitter is as follows:

$$EffectiveJitter \quad \frac{D_{CLK}}{\sqrt{\frac{40}{20}}} \quad \frac{D_{CLK}}{1.41}$$

TABLE 30-19: INTERNAL FRC ACCURACY

AC CHARACTERISTICS		(unless	Standard Operating Conditions: 2.3V to 3.6V(unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial $-40^{\circ}C \le TA \le +105^{\circ}C$ for V-temp								
Param. No.	Characteristics	Min.	Typical	Max.	Units	Conditions					
Internal	Internal FRC Accuracy @ 8.00 MHz ⁽¹⁾										
F20b	FRC	-0.9	—	+0.9	%	_					

Note 1: Frequency calibrated at 25°C and 3.3V. The TUN bits can be used to compensate for temperature drift.

TABLE 30-20: INTERNAL LPRC ACCURACY

AC CHARACTERISTICS		(unless	$\begin{array}{ll} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^\circ C \leq TA \leq +85^\circ C \mbox{ for Industrial} \\ & -40^\circ C \leq TA \leq +105^\circ C \mbox{ for V-temp} \end{array}$								
Param. No.	Characteristics	Min.	Typical	Max.	Units	Conditions					
LPRC @	LPRC @ 31.25 kHz ⁽¹⁾										
F21	LPRC	-15 — +15 % —									

Note 1: Change of LPRC frequency as VDD changes.

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FIGURE 30-3: I/O TIMING CHARACTERISTICS

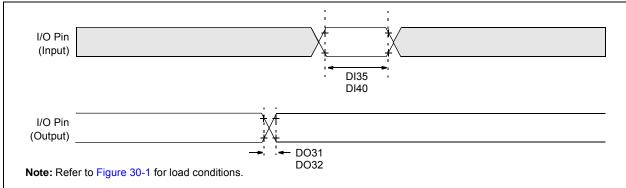


TABLE 30-21: I/O TIMING REQUIREMENTS

AC CHARACTERISTICS			(unless other	$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ & -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$						
Param. No. Symbol Characteristic			stics ⁽²⁾	Min.	Typical ⁽¹⁾	Max.	Units	Conditions		
DO31	TioR	Port Output Rise Time		_	5	15	ns	Vdd < 2.5V		
				_	5	10	ns	VDD > 2.5V		
DO32	TIOF	Port Output Fall Tim	e	—	5	15	ns	VDD < 2.5V		
				_	5	10	ns	VDD > 2.5V		
DI35	TINP	INTx Pin High or Low Time		10	_	_	ns	—		
DI40	Trbp	CNx High or Low Tir	me (input)	2	_	_	TSYSCLK	_		

Note 1: Data in "Typical" column is at 3.3V, 25°C unless otherwise stated.

2: This parameter is characterized, but not tested in manufacturing.

FIGURE 30-4: POWER-ON RESET TIMING CHARACTERISTICS

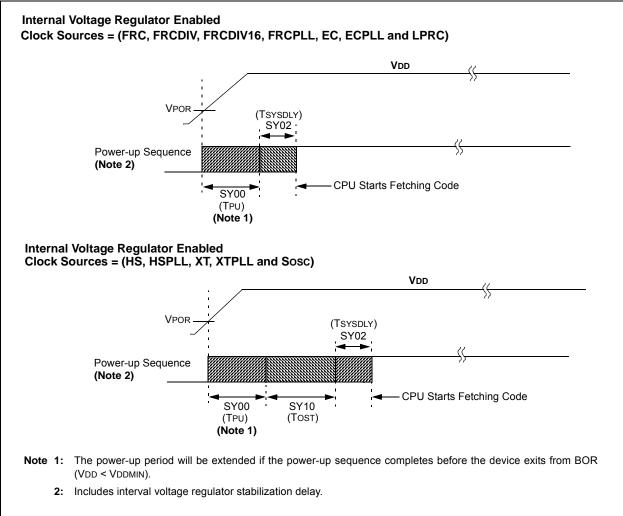


FIGURE 30-5: EXTERNAL RESET TIMING CHARACTERISTICS

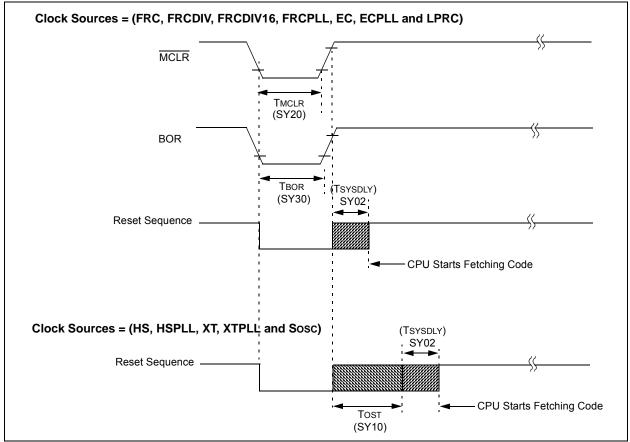


TABLE 30-22:	RESETS TIMING
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AC CHARACTERISTICS			$\begin{tabular}{lllllllllllllllllllllllllllllllllll$						
Param. No.	Symbol Characteristics ¹			Typical ⁽²⁾	Max.	Units	Conditions		
SY00	Τρυ	Power-up Period Internal Voltage Regulator Enabled		400	600	μS	_		
SY02	TSYSDLY	System Delay Period: Time Required to Reload Device Configuration Fuses plus SYSCLK Delay before First instruction is Fetched.	_	1 μs + 8 SYSCLK cycles	_	_	_		
SY20	TMCLR	MCLR Pulse Width (low)	2	_		μS	—		
SY30	TBOR	BOR Pulse Width (low)	—	1	_	μS	_		

Note 1: These parameters are characterized, but not tested in manufacturing.

2: Data in "Typ" column is at 3.3V, 25°C unless otherwise stated. Characterized by design but not tested.

FIGURE 30-6: TIMER1, 2, 3, 4, 5 EXTERNAL CLOCK TIMING CHARACTERISTICS

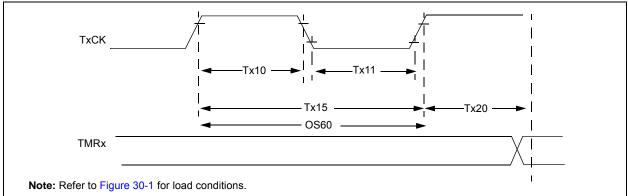


TABLE 30-23: TIMER1 EXTERNAL CLOCK TIMING REQUIREMENTS

					Standard Operating Conditions: 2.3V to 3.6V(unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial $-40^{\circ}C \le TA \le +105^{\circ}C$ for V-temp					
Param. No.	Symbol	Charac	teristics ⁽²⁾		Min.	Typical	Max.	Units	Conditions	
TA10	T⊤xH	TxCK High Time	Synchronc with presca		[(12.5 ns or 1 ТРВ)/N] + 25 ns	—	-	ns	Must also meet parameter TA15	
			Asynchron with presca		10	—		ns	—	
TA11	T⊤xL	TxCK Low Time	Synchrono with presca		[(12.5 ns or 1 Трв)/N] + 25 ns	—		ns	Must also meet parameter TA15	
			Asynchron with presca		10	—	_	ns	—	
TA15	T⊤xP	5		ous, aler	[(Greater of 25 ns or 2 TPB)/N] + 30 ns	—	_	ns	VDD > 2.7V	
					[(Greater of 25 ns or 2 TPB)/N] + 50 ns	—	_	ns	VDD < 2.7V	
			Asynchronous, with prescaler		20	—	_	ns	VDD > 2.7V (Note 3)	
					50	—		ns	VDD < 2.7V (Note 3)	
OS60	FT1	SOSC1/T1CK Oscillator Input Frequency Range (oscillator enabled by set the TCS (T1CON<1>) bi		tting	32	—	100	kHz	—	
TA20	TCKEXTMRL	Delay from E Clock Edge t Increment		K	_	—	1	Трв	—	

Note 1: Timer1 is a Type A timer.

2: This parameter is characterized, but not tested in manufacturing.

3: N = Prescale Value (1, 8, 64, 256).

TABLE 30-24: TIMER2, 3, 4, 5 EXTERNAL CLOCK TIMING REQUIREMENTS

AC CHARACTERISTICS (unless				(unless	d Operating Condition otherwise stated) Ig temperature -40°C -40°C	C ≤ TA ≤	≤+85°C		
Param. No.	Symbol	Chai	racteristics	s ⁽¹⁾	Min.	Max.	Units	Condit	ions
TB10	T⊤xH	TxCK High Time	Synchrono prescaler	ous, with	[(12.5 ns or 1 TPB)/N] + 25 ns	—	ns	Must also meet parameter TB15	N = prescale value (1, 2, 4, 8,
TB11	TtxL	TxCK Low Time	Synchronous, with prescaler		[(12.5 ns or 1 ТРВ)/N] + 25 ns	_	ns	Must also meet parameter TB15	16, 32, 64, 256)
TB15	ΤτχΡ	TxCK Input	Synchrono prescaler	ous, with	[(Greater of [(25 ns or 2 TPB)/N] + 30 ns	_	ns	VDD > 2.7V	
		Period [(Greater of [(25 ns or - ns ND < 2.7V 2 TPB)/N] + 50 ns - ns VDD < 2.7V							
TB20	TCKEXTMRL	Delay from External TxCK Clock Edge to Timer Increment			_	1	Трв		

Note 1: These parameters are characterized, but not tested in manufacturing.

FIGURE 30-7: INPUT CAPTURE (CAPx) TIMING CHARACTERISTICS

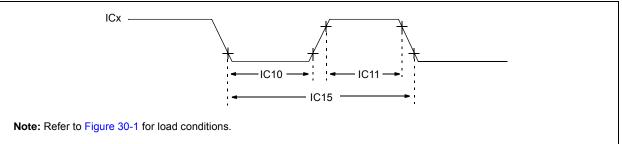


TABLE 30-25: INPUT CAPTURE MODULE TIMING REQUIREMENTS

AC CHARACTERISTICS (unles				perating Conditions: 2.3V erwise stated) emperature $-40^{\circ}C \le TA \le +$ $-40^{\circ}C \le TA \le +$	∙85°C fo			
Param. No.	Symbol	Characteristics ⁽¹⁾		Min.	Max.	Units	Con	ditions
IC10	TccL	ICx Input Low Time		[(12.5 ns or 1 ТРВ)/N] + 25 ns	_	ns	Must also meet parameter IC15.	N = prescale value (1, 4, 16)
IC11	ТссН	ICx Input	High Time	[(12.5 ns or 1 ТРВ)/N] + 25 ns	-	ns	Must also meet parameter IC15.	
IC15	TCCP	ICx Input	Period	[(25 ns or 2 Трв)/N] + 50 ns	_	ns	_	

Note 1: These parameters are characterized, but not tested in manufacturing.

FIGURE 30-8: OUTPUT COMPARE MODULE (OCx) TIMING CHARACTERISTICS

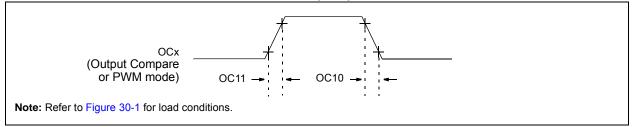


TABLE 30-26: OUTPUT COMPARE MODULE TIMING REQUIREMENTS

		$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ & -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$					
Param. No.	Symbol	Characteristics ⁽¹⁾	Min.	Typical ⁽²⁾	Max.	Units	Conditions
OC10	TccF	OCx Output Fall Time	—	—	_	ns	See parameter DO32
OC11	TccR	OCx Output Rise Time	—	—		ns	See parameter DO31

Note 1: These parameters are characterized, but not tested in manufacturing.

2: Data in "Typical" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

FIGURE 30-9: OCx/PWM MODULE TIMING CHARACTERISTICS

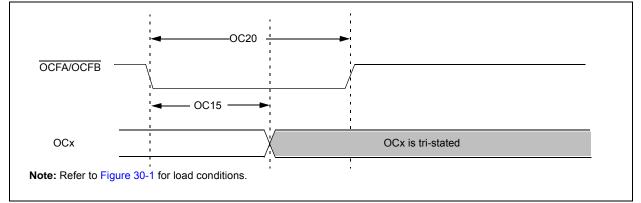


TABLE 30-27: SIMPLE OCx/PWM MODE TIMING REQUIREMENTS

AC CHARACTERISTICS			$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^\circ C \leq TA \leq +85^\circ C \mbox{ for Industrial} \\ & -40^\circ C \leq TA \leq +105^\circ C \mbox{ for V-temp} \end{array}$					
Param No.	Symbol	Characteristics ⁽¹⁾	Min	Typical ⁽²⁾	Max	Units	Conditions	
OC15	TFD	Fault Input to PWM I/O Change	—	—	50	ns	_	
OC20	TFLT	Fault Input Pulse Width	50	—		ns	_	

Note 1: These parameters are characterized, but not tested in manufacturing.

2: Data in "Typical" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

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FIGURE 30-10: SPIX MODULE MASTER MODE (CKE = 0) TIMING CHARACTERISTICS

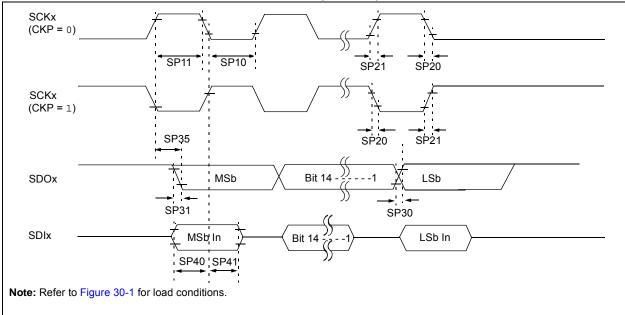


TABLE 30-28: SPIx MASTER MODE (CKE = 0) TIMING REQUIREMENTS

AC CHARACTERISTICS			$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ & -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$					
Param. No.	Symbol	Characteristics ⁽¹⁾	Min.	Typical ⁽²⁾	Max.	Units	Conditions	
SP10	TscL	SCKx Output Low Time (Note 3)	Тѕск/2	_		ns	_	
SP11	TscH	SCKx Output High Time (Note 3)	Тѕск/2	—	_	ns	_	
SP20	TscF	SCKx Output Fall Time (Note 4)	—	—	_	ns	See parameter DO32	
SP21	TscR	SCKx Output Rise Time (Note 4)	—	—	-	ns	See parameter DO31	
SP30	TDOF	SDOx Data Output Fall Time (Note 4)	—	—	-	ns	See parameter DO32	
SP31	TDOR	SDOx Data Output Rise Time (Note 4)	—	_	_	ns	See parameter DO31	
SP35	TscH2doV,	SDOx Data Output Valid after	—	—	15	ns	VDD > 2.7V	
	TscL2doV	SCKx Edge	—	_	20	ns	VDD < 2.7V	
SP40	TDIV2scH, TDIV2scL	Setup Time of SDIx Data Input to SCKx Edge	10	—	_	ns	—	
SP41	TscH2diL, TscL2diL	Hold Time of SDIx Data Input to SCKx Edge	10	_	—	ns	—	

Note 1: These parameters are characterized, but not tested in manufacturing.

2: Data in "Typical" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

3: The minimum clock period for SCKx is 50 ns. Therefore, the clock generated in Master mode must not violate this specification.

4: Assumes 50 pF load on all SPIx pins.

SP36 SCKx (CKP = 0) SP11 SP10 SP21 SP20 SCKx (CKP = 1) SP35 SP21 SP20 LSb SDOx MSb Bit 14 SP30,SP31 SDIx Bit 14 MSb In LSb In SP40 SP41 Note: Refer to Figure 30-1 for load conditions.

FIGURE 30-11: SPIx MODULE MASTER MODE (CKE = 1) TIMING CHARACTERISTICS

TABLE 30-29: SPIX MODULE MASTER MODE (CKE = 1) TIMING REQUIREMENTS

AC CHA	AC CHARACTERISTICS			$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^\circ C \leq TA \leq +85^\circ C \mbox{ for Industrial} \\ & -40^\circ C \leq TA \leq +105^\circ C \mbox{ for V-temp} \end{array}$				
Param. No.	Symbol	Characteristics ⁽¹⁾	Min.	Тур. ⁽²⁾	Max.	Units	Conditions	
SP10	TscL	SCKx Output Low Time (Note 3)	Tsck/2	—	_	ns		
SP11	TscH	SCKx Output High Time (Note 3)	Tsck/2	_	_	ns	—	
SP20	TscF	SCKx Output Fall Time (Note 4)	_	—	_	ns	See parameter DO32	
SP21	TscR	SCKx Output Rise Time (Note 4)	_	_	_	ns	See parameter DO31	
SP30	TDOF	SDOx Data Output Fall Time (Note 4)	—	—		ns	See parameter DO32	
SP31	TDOR	SDOx Data Output Rise Time (Note 4)	—	—	—	ns	See parameter DO31	
SP35	TscH2doV,	SDOx Data Output Valid after			15	ns	VDD > 2.7V	
	TscL2doV	SCKx Edge			20	ns	Vdd < 2.7V	
SP36	TDOV2SC, TDOV2SCL	SDOx Data Output Setup to First SCKx Edge	15	—		ns	_	
SP40	TDIV2scH,	Setup Time of SDIx Data Input to	15	_	_	ns	VDD > 2.7V	
	TDIV2scL	SCKx Edge	20	_		ns	VDD < 2.7V	
SP41	TscH2DIL,	Hold Time of SDIx Data Input	15	_	—	ns	VDD > 2.7V	
	TscL2DIL	to SCKx Edge	20	—	—	ns	VDD < 2.7V	

Note 1: These parameters are characterized, but not tested in manufacturing.

Data in "Typical" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only 2: and are not tested.

The minimum clock period for SCKx is 50 ns. Therefore, the clock generated in Master mode must not 3: violate this specification.

Assumes 50 pF load on all SPIx pins. 4:

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FIGURE 30-12: SPIx MODULE SLAVE MODE (CKE = 0) TIMING CHARACTERISTICS

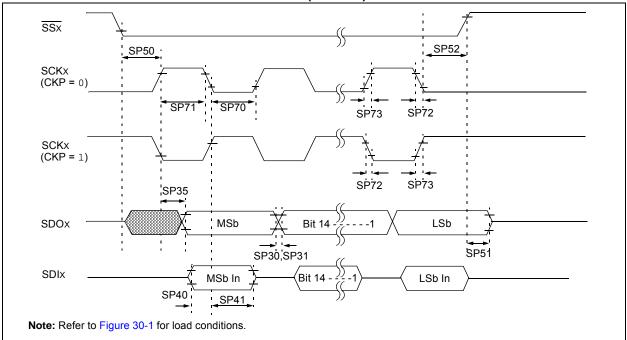


TABLE 30-30: SPIX MODULE SLAVE MODE (CKE = 0) TIMING REQUIREMENTS

АС СНА	AC CHARACTERISTICS			$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ & -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$				
Param. No.	Symbol	Characteristics ⁽¹⁾	Min.	Тур. ⁽²⁾	Max.	Units	Conditions	
SP70	TscL	SCKx Input Low Time (Note 3)	Tsck/2	_	_	ns	—	
SP71	TscH	SCKx Input High Time (Note 3)	Tsck/2	_		ns	—	
SP72	TscF	SCKx Input Fall Time	—	_	_	ns	See parameter DO32	
SP73	TscR	SCKx Input Rise Time	—	-	_	ns	See parameter DO31	
SP30	TDOF	SDOx Data Output Fall Time (Note 4)	—			ns	See parameter DO32	
SP31	TDOR	SDOx Data Output Rise Time (Note 4)	_	_	_	ns	See parameter DO31	
SP35		SDOx Data Output Valid after	—	_	15	ns	VDD > 2.7V	
	TscL2DoV	SCKx Edge	_		20	ns	VDD < 2.7V	
SP40	TDIV2scH, TDIV2scL	Setup Time of SDIx Data Input to SCKx Edge	10			ns		
SP41	TscH2DIL, TscL2DIL	Hold Time of SDIx Data Input to SCKx Edge	10	-	_	ns	—	
SP50	TssL2scH, TssL2scL	$\overline{SSx} \downarrow$ to SCKx \uparrow or SCKx Input	175	_	_	ns	—	
SP51	TssH2doZ	SSx ↑ to SDOx Output High-Impedance (Note 3)	5	_	25	ns	—	
SP52	TscH2ssH TscL2ssH	SSx after SCKx Edge	Тѕск + 20	_		ns	—	

Note 1: These parameters are characterized, but not tested in manufacturing.

Data in "Typical" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only 2: and are not tested.

The minimum clock period for SCKx is 50 ns. 3:

Assumes 50 pF load on all SPIx pins. 4:

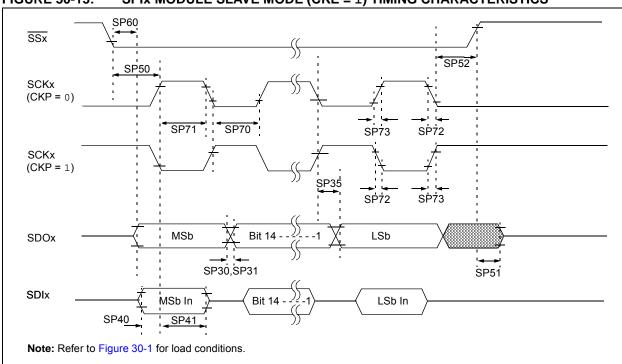


FIGURE 30-13: SPIX MODULE SLAVE MODE (CKE = 1) TIMING CHARACTERISTICS

TABLE 30-31: SPIX MODULE SLAVE MODE (CKE = 1) TIMING REQUIREMENTS

AC CHA	AC CHARACTERISTICS			$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature } -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$					
Param. No.	Symbol	Characteristics ⁽¹⁾	Min.	Typical ⁽²⁾	Max.	Units	Conditions		
SP70	TscL	SCKx Input Low Time (Note 3)	Тѕск/2	_	_	ns	—		
SP71	TscH	SCKx Input High Time (Note 3)	Tsck/2	_		ns	—		
SP72	TscF	SCKx Input Fall Time	_	5	10	ns	—		
SP73	TscR	SCKx Input Rise Time	_	5	10	ns	—		
SP30	TDOF	SDOx Data Output Fall Time (Note 4)	—	—		ns	See parameter DO32		
SP31	TDOR	SDOx Data Output Rise Time (Note 4)	—	—	_	ns	See parameter DO31		
SP35	TscH2doV,		_	—	20	ns	VDD > 2.7V		
	TscL2DoV	SCKx Edge		—	30	ns	VDD < 2.7V		
SP40	TDIV2scH, TDIV2scL	Setup Time of SDIx Data Input to SCKx Edge	10	—	_	ns	—		
SP41	TscH2diL, TscL2diL	Hold Time of SDIx Data Input to SCKx Edge	10	—	_	ns	—		
SP50	TssL2scH, TssL2scL	$\overline{SSx} \downarrow$ to SCKx \downarrow or SCKx \uparrow Input	175	—		ns	—		

Note 1: These parameters are characterized, but not tested in manufacturing.

2: Data in "Typical" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

3: The minimum clock period for SCKx is 50 ns.

4: Assumes 50 pF load on all SPIx pins.

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TABLE 30-31: SPIX MODULE SLAVE MODE (CKE = 1) TIMING REQUIREMENTS (CONTINUED)

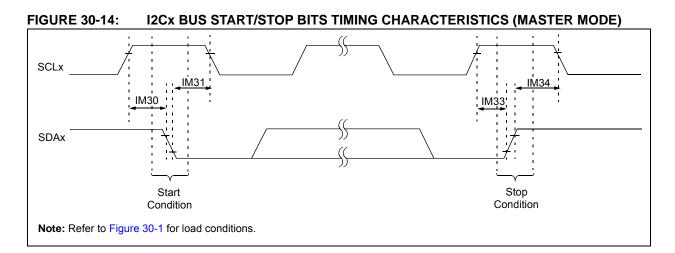
АС СНА	AC CHARACTERISTICS			$\label{eq:standard} \begin{array}{l} \mbox{Standard Operating Conditions: } 2.3V to 3.6V \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature } -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$				
Param. No.	Symbol	Characteristics ⁽¹⁾	Min.	Typical ⁽²⁾	Max.	Units	Conditions	
SP51	TssH2doZ	SSx ↑ to SDOx Output High-Impedance (Note 4)	5	_	25	ns	_	
SP52	TscH2ssH TscL2ssH	SSx ↑ after SCKx Edge	Тscк + 20	—	_	ns	_	
SP60	TssL2doV	SDOx Data Output Valid after SSx Edge	-	—	25	ns		

Note 1: These parameters are characterized, but not tested in manufacturing.

2: Data in "Typical" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

3: The minimum clock period for SCKx is 50 ns.

4: Assumes 50 pF load on all SPIx pins.





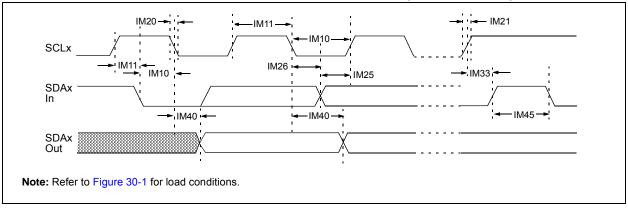


TABLE 30-32: I2Cx BUS DATA TIMING REQUIREMENTS (MASTER MODE)

	RACTER	ISTICS		$\begin{array}{ll} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ & -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$					
Param. No.	Symbol	Charact	eristics	Min. ⁽¹⁾ Max.		Units	Conditions		
IM10	TLO:SCL	Clock Low Time	100 kHz mode	Трв * (BRG + 2)	—	μS	_		
			400 kHz mode	Трв * (BRG + 2)	—	μS	—		
			1 MHz mode (Note 2)	Трв * (BRG + 2)	—	μs	—		
IM11	THI:SCL	Clock High Time	100 kHz mode	Трв * (BRG + 2)	_	μS	—		
			400 kHz mode	Трв * (BRG + 2)	_	μS	—		
			1 MHz mode (Note 2)	Трв * (BRG + 2)	—	μs	—		
IM20	TF:SCL	SDAx and SCLx	100 kHz mode	—	300	ns	CB is specified to be		
		Fall Time	400 kHz mode	20 + 0.1 Св	300	ns	from 10 to 400 pF		
			1 MHz mode (Note 2)	_	100	ns			
IM21	TR:SCL	SDAx and SCLx	100 kHz mode	—	1000	ns	CB is specified to be		
		Rise Time	400 kHz mode	20 + 0.1 Св	300	ns	from 10 to 400 pF		
			1 MHz mode (Note 2)	_	300	ns			
	Data Input	100 kHz mode	250	—	ns	—			
		Setup Time	400 kHz mode	100	_	ns			
			1 MHz mode (Note 2)	100	—	ns			
IM26	THD:DAT	Data Input	100 kHz mode	0	—	μS	—		
		Hold Time	400 kHz mode	0	0.9	μS			
			1 MHz mode (Note 2)	0	0.3	μs			
IM30	TSU:STA	Start Condition	100 kHz mode	Трв * (BRG + 2)	_	μS	Only relevant for		
		Setup Time	400 kHz mode	Трв * (BRG + 2)	—	μS	Repeated Start condition		
			1 MHz mode (Note 2)	Трв * (BRG + 2)		μs	Condition		
IM31	THD:STA	Start Condition	100 kHz mode	Трв * (BRG + 2)	—	μS	After this period, the		
		Hold Time	400 kHz mode	Трв * (BRG + 2)		μS	first clock pulse is generated		
			1 MHz mode (Note 2)	Трв * (BRG + 2)		μs	generaleu		
IM33	Tsu:sto	Stop Condition	100 kHz mode	Трв * (BRG + 2)	—	μS			
		Setup Time	400 kHz mode	Трв * (BRG + 2)		μS			
			1 MHz mode (Note 2)	Трв * (BRG + 2)	—	μs			
IM34	THD:STO	Stop Condition	100 kHz mode	Трв * (BRG + 2)		ns			
		Hold Time	400 kHz mode 1 MHz mode (Note 2)	Трв * (BRG + 2) Трв * (BRG + 2)		ns ns			

Note 1: BRG is the value of the I^2C Baud Rate Generator.

2: Maximum pin capacitance = 10 pF for all I2Cx pins (for 1 MHz mode only).

3: The typical value for this parameter is 104 ns.

TABLE 30-32:	I2Cx BUS DATA	TIMING REQUIREMENTS	6 (MASTER MODE) (CONTINUED)	
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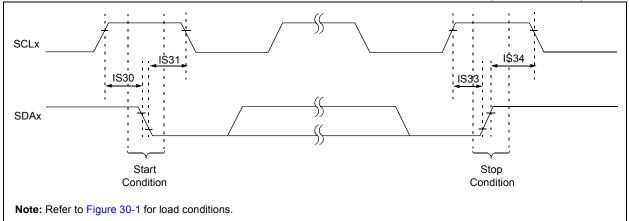
AC CHARACTERISTICS				$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ & -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$			
Param. No.	Symbol	Characteristics		Min. ⁽¹⁾	Max.	Units	Conditions
IM40	TAA:SCL	Output Valid from Clock	100 kHz mode	—	3500	ns	—
			400 kHz mode	—	1000	ns	—
			1 MHz mode (Note 2)	—	350	ns	—
IM45	Tbf:sda	Bus Free Time	100 kHz mode	4.7	—	μS	The amount of time the bus must be free before a new transmission can start
			400 kHz mode	1.3	—	μS	
			1 MHz mode (Note 2)	0.5	—	μS	
IM50	Св	Bus Capacitive L	oading	_	400	pF	_
IM51	Tpgd	Pulse Gobbler D	elay	52	312	ns	See Note 3

Note 1: BRG is the value of the I^2C Baud Rate Generator.

2: Maximum pin capacitance = 10 pF for all I2Cx pins (for 1 MHz mode only).

3: The typical value for this parameter is 104 ns.

FIGURE 30-16: I2Cx BUS START/STOP BITS TIMING CHARACTERISTICS (SLAVE MODE)



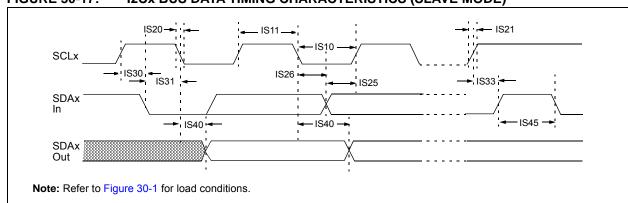


FIGURE 30-17: I2Cx BUS DATA TIMING CHARACTERISTICS (SLAVE MODE)

TABLE 30-33:	I2Cx BUS DATA T	IMING REQUIREMENTS	(SLAVE MODE)
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АС СНА	RACTERIS	STICS		(unless other	Standard Operating Conditions: 2.3V to 3.6V(unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industria $-40^{\circ}C \le TA \le +105^{\circ}C$ for V-temp				
Param. No.	Symbol	Charact	eristics	Min.	Max.	Units	Conditions		
IS10	TLO:SCL	Clock Low Time	100 kHz mode	4.7	_	μS	PBCLK must operate at a minimum of 800 kHz		
			400 kHz mode	1.3	_	μS	PBCLK must operate at a minimum of 3.2 MHz		
			1 MHz mode (Note 1)	0.5	—	μS	—		
IS11	THI:SCL	Clock High Time	100 kHz mode	4.0	_	μS	PBCLK must operate at a minimum of 800 kHz		
			400 kHz mode	0.6	_	μS	PBCLK must operate at a minimum of 3.2 MHz		
			1 MHz mode (Note 1)	0.5	_	μS	—		
IS20	TF:SCL	SDAx and SCLx	100 kHz mode	—	300	ns	CB is specified to be from		
		Fall Time	400 kHz mode	20 + 0.1 Св	300	ns	10 to 400 pF		
			1 MHz mode (Note 1)	—	100	ns			
IS21	TR:SCL	SDAx and SCLx	100 kHz mode	_	1000	ns	CB is specified to be from		
		Rise Time	400 kHz mode	20 + 0.1 Св	300	ns	10 to 400 pF		
			1 MHz mode (Note 1)	_	300	ns			
IS25	TSU:DAT	Data Input	100 kHz mode	250	_	ns	—		
		Setup Time	400 kHz mode	100	—	ns			
			1 MHz mode (Note 1)	100	_	ns			
IS26	THD:DAT	Data Input	100 kHz mode	0	—	ns	—		
		Hold Time	400 kHz mode	0	0.9	μs			
			1 MHz mode (Note 1)	0	0.3	μS			
IS30	TSU:STA	Start Condition	100 kHz mode	4700	—	ns	Only relevant for Repeated		
		Setup Time	400 kHz mode	600	—	ns	Start condition		
			1 MHz mode (Note 1)	250	_	ns			
IS31	THD:STA	Start Condition	100 kHz mode	4000		ns	After this period, the first		
		Hold Time	400 kHz mode	600	_	ns	clock pulse is generated		
			1 MHz mode (Note 1)	250	_	ns			
IS33	Tsu:sto	Stop Condition	100 kHz mode	4000	_	ns			
		Setup Time	400 kHz mode	600	—	ns			
			1 MHz mode (Note 1)	600	_	ns			

Note 1: Maximum pin capacitance = 10 pF for all I2Cx pins (for 1 MHz mode only).

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TABLE 30-33: I2Cx BUS DATA TIMING REQUIREMENTS (SLAVE MODE) (CONTINUED)

AC CHARACTERISTICS			$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$					
Param. No. Symbol Characteristics			eristics	Min.	Max.	Units	Conditions	
IS34	THD:STO	Stop Condition	100 kHz mode	4000	—	ns	—	
		Hold Time	400 kHz mode	600	—	ns		
			1 MHz mode (Note 1)	250		ns		
IS40	TAA:SCL	Output Valid from	100 kHz mode	0	3500	ns	—	
		Clock	400 kHz mode	0	1000	ns		
			1 MHz mode (Note 1)	0	350	ns		
IS45	TBF:SDA	Bus Free Time	100 kHz mode	4.7		μs	The amount of time the bus	
			400 kHz mode	1.3	—	μs	must be free before a new	
			1 MHz mode (Note 1)	0.5	—	μS	transmission can start	
IS50	Св	Bus Capacitive Lo	ading	—	400	pF	—	

Note 1: Maximum pin capacitance = 10 pF for all I2Cx pins (for 1 MHz mode only).

			Standard O (unless oth			ee Not	e 5): 2.5V to 3.6V
			Operating te	emperature			C for Industrial °C for V-temp
Param. No.	Symbol	Characteristics	Min.	Typical	Max.	Units	Conditions
Device	Supply						
AD01	AVdd	Module VDD Supply	Greater of VDD – 0.3 or 2.5	_	Lesser of VDD + 0.3 or 3.6	V	_
AD02	AVss	Module Vss Supply	Vss	—	AVdd	V	(Note 1)
Referen	ce Inputs	·					·
AD05 AD05a	Vrefh	Reference Voltage High	AVss + 2.0 2.5	_	AVDD 3.6	V V	(Note 1) VREFH = AVDD (Note 3)
AD06	Vrefl	Reference Voltage Low	AVss	—	Vrefh – 2.0	V	(Note 1)
AD07	Vref	Absolute Reference Voltage (VREFH – VREFL)	2.0	—	AVdd	V	(Note 3)
AD08 AD08a	IREF	Current Drain	_	250 —	400 3	μΑ μΑ	ADC operating ADC off
Analog	Input	·					
AD12	VINH-VINL	Full-Scale Input Span	VREFL	_	VREFH	V	—
AD13	VINL	Absolute VINL Input Voltage	AVss – 0.3	_	AVDD/2	V	_
AD14	VIN	Absolute Input Voltage	AVss - 0.3	_	AVDD + 0.3	V	—
AD15	_	Leakage Current		±0.001	±0.610	μA	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.3V Source Impedance = 10 k Ω
AD17	RIN	Recommended Impedance of Analog Voltage Source	—	_	5k	Ω	(Note 1)
ADC Ac	curacy – N	leasurements with Exte	rnal VREF+/V	REF-			·
AD20c	Nr	Resolution		10 data bit	S	bits	
AD21c	INL	Integral Non-linearity	> -1	_	< 1	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.3V
AD22c	DNL	Differential Non-linearity	> -1	_	< 1	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.3V (Note 2)
AD23c	Gerr	Gain Error	> -1	_	< 1	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.3V
AD24c	Eoff	Offset Error	> -1	_	< 1	Lsb	VINL = AVSS = 0V, AVDD = 3.3V
AD25c	—	Monotonicity	_		_	_	Guaranteed

TABLE 30-34: ADC MODULE SPECIFICATIONS

Note 1: These parameters are not characterized or tested in manufacturing.

2: With no missing codes.

3: These parameters are characterized, but not tested in manufacturing.

4: Characterized with a 1 kHz sine wave.

TABLE 30-34: ADC MODULE SPECIFICATIONS

	AC CHAF	ACTERISTICS	$\begin{array}{l} \mbox{Standard Operating Conditions (see Note 5): 2.5V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ & -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$						
Param. No.	Symbol	Characteristics	Min.	Typical	Max.	Units	Conditions		
ADC Ac	curacy – N	leasurements with Inter	nal VREF+/V	REF-					
AD20d	Nr	Resolution		10 data bits	3	bits	(Note 3)		
AD21d	INL	Integral Non-linearity	> -1 — < 1 LSt	<1 LSb	VINL = AVss = 0V, AVDD = 2.5V to 3.6V (Note 3)				
AD22d	DNL	Differential Non-linearity	> -1	_	< 1	LSb	VINL = AVss = 0V, AVDD = 2.5V to 3.6V (Notes 2,3)		
AD23d	Gerr	Gain Error	> -4	—	< 4	LSb	VINL = AVss = 0V, AVDD = 2.5V to 3.6V (Note 3)		
AD24d	EOFF	Offset Error	> -2	—	< 2	Lsb	VINL = AVss = 0V, AVDD = 2.5V to 3.6V (Note 3)		
AD25d	—	Monotonicity		—			Guaranteed		
Dynami	c Performa	ance							
AD32b	SINAD	Signal to Noise and Distortion	55	58.5	—	dB	(Notes 3,4)		
AD34b	ENOB	Effective Number of bits	9.0	9.5	_	bits	(Notes 3,4)		

Note 1: These parameters are not characterized or tested in manufacturing.

2: With no missing codes.

3: These parameters are characterized, but not tested in manufacturing.

4: Characterized with a 1 kHz sine wave.

AC CHARA	CTERISTIC	S ⁽²⁾	$\begin{array}{l} \mbox{Standard Operating Conditions (see Note 3): 2.5V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$					
ADC Speed	ADC Speed TAD Min. Sampling Time Min.			Vdd	ADC Channels Configuration			
1 Msps to 400 ksps ⁽¹⁾	65 ns	132 ns	500Ω	3.0V to 3.6V	ANX CHX ANX ADC			
Up to 400 ksps	200 ns	200 ns	5.0 kΩ	2.5V to 3.6V	ANX ADC ANX or VREF-			

TABLE 30-35: 10-BIT CONVERSION RATE PARAMETERS

Note 1: External VREF- and VREF+ pins must be used for correct operation.

2: These parameters are characterized, but not tested in manufacturing.

AC CHA	ARACTER	ISTICS	$\begin{array}{l} \mbox{Standard Operating Conditions (see Note 4): 2.5V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ & -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$							
Param. No.	Symbol	Characteristics	Min.	Typical ⁽¹⁾	Max.	Units	Conditions			
Clock Parameters										
AD50	TAD	ADC Clock Period ⁽²⁾	65	_	_	ns	See Table 30-35			
Conver	sion Rate	•	•							
AD55	TCONV	Conversion Time		12 TAD	—	_	—			
AD56	FCNV	Throughput Rate	—	—	1000	ksps	AVDD = 3.0V to 3.6V			
		(Sampling Speed)	—	—	400	ksps	AVDD = 2.5V to 3.6V			
AD57	TSAMP	Sample Time	1 Tad	—	—	_	TSAMP must be \geq 132 ns			
Timing	Paramete	rs								
AD60	TPCS	Conversion Start from Sample Trigger ⁽³⁾	—	1.0 Tad	—	—	Auto-Convert Trigger (SSRC<2:0> = 111) not selected			
AD61	TPSS	Sample Start from Setting Sample (SAMP) bit	0.5 Tad	—	1.5 TAD	_	_			
AD62	TCSS	Conversion Completion to Sample Start (ASAM = 1) ⁽³⁾	—	0.5 TAD	—		_			
AD63	TDPU	Time to Stabilize Analog Stage from ADC Off to ADC On ⁽³⁾	_		2	μS	_			

TABLE 30-36: ANALOG-TO-DIGITAL CONVERSION TIMING REQUIREMENTS

Note 1: These parameters are characterized, but not tested in manufacturing.

2: Because the sample caps will eventually lose charge, clock rates below 10 kHz can affect linearity performance, especially at elevated temperatures.

3: Characterized by design but not tested.

AD50 ADCLK Instruction Execution Set SAMP Clear SAMF SAMP ch0_dischrg 1 ch0_samp eoc AD61-AD60 - TSAMP AD55 AD55 1 CONV ADxIF ~ Buffer(0) . 55 55 Buffer(1) -55 . . ÷ 1 2 3456 08 6 6 1 8 1 - Software sets ADxCON. SAMP to start sampling. (2) - Sampling starts after discharge period. TSAMP is described in Section 17. "10-bit Analog-to-Digital Converter (ADC)" (DS60001104) in the "PIC32 Family Reference Manual". 3 - Software clears ADxCON. SAMP to start conversion. (4) - Sampling ends, conversion sequence starts. 5 – Convert bit 9. 6 - Convert bit 8. ⑦ – Convert bit 0. (8) - One TAD for end of conversion.

FIGURE 30-18: ANALOG-TO-DIGITAL CONVERSION (10-BIT MODE) TIMING CHARACTERISTICS (ASAM = 0, SSRC<2:0> = 000)

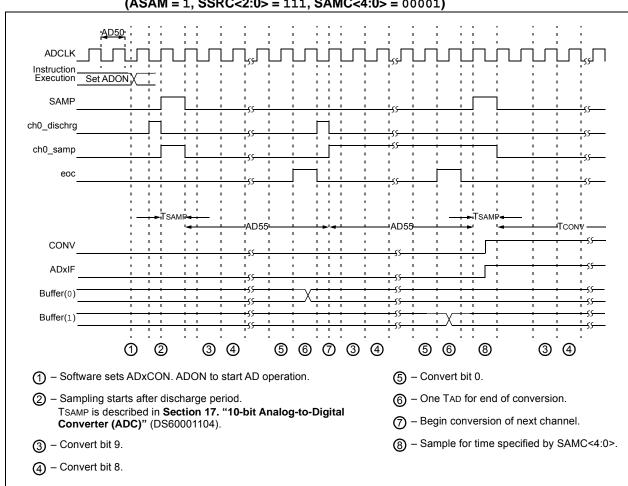


FIGURE 30-19: ANALOG-TO-DIGITAL CONVERSION (10-BIT MODE) TIMING CHARACTERISTICS (ASAM = 1, SSRC<2:0> = 111, SAMC<4:0> = 00001)

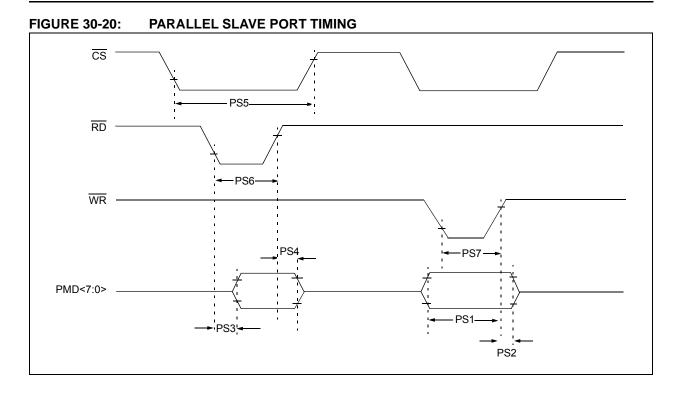
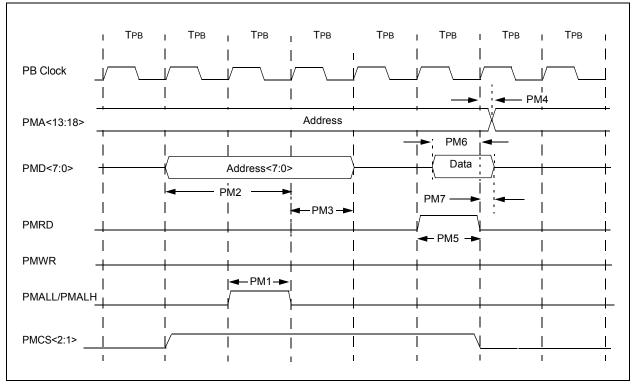


TABLE 30-37: PARALLEL SLAVE PORT REQUIREMENTS

АС СН	ARACTE	RISTICS	$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^\circ C \leq TA \leq +85^\circ C \mbox{ for Industrial} \\ & -40^\circ C \leq TA \leq +105^\circ C \mbox{ for V-temp} \end{array}$					
Para m.No.	Symbol	Characteristics ⁽¹⁾	Min. Typ. Max. Units Condition					
PS1	TdtV2wr H	Data In Valid before \overline{WR} or \overline{CS} Inactive (setup time)	20			ns	_	
PS2	TwrH2dt I	WR or CS Inactive to Data-In Invalid (hold time)	40	—	—	ns	_	
PS3	TrdL2dt V	\overline{RD} and \overline{CS} Active to Data-Out Valid	_	—	60	ns	_	
PS4	TrdH2dtl	\overline{RD} Active or \overline{CS} Inactive to Data-Out Invalid	0	—	10	ns	_	
PS5	Tcs	CS Active Time	Трв + 40	_	_	ns	—	
PS6	Twr	WR Active Time	Трв + 25			ns		
PS7		RD Active Time	Трв + 25		_	ns		

Note 1: These parameters are characterized, but not tested in manufacturing.

FIGURE 30-21: PARALLEL MASTER PORT READ TIMING DIAGRAM

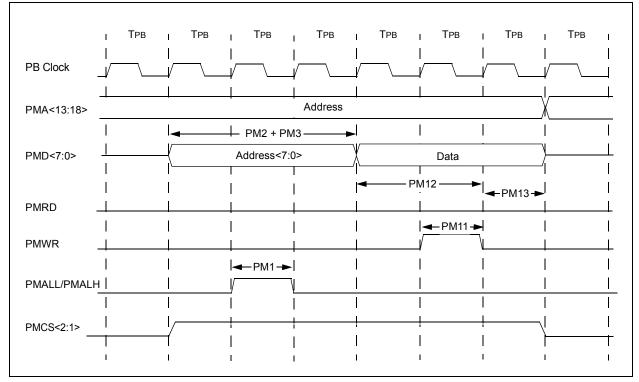


AC CHARACTERISTICS			$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$				°C for Industrial
Param. No.	Symbol	Characteristics ⁽¹⁾	Min.	Тур.	Max.	Units	Conditions
PM1	TLAT	PMALL/PMALH Pulse Width	—	1 Трв	_	—	—
PM2	Tadsu	Address Out Valid to PMALL/PMALH Invalid (address setup time)	—	2 Трв		—	_
PM3	Tadhold	PMALL/PMALH Invalid to Address Out Invalid (address hold time)	—	1 Трв	—	—	_
PM4	Tahold	PMRD Inactive to Address Out Invalid (address hold time)	5	—	_	ns	_
PM5	Trd	PMRD Pulse Width	—	1 Трв	_	—	—
PM6	TDSU	PMRD or PMENB Active to Data In Valid (data setup time)	15	_	_	ns	_
PM7	TDHOLD	PMRD or PMENB Inactive to Data In Invalid (data hold time)	5	—	_	ns	—

TABLE 30-38: PARALLEL MASTER PORT READ TIMING REQUIREMENTS

Note 1: These parameters are characterized, but not tested in manufacturing.

FIGURE 30-22: PARALLEL MASTER PORT WRITE TIMING DIAGRAM



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TABLE 30-39: PARALLEL MASTER PORT WRITE TIMING REQUIREMENTS

АС СНА	AC CHARACTERISTICS			$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industrial} \\ & -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$					
Param. No.	Symbol	Characteristics ⁽¹⁾	Min. Typ. Max. Units Conditio				Conditions		
PM11	Twr	PMWR Pulse Width	_	1 Трв	_	_	_		
PM12	TDVSU	Data Out Valid before PMWR or PMENB goes Inactive (data setup time)	—	2 Трв	—	_	_		
PM13	TDVHOLD	PMWR or PMEMB Invalid to Data Out Invalid (data hold time)	—	1 Трв			—		

Note 1: These parameters are characterized, but not tested in manufacturing.

TABLE 30-40: OTG ELECTRICAL SPECIFICATIONS

AC CHARACTERISTICS			$\begin{tabular}{lllllllllllllllllllllllllllllllllll$					
Param. No.	Symbol	Characteristics ⁽¹⁾	Min.	Тур.	Max.	Units	Conditions	
USB313	VUSB3V3	USB Voltage	3.0	_	3.6	V	Voltage on VUSB3V3 must be in this range for proper USB operation	
USB315	VILUSB	Input Low Voltage for USB Buffer	_		0.8	V	—	
USB316	VIHUSB	Input High Voltage for USB Buffer	2.0		_	V	—	
USB318	VDIFS	Differential Input Sensitivity	—	_	0.2	V	The difference between D+ and D- must exceed this value while VCM is met	
USB319	VCM	Differential Common Mode Range	0.8		2.5	V	—	
USB320	Ζουτ	Driver Output Impedance	28.0	—	44.0	Ω	—	
USB321	Vol	Voltage Output Low	0.0	—	0.3	V	1.425 kΩ load connected to VUSB3V3	
USB322	Vон	Voltage Output High	2.8	_	3.6	V	1.425 k Ω load connected to ground	

Note 1: These parameters are characterized, but not tested in manufacturing.

DC CHARACTERISTICS			Standard Operating Conditions (see Note 3):2.3V to 3.6V(unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial $-40^{\circ}C \le TA \le +105^{\circ}C$ for V-temp						
Param No.	Symbol	Characteristic	Min.	Тур.	Max.	Units	Conditions		
CTMU CURRENT SOURCE									
CTMUI1	IOUT1	Base Range ⁽¹⁾	_	0.55	_	μA	CTMUCON<9:8> = 01		
CTMUI2	Ιουτ2	10x Range ⁽¹⁾	_	5.5		μA	CTMUCON<9:8> = 10		
CTMUI3	Ιουτ3	100x Range ⁽¹⁾	_	55		μA	CTMUCON<9:8> = 11		
CTMUI4	IOUT4	1000x Range ⁽¹⁾	_	550	_	μA	CTMUCON<9:8> = 00		
CTMUFV1	VF	Temperature Diode Forward Voltage ^(1,2)	_	0.598	—	V	TA = +25°C, CTMUCON<9:8> = 01		
			_	0.658	—	V	TA = +25°C, CTMUCON<9:8> = 10		
			_	0.721	_	V	TA = +25°C, CTMUCON<9:8> = 11		
CTMUFV2	VFVR	Temperature Diode Rate of	_	-1.92		mV/⁰C	CTMUCON<9:8> = 01		
		Change ^(1,2)	_	-1.74	_	mV/⁰C	CTMUCON<9:8> = 10		
			—	-1.56	_	mV/ºC	CTMUCON<9:8> = 11		

TABLE 30-41: CTMU CURRENT SOURCE SPECIFICATIONS

Note 1: Nominal value at center point of current trim range (CTMUCON<15:10> = 000000).

2: Parameters are characterized but not tested in manufacturing. Measurements taken with the following conditions:

- VREF+ = AVDD = 3.3V
- ADC module configured for conversion speed of 500 ksps
- All PMD bits are cleared (PMDx = 0)
- Executing a while(1) statement
- Device operating from the FRC with no PLL
- **3:** The CTMU module is functional at VBORMIN < VDD < VDDMIN, but with degraded performance. Unless otherwise stated, module functionality is tested, but not characterized.

T_{TCKcyc} T_{TCKlow} T_{TCKhigh} тск -. T_{rf} TMS TDI T_{Tsetup} T_{Thold} T_{rf} TDO T_{TDOout} T_{TRST*low} T_{TDOzstate} TRST* I ∎ T_{rf} Undefined Defined

FIGURE 30-23: EJTAG TIMING CHARACTERISTICS

TABLE 30-42: EJTAG TIMING REQUIREMENTS

AC CHARACTERISTICS			$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^\circ C \leq TA \leq +85^\circ C \mbox{ for Industrial} \\ & -40^\circ C \leq TA \leq +105^\circ C \mbox{ for V-temp} \end{array}$					
Param. No.	Symbol	Description ⁽¹⁾	Min.	Max.	Units	Conditions		
EJ1	Ттсксус	TCK Cycle Time	25		ns	—		
EJ2	Ттскнідн	TCK High Time	10		ns			
EJ3	TTCKLOW	TCK Low Time	10		ns	—		
EJ4	TTSETUP	TAP Signals Setup Time Before Rising TCK	5	_	ns	_		
EJ5	TTHOLD	TAP Signals Hold Time After Rising TCK	3	—	ns	_		
EJ6	TTDOOUT	TDO Output Delay Time from Falling TCK	—	5	ns	_		
EJ7	TTDOZSTATE	TDO 3-State Delay Time from Falling TCK	—	5	ns	_		
EJ8	TTRSTLOW	TRST Low Time	25		ns	—		
EJ9	Trf	TAP Signals Rise/Fall Time, All Input and Output	—	—	ns	_		

Note 1: These parameters are characterized, but not tested in manufacturing.

31.0 50 MHz ELECTRICAL CHARACTERISTICS

This section provides an overview of the PIC32MX1XX/2XX 28/36/44-pin Family electrical characteristics for devices operating at 50 MHz.

The specifications for 50 MHz are identical to those shown in **Section 30.0 "Electrical Characteristics"**, with the exception of the parameters listed in this chapter.

Parameters in this chapter begin with the letter "M", which denotes 50 MHz operation. For example, parameter DC29a in **Section 30.0** "Electrical Characteristics", is the up to 40 MHz operation equivalent for MDC29a.

Absolute maximum ratings for the PIC32MX1XX/2XX 28/36/44-pin Family 50 MHz devices are listed below. Exposure to these maximum rating conditions for extended periods may affect device reliability. Functional operation of the device at these or any other conditions, above the parameters indicated in the operation listings of this specification, is not implied.

Absolute Maximum Ratings

(See Note 1)

Ambient temperature under bias $-40^{\circ}C$ Storage temperature $-65^{\circ}C$ toVoltage on VDD with respect to Vss $-0.3V$ Voltage on any pin that is not 5V tolerant, with respect to Vss (Note 3) $-0.3V$ to (VDVoltage on any 5V tolerant pin with respect to Vss when VDD $\geq 2.3V$ (Note 3) $-0.3V$ Voltage on any 5V tolerant pin with respect to Vss when VDD $\leq 2.3V$ (Note 3) $-0.3V$	o +150°C to +4.0V D + 0.3V)
Voltage on VDD with respect to Vss-0.3VVoltage on any pin that is not 5V tolerant, with respect to Vss (Note 3)-0.3V to (VDVoltage on any 5V tolerant pin with respect to Vss when VDD $\ge 2.3V$ (Note 3)-0.3V	to +4.0V D + 0.3V)
Voltage on VDD with respect to Vss-0.3VVoltage on any pin that is not 5V tolerant, with respect to Vss (Note 3)-0.3V to (VDVoltage on any 5V tolerant pin with respect to Vss when VDD $\ge 2.3V$ (Note 3)-0.3V	to +4.0V D + 0.3V)
Voltage on any 5V tolerant pin with respect to Vss when VDD $\ge 2.3V$ (Note 3)	,
Voltage on any 5V tolerant pin with respect to Vss when VDD < 2.3V (Note 3)	to +5.5V
	to +3.6V
Voltage on D+ or D- pin with respect to VUSB3V30.3V to (VUSB3V	3 + 0.3V)
-0.3V voltage on VBUS with respect to VSS	to +5.5V
Maximum current out of Vss pin(s)	300 mA
Maximum current into VDD pin(s) (Note 2)	300 mA
Maximum output current sunk by any I/O pin	15 mA
Maximum output current sourced by any I/O pin	15 mA
Maximum current sunk by all ports	200 mA
Maximum current sourced by all ports (Note 2)	

Note 1: Stresses above those listed under "**Absolute Maximum Ratings**" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions, above those indicated in the operation listings of this specification, is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

2: Maximum allowable current is a function of device maximum power dissipation (see Table 30-2).

3: See the "Pin Diagrams" section for the 5V tolerant pins.

31.1 DC Characteristics

TABLE 31-1: OPERATING MIPS VS. VOLTAGE

Characteristic	VDD Range	Temp. Range	Max. Frequency
(in Volts) ⁽¹⁾		(in °C)	PIC32MX1XX/2XX 28/36/44-pin Family
MDC5	2.3-3.6V	-40°C to +85°C	50 MHz

Note 1: Overall functional device operation at VBORMIN < VDD < VDDMIN is tested, but not characterized. All device Analog modules, such as ADC, etc., will function, but with degraded performance below VDDMIN. Refer to parameter BO10 in Table 30-11 for BOR values.

TABLE 31-2: DC CHARACTERISTICS: OPERATING CURRENT (IDD)

DC CHARACTERISTICS			(unless other	erating Conditions: 2.3V to 3.6V wise stated) aperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial					
Parameter No.	Typical ⁽³⁾	Max.	Units	Units Conditions					
Operating (Operating Current (IDD) (Note 1, 2)								
MDC24	25	37	mA	50 MHz					

Note 1: A device's IDD supply current is mainly a function of the operating voltage and frequency. Other factors, such as PBCLK (Peripheral Bus Clock) frequency, number of peripheral modules enabled, internal code execution pattern, execution from Program Flash memory vs. SRAM, I/O pin loading and switching rate, oscillator type, as well as temperature, can have an impact on the current consumption.

- 2: The test conditions for IDD measurements are as follows:
 - Oscillator mode is EC (for 8 MHz and below) and EC+PLL (for above 8 MHz) with OSC1 driven by external square wave from rail-to-rail, (OSC1 input clock input over/undershoot < 100 mV required)
 - OSC2/CLKO is configured as an I/O input pin
 - USB PLL oscillator is disabled if the USB module is implemented, PBCLK divisor = 1:8
 - CPU, Program Flash, and SRAM data memory are operational, SRAM data memory Wait states = 1
 - No peripheral modules are operating, (ON bit = 0), but the associated PMD bit is cleared
 - WDT, Clock Switching, Fail-Safe Clock Monitor, and Secondary Oscillator are disabled
 - · All I/O pins are configured as inputs and pulled to Vss
 - MCLR = VDD
 - CPU executing while(1) statement from Flash
- 3: RTCC and JTAG are disabled
- **4:** Data in "Typical" column is at 3.3V, 25°C at specified operating frequency unless otherwise stated. Parameters are for design guidance only and are not tested.

TABLE 31-3: DC CHARACTERISTICS: IDLE CURRENT (IIDLE)

DC CHARACTERISTICS			(unless oth	perating Conditions: 2.3V to 3.6V erwise stated) mperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial					
Parameter No.	Typical ⁽²⁾	Max.	Units Conditions						
Idle Current (II	Idle Current (IIDLE): Core Off, Clock on Base Current (Note 1)								
MDC34a	8	13	mA 50 MHz						

Note 1: The test conditions for IIDLE current measurements are as follows:

- Oscillator mode is EC (for 8 MHz and below) and EC+PLL (for above 8 MHz) with OSC1 driven by external square wave from rail-to-rail, (OSC1 input clock input over/undershoot < 100 mV required)
- OSC2/CLKO is configured as an I/O input pin
- USB PLL oscillator is disabled if the USB module is implemented, PBCLK divisor = 1:8
- CPU is in Idle mode (CPU core Halted), and SRAM data memory Wait states = 1
- No peripheral modules are operating, (ON bit = 0), but the associated PMD bit is cleared
- WDT, Clock Switching, Fail-Safe Clock Monitor, and Secondary Oscillator are disabled
- · All I/O pins are configured as inputs and pulled to Vss
- MCLR = VDD
- RTCC and JTAG are disabled
- 2: Data in the "Typical" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

DC CHAR	ACTERIST	ICS			nditions: 2.3V to 3.6V (unless otherwise stated) -40°C \leq TA \leq +85°C for Industrial			
Param. No.	Typical ⁽²⁾	Max.	Units	Conditions				
Power-Down Current (IPD) (Note 1)								
MDC40k	10	25	μA	-40°C	Page Power Down Current			
MDC40n	250	500	μΑ	+85°C Base Power-Down Current				
Module D	oifferential (Current						
MDC41e	10	55	μA	3.6V	Watchdog Timer Current: AIWDT (Note 3)			
MDC42e	23	55	μA	3.6V RTCC + Timer1 w/32 kHz Crystal: △IRTCC (Not				
MDC43d	1100	1300	μA	3.6V ADC: △IADC (Notes 3,4)				

TABLE 31-4: DC CHARACTERISTICS: POWER-DOWN CURRENT (IPD)

Note 1: The test conditions for IPD current measurements are as follows:

- Oscillator mode is EC (for 8 MHz and below) and EC+PLL (for above 8 MHz) with OSC1 driven by external square wave from rail-to-rail, (OSC1 input clock input over/undershoot < 100 mV required)
- OSC2/CLKO is configured as an I/O input pin
- USB PLL oscillator is disabled if the USB module is implemented, PBCLK divisor = 1:8
- CPU is in Sleep mode, and SRAM data memory Wait states = 1
- No peripheral modules are operating, (ON bit = 0), but the associated PMD bit is set
- WDT, Clock Switching, Fail-Safe Clock Monitor, and Secondary Oscillator are disabled
- All I/O pins are configured as inputs and pulled to Vss
- MCLR = VDD
- RTCC and JTAG are disabled
- 2: Data in the "Typical" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.
- 3: The ∆ current is the additional current consumed when the module is enabled. This current should be added to the base IPD current.
- 4: Test conditions for ADC module differential current are as follows: Internal ADC RC oscillator enabled.

TABLE 31-5: EXTERNAL CLOCK TIMING REQUIREMENTS

AC CHARACTERISTICS		Standard Operating Conditions: 2.3V to 3.6V(unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial					
Param. No.	Symbol	Characteristics	Min.	Typical	Max.	Units	Conditions
MOS10		External CLKI Frequency (External clocks allowed only in EC and ECPLL modes)	DC 4		50 50		EC (Note 2) ECPLL (Note 1)

Note 1: PLL input requirements: 4 MHz \leq FPLLIN \leq 5 MHz (use PLL prescaler to reduce Fosc). This parameter is characterized, but tested at 10 MHz only at manufacturing.

2: This parameter is characterized, but not tested in manufacturing.

TABLE 31-6: SPIX MASTER MODE (CKE = 0) TIMING REQUIREMENTS

AC CHARACTERISTICS		Standard Operating Conditions: 2.3V to 3.6V(unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial					
Param. No.	Symbol	Characteristics	Min. Typical Max. Units Conditi				Conditions
MSP10	TscL	SCKx Output Low Time (Note 1,2)	Тѕск/2	_	—	ns	_
MSP11	TscH	SCKx Output High Time (Note 1,2)	Тѕск/2	—	_	ns	—

Note 1: These parameters are characterized, but not tested in manufacturing.

2: The minimum clock period for SCKx is 40 ns. Therefore, the clock generated in Master mode must not violate this specification.

TABLE 31-7: SPIX MODULE MASTER MODE (CKE = 1) TIMING REQUIREMENTS

AC CHARACTERISTICS		Standard Operating Conditions: 2.3V to 3.6V(unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industri					
Param. No.	Symbol	Characteristics ⁽¹⁾	Min. Typ. Max. Units Condition				Conditions
MSP10	TscL	SCKx Output Low Time (Note 1,2)	Тѕск/2			ns	_
MSP11	TscH	SCKx Output High Time (Note 1,2)	Tsck/2	_	_	ns	_

Note 1: These parameters are characterized, but not tested in manufacturing.

2: The minimum clock period for SCKx is 40 ns. Therefore, the clock generated in Master mode must not violate this specification.

TABLE 31-8: SPIX MODULE SLAVE MODE (CKE = 0) TIMING REQUIREMENTS

AC CHARACTERISTICS			(unless o	otherwis	e stated ture -40	l) °C ≤ TA :	: 2.3V to 3.6V ≤ +85°C for Industrial ≤ +105°C for V-temp
Param. No.	Symbol	Characteristics	Min.	Тур.	Max.	Units	Conditions
MSP70	TscL	SCKx Input Low Time (Note 1,2)	Tsck/2			ns	_
MSP71	TscH	SCKx Input High Time (Note 1,2)	Tsck/2	—		ns	—
MSP51	TssH2doZ	SSx ↑ to SDOx Output High-Impedance (Note 2)	5	_	25	ns	—

Note 1: These parameters are characterized, but not tested in manufacturing.

2: The minimum clock period for SCKx is 40 ns.

TABLE 31-9: SPIX MODULE SLAVE MODE (CKE = 1) TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 2.3V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial				
Param. No.	Symbol	Characteristics	Min.	Typical	Max.	Units	Conditions
SP70	TscL	SCKx Input Low Time (Note 1,2)	Тѕск/2	_	_	ns	_
SP71	TscH	SCKx Input High Time (Note 1,2)	Tsck/2	_		ns	—

Note 1: These parameters are characterized, but not tested in manufacturing.

2: The minimum clock period for SCKx is 40 ns.

NOTES:

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32.0

Note:

0.50

0.00

1.00

1.50

2.00

range (e.g., outside specified power supply range) and therefore, outside the warranted range. FIGURE 32-1: I/O OUTPUT VOLTAGE HIGH (Vон) **FIGURE 32-2:** VOH (V) -0.050 0.050 -0.045 3.6V 0.045 -0.040 3.3V 0.040 -0.035 0.035 3V -0.030 0.030 IOH(A) IOH(A) -0.025 0.025 -0.020 0.020 Absolute Maximum -0.015 0.015 -0.010 0.010 0.005 -0.005 0.000 0.000

2.50

3.00

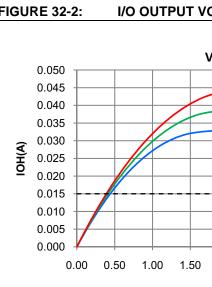
4.00

3.50

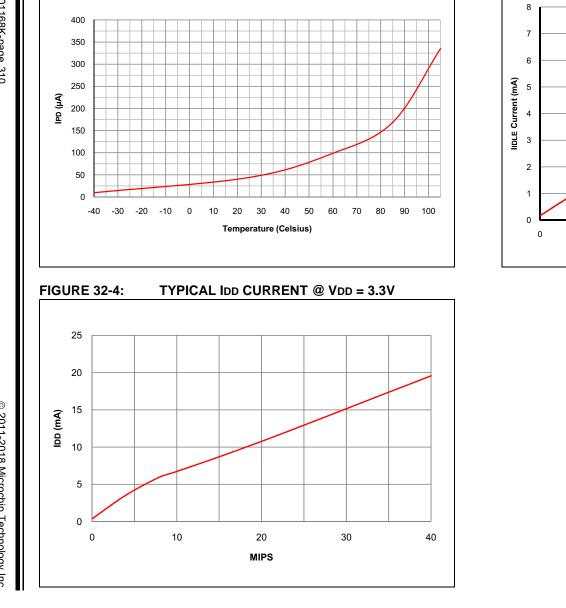
The graphs provided following this note are a statistical summary based on a limited number of samples and are provided following this note are a statistical summary based on a limited number of samples and are provided following this note are a statistical summary based on a limited number of samples and are provided following the samples are a statistical summary based on a limited number of samples and are provided following the samples are a statistical summary based on a limited number of samples are a statistical summary based on a limited number of samples are a statistical summary based on a limited number of samples are a statistical summary based on a limited number of samples are a statistical summary based on a limited number of samples are a statistical summary based on a limited number of samples are a statistical summary based on a limited number of samples are a statistical summary based on a limited number of samples are a statistical summary based on a limited number of samples are a statistical summary based on a limited number of samples and are provided by a statistical summary based on a limited number of samples and are provided by a statistical summary based on a limited number of samples are a statistical summary based on a limited number of samples are a statistical summary based on a limited number of samples are a statistical summary based on a limited number of samples are a statistical summary based on a limited number of samples are a statistical summary based on a limited number of samples are a statistical summary based on a limited number of samples are a statistical summary based on a limited number of samples are a statistical summary based on a limited number of samples are a statistical summary based on a statistical summary based

only. The performance characteristics listed herein are not tested or guaranteed. In some graphs, the data presented n

DC AND AC DEVICE CHARACTERISTICS GRAPHS



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TYPICAL IPD CURRENT @ VDD = 3.3V

FIGURE 32-5:

TYPICAL IDLE

10

м



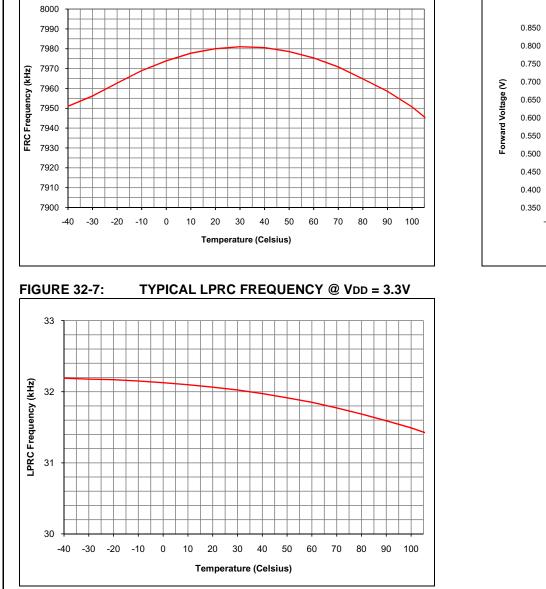
FIGURE 32-3:

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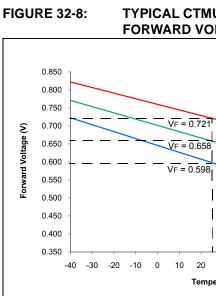


FIGURE 32-6:





TYPICAL FRC FREQUENCY @ VDD = 3.3V



NOTES:

33.0 PACKAGING INFORMATION

33.1 Package Marking Information

28-Lead SOIC



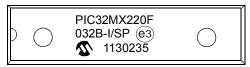
Example



28-Lead SPDIP



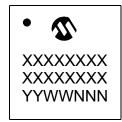
Example



28-Lead SSOP



28-Lead QFN



Example



Example



Legend	d: XXX Y YY WW NNN @3 *	Customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package.
Note:		According to the number cannot be marked on one line, it is carried over to the next imiting the number of available characters for customer-specific information.

33.1 Package Marking Information (Continued)



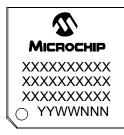
44-Lead VTLA



44-Lead QFN



44-Lead TQFP



Example 32MX220F 032CE/TL@3 1130235

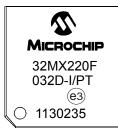
Example



Example



Example



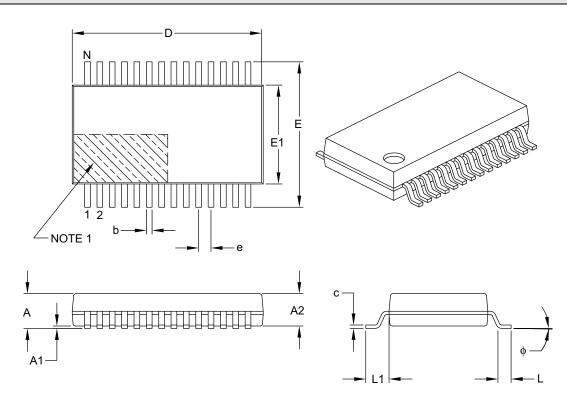
Legend	I: XXX Y YY WW NNN @3 *	Customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator (@3) can be found on the outer packaging for this package.
Note:		licrochip part number cannot be marked on one line, it is carried over to the next imiting the number of available characters for customer-specific information.

33.2 Package Details

This section provides the technical details of the packages.

28-Lead Plastic Shrink Small Outline (SS) – 5.30 mm Body [SSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units		MILLIMETERS			
	Dimension Limits		NOM	MAX		
Number of Pins	N	28				
Pitch	е		0.65 BSC			
Overall Height	А	-	-	2.00		
Molded Package Thickness	A2	1.65	1.75	1.85		
Standoff	A1	0.05	-	-		
Overall Width	E	7.40	7.80	8.20		
Molded Package Width	E1	5.00	5.30	5.60		
Overall Length	D	9.90	10.20	10.50		
Foot Length	L	0.55	0.75	0.95		
Footprint L1		1.25 REF				
Lead Thickness	С	0.09	-	0.25		
Foot Angle	ф	0°	4°	8°		
Lead Width	b	0.22	-	0.38		

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.20 mm per side.

- 3. Dimensioning and tolerancing per ASME Y14.5M.
 - BSC: Basic Dimension. Theoretically exact value shown without tolerances.

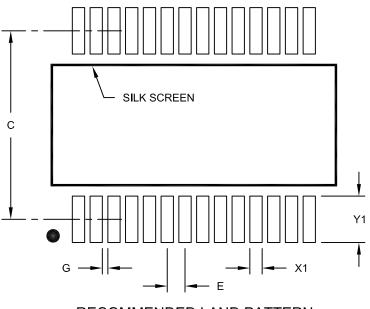
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-073B

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28-Lead Plastic Shrink Small Outline (SS) - 5.30 mm Body [SSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	MILLIMETERS			
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	0.65 BSC		
Contact Pad Spacing	С	7.20		
Contact Pad Width (X28)	X1			0.45
Contact Pad Length (X28)	Y1			1.75
Distance Between Pads		0.20		

Notes:

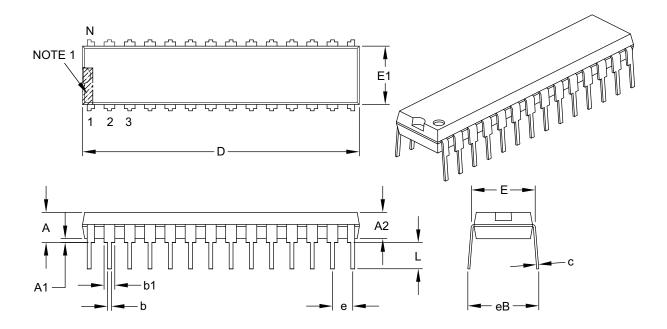
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2073A

28-Lead Skinny Plastic Dual In-Line (SP) – 300 mil Body [SPDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units		INCHES	
Dimensio	on Limits	MIN	NOM	MAX
Number of Pins	Ν		28	
Pitch	е	.100 BSC		
Top to Seating Plane	Α	-	-	.200
Molded Package Thickness	A2	.120	.135	.150
Base to Seating Plane	A1	.015	-	-
Shoulder to Shoulder Width	Е	.290	.310	.335
Molded Package Width	E1	.240	.285	.295
Overall Length	D	1.345	1.365	1.400
Tip to Seating Plane	L	.110	.130	.150
Lead Thickness	С	.008	.010	.015
Upper Lead Width	b1	.040	.050	.070
Lower Lead Width	b	.014	.018	.022
Overall Row Spacing §	eB	-	-	.430

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. § Significant Characteristic.

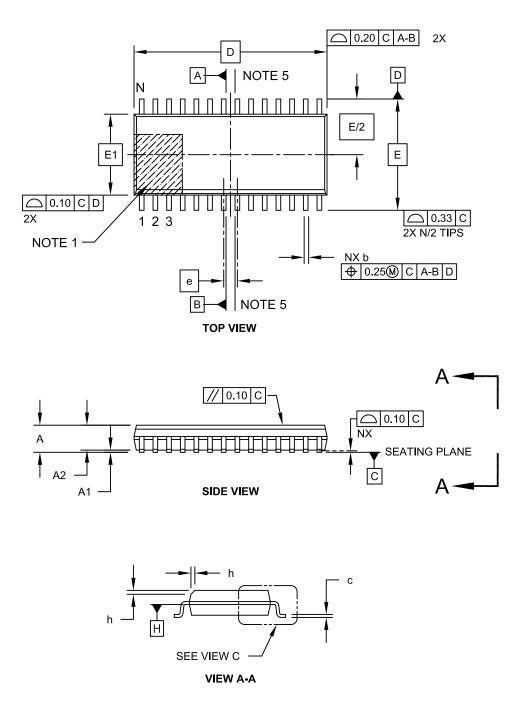
3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.

 Dimensioning and tolerancing per ASME Y14.5M. BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-070B

28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

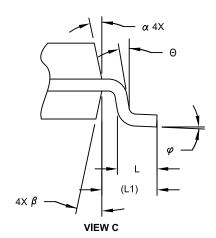
Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging

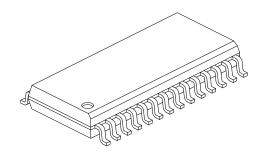


Microchip Technology Drawing C04-052C Sheet 1 of 2

28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging





	MILLIMETERS			
Dimension L		MIN	NOM	MAX
Number of Pins	И		28	
Pitch	е	1.27 BSC		
Overall Height	A	-	-	2.65
Molded Package Thickness	A2	2.05	-	-
Standoff §	A1	0.10	-	0.30
Overall Width	E	10.30 BSC		
Molded Package Width	E1	7.50 BSC		
Overall Length	D	17.90 BSC		
Chamfer (Optional)	h	0.25 - 0.75		0.75
Foot Length	L	0.40	-	1.27
Footprint	L1	1.40 REF		
Lead Angle	Θ	0°	-	-
Foot Angle	φ	0°	-	8°
Lead Thickness	С	0.18	-	0.33
Lead Width	b	0.31	-	0.51
Mold Draft Angle Top	α	5°	-	15°
Mold Draft Angle Bottom	β	5°	-	15°

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. § Significant Characteristic
- 3. Dimension D does not include mold flash, protrusions or gate burrs, which shall not exceed 0.15 mm per end. Dimension E1 does not include interlead flash or protrusion, which shall not exceed 0.25 mm per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M BSC: Basic Dimension. Theoretically exact value shown without tolerances.

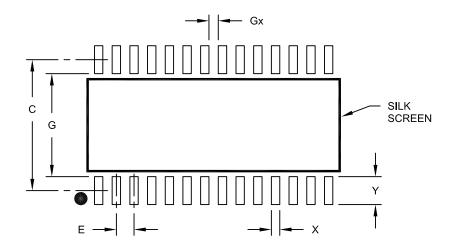
REF: Reference Dimension, usually without tolerance, for information purposes only.

5. Datums A & B to be determined at Datum H.

Microchip Technology Drawing C04-052C Sheet 2 of 2

28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	Units		MILLIMETERS			
Dimension Limits		MIN	NOM	MAX		
Contact Pitch E		1.27 BSC				
Contact Pad Spacing	С	9.40				
Contact Pad Width (X28)				0.60		
Contact Pad Length (X28)	Y			2.00		
Distance Between Pads	Gx	0.67				
Distance Between Pads		7.40				

Notes:

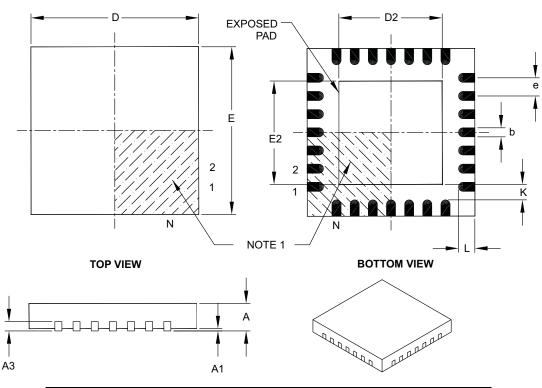
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2052A

28-Lead Plastic Quad Flat, No Lead Package (ML) – 6x6 mm Body [QFN] with 0.55 mm Contact Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	MILLIMETERS			
	Dimension Limits	MIN	NOM	MAX	
Number of Pins	N	28			
Pitch	e	0.65 BSC			
Overall Height	A	0.80	0.90	1.00	
Standoff	A1	0.00	0.02	0.05	
Contact Thickness	A3	0.20 REF			
Overall Width	all Width E 6.00 BSC		6.00 BSC		
Exposed Pad Width	E2	3.65 3.70 4.20		4.20	
Overall Length	D	6.00 BSC			
Exposed Pad Length	D2	3.65	3.70	4.20	
Contact Width	b	0.23	0.30	0.35	
Contact Length	L	0.50	0.55	0.70	
Contact-to-Exposed Pad	K	0.20	-	_	

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Package is saw singulated.

3. Dimensioning and tolerancing per ASME Y14.5M.

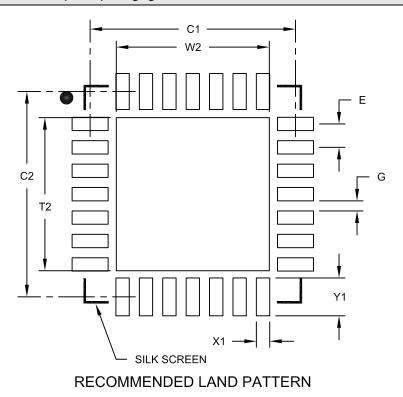
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-105B

28-Lead Plastic Quad Flat, No Lead Package (ML) – 6x6 mm Body [QFN] with 0.55 mm Contact Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	MILLIMETERS			
Dimension Limits		MIN	NOM	MAX
Contact Pitch E		0.65 BSC		
Optional Center Pad Width	W2			4.25
Optional Center Pad Length	T2			4.25
Contact Pad Spacing	C1		5.70	
Contact Pad Spacing	C2		5.70	
Contact Pad Width (X28)	X1			0.37
Contact Pad Length (X28)	Y1			1.00
Distance Between Pads	G	0.20		

Notes:

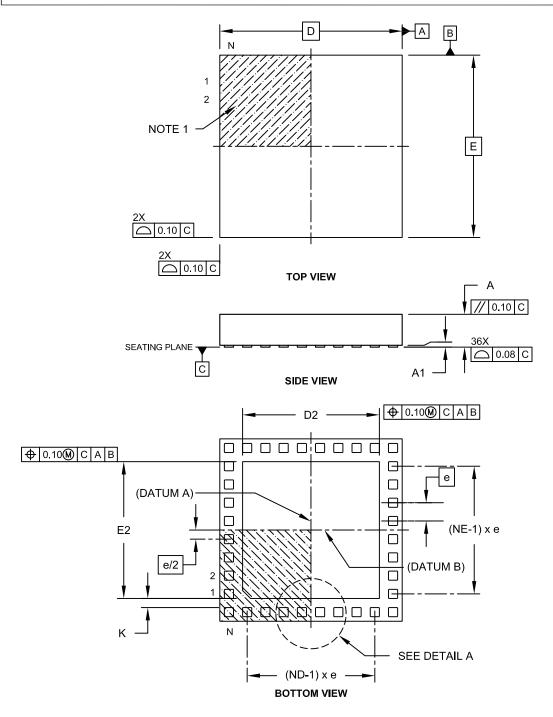
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2105A

36-Terminal Very Thin Thermal Leadless Array Package (TL) – 5x5x0.9 mm Body with Exposed Pad [VTLA]

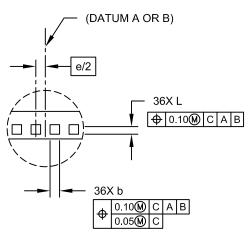
Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging

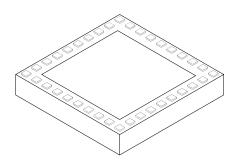


Microchip Technology Drawing C04-187C Sheet 1 of 2

36-Terminal Very Thin Thermal Leadless Array Package (TL) – 5x5x0.9 mm Body with Exposed Pad [VTLA]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging





DETAIL A

	MILLIMETERS			
Dimension Li		MIN	NOM	MAX
Number of Pins	Ν		36	
Number of Pins per Side	ND	10		
Number of Pins per Side	NE	8		
Pitch	е	0.50 BSC		
Overall Height	А	0.80	0.90	1.00
Standoff	A1	0.025	-	0.075
Overall Width	Е	5.00 BSC		
Exposed Pad Width	E2	3.60	3.75	3.90
Overall Length	D	5.00 BSC		
Exposed Pad Length	D2	3.60	3.75	3.90
Contact Width	b	0.20	0.25	0.30
Contact Length	L	0.20	0.25	0.30
Contact-to-Exposed Pad	Κ	0.20	-	-

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

- 2. Package is saw singulated.
- 3. Dimensioning and tolerancing per ASME Y14.5M.

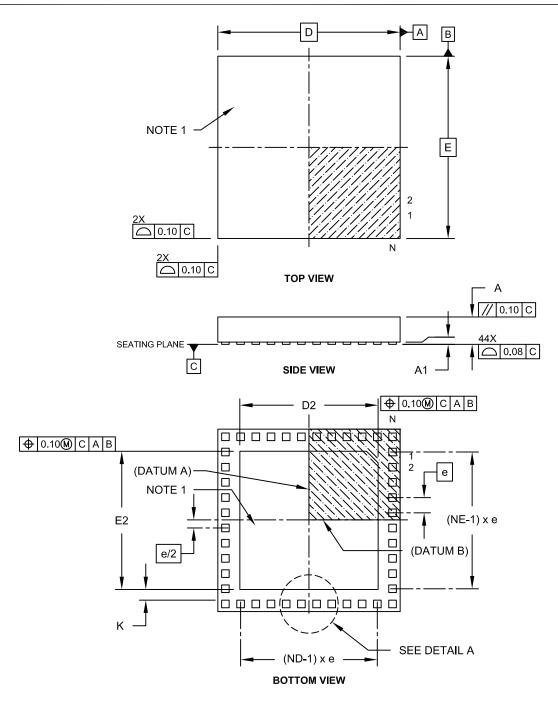
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-187C Sheet 2 of 2

44-Terminal Very Thin Leadless Array Package (TL) – 6x6x0.9 mm Body With Exposed Pad [VTLA]

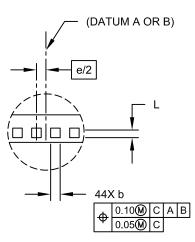
Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



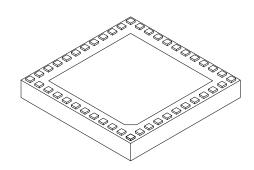
Microchip Technology Drawing C04-157C Sheet 1 of 2

44-Terminal Very Thin Leadless Array Package (TL) – 6x6x0.9 mm Body With Exposed Pad [VTLA]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



DETAIL A



Units		MILLIMETERS		
Dimension	Limits	MIN	NOM	MAX
Number of Pins	N		44	
Number of Pins per Side	ND		12	
Number of Pins per Side	NE		10	
Pitch	е		0.50 BSC	
Overall Height	A	0.80	0.90	1.00
Standoff	A1	0.025	-	0.075
Overall Width	E		6.00 BSC	
Exposed Pad Width	E2	4.40	4.55	4.70
Overall Length	D		6.00 BSC	
Exposed Pad Length	D2	4.40	4.55	4.70
Contact Width	b	0.20	0.25	0.30
Contact Length	L	0.20	0.25	0.30
Contact-to-Exposed Pad	K	0.20	-	-

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Package is saw singulated.

3. Dimensioning and tolerancing per ASME Y14.5M.

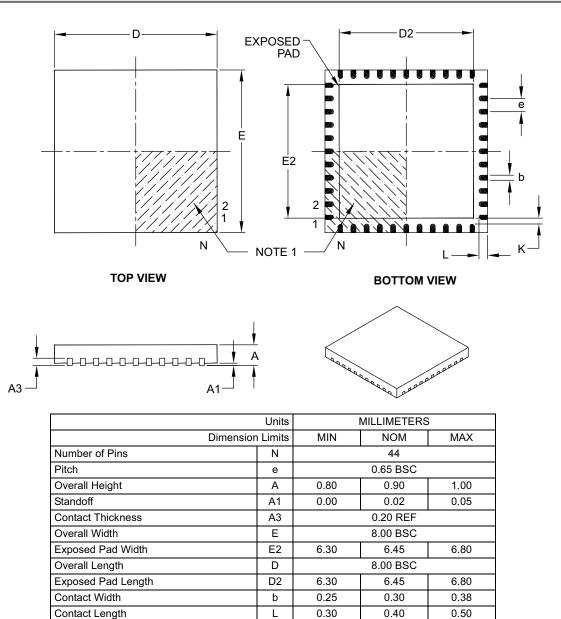
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-157C Sheet 2 of 2

44-Lead Plastic Quad Flat, No Lead Package (ML) – 8x8 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Κ

0.20

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Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Package is saw singulated.

3. Dimensioning and tolerancing per ASME Y14.5M.

Contact-to-Exposed Pad

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

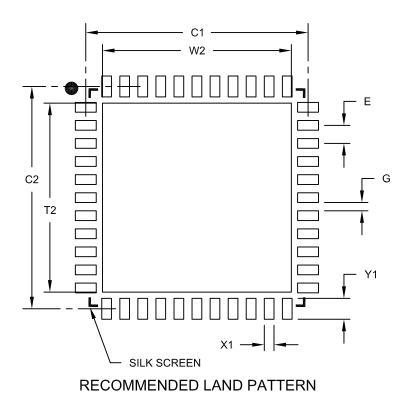
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-103B

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44-Lead Plastic Quad Flat, No Lead Package (ML) – 8x8 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units			MILLIMETERS		
Dimension	Limits	MIN	NOM	MAX	
Contact Pitch	E		0.65 BSC		
Optional Center Pad Width	W2			6.80	
Optional Center Pad Length	T2			6.80	
Contact Pad Spacing	C1		8.00		
Contact Pad Spacing	C2		8.00		
Contact Pad Width (X44)	X1			0.35	
Contact Pad Length (X44)	Y1			0.80	
Distance Between Pads	G	0.25			

Notes:

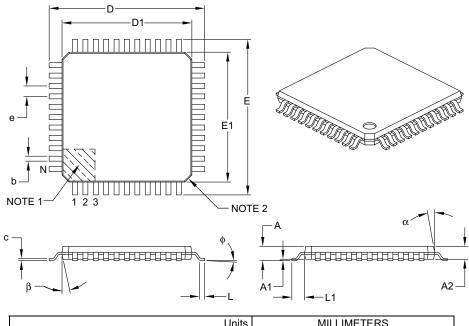
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2103A

44-Lead Plastic Thin Quad Flatpack (PT) – 10x10x1 mm Body, 2.00 mm [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units			MILLIMETERS	;
D	imension Limits	MIN	NOM	MAX
Number of Leads	N		44	
Lead Pitch	е		0.80 BSC	
Overall Height	А	_	-	1.20
Molded Package Thickness	A2	0.95	1.00	1.05
Standoff	A1	0.05	-	0.15
Foot Length	L	0.45	0.60	0.75
Footprint	L1		1.00 REF	
Foot Angle	ф	0°	3.5°	7°
Overall Width	E	12.00 BSC		
Overall Length	D	12.00 BSC		
Molded Package Width	E1	10.00 BSC		
Molded Package Length	D1	10.00 BSC		
Lead Thickness	С	0.09	-	0.20
Lead Width	b	0.30	0.37	0.45
Mold Draft Angle Top	α	11°	12°	13°
Mold Draft Angle Bottom	β	11°	12°	13°

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Chamfers at corners are optional; size may vary.

Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25 mm per side.
 Dimensioning and tolerancing per ASME Y14.5M.

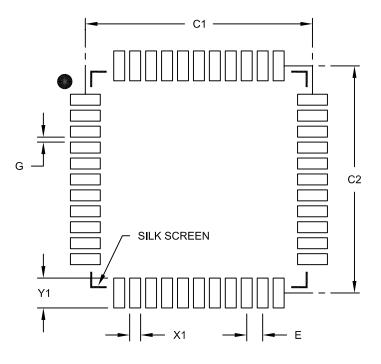
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-076B

44-Lead Plastic Thin Quad Flatpack (PT) 10X10X1 mm Body, 2.00 mm Footprint [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

-				
Units		L N	ILLIMETER	S
Dimension	Limits	MIN	NOM	MAX
Contact Pitch	E		0.80 BSC	
Contact Pad Spacing	C1		11.40	
Contact Pad Spacing	C2		11.40	
Contact Pad Width (X44)	X1			0.55
Contact Pad Length (X44)	Y1			1.50
Distance Between Pads	G	0.25		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2076B

APPENDIX A: REVISION HISTORY

Revision A (May 2011)

This is the initial released version of this document.

Revision B (October 2011)

The following two global changes are included in this revision:

- All packaging references to VLAP have been changed to VTLA throughout the document
- All references to VCORE have been removed
- All occurrences of the ASCL1, ASCL2, ASDA1, and ASDA2 pins have been removed
- V-temp temperature range (-40°C to +105°C) was added to all electrical specification tables

This revision includes the addition of the following devices:

PIC32MX230F064B

PIC32MX230F064C

PIC32MX230F064D

• PIC32MX250F128B

PIC32MX250F128C

PIC32MX250F128D

- PIC32MX130F064B
- PIC32MX130F064C
- PIC32MX130F064D
- PIC32MX150F128B
- PIC32MX150F128C
- PIC32MX150F128D

Text and formatting changes were incorporated throughout the document.

All other major changes are referenced by their respective section in Table A-1.

Section	Update Description
"32-bit Microcontrollers (up to 128 KB Flash and 32 KB SRAM) with Audio	Split the existing Features table into two: PIC32MX1XX General Purpose Family Features (Table 1) and PIC32MX2XX USB Family Features (Table 2).
and Graphics Interfaces, USB, and Advanced Analog"	Added the SPDIP package reference (see Table 1, Table 2, and " Pin Diagrams ").
	Added the new devices to the applicable pin diagrams.
	Changed PGED2 to PGED1 on pin 35 of the 36-pin VTLA diagram for PIC32MX220F032C, PIC32MX220F016C, PIC32MX230F064C, and PIC32MX250F128C devices.
1.0 "Device Overview"	Added the SPDIP package reference and updated the pin number for AN12 for 44-pin QFN devices in the Pinout I/O Descriptions (see Table 1-1).
	Added the PGEC4/PGED4 pin pair and updated the C1INA-C1IND and C2INA-C2IND pin numbers for 28-pin SSOP/SPDIP/SOIC devices in the Pinout I/O Descriptions (see Table 1-1).
2.0 "Guidelines for Getting Started with 32-bit Microcontrollers"	Updated the Recommended Minimum Connection diagram (see Figure 2-1).

TABLE A-1: MAJOR SECTION UPDATES

TABLE A-1: MAJOR SECTION UPDATES (CONTINUED)

Section	Update Description
4.0 "Memory Organization"	Added Memory Maps for the new devices (see Figure 4-3 and Figure 4-4).
	Removed the BMXCHEDMA bit from the Bus Matrix Register map (see Table 4-1).
	Added the REFOTRIM register, added the DIVSWEN bit to the REFOCON registers, added Note 4 to the ULOCK and SOSCEN bits and added the PBDIVRDY bit in the OSCCON register in the in the System Control Register map (see Table 4-16).
	Removed the ALTI2C1 and ALTI2C2 bits from the DEVCFG3 register and added Note 1 to the UPLLEN and UPLLIDIV<2:0> bits of the DEVCFG2 register in the Device Configuration Word Summary (see Table 4-17).
	Updated Note 1 in the Device and Revision ID Summary (see Table 4-18).
	Added Note 2 to the PORTA Register map (see Table 4-19).
	Added the ANSB6 and ANSB12 bits to the ANSELB register in the PORTB Register map (see Table 4-20).
	Added Notes 2 and 3 to the PORTC Register map (see Table 4-21).
	Updated all register names in the Peripheral Pin Select Register map (see Table 4-23).
	Added values in support of new devices (16 KB RAM and 32 KB RAM) in the Data RAM Size register (see Register 4-5).
	Added values in support of new devices (64 KB Flash and 128 KB Flash) in the Data RAM Size register (see Register 4-5).
8.0 "Oscillator Configuration"	Added Note 5 to the PIC32MX1XX/2XX Family Clock Diagram (see Figure 8-1).
	Added the PBDIVRDY bit and Note 2 to the Oscillator Control register (see Register 8-1).
	Added the DIVSWEN bit and Note 3 to the Reference Oscillator Control register (see Register 8-3).
	Added the REFOTRIM register (see Register 8-4).
21.0 "10-bit Analog-to-Digital	Updated the ADC1 Module Block Diagram (see Figure 21-1).
Converter (ADC)"	Updated the Notes in the ADC Input Select register (see Register 21-4).
24.0 "Charge Time Measurement	Updated the CTMU Block Diagram (see Figure 24-1).
Unit (CTMU)"	Added Note 3 to the CTMU Control register (see Register 24-1)
26.0 "Special Features"	Added Note 1 and the PGEC4/PGED4 pin pair to the ICESEL<1:0> bits in DEVCFG0: Device Configuration Word 0 (see Register 26-1).
	Removed the ALTI2C1 and ALTI2C2 bits from the Device Configuration Word 3 register (see Register 26-4).
	Removed 26.3.3 "Power-up Requirements".
	Added Note 3 to the Connections for the On-Chip Regulator diagram (see Figure 26-2).
	Updated the Block Diagram of Programming, Debugging and Trace Ports diagram (see Figure 26-3).

ABLE A-1: MAJOR SECTION UPDATES (CONTINUED)		
Section	Update Description	
29.0 "Electrical Characteristics"	Updated the Absolute Maximum Ratings (removed Voltage on VCORE with respect to Vss).	
	Added the SPDIP specification to the Thermal Packaging Characteristics (see Table 29-2).	
	Updated the Typical values for parameters DC20-DC24 in the Operating Current (IDD) specification (see Table 29-5).	
	Updated the Typical values for parameters DC30a-DC34a in the Idle Current (IIDLE) specification (see Table 29-6).	
	Updated the Typical values for parameters DC40i and DC40n and removed parameter DC40m in the Power-down Current (IPD) specification (see Table 29-7).	
	Removed parameter D320 (VCORE) from the Internal Voltage Regulator Specifications and updated the Comments (see Table 29-13).	
	Updated the Minimum, Typical, and Maximum values for parameter F20b in the Internal FRC Accuracy specification (see Table 29-17).	
	Removed parameter SY01 (TPWRT) and removed all Conditions from Resets Timing (see Table 29-20).	
	Updated all parameters in the CTMU Specifications (see Table 29-39).	
31.0 "Packaging Information"	Added the 28-lead SPDIP package diagram information (see 31.1 " Package Marking Information " and 31.2 " Package Details ").	
"Product Identification System"	Added the SPDIP (SP) package definition.	

TABLE A-1: MAJOR SECTION UPDATES (CONTINUED)

Revision C (November 2011)

All major changes are referenced by their respective section in Table A-2.

TABLE A-2: MAJOR SECTION UPDATES

Section	Update Description
"32-bit Microcontrollers (up to 128 KB Flash and 32 KB SRAM) with Audio and Graphics Interfaces, USB, and Advanced Analog"	Revised the source/sink on I/O pins (see "Input/Output" on page 1). Added the SPDIP package to the PIC32MX220F032B device in the PIC32MX2XX USB Family Features (see Table 2).
4.0 "Memory Organization"	Removed ANSB6 from the ANSELB register and added the ODCB6, ODCB10, and ODCB11 bits in the PORTB Register Map (see Table 4-20).
29.0 "Electrical Characteristics"	Updated the minimum value for parameter OS50 in the PLL Clock Timing Specifications (see Table 29-16).

Revision D (February 2012)

All occurrences of VUSB were changed to: VUSB3V3. In addition, text and formatting changes were incorporated throughout the document.

All other major changes are referenced by their respective section in Table A-3.

TABLE A-3: MAJOR SECTION UPDATES

Section	Update Description
"32-bit Microcontrollers (up to 128	Corrected a part number error in all pin diagrams.
KB Flash and 32 KB SRAM) with Audio and Graphics Interfaces, USB, and Advanced Analog"	Updated the DMA Channels (Programmable/Dedicated) column in the PIC32MX1XX General Purpose Family Features (see Table 1).
1.0 "Device Overview"	Added the TQFP and VTLA packages to the 44-pin column heading and updated the pin numbers for the SCL1, SCL2, SDA1, and SDA2 pins in the Pinout I/O Descriptions (see Table 1-1).
7.0 "Interrupt Controller"	Updated the Note that follows the features.
	Updated the Interrupt Controller Block Diagram (see Figure 7-1).
29.0 "Electrical Characteristics"	Updated the Maximum values for parameters DC20-DC24, and the Minimum value for parameter DC21 in the Operating Current (IDD) DC Characteristics (see Table 29-5).
	Updated all Minimum and Maximum values for the Idle Current (IIDLE) DC Characteristics (see Table 29-6).
	Updated the Maximum values for parameters DC40k, DC40l, DC40n, and DC40m in the Power-down Current (IPD) DC Characteristics (see Table 29-7).
	Changed the minimum clock period for SCKx from 40 ns to 50 ns in Note 3 of the SPIx Master and Slave Mode Timing Requirements (see Table 29-26 through Table 29-29).
30.0 "DC and AC Device Characteristics Graphs"	Updated the Typical IIDLE Current @ VDD = 3.3V graph (see Figure 30-5).

Revision E (October 2012)

All singular pin diagram occurrences of CVREF were changed to: CVREFOUT. In addition, minor text and formatting changes were incorporated throughout the document.

All major changes are referenced by their respective section in Table A-4.

TABLE A-4:	MAJOR SECTION UPDATES
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Section	Update Description
"32-bit Microcontrollers (up to 128 KB Flash and 32 KB SRAM) with Audio and Graphics Interfaces, USB, and Advanced Analog"	Updated the following feature sections: "Operating Conditions" "Communication Interfaces"
2.0 "Guidelines for Getting Started with 32-bit MCUs"	Removed Section 2.8 "Configuration of Analog and Digital Pins During ICSP Operations".
3.0 "CPU"	Removed references to GPR shadow registers in 3.1 "Features" and 3.2.1 "Execution Unit" .
4.0 "Memory Organization"	Updated the BRG bit range in the SPI1 and SPI2 Register Map (see Table 4-8). Added the PWP<6> bit to the Device Configuration Word Summary (see Table 4-17).
5.0 "Flash Program Memory"	Added a note with Flash page size and row size information.
7.0 "Interrupt Controller"	Updated the TPC<2:0> bit definitions (see Register 7-1). Updated the IPTMR<31:0> bit definition (see Register 7-3).
8.0 "Oscillator Configuration"	Updated the PIC32MX1XX/2XX Family Clock Diagram (see Figure 8-1). Updated the RODIV<14:0> bit definitions (see Register 8-3).
10.0 "USB On-The-Go (OTG)"	Updated the Notes in the USB Interface Diagram (see Figure 10-1).
18.0 "Universal Asynchronous Receiver Transmitter (UART)"	Updated the baud rate range in the list of primary features.
26.0 "Special Features"	Added the PWP<6> bit to the Device Configuration Word 0 (see Register 26-1).
29.0 "Electrical Characteristics"	Added Note 1 to Operating MIPS vs. Voltage (see Table 29-1). Added Note 2 to DC Temperature and Voltage Specifications (see Table 29-4). Updated the Conditions for parameter DC25 in DC Characteristics: Operating Current (IDD) (see Table 29-5). Added Note 2 to Electrical Characteristics: BOR (see Table 29-10). Added Note 4 to Comparator Specifications (see Table 29-12). Added Note 5 to ADC Module Specifications (see Table 29-32). Updated the 10-bit Conversion Rate Parameters and added Note 3 (see Table 29-33). Added Note 4 to the Analog-to-Digital Conversion Timing Requirements (see Table 29-34). Added Note 3 to CTMU Current Source Specifications (see Table 29-39).
30.0 "50 MHz Electrical Characteristics"	New chapter with electrical characteristics for 50 MHz devices.
31.0 "Packaging Information"	The 36-pin and 44-pin VTLA packages have been updated.

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Revision F (February 2014)

This revision includes the addition of the following devices:

PIC32MX170F256B
 PIC32MX270F256B

• PIC32MX170F256D • PIC32MX270F256D

• PIC32MIX170F256D • PIC32MIX270F256D

TABLE A-5: MAJOR SECTION UPDATES

Section Update Description 32-bit Microcontrollers (up to 256 Added new devices to the family features (see Table 1 and Table 2). KB Flash and 64 KB SRAM) with Updated pin diagrams to include new devices (see "Pin Diagrams"). Audio and Graphics Interfaces, USB, and Advanced Analog 1.0 "Device Overview" Added Note 3 reference to the following pin names: VBUS, VUSB3V3, VBUSON, D+, D-, and USBID. 2.0 "Guidelines for Getting Replaced Figure 2-1: Recommended Minimum Connection. Started with 32-bit MCUs" Updated Figure 2-2: MCLR Pin Connections. Added 2.9 "Sosc Design Recommendation". 4.0 "Memory Organization" Added memory tables for devices with 64 KB RAM (see Table 4-4 through Table 4-5). Changed the Virtual Addresses for all registers and updated the PWP bits in the DEVCFG: Device Configuration Word Summary (see Table 4-17). Updated the ODCA, ODCB, and ODCC port registers (see Table 4-19, Table 4-20, and Table 4-21). The RTCTIME, RTCDATE, ALRMTIME, and ALRMDATE registers were updated (see Table 4-25). Added Data Ram Size value for 64 KB RAM devices (see Register 4-5). Added Program Flash Size value for 256 KB Flash devices (see Register 4-5). 12.0 "Timer1" The Timer1 block diagram was updated to include the 16-bit data bus (see Figure 12-1). 13.0 "Timer2/3, Timer4/5" The Timer2-Timer5 block diagram (16-bit) was updated to include the 16-bit data bus (see Figure 13-1). The Timer2/3, Timer4/5 block diagram (32-bit) was updated to include the 32bit data bus (see Figure 13-1). 19.0 "Parallel Master Port (PMP)" The CSF<1:0> bit value definitions for '00' and '01' were updated (see Register 19-1). Bit 14 in the Parallel Port Address register (PMADDR) was updated (see Register 19-3). 20.0 "Real-Time Clock and The following registers were updated: Calendar (RTCC)" RTCTIME (see Register 20-3) RTCDATE (see Register 20-4) ALRMTIME (see Register 20-5) ALRMDATE (see Register 20-6) 26.0 "Special Features" Updated the PWP bits (see Register 26-1). 29.0 "Electrical Characteristics" Added parameters DO50 and DO50a to the Capacitive Loading Requirements on Output Pins (see Table 29-14). Added Note 5 to the IDD DC Characteristics (see Table 29-5). Added Note 4 to the IIDLE DC Characteristics (see Table 29-6). Added Note 5 to the IPD DC Characteristics (see Table 29-7). Updated the conditions for parameters USB321 (VOL) and USB322 (VOH) in the OTG Electrical Specifications (see Table 29-38). Product Identification System Added 40 MHz speed information.

In addition, this revision includes the following major changes as described in Table A-5, as well as minor

updates to text and formatting, which were

incorporated throughout the document.

Revision G (April 2015)

This revision includes the addition of the following devices:

- PIC32MX130F256B PIC32MX230F256B
- PIC32MX130F256D PIC32MX230F256D

The title of the document was updated to avoid confusion with the PIC32MX1XX/2XX/5XX 64/100-pin Family data sheet.

TABLE A-6: MAJOR SECTION UPDATES

All peripheral SFR maps have been relocated from the Memory chapter to their respective peripheral chapters.

In addition, this revision includes the following major changes as described in Table A-6, as well as minor updates to text and formatting, which were incorporated throughout the document.

Section	Update Description
32-bit Microcontrollers (up to 256 KB Flash and 64 KB SRAM) with Audio and Graphics Interfaces, USB, and Advanced Analog	Added new devices to the family features (see Table 1 and Table 2). Updated pin diagrams to include new devices (see Pin Diagrams).
2.0 "Guidelines for Getting Started with 32-bit MCUs"	Updated these sections: 2.2 "Decoupling Capacitors", 2.3 "Capacitor on Internal Voltage Regulator (VCAP)", 2.4 "Master Clear (MCLR) Pin", 2.8.1 "Crystal Oscillator Design Consideration"
4.0 "Memory Organization"	Added Memory Map for new devices (see Figure 4-6).
14.0 "Watchdog Timer (WDT)"	New chapter created from content previously located in the Special Features chapter.
30.0 "Electrical Characteristics"	Removed parameter D312 (TSET) from the Comparator Specifications (see Table 30-12).
	Added the Comparator Voltage Reference Specifications (see Table 30-13).
	Updated Table 30-12.

Revision H (July 2015)

This revision includes the following major changes as described in Table A-7, as well as minor updates to text and formatting, which were incorporated throughout the document.

TABLE A-7: MAJOR SECTION UPDATES

Section	Update Description
2.0 "Guidelines for Getting Started with 32-bit MCUs"	Section 2.9 "Sosc Design Recommendation" was removed.
8.0 "Oscillator Configuration"	The Primary Oscillator (Posc) logic in the Oscillator diagram was updated (see Figure 8-1).
30.0 "Electrical Characteristics"	The Power-Down Current (IPD) DC Characteristics parameter DC40k was updated (see Table 30-7).
	Table 30-9: "DC Characteristics: I/O Pin Input Injection current Specifications" was added.

Revision J (April 2016)

This revision includes the following major changes as described in Table A-8, as well as minor updates to text and formatting, which were incorporated throughout the document.

TABLE A-8: MAJOR SECTION UPDATES

Section	Update Description
"32-bit Microcontrollers (up to 256 KB Flash and 64 KB SRAM) with Audio and Graphics Interfaces, USB, and Advanced Analog"	28/36/44-pin USB Family Features".
2.0 "Guidelines for Getting Started with 32-bit MCUs"	EXAMPLE 2-1: "Crystal Load Capacitor Calculation" was updated.
30.0 "Electrical Characteristics"	Parameter DO50a (Csosc) was removed from the Capacitive Loading Requirements on Output Pins AC Characteristics (see Table 30-16).
"Product Identification System"	The device mapping was updated to include type B for Software Targeting.

Revision K (May 2018)

This revision includes the following major changes as described in Table A-9, as well as minor updates to text and formatting, which were incorporated throughout the document.

TABLE A-9: MAJOR SECTION UPDATES

Section	Update Description
"32-bit Microcontrollers (up to 256 KB Flash and 64 KB SRAM) with Audio and Graphics Interfaces, USB, and Advanced Analog"	The PIC32MX270F256DB device and Note 4 were removed from the PIC32MX2XX 28/36/44-Pin USB Family Features (see Table 2).
"Product Identification System"	Type B for Software Targeting was removed.
Section 2.10 "Considerations When Interfacing To Remotely Powered Circuits"	A new section has been added.

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Tape and Reel Flag (if Speed (if applicable) Temperature Range Package	32-bit RISC MCU with M4K [®] core, 32 KB program memory, 44-pin, Industrial temperature, TQFP package.
	Flash Memory Family
Architecture	$MX = M4K^{\otimes} MCU \text{ core}$
Product Groups	1XX = General purpose microcontroller family 2XX = General purpose microcontroller family
Flash Memory Family	F = Flash program memory
Program Memory Size	016 = 16K 032 = 32K 064 = 64K 128 = 128K 256 = 256K
Pin Count	B = 28-pin C = 36-pin D = 44-pin
Speed	 () = 40 MHz – () indicates a blank field; package markings for 40 MHz devices do not include the Speed 50 = 50 MHz
Temperature Range	I = -40° C to $+85^{\circ}$ C (Industrial) V = -40° C to $+105^{\circ}$ C (V-temp)
Package	ML= 28-Lead (6x6 mm) QFN (Plastic Quad Flatpack)ML= 44-Lead (8x8 mm) QFN (Plastic Quad Flatpack)PT= 44-Lead (10x10x1 mm) TQFP (Plastic Thin Quad Flatpack)SO= 28-Lead (7.50 mm) SOIC (Plastic Small Outline)SP= 28-Lead (300 mil) SPDIP (Skinny Plastic Dual In-line)SS= 28-Lead (5.30 mm) SSOP (Plastic Shrink Small Outline)TL= 36-Lead (5x5 mm) VTLA (Very Thin Leadless Array)TL= 44-Lead (6x6 mm) VTLA (Very Thin Leadless Array)
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